

LM3S1958 Microcontroller

DATA SHEET

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About This Document

This data sheet provides reference information for the LM3S1958 microcontroller, describing the functional blocks of the system-on-chip (SoC) device designed around the ARM® Cortex™-M3 core.

Audience

This manual is intended for system software developers, hardware designers, and application developers.

About This Manual

This document is organized into sections that correspond to each major feature.

Related Documents

The following documents are referenced by the data sheet, and available on the documentation CD or from the Luminary Micro web site at www.luminarymicro.com:

- ARM® Cortex™-M3 Technical Reference Manual
- ARM® CoreSight Technical Reference Manual
- ARM® v7-M Architecture Application Level Reference Manual

The following related documents are also referenced:

IEEE Standard 1149.1-Test Access Port and Boundary-Scan Architecture

This documentation list was current as of publication date. Please check the Luminary Micro web site for additional documentation, including application notes and white papers.

Documentation Conventions

This document uses the conventions shown in Table 1 on page 17.

Table 1. Documentation Conventions

Notation	Meaning	
General Register Nota	tion	
REGISTER	APB registers are indicated in uppercase bold. For example, PBORCTL is the Power-On and Brown-Out Reset Control register. If a register name contains a lowercase n, it represents more than one register. For example, SRCRn represents any (or all) of the three Software Reset Control registers: SRCR0 , SRCR1 , and SRCR2 .	
bit	A single bit in a register.	
bit field	Two or more consecutive and related bits.	
offset 0xnnn	A hexadecimal increment to a register's address, relative to that module's base address as specified in "Memory Map" on page 37.	
Register N	Registers are numbered consecutively throughout the document to aid in referencing them. The register number has no meaning to software.	

Notation	Meaning			
reserved	Register bits marked <i>reserved</i> are reserved for future use. In most cases, reserved bits are set to 0; however, user software should not rely on the value of a reserved bit. To provide software compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.			
yy:xx	The range of register bits inclusive from xx to yy. For example, 31:15 means bits 15 through 31 in that register.			
Register Bit/Field Types	This value in the register bit diagram indicates whether software running on the controller can change the value of the bit field.			
RC	Software can read this field. The bit or field is cleared by hardware after reading the bit/field.			
RO	Software can read this field. Always write the chip reset value.			
R/W	Software can read or write this field.			
R/W1C	Software can read or write this field. A write of a 0 to a W1C bit does not affect the bit value in the register. A write of a 1 clears the value of the bit in the register; the remaining bits remain unchanged.			
	This register type is primarily used for clearing interrupt status bits where the read operation provides the interrupt status and the write of the read value clears only the interrupts being reported at the time the register was read.			
W1C	Software can write this field. A write of a 0 to a W1C bit does not affect the bit value in the register. A write of a 1 clears the value of the bit in the register; the remaining bits remain unchanged. A read of the register returns no meaningful data.			
	This register is typically used to clear the corresponding bit in an interrupt register.			
WO	Only a write by software is valid; a read of the register returns no meaningful data.			
Register Bit/Field Reset Value	This value in the register bit diagram shows the bit/field value after any reset, unless noted.			
0	Bit cleared to 0 on chip reset.			
1	Bit set to 1 on chip reset.			
-	Nondeterministic.			
Pin/Signal Notation				
[]	Pin alternate function; a pin defaults to the signal without the brackets.			
pin	Refers to the physical connection on the package.			
signal	Refers to the electrical signal encoding of a pin.			
assert a signal	Change the value of the signal from the logically False state to the logically True state. For active High signals, the asserted signal value is 1 (High); for active Low signals, the asserted signal value is 0 (Low). The active polarity (High or Low) is defined by the signal name (see SIGNAL and SIGNAL below).			
deassert a signal	Change the value of the signal from the logically True state to the logically False state.			
SIGNAL	Signal names are in uppercase and in the Courier font. An overbar on a signal name indicates that it is active Low. To assert SIGNAL is to drive it Low; to deassert SIGNAL is to drive it High.			
SIGNAL	Signal names are in uppercase and in the Courier font. An active High signal has no overbar. To assert SIGNAL is to drive it High; to deassert SIGNAL is to drive it Low.			
Numbers	·			
X	An uppercase X indicates any of several values is allowed, where X can be any legal pattern. For example, a binary value of 0X00 can be either 0100 or 0000, a hex value of 0xX is 0x0 or 0x1, and so on.			
0x Hexadecimal numbers have a prefix of 0x. For example, 0x00FF is the hexadecimal Binary numbers are indicated with a b suffix, for example, 1011b. Decimal numbers a without a prefix or suffix.				

1 Architectural Overview

The Luminary Micro Stellaris[®] family of microcontrollers—the first ARM® Cortex[™]-M3 based controllers—brings high-performance 32-bit computing to cost-sensitive embedded microcontroller applications. These pioneering parts deliver customers 32-bit performance at a cost equivalent to legacy 8- and 16-bit devices, all in a package with a small footprint.

The Stellaris[®] family offers efficient performance and extensive integration, favorably positioning the device into cost-conscious applications requiring significant control-processing and connectivity capabilities. The Stellaris[®] LM3S2000 series, designed for Controller Area Network (CAN) applications, extends the Stellaris family with Bosch CAN networking technology, the golden standard in short-haul industrial networks. The Stellaris[®] LM3S2000 series also marks the first integration of CAN capabilities with the revolutionary Cortex-M3 core. The Stellaris[®] LM3S6000 series combines both a 10/100 Ethernet Media Access Control (MAC) and Physical (PHY) layer, marking the first time that integrated connectivity is available with an ARM Cortex-M3 MCU and the only integrated 10/100 Ethernet MAC and PHY available in an ARM architecture MCU.

The LM3S1958 microcontroller is targeted for industrial applications, including remote monitoring, electronic point-of-sale machines, test and measurement equipment, network appliances and switches, factory automation, HVAC and building control, gaming equipment, motion control, medical instrumentation, and fire and security.

For applications requiring extreme conservation of power, the LM3S1958 microcontroller features a Battery-backed Hibernation module to efficiently power down the LM3S1958 to a low-power state during extended periods of inactivity. With a power-up/power-down sequencer, a continuous time counter (RTC), a pair of match registers, an APB interface to the system bus, and dedicated non-volatile memory, the Hibernation module positions the LM3S1958 microcontroller perfectly for battery applications.

In addition, the LM3S1958 microcontroller offers the advantages of ARM's widely available development tools, System-on-Chip (SoC) infrastructure IP applications, and a large user community. Additionally, the microcontroller uses ARM's Thumb®-compatible Thumb-2 instruction set to reduce memory requirements and, thereby, cost. Finally, the LM3S1958 microcontroller is code-compatible to all members of the extensive Stellaris® family; providing flexibility to fit our customers' precise needs.

Luminary Micro offers a complete solution to get to market quickly, with evaluation and development boards, white papers and application notes, an easy-to-use peripheral driver library, and a strong support, sales, and distributor network.

1.1 Product Features

The LM3S1958 microcontroller includes the following product features:

- 32-Bit RISC Performance
 - 32-bit ARM® Cortex™-M3 v7M architecture optimized for small-footprint embedded applications
 - System timer (SysTick), providing a simple, 24-bit clear-on-write, decrementing, wrap-on-zero counter with a flexible control mechanism
 - Thumb®-compatible Thumb-2-only instruction set processor core for high code density
 - 50-MHz operation

- Hardware-division and single-cycle-multiplication
- Integrated Nested Vectored Interrupt Controller (NVIC) providing deterministic interrupt handling
- 31 interrupts with eight priority levels
- Memory protection unit (MPU), providing a privileged mode for protected operating system functionality
- Unaligned data access, enabling data to be efficiently packed into memory
- Atomic bit manipulation (bit-banding), delivering maximum memory utilization and streamlined peripheral control

Internal Memory

- 256 KB single-cycle flash
 - User-managed flash block protection on a 2-KB block basis
 - · User-managed flash data programming
 - User-defined and managed flash-protection block
- 64 KB single-cycle SRAM

General-Purpose Timers

- Four General-Purpose Timer Modules (GPTM), each of which provides two 16-bit timer/counters. Each GPTM can be configured to operate independently as timers or event counters (eight total): as a single 32-bit timer (four total), as one 32-bit Real-Time Clock (RTC) to event capture, for Pulse Width Modulation (PWM), or to trigger analog-to-digital conversions
- 32-bit Timer modes
 - · Programmable one-shot timer
 - Programmable periodic timer
 - Real-Time Clock when using an external 32.768-KHz clock as the input
 - User-enabled stalling in periodic and one-shot mode when the controller asserts the CPU Halt flag during debug
 - ADC event trigger
- 16-bit Timer modes
 - General-purpose timer function with an 8-bit prescaler
 - Programmable one-shot timer
 - Programmable periodic timer
 - User-enabled stalling when the controller asserts CPU Halt flag during debug

- · ADC event trigger
- 16-bit Input Capture modes
 - · Input edge count capture
 - · Input edge time capture
- 16-bit PWM mode
 - Simple PWM mode with software-programmable output inversion of the PWM signal
- ARM FiRM-compliant Watchdog Timer
 - 32-bit down counter with a programmable load register
 - Separate watchdog clock with an enable
 - Programmable interrupt generation logic with interrupt masking
 - Lock register protection from runaway software
 - Reset generation logic with an enable/disable
 - User-enabled stalling when the controller asserts the CPU Halt flag during debug
- Synchronous Serial Interface (SSI)
 - Two SSI modules, each with the following features:
 - Master or slave operation
 - Programmable clock bit rate and prescale
 - Separate transmit and receive FIFOs, 16 bits wide, 8 locations deep
 - Programmable interface operation for Freescale SPI, MICROWIRE, or Texas Instruments synchronous serial interfaces
 - Programmable data frame size from 4 to 16 bits
 - Internal loopback test mode for diagnostic/debug testing

UART

- Three fully programmable 16C550-type UARTs with IrDA support
- Separate 16x8 transmit (TX) and 16x12 receive (RX) FIFOs to reduce CPU interrupt service loading
- Programmable baud-rate generator with fractional divider
- Programmable FIFO length, including 1-byte deep operation providing conventional double-buffered interface
- FIFO trigger levels of 1/8, ½, ½, ¾, and 7/8

- Standard asynchronous communication bits for start, stop, and parity
- False-start-bit detection
- Line-break generation and detection

ADC

- Single- and differential-input configurations
- Eight 10-bit channels (inputs) when used as single-ended inputs
- Sample rate of one million samples/second
- Flexible, configurable analog-to-digital conversion
- Four programmable sample conversion sequences from one to eight entries long, with corresponding conversion result FIFOs
- Each sequence triggered by software or internal event (timers, or GPIO)
- On-chip temperature sensor

I²C

- Two I²C modules
- Master and slave receive and transmit operation with transmission speed up to 100 Kbps in Standard mode and 400 Kbps in Fast mode
- Interrupt generation
- Master with arbitration and clock synchronization, multimaster support, and 7-bit addressing mode

GPIOs

- 21-52 GPIOs, depending on configuration
- 5-V-tolerant input/outputs
- Programmable interrupt generation as either edge-triggered or level-sensitive
- Bit masking in both read and write operations through address lines
- Can initiate an ADC sample sequence
- Programmable control for GPIO pad configuration:
 - · Weak pull-up or pull-down resistors
 - 2-mA, 4-mA, and 8-mA pad drive
 - Slew rate control for the 8-mA drive
 - · Open drain enables

· Digital input enables

Power

- On-chip Low Drop-Out (LDO) voltage regulator, with programmable output user-adjustable from 2.25 V to 2.75 V
- Hibernation module handles the power-up/down 3.3 V sequencing and control for the core digital logic and analog circuits
- Low-power options on controller: Sleep and Deep-sleep modes
- Low-power options for peripherals: software controls shutdown of individual peripherals
- User-enabled LDO unregulated voltage detection and automatic reset
- 3.3-V supply brown-out detection and reporting via interrupt or reset
- Flexible Reset Sources
 - Power-on reset (POR)
 - Reset pin assertion
 - Brown-out (BOR) detector alerts to system power drops
 - Software reset
 - Watchdog timer reset
 - Internal low drop-out (LDO) regulator output goes unregulated
- Additional Features
 - Six reset sources
 - Programmable clock source control
 - Clock gating to individual peripherals for power savings
 - IEEE 1149.1-1990 compliant Test Access Port (TAP) controller
 - Debug access via JTAG and Serial Wire interfaces
 - Full JTAG boundary scan
- Industrial-range 100-pin RoHS-compliant LQFP package

1.2 Target Applications

- Remote monitoring
- Electronic point-of-sale (POS) machines
- Test and measurement equipment

- Network appliances and switches
- Factory automation
- HVAC and building control
- Gaming equipment
- Motion control
- Medical instrumentation
- Fire and security
- Power and energy
- Transportation

1.3 High-Level Block Diagram

Figure 1-1 on page 25 shows the features on the Stellaris® Fury-class family of devices.

24

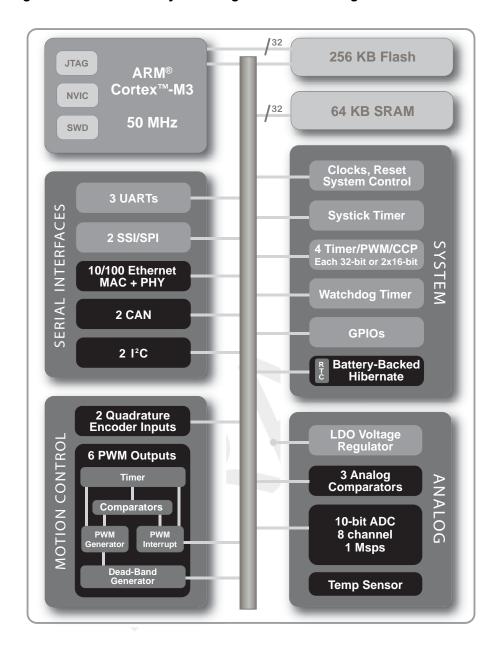


Figure 1-1. Stellaris® Fury-class High-Level Block Diagram

1.4 Functional Overview

The following sections provide an overview of the features of the LM3S1958 microcontroller. The page number in parenthesis indicates where that feature is discussed in detail. Ordering and support information can be found in "Ordering and Contact Information" on page 417.

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1.4.1 ARM Cortex™-M3

1.4.1.1 Processor Core (see page 31)

All members of the Stellaris[®] product family, including the LM3S1958 microcontroller, are designed around an ARM Cortex[™]-M3 processor core. The ARM Cortex-M3 processor provides the core for a high-performance, low-cost platform that meets the needs of minimal memory implementation, reduced pin count, and low-power consumption, while delivering outstanding computational performance and exceptional system response to interrupts.

"ARM Cortex-M3 Processor Core" on page 31 provides an overview of the ARM core; the core is detailed in the *ARM*® *Cortex*™-*M3 Technical Reference Manual*.

1.4.1.2 System Timer (SysTick)

Cortex-M3 includes an integrated system timer, SysTick. SysTick provides a simple, 24-bit clear-on-write, decrementing, wrap-on-zero counter with a flexible control mechanism. The counter can be used in several different ways, for example:

- An RTOS tick timer which fires at a programmable rate (for example, 100 Hz) and invokes a SysTick routine.
- A high-speed alarm timer using the system clock.
- A variable rate alarm or signal timer—the duration is range-dependent on the reference clock used and the dynamic range of the counter.
- A simple counter. Software can use this to measure time to completion and time used.
- An internal clock source control based on missing/meeting durations. The COUNTFLAG bit-field in the control and status register can be used to determine if an action completed within a set duration, as part of a dynamic clock management control loop.

1.4.1.3 Nested Vectored Interrupt Controller (NVIC)

The LM3S1958 controller includes the ARM Nested Vectored Interrupt Controller (NVIC) on the ARM Cortex-M3 core. The NVIC and Cortex-M3 prioritize and handle all exceptions. All exceptions are handled in Handler Mode. The processor state is automatically stored to the stack on an exception, and automatically restored from the stack at the end of the Interrupt Service Routine (ISR). The vector is fetched in parallel to the state saving, which enables efficient interrupt entry. The processor supports tail-chaining, which enables back-to-back interrupts to be performed without the overhead of state saving and restoration. Software can set eight priority levels on 7 exceptions (system handlers) and 31 interrupts.

"Interrupts" on page 39 provides an overview of the NVIC controller and the interrupt map. Exceptions and interrupts are detailed in the *ARM*® *Cortex*™-*M3 Technical Reference Manual*.

1.4.2 Motor Control Peripherals

To enhance motor control, the LM3S1958 controller features Pulse Width Modulation (PWM) outputs.

1.4.2.1 PWM (see page 195)

Pulse width modulation (PWM) is a powerful technique for digitally encoding analog signal levels. High-resolution counters are used to generate a square wave, and the duty cycle of the square wave is modulated to encode an analog signal. Typical applications include switching power supplies and motor control.

On the LM3S1958, PWM motion control functionality can be achieved through the motion control features of the general-purpose timers (using the CCP pins).

CCP Pins (see page 195)

The General-Purpose Timer Module's CCP (Capture Compare PWM) pins are software programmable to support a simple PWM mode with a software-programmable output inversion of the PWM signal.

1.4.3 Serial Communications Peripherals

The LM3S1958 controller supports both asynchronous and synchronous serial communications with:

- Three fully programmable 16C550-type UARTs
- Two SSI modules
- Two I²C modules

1.4.3.1 **UART** (see page 278)

A Universal Asynchronous Receiver/Transmitter (UART) is an integrated circuit used for RS-232C serial communications, containing a transmitter (parallel-to-serial converter) and a receiver (serial-to-parallel converter), each clocked separately.

The LM3S1958 controller includes three fully programmable 16C550-type UARTs that support data transfer speeds up to 460.8 Kbps. In addition, each UART is capable of supporting IrDA. (Although similar in functionality to a 16C550 UART, it is not register-compatible.)

Separate 16x8 transmit (TX) and 16x12 receive (RX) FIFOs reduce CPU interrupt service loading. The UART can generate individually masked interrupts from the RX, TX, modem status, and error conditions. The module provides a single combined interrupt when any of the interrupts are asserted and are unmasked.

1.4.3.2 SSI (see page 318)

Synchronous Serial Interface (SSI) is a four-wire bi-directional communications interface.

The LM3S1958 controller includes two SSI modules that provide the functionality for synchronous serial communications with peripheral devices, and can be configured to use the Freescale SPI, MICROWIRE, or TI synchronous serial interface frame formats. The size of the data frame is also configurable, and can be set between 4 and 16 bits, inclusive.

Each SSI module performs serial-to-parallel conversion on data received from a peripheral device, and parallel-to-serial conversion on data transmitted to a peripheral device. The TX and RX paths are buffered with internal FIFOs, allowing up to eight 16-bit values to be stored independently.

Each SSI module can be configured as either a master or slave device. As a slave device, the SSI module can also be configured to disable its output, which allows a master device to be coupled with multiple slave devices.

Each SSI module also includes a programmable bit rate clock divider and prescaler to generate the output serial clock derived from the SSI module's input clock. Bit rates are generated based on the input clock and the maximum bit rate is determined by the connected peripheral.

1.4.3.3 I²C(see page 353)

The Inter-Integrated Circuit (I²C) bus provides bi-directional data transfer through a two-wire design (a serial data line SDA and a serial clock line SCL).

The I²C bus interfaces to external I²C devices such as serial memory (RAMs and ROMs), networking devices, LCDs, tone generators, and so on. The I²C bus may also be used for system testing and diagnostic purposes in product development and manufacture.

The LM3S1958 controller includes two I²C modules that provide the ability to communicate to other IC devices over an I²C bus. The I²C bus supports devices that can both transmit and receive (write and read) data.

Devices on the I²C bus can be designated as either a master or a slave. Each I²C module supports both sending and receiving data as either a master or a slave, and also supports the simultaneous operation as both a master and a slave. The four I²C modes are: Master Transmit, Master Receive, Slave Transmit, and Slave Receive.

A Stellaris[®] I²C module can operate at two speeds: Standard (100 Kbps) and Fast (400 Kbps).

Both the I²C master and slave can generate interrupts. The I²C master generates interrupts when a transmit or receive operation completes (or aborts due to an error). The I²C slave generates interrupts when data has been sent or requested by a master.

1.4.4 System Peripherals

1.4.4.1 Programmable GPIOs (see page 148)

General-purpose input/output (GPIO) pins offer flexibility for a variety of connections.

The Stellaris[®] GPIO module is composed of eight physical GPIO blocks, each corresponding to an individual GPIO port. The GPIO module is FiRM-compliant (compliant to the ARM Foundation IP for Real-Time Microcontrollers specification) and supports 21-52 programmable input/output pins. The number of GPIOs available depends on the peripherals being used (see "Signal Tables" on page 389 for the signals available to each GPIO pin).

The GPIO module features programmable interrupt generation as either edge-triggered or level-sensitive on all pins, programmable control for GPIO pad configuration, and bit masking in both read and write operations through address lines.

1.4.4.2 Four Programmable Timers (see page 189)

Programmable timers can be used to count or time external events that drive the Timer input pins.

The Stellaris[®] General-Purpose Timer Module (GPTM) contains four GPTM blocks. Each GPTM block provides two 16-bit timer/counters that can be configured to operate independently as timers or event counters, or configured to operate as one 32-bit timer or one 32-bit Real-Time Clock (RTC). Timers can also be used to trigger analog-to-digital (ADC) conversions.

When configured in 32-bit mode, a timer can run as a one-shot timer, periodic timer, or Real-Time Clock (RTC). When in 16-bit mode, a timer can run as a one-shot timer or periodic timer, and can extend its precision by using an 8-bit prescaler. A 16-bit timer can also be configured for event capture or Pulse Width Modulation (PWM) generation.

1.4.4.3 Watchdog Timer (see page 222)

A watchdog timer can generate nonmaskable interrupts (NMIs) or a reset when a time-out value is reached. The watchdog timer is used to regain control when a system has failed due to a software error or to the failure of an external device to respond in the expected way.

The Stellaris[®] Watchdog Timer module consists of a 32-bit down counter, a programmable load register, interrupt generation logic, and a locking register.

The Watchdog Timer can be configured to generate an interrupt to the controller on its first time-out, and to generate a reset signal on its second time-out. Once the Watchdog Timer has been configured, the lock register can be written to prevent the timer configuration from being inadvertently altered.

1.4.5 Memory Peripherals

The LM3S1958 controller offers both SRAM and Flash memory.

1.4.5.1 SRAM (see page 124)

The LM3S1958 static random access memory (SRAM) controller supports 64 KB SRAM. The internal SRAM of the Stellaris[®] devices is located at offset 0x0000.0000 of the device memory map. To reduce the number of time-consuming read-modify-write (RMW) operations, ARM has introduced *bit-banding* technology in the new Cortex-M3 processor. With a bit-band-enabled processor, certain regions in the memory map (SRAM and peripheral space) can use address aliases to access individual bits in a single, atomic operation.

1.4.5.2 Flash (see page 125)

The LM3S1958 Flash controller supports 256 KB of flash memory. The flash is organized as a set of 1-KB blocks that can be individually erased. Erasing a block causes the entire contents of the block to be reset to all 1s. These blocks are paired into a set of 2-KB blocks that can be individually protected. The blocks can be marked as read-only or execute-only, providing different levels of code protection. Read-only blocks cannot be erased or programmed, protecting the contents of those blocks from being modified. Execute-only blocks cannot be erased or programmed, and can only be read by the controller instruction fetch mechanism, protecting the contents of those blocks from being read by either the controller or by a debugger.

1.4.6 Additional Features

1.4.6.1 Memory Map (see page 37)

A memory map lists the location of instructions and data in memory. The memory map for the LM3S1958 controller can be found in "Memory Map" on page 37. Register addresses are given as a hexadecimal increment, relative to the module's base address as shown in the memory map.

The ARM® Cortex™-M3 Technical Reference Manual provides further information on the memory map.

1.4.6.2 JTAG TAP Controller (see page 42)

The Joint Test Action Group (JTAG) port provides a standardized serial interface for controlling the Test Access Port (TAP) and associated test logic. The TAP, JTAG instruction register, and JTAG data registers can be used to test the interconnects of assembled printed circuit boards, obtain manufacturing information on the components, and observe and/or control the inputs and outputs of the controller during normal operation. The JTAG port provides a high degree of testability and chip-level access at a low cost.

The JTAG port is comprised of the standard five pins: TRST, TCK, TMS, TDI, and TDO. Data is transmitted serially into the controller on TDI and out of the controller on TDO. The interpretation of this data is dependent on the current state of the TAP controller. For detailed information on the operation of the JTAG port and TAP controller, please refer to the IEEE Standard 1149.1-Test Access Port and Boundary-Scan Architecture.

The Luminary Micro JTAG controller works with the ARM JTAG controller built into the Cortex-M3 core. This is implemented by multiplexing the \tiny{TDO} outputs from both JTAG controllers. ARM JTAG instructions select the ARM \tiny{TDO} output while Luminary Micro JTAG instructions select the Luminary

Micro TDO outputs. The multiplexer is controlled by the Luminary Micro JTAG controller, which has comprehensive programming for the ARM, Luminary Micro, and unimplemented JTAG instructions.

1.4.6.3 System Control and Clocks (see page 53)

System control determines the overall operation of the device. It provides information about the device, controls the clocking of the device and individual peripherals, and handles reset detection and reporting.

1.4.6.4 Hibernation Module (see page 106)

The Hibernation module provides logic to switch power off to the main processor and peripherals, and to wake on external or time-based events. The Hibernation module includes power-sequencing logic, a real-time clock with a pair of match registers, low-battery detection circuitry, and interrupt signalling to the processor. It also includes 64 32-bit words of non-volatile memory that can be used for saving state during hibernation.

1.4.7 Hardware Details

Details on the pins and package can be found in the following sections:

- "Pin Diagram" on page 388
- "Signal Tables" on page 389
- "Operating Characteristics" on page 403
- "Electrical Characteristics" on page 404
- "Package Information" on page 415

2 ARM Cortex-M3 Processor Core

The ARM Cortex-M3 processor provides the core for a high-performance, low-cost platform that meets the needs of minimal memory implementation, reduced pin count, and low power consumption, while delivering outstanding computational performance and exceptional system response to interrupts. Features include:

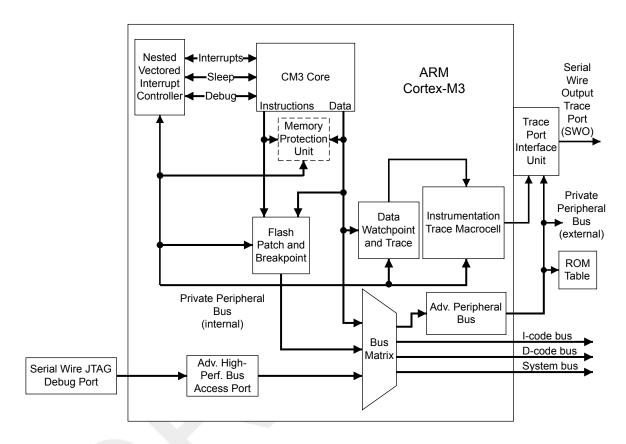
- Compact core.
- Thumb-2 instruction set, delivering the high-performance expected of an ARM core in the memory size usually associated with 8- and 16-bit devices; typically in the range of a few kilobytes of memory for microcontroller class applications.
- Speedy application execution through Harvard architecture characterized by separate buses for instruction and data.
- Exceptional interrupt handling, by implementing the register manipulations required for handling an interrupt in hardware.
- Memory protection unit (MPU) to provide a privileged mode of operation for complex applications.
- Migration from the ARM7(TM) processor family for better performance and power efficiency.
- Full-featured debug solution with a:
 - Serial Wire JTAG Debug Port (SWJ-DP)
 - Flash Patch and Breakpoint (FPB) unit for implementing breakpoints
 - Data Watchpoint and Trigger (DWT) unit for implementing watchpoints, trigger resources, and system profiling
 - Instrumentation Trace Macrocell (ITM) for support of printf style debugging
 - Trace Port Interface Unit (TPIU) for bridging to a Trace Port Analyzer

The Stellaris[®] family of microcontrollers builds on this core to bring high-performance 32-bit computing to cost-sensitive embedded microcontroller applications, such as factory automation and control, industrial control power devices, building and home automation, and stepper motors.

For more information on the ARM Cortex-M3 processor core, see the *ARM*® *Cortex*™-*M3 Technical Reference Manual*. For information on SWJ-DP, see the *ARM*® *CoreSight Technical Reference Manual*.

2.1 Block Diagram

Figure 2-1. CPU Block Diagram



2.2 Functional Description

Important: The ARM® Cortex™-M3 Technical Reference Manual describes all the features of an ARM Cortex-M3 in detail. However, these features differ based on the implementation. This section describes the Stellaris® implementation.

Luminary Micro has implemented the ARM Cortex-M3 core as shown in Figure 2-1 on page 32. As noted in the *ARM*® *Cortex*™-*M3 Technical Reference Manual*, several Cortex-M3 components are flexible in their implementation: SW/JTAG-DP, ETM, TPIU, the ROM table, the MPU, and the Nested Vectored Interrupt Controller (NVIC). Each of these is addressed in the sections that follow.

2.2.1 Serial Wire and JTAG Debug

Luminary Micro has replaced the ARM SW-DP and JTAG-DP with the ARM CoreSight™-compliant Serial Wire JTAG Debug Port (SWJ-DP) interface. This means Chapter 12, "Debug Port," of the *ARM*® *Cortex™-M3 Technical Reference Manual* does not apply to Stellaris[®] devices.

The SWJ-DP interface combines the SWD and JTAG debug ports into one module. See the CoreSight™ Design Kit Technical Reference Manual for details on SWJ-DP.

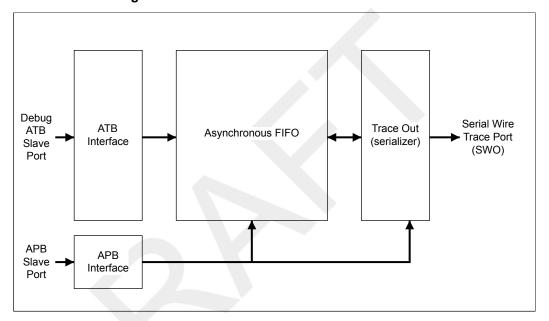
2.2.2 Embedded Trace Macrocell (ETM)

ETM was not implemented in the Stellaris[®] devices. This means Chapters 15 and 16 of the *ARM*® *Cortex*™-*M3 Technical Reference Manual* can be ignored.

2.2.3 Trace Port Interface Unit (TPIU)

The TPIU acts as a bridge between the Cortex-M3 trace data from the ITM, and an off-chip Trace Port Analyzer. The Stellaris[®] devices have implemented TPIU as shown in Figure 2-2 on page 33. This is similar to the non-ETM version described in the *ARM® Cortex™-M3 Technical Reference Manual*, however, SWJ-DP only provides SWV output for the TPIU.

Figure 2-2. TPIU Block Diagram



2.2.4 ROM Table

The default ROM table was implemented as described in the *ARM*® *Cortex*™-*M3 Technical Reference Manual*.

2.2.5 Memory Protection Unit (MPU)

The Memory Protection Unit (MPU) is included on the LM3S1958 controller and supports the standard ARMv7 Protected Memory System Architecture (PMSA) model. The MPU provides full support for protection regions, overlapping protection regions, access permissions, and exporting memory attributes to the system.

2.2.6 Nested Vectored Interrupt Controller (NVIC)

The Nested Vectored Interrupt Controller (NVIC):

Facilitates low-latency exception and interrupt handling

- Controls power management
- Implements system control registers

The NVIC supports up to 240 dynamically reprioritizable interrupts each with up to 256 levels of priority. The NVIC and the processor core interface are closely coupled, which enables low latency interrupt processing and efficient processing of late arriving interrupts. The NVIC maintains knowledge of the stacked (nested) interrupts to enable tail-chaining of interrupts.

You can only fully access the NVIC from privileged mode, but you can pend interrupts in user-mode if you enable the Configuration Control Register (see the ARM® Cortex™-M3 Technical Reference Manual). Any other user-mode access causes a bus fault.

All NVIC registers are accessible using byte, halfword, and word unless otherwise stated.

All NVIC registers and system debug registers are little endian regardless of the endianness state of the processor.

2.2.6.1 Interrupts

The ARM® Cortex™-M3 Technical Reference Manual describes the maximum number of interrupts and interrupt priorities. The LM3S1958 microcontroller supports 31 interrupts with eight priority levels.

2.2.6.2 System Timer (SysTick)

Cortex-M3 includes an integrated system timer, SysTick. SysTick provides a simple, 24-bit clear-on-write, decrementing, wrap-on-zero counter with a flexible control mechanism. The counter can be used in several different ways, for example:

- An RTOS tick timer which fires at a programmable rate (for example 100 Hz) and invokes a SysTick routine.
- A high-speed alarm timer using the system clock.
- A variable rate alarm or signal timer—the duration is range-dependent on the reference clock used and the dynamic range of the counter.
- A simple counter. Software can use this to measure time to completion and time used.
- An internal clock source control based on missing/meeting durations. The COUNTFLAG bit-field
 in the control and status register can be used to determine if an action completed within a set
 duration, as part of a dynamic clock management control loop.

Functional Description

The timer consists of three registers:

- A control and status counter to configure its clock, enable the counter, enable the SysTick interrupt, and determine counter status.
- The reload value for the counter, used to provide the counter's wrap value.
- The current value of the counter.

A fourth register, the SysTick Calibration Value Register, is not implemented in the Stellaris devices.

When enabled, the timer counts down from the reload value to zero, reloads (wraps) to the value in the SysTick Reload Value register on the next clock edge, then decrements on subsequent clocks. Writing a value of zero to the Reload Value register disables the counter on the next wrap. When the counter reaches zero, the COUNTFLAG status bit is set. The COUNTFLAG bit clears on reads.

Writing to the Current Value register clears the register and the COUNTFLAG status bit. The write does not trigger the SysTick exception logic. On a read, the current value is the value of the register at the time the register is accessed.

If the core is in debug state (halted), the counter will not decrement. The timer is clocked with respect to a reference clock. The reference clock can be the core clock or an external clock source.

SysTick Control and Status Register

Use the SysTick Control and Status Register to enable the SysTick features. The reset is 0x0000.0000.

Bit/Field	Name	Type	Reset	Description
31:17	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
16	COUNTFLAG	R/W	0	Returns 1 if timer counted to 0 since last time this was read. Clears on read by application. If read by the debugger using the DAP, this bit is cleared on read-only if the MasterType bit in the AHB-AP Control Register is set to 0. Otherwise, the COUNTFLAG bit is not changed by the debugger read.
15:3	reserved	R/W	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	CLKSOURCE	R/W	0	0 = external reference clock. (Not implemented for Stellaris microcontrollers.)
				1 = core clock.
				If no reference clock is provided, it is held at 1 and so gives the same time as the core clock. The core clock must be at least 2.5 times faster than the reference clock. If it is not, the count values are Unpredictable.
1	TICKINT	R/W	0	1 = counting down to 0 pends the SysTick handler.
				0 = counting down to 0 does not pend the SysTick handler. Software can use the COUNTFLAG to determine if ever counted to 0.
0	ENABLE	R/W	0	1 = counter operates in a multi-shot way. That is, counter loads with the Reload value and then begins counting down. On reaching 0, it sets the COUNTFLAG to 1 and optionally pends the SysTick handler, based on TICKINT. It then loads the Reload value again, and begins counting. 0 = counter disabled.

SysTick Reload Value Register

Use the SysTick Reload Value Register to specify the start value to load into the current value register when the counter reaches 0. It can be any value between 1 and 0x00FFFFFF. A start value of 0 is possible, but has no effect because the SysTick interrupt and COUNTFLAG are activated when counting from 1 to 0.

Therefore, as a multi-shot timer, repeated over and over, it fires every N+1 clock pulse, where N is any value from 1 to 0x00FFFFFF. So, if the tick interrupt is required every 100 clock pulses, 99 must be written into the RELOAD. If a new value is written on each tick interrupt, so treated as single shot, then the actual count down must be written. For example, if a tick is next required after 400 clock pulses, 400 must be written into the RELOAD.

Bit/Field	Name	Туре	Reset	Description
31:24	reserved	RO		Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
23:0	RELOAD	W1C	-	Value to load into the SysTick Current Value Register when the counter reaches 0.

SysTick Current Value Register

Use the SysTick Current Value Register to find the current value in the register.

Bit/Field	Name	Туре	Reset	Description
31:24	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
23:0	CURRENT	W1C	-	Current value at the time the register is accessed. No read-modify-write protection is provided, so change with care. This register is write-clear. Writing to it with any value clears the register to 0. Clearing this register also clears the COUNTFLAG bit of the SysTick Control and Status Register.

SysTick Calibration Value Register

The SysTick Calibration Value register is not implemented.



3 Memory Map

The memory map for the LM3S1958 controller is provided in Table 3-1 on page 37.

In this manual, register addresses are given as a hexadecimal increment, relative to the module's base address as shown in the memory map. See also Chapter 4, "Memory Map" in the *ARM*® *Cortex™-M3 Technical Reference Manual*.

Note: In Table 3-1 on page 37 addresses not listed are reserved.

Table 3-1. Memory Map^a

Start	End	Description	For details on registers, see page	
Memory			•	
0x0000.0000	0x1FFF.FFFF	On-chip flash ^b	128	
0x2000.0000	0x200F.FFFF	Bit-banded on-chip SRAM ^c	128	
0x2010.0000	0x21FF.FFFF	Reserved non-bit-banded SRAM space	-	
0x2200.0000	0x23FF.FFFF	Bit-band alias of 0x2000.0000 through 0x200F.FFFF	124	
0x2400.0000	0x3FFF.FFFF	Reserved non-bit-banded SRAM space	-	
FiRM Peripherals			1	
0x4000.0000	0x4000.0FFF	Watchdog timer	224	
0x4000.1000	0x4000.3FFF	Reserved	-	
0x4000.4000	0x4000.4FFF	GPIO Port A	154	
0x4000.5000	0x4000.5FFF	GPIO Port B	154	
0x4000.6000	0x4000.6FFF	GPIO Port C	154	
0x4000.7000	0x4000.7FFF	GPIO Port D	154	
0x4000.8000	0x4000.8FFF	SSI0	329	
0x4000.9000	0x4000.9FFF	SSI1	329	
0x4000.A000	0x4000.BFFF	Reserved	-	
0x4000.C000	0x4000.CFFF	UART0	285	
0x4000.D000	0x4000.DFFF	UART1	285	
0x4000.E000	0x4000.EFFF	UART2	285	
0x4000.F000	0x4000.FFFF	Reserved	-	
0x4001.0000	0x4001.FFFF	Reserved for future FiRM peripherals	-	
Peripherals			•	
0x4002.0000	0x4002.07FF	I2C Master 0	366	
0x4002.0800	0x4002.0FFF	I2C Slave 0	379	
0x4002.1000	0x4002.17FF	I2C Master 1	366	
0x4001.1800	0x4002.1FFF	I2C Slave 1	379	
0x4002.2000	0x4002.3FFF	Reserved	-	
0x4002.4000	0x4002.4FFF	GPIO Port E	154	
0x4002.5000	0x4002.5FFF	GPIO Port F	154	
0x4002.6000	0x4002.6FFF	GPIO Port G	154	
0x4002.7000	0x4002.7FFF	GPIO Port H	154	

Start	End	Description	For details on registers, see page	
0x4002.9000	0x4002.BFFF	Reserved	-	
0x4002.E000	0x4002.FFFF	Reserved	-	
0x4003.0000	0x4003.0FFF	Timer0	200	
0x4003.1000	0x4003.1FFF	Timer1	200	
0x4003.2000	0x4003.2FFF	Timer2	200	
0x4003.3000	0x4003.3FFF	Timer3	200	
0x4003.4000	0x4003.7FFF	Reserved	-	
0x4003.8000	0x4003.8FFF	ADC	251	
0x4003.9000	0x4003.BFFF	Reserved	-	
0x4003.D000	0x4003.FFFF	Reserved	-	
0x4004.3000	0x4004.7FFF	Reserved	-	
0x4004.9000	0x4004.BFFF	Reserved	-	
0x4004.C000	0x400F.BFFF	Reserved	-	
0x400F.C000	0x400F.CFFF	Hibernation Module	111	
0x400F.D000	0x400F.DFFF	Flash control	128	
0x400F.E000	0x400F.EFFF	System control	60	
0x400F.F000	0x400F.FFFF	Reserved	-	
0x4011.1000	0x4011.1FFF	Reserved	-	
0x4012.0000	0x41FF.FFFF	Reserved for non bit-banded peripheral space	-	
0x4200.0000	0x43FF.FFFF	Bit-banded alias of 0x4000.0000 through 0x400F.FFFF	-	
0x4400.0000	0x5E32.FFFF	Reserved for non bit-banded peripheral space	-	
0x5E34.0000	0x5FFF.FFFF	Reserved	-	
0x6000.0000	0xDFFF.FFFF	Reserved for external devices	-	
Private Peripheral Bus				
0xE000.0000	0xE000.0FFF	Instrumentation Trace Macrocell (ITM)	ARM®	
0xE000.1000	0xE000.1FFF	Data Watchpoint and Trace (DWT)	Cortex™-M3 Technical	
0xE000.2000	0xE000.2FFF	Flash Patch and Breakpoint (FPB)	Reference	
0xE000.3000	0xE000.DFFF	Reserved	Manual	
0xE000.E000	0xE000.EFFF	Nested Vectored Interrupt Controller (NVIC)	1	
0xE000.F000	0xE003.FFFF	Reserved	1	
0xE004.0000	0xE004.0FFF	Trace Port Interface Unit (TPIU)	1	
0xE004.1000	0xE004.1FFF	Reserved	-	
0xE004.2000	0xE00F.FFFF	Reserved	-	
0xE010.0000	0xFFFF.FFFF	Reserved for vendor peripherals	-	

a. All reserved space returns a bus fault when read or written.

b. The unavailable flash will bus fault throughout this range.

c. The unavailable SRAM will bus fault throughout this range.

4 Interrupts

The ARM Cortex-M3 processor and the Nested Vectored Interrupt Controller (NVIC) prioritize and handle all exceptions. All exceptions are handled in Handler Mode. The processor state is automatically stored to the stack on an exception, and automatically restored from the stack at the end of the Interrupt Service Routine (ISR). The vector is fetched in parallel to the state saving, which enables efficient interrupt entry. The processor supports tail-chaining, which enables back-to-back interrupts to be performed without the overhead of state saving and restoration.

Table 4-1 on page 39 lists all the exceptions. Software can set eight priority levels on seven of these exceptions (system handlers) as well as on 31 interrupts (listed in Table 4-2 on page 40).

Priorities on the system handlers are set with the NVIC System Handler Priority registers. Interrupts are enabled through the NVIC Interrupt Set Enable register and prioritized with the NVIC Interrupt Priority registers. You can also group priorities by splitting priority levels into pre-emption priorities and subpriorities. All the interrupt registers are described in Chapter 8, "Nested Vectored Interrupt Controller" in the *ARM® Cortex™-M3 Technical Reference Manual*.

Internally, the highest user-settable priority (0) is treated as fourth priority, after a Reset, NMI, and a Hard Fault. Note that 0 is the default priority for all the settable priorities.

If you assign the same priority level to two or more interrupts, their hardware priority (the lower the position number) determines the order in which the processor activates them. For example, if both GPIO Port A and GPIO Port B are priority level 1, then GPIO Port A has higher priority.

See Chapter 5, "Exceptions" and Chapter 8, "Nested Vectored Interrupt Controller" in the *ARM*® *Cortex*™-*M3 Technical Reference Manual* for more information on exceptions and interrupts.

Note: In Table 4-2 on page 40 interrupts not listed are reserved.

Table 4-1. Exception Types

Exception Type	Position	Priority ^a	Description
-	0	-	Stack top is loaded from first entry of vector table on reset.
Reset	1	-3 (highest)	Invoked on power up and warm reset. On first instruction, drops to lowest priority (and then is called the base level of activation). This is asynchronous.
Non-Maskable Interrupt (NMI)	2	-2	Cannot be stopped or preempted by any exception but reset. This is asynchronous.
			An NMI is only producible by software, using the NVIC Interrupt Control State register.
Hard Fault	3	-1	All classes of Fault, when the fault cannot activate due to priority or the configurable fault handler has been disabled. This is synchronous.
Memory Management	4	settable	MPU mismatch, including access violation and no match. This is synchronous.
			The priority of this exception can be changed.
Bus Fault	5	settable Pre-fetch fault, memory access fault, and other address/memory faults. This is synchronous when precise and asynchronous wimprecise.	
			You can enable or disable this fault.
Usage Fault	6	settable	Usage fault, such as undefined instruction executed or illegal state transition attempt. This is synchronous.
-	7-10	-	Reserved.
SVCall	11	settable	System service call with SVC instruction. This is synchronous.

Exception Type	Position	Priority ^a	Description
Debug Monitor	12	settable	Debug monitor (when not halting). This is synchronous, but only active when enabled. It does not activate if lower priority than the current activation.
-	13	-	Reserved.
PendSV	14	settable	Pendable request for system service. This is asynchronous and only pended by software.
SysTick	15	settable	System tick timer has fired. This is asynchronous.
Interrupts	16 and above	settable	Asserted from outside the ARM Cortex-M3 core and fed through the NVIC (prioritized). These are all asynchronous. Table 4-2 on page 40 lists the interrupts on the LM3S1958 controller.

a. 0 is the default priority for all the settable priorities.

Table 4-2. Interrupts

Interrupt (Bit in Interrupt Registers)	Description			
0	GPIO Port A			
1	GPIO Port B			
2	GPIO Port C			
3	GPIO Port D			
4	GPIO Port E			
5	UART0			
6	UART1			
7	SSI0			
8	I2C0			
14	ADC Sequence 0			
15	ADC Sequence 1			
16	ADC Sequence 2			
17	ADC Sequence 3			
18	Watchdog timer			
19	Timer0 A			
20	Timer0 B			
21	Timer1 A			
22	Timer1 B			
23	Timer2 A			
24	Timer2 B			
28	System Control			
29	Flash Control			
30	GPIO Port F			
31	GPIO Port G			
32	GPIO Port H			
33	UART2			
34	SSI1			
35	Timer3 A			
36	Timer3 B			
37	12C1			

Interrupt (Bit in Interrupt Registers)	Description
43	Hibernation Module
44-47	Reserved



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5 JTAG Interface

The Joint Test Action Group (JTAG) port is an IEEE standard that defines a Test Access Port and Boundary Scan Architecture for digital integrated circuits and provides a standardized serial interface for controlling the associated test logic. The TAP, Instruction Register (IR), and Data Registers (DR) can be used to test the interconnections of assembled printed circuit boards and obtain manufacturing information on the components. The JTAG Port also provides a means of accessing and controlling design-for-test features such as I/O pin observation and control, scan testing, and debugging.

The JTAG port is comprised of the standard five pins: TRST, TCK, TMS, TDI, and TDO. Data is transmitted serially into the controller on TDI and out of the controller on TDO. The interpretation of this data is dependent on the current state of the TAP controller. For detailed information on the operation of the JTAG port and TAP controller, please refer to the IEEE Standard 1149.1-Test Access Port and Boundary-Scan Architecture.

The Luminary Micro JTAG controller works with the ARM JTAG controller built into the Cortex-M3 core. This is implemented by multiplexing the TDO outputs from both JTAG controllers. ARM JTAG instructions select the ARM TDO output while Luminary Micro JTAG instructions select the Luminary Micro TDO outputs. The multiplexer is controlled by the Luminary Micro JTAG controller, which has comprehensive programming for the ARM, LMI, and unimplemented JTAG instructions.

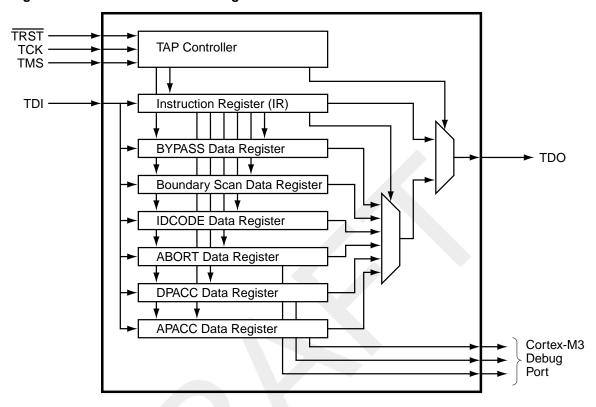
The JTAG module has the following features:

- IEEE 1149.1-1990 compatible Test Access Port (TAP) controller
- Four-bit Instruction Register (IR) chain for storing JTAG instructions
- IEEE standard instructions:
 - BYPASS instruction
 - IDCODE instruction
 - SAMPLE/PRELOAD instruction
 - EXTEST instruction
 - INTEST instruction
- ARM additional instructions:
 - APACC instruction
 - DPACC instruction
 - ABORT instruction
- Integrated ARM Serial Wire Debug (SWD)

See the ARM® Cortex™-M3 Technical Reference Manual for more information on the ARM JTAG controller.

5.1 Block Diagram

Figure 5-1. JTAG Module Block Diagram



5.2 Functional Description

A high-level conceptual drawing of the JTAG module is shown in Figure 5-1 on page 43. The JTAG module is composed of the Test Access Port (TAP) controller and serial shift chains with parallel update registers. The TAP controller is a simple state machine controlled by the TRST, TCK and TMS inputs. The current state of the TAP controller depends on the current value of TRST and the sequence of values captured on TMS at the rising edge of TCK. The TAP controller determines when the serial shift chains capture new data, shift data from TDI towards TDO, and update the parallel load registers. The current state of the TAP controller also determines whether the Instruction Register (IR) chain or one of the Data Register (DR) chains is being accessed.

The serial shift chains with parallel load registers are comprised of a single Instruction Register (IR) chain and multiple Data Register (DR) chains. The current instruction loaded in the parallel load register determines which DR chain is captured, shifted, or updated during the sequencing of the TAP controller.

Some instructions, like EXTEST and INTEST, operate on data currently in a DR chain and do not capture, shift, or update any of the chains. Instructions that are not implemented decode to the BYPASS instruction to ensure that the serial path between TDI and TDO is always connected (see Table 5-2 on page 49 for a list of implemented instructions).

See "JTAG and Boundary Scan" on page 410 for JTAG timing diagrams.

5.2.1 JTAG Interface Pins

The JTAG interface consists of five standard pins: TRST, TCK, TMS, TDI, and TDO. These pins and their associated reset state are given in Table 5-1 on page 44. Detailed information on each pin follows.

Table 5-1. JTAG Port Pins Reset State

Pin Name	Data Direction	Internal Pull-Up	Internal Pull-Down	Drive Strength	Drive Value
TRST	Input	Enabled	Disabled	N/A	N/A
TCK	Input	Enabled	Disabled	N/A	N/A
TMS	Input	Enabled	Disabled	N/A	N/A
TDI	Input	Enabled	Disabled	N/A	N/A
TDO	Output	Enabled	Disabled	2-mA driver	High-Z

5.2.1.1 Test Reset Input (TRST)

The TRST pin is an asynchronous active Low input signal for initializing and resetting the JTAG TAP controller and associated JTAG circuitry. When TRST is asserted, the TAP controller resets to the Test-Logic-Reset state and remains there while TRST is asserted. When the TAP controller enters the Test-Logic-Reset state, the JTAG Instruction Register (IR) resets to the default instruction, IDCODE.

By default, the internal pull-up resistor on the TRST pin is enabled after reset. Changes to the pull-up resistor settings on GPIO Port B should ensure that the internal pull-up resistor remains enabled on PB7/TRST; otherwise JTAG communication could be lost.

5.2.1.2 Test Clock Input (TCK)

The TCK pin is the clock for the JTAG module. This clock is provided so the test logic can operate independently of any other system clocks. In addition, it ensures that multiple JTAG TAP controllers that are daisy-chained together can synchronously communicate serial test data between components. During normal operation, TCK is driven by a free-running clock with a nominal 50% duty cycle. When necessary, TCK can be stopped at 0 or 1 for extended periods of time. While TCK is stopped at 0 or 1, the state of the TAP controller does not change and data in the JTAG Instruction and Data Registers is not lost.

By default, the internal pull-up resistor on the ${ t TCK}$ pin is enabled after reset. This assures that no clocking occurs if the pin is not driven from an external source. The internal pull-up and pull-down resistors can be turned off to save internal power as long as the ${ t TCK}$ pin is constantly being driven by an external source.

5.2.1.3 Test Mode Select (TMS)

The TMS pin selects the next state of the JTAG TAP controller. TMS is sampled on the rising edge of TCK. Depending on the current TAP state and the sampled value of TMS, the next state is entered. Because the TMS pin is sampled on the rising edge of TCK, the *IEEE Standard 1149.1* expects the value on TMS to change on the falling edge of TCK.

Holding TMS high for five consecutive TCK cycles drives the TAP controller state machine to the Test-Logic-Reset state. When the TAP controller enters the Test-Logic-Reset state, the JTAG Instruction Register (IR) resets to the default instruction, IDCODE. Therefore, this sequence can be used as a reset mechanism, similar to asserting TRST. The JTAG Test Access Port state machine can be seen in its entirety in Figure 5-2 on page 46.

By default, the internal pull-up resistor on the TMS pin is enabled after reset. Changes to the pull-up resistor settings on GPIO Port C should ensure that the internal pull-up resistor remains enabled on PC1/TMS; otherwise JTAG communication could be lost.

5.2.1.4 Test Data Input (TDI)

The TDI pin provides a stream of serial information to the IR chain and the DR chains. TDI is sampled on the rising edge of TCK and, depending on the current TAP state and the current instruction, presents this data to the proper shift register chain. Because the TDI pin is sampled on the rising edge of TCK, the *IEEE Standard 1149.1* expects the value on TDI to change on the falling edge of TCK.

By default, the internal pull-up resistor on the TDI pin is enabled after reset. Changes to the pull-up resistor settings on GPIO Port C should ensure that the internal pull-up resistor remains enabled on PC2/TDI: otherwise JTAG communication could be lost.

5.2.1.5 Test Data Output (TDO)

The TDO pin provides an output stream of serial information from the IR chain or the DR chains. The value of TDO depends on the current TAP state, the current instruction, and the data in the chain being accessed. In order to save power when the JTAG port is not being used, the TDO pin is placed in an inactive drive state when not actively shifting out data. Because TDO can be connected to the TDI of another controller in a daisy-chain configuration, the *IEEE Standard 1149.1* expects the value on TDO to change on the falling edge of TCK.

By default, the internal pull-up resistor on the <code>TDO</code> pin is enabled after reset. This assures that the pin remains at a constant logic level when the JTAG port is not being used. The internal pull-up and pull-down resistors can be turned off to save internal power if a High-Z output value is acceptable during certain TAP controller states.

5.2.2 JTAG TAP Controller

The JTAG TAP controller state machine is shown in Figure 5-2 on page 46. The TAP controller state machine is reset to the Test-Logic-Reset state on the assertion of a Power-On-Reset (POR) or the assertion of TRST. Asserting the correct sequence on the TMS pin allows the JTAG module to shift in new instructions, shift in data, or idle during extended testing sequences. For detailed information on the function of the TAP controller and the operations that occur in each state, please refer to *IEEE Standard 1149.1*.

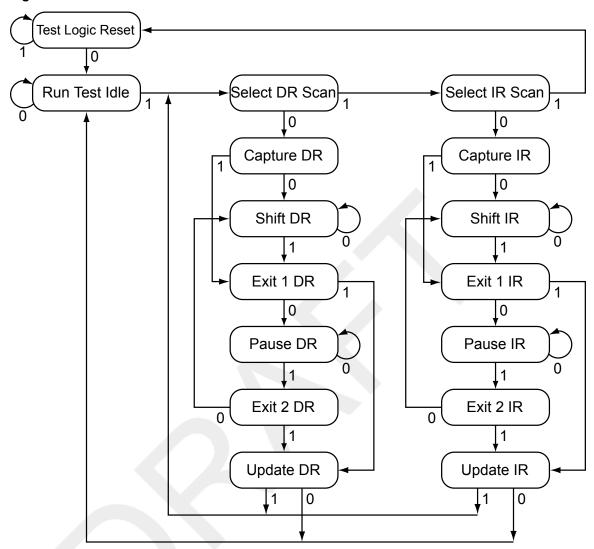


Figure 5-2. Test Access Port State Machine

5.2.3 Shift Registers

The Shift Registers consist of a serial shift register chain and a parallel load register. The serial shift register chain samples specific information during the TAP controller's CAPTURE states and allows this information to be shifted out of TDO during the TAP controller's SHIFT states. While the sampled data is being shifted out of the chain on TDO, new data is being shifted into the serial shift register on TDI. This new data is stored in the parallel load register during the TAP controller's UPDATE states. Each of the shift registers is discussed in detail in "Register Descriptions" on page 49.

5.2.4 Operational Considerations

There are certain operational considerations when using the JTAG module. Because the JTAG pins can be programmed to be GPIOs, board configuration and reset conditions on these pins must be considered. In addition, because the JTAG module has integrated ARM Serial Wire Debug, the method for switching between these two operational modes is described below.

5.2.4.1 GPIO Functionality

When the controller is reset with either a POR or \overline{RST} , the JTAG/SWD port pins default to their JTAG/SWD configurations. The default configuration includes enabling digital functionality (setting **GPIODEN** to 1), enabling the pull-up resistors (setting **GPIOPUR** to 1), and enabling the alternate hardware function (setting **GPIOAFSEL** to 1) for the PB7 and PC[3:0] JTAG/SWD pins.

It is possible for software to configure these pins as GPIOs after reset by writing 0s to PB7 and PC[3:0] in the **GPIOAFSEL** register. If the user does not require the JTAG/SWD port for debugging or board-level testing, this provides five more GPIOs for use in the design.

Caution – If the JTAG pins are used as GPIOs in a design, PB7 and PC2 cannot have external pull-down resistors connected to both of them at the same time. If both pins are pulled Low during reset, the controller has unpredictable behavior. If this happens, remove one or both of the pull-down resistors, and apply $\overline{\text{RST}}$ or power-cycle the part.

In addition, it is possible to create a software sequence that prevents the debugger from connecting to the Stellaris® microcontroller. If the program code loaded into flash immediately changes the JTAG pins to their GPIO functionality, the debugger may not have enough time to connect and halt the controller before the JTAG pin functionality switches. This may lock the debugger out of the part. This can be avoided with a software routine that restores JTAG functionality based on an external or software trigger.

The commit control registers provide a layer of protection against accidental programming of critical hardware peripherals. Writes to protected bits of the **GPIO Alternate Function Select (GPIOAFSEL)** register (see page 164) are not committed to storage unless the **GPIO Lock (GPIOLOCK)** register (see page 174) has been unlocked and the appropriate bits of the **GPIO Commit (GPIOCR)** register (see page 175) have been set to 1.

Recovering a "Locked" Device

If software configures any of the JTAG/SWD pins as GPIO and loses the ability to communicate with the debugger, there is a debug sequence that can be used to recover the device. Performing a total of ten JTAG-to-SWD and SWD-to-JTAG switch sequences while holding the device in reset mass erases the flash memory. The sequence to recover the device is:

- Assert and hold the RST signal.
- 2. Perform the JTAG-to-SWD switch sequence.
- Perform the SWD-to-JTAG switch sequence.
- Perform the JTAG-to-SWD switch sequence.
- Perform the SWD-to-JTAG switch sequence.
- Perform the JTAG-to-SWD switch sequence.
- 7. Perform the SWD-to-JTAG switch sequence.
- 8. Perform the JTAG-to-SWD switch sequence.
- Perform the SWD-to-JTAG switch sequence.
- 10. Perform the JTAG-to-SWD switch sequence.
- 11. Perform the SWD-to-JTAG switch sequence.

12. Release the \overline{RST} signal.

The JTAG-to-SWD and SWD-to-JTAG switch sequences are described in "ARM Serial Wire Debug (SWD)" on page 48. When performing switch sequences for the purpose of recovering the debug capabilities of the device, only steps 1 and 2 of the switch sequence need to be performed.

5.2.4.2 ARM Serial Wire Debug (SWD)

In order to seamlessly integrate the ARM Serial Wire Debug (SWD) functionality, a serial-wire debugger must be able to connect to the Cortex-M3 core without having to perform, or have any knowledge of, JTAG cycles. This is accomplished with a SWD preamble that is issued before the SWD session begins.

The preamble used to enable the SWD interface of the SWJ-DP module starts with the TAP controller in the Test-Logic-Reset state. From here, the preamble sequences the TAP controller through the following states: Run Test Idle, Select DR, Select IR, Test Logic Reset, Test Logic Reset, Run Test Idle, Run Test Idle, Select DR, Select IR, Test Logic Reset, Test Logic Reset, Run Test Idle, Run Test Idle, Select DR, Select IR, and Test Logic Reset states.

Stepping through this sequences of the TAP state machine enables the SWD interface and disables the JTAG interface. For more information on this operation and the SWD interface, see the *ARM*® *Cortex*™-*M3 Technical Reference Manual* and the *ARM*® *CoreSight Technical Reference Manual*.

Because this sequence is a valid series of JTAG operations that could be issued, the ARM JTAG TAP controller is not fully compliant to the *IEEE Standard 1149.1*. This is the only instance where the ARM JTAG TAP controller does not meet full compliance with the specification. Due to the low probability of this sequence occurring during normal operation of the TAP controller, it should not affect normal performance of the JTAG interface.

JTAG-to-SWD Switching

To switch the operating mode of the Debug Access Port (DAP) from JTAG to SWD mode, the external debug hardware must send a switch sequence to the device. The 16-bit switch sequence for switching to SWD mode is defined as b1110011110011110, transmitted LSB first. This can also be represented as 16'hE79E when transmitted LSB first. The complete switch sequence should consist of the following transactions on the TCK/SWCLK and TMS/SWDIO signals:

- 1. Send at least 50 TCK/SWCLK cycles with TMS/SWDIO set to 1. This ensures that both JTAG and SWD are in their reset/idle states.
- 2. Send the 16-bit JTAG-to-SWD switch sequence, 16'hE79E.
- Send at least 50 TCK/SWCLK cycles with TMS/SWDIO set to 1. This ensures that if SWJ-DP was already in SWD mode, before sending the switch sequence, the SWD goes into the line reset state.

SWD-to-JTAG Switching

To switch the operating mode of the Debug Access Port (DAP) from SWD to JTAG mode, the external debug hardware must send a switch sequence to the device. The 16-bit switch sequence for switching to JTAG mode is defined as b1110011110011110, transmitted LSB first. This can also be represented as 16'hE73C when transmitted LSB first. The complete switch sequence should consist of the following transactions on the TCK/SWCLK and TMS/SWDIO signals:

1. Send at least 50 TCK/SWCLK cycles with TMS/SWDIO set to 1. This ensures that both JTAG and SWD are in their reset/idle states.

- 2. Send the 16-bit SWD-to-JTAG switch sequence, 16'hE73C.
- 3. Send at least 5 TCK/SWCLK cycles with TMS/SWDIO set to 1. This ensures that if SWJ-DP was already in JTAG mode, before sending the switch sequence, the JTAG goes into the Test Logic Reset state.

5.3 Initialization and Configuration

After a Power-On-Reset or an external reset (RST), the JTAG pins are automatically configured for JTAG communication. No user-defined initialization or configuration is needed. However, if the user application changes these pins to their GPIO function, they must be configured back to their JTAG functionality before JTAG communication can be restored. This is done by enabling the five JTAG pins (PB7 and PC[3:0]) for their alternate function using the **GPIOAFSEL** register.

5.4 Register Descriptions

There are no APB-accessible registers in the JTAG TAP Controller or Shift Register chains. The registers within the JTAG controller are all accessed serially through the TAP Controller. The registers can be broken down into two main categories: Instruction Registers and Data Registers.

5.4.1 Instruction Register (IR)

The JTAG TAP Instruction Register (IR) is a four-bit serial scan chain with a parallel load register connected between the JTAG TDI and TDO pins. When the TAP Controller is placed in the correct states, bits can be shifted into the Instruction Register. Once these bits have been shifted into the chain and updated, they are interpreted as the current instruction. The decode of the Instruction Register bits is shown in Table 5-2 on page 49. A detailed explanation of each instruction, along with its associated Data Register, follows.

Table 5-2. JTAG Instruction	Register Commands
-----------------------------	--------------------------

IR[3:0]	Instruction	Description
0000	EXTEST	Drives the values preloaded into the Boundary Scan Chain by the SAMPLE/PRELOAD instruction onto the pads.
0001	INTEST	Drives the values preloaded into the Boundary Scan Chain by the SAMPLE/PRELOAD instruction into the controller.
0010	SAMPLE / PRELOAD	Captures the current I/O values and shifts the sampled values out of the Boundary Scan Chain while new preload data is shifted in.
1000	ABORT	Shifts data into the ARM Debug Port Abort Register.
1010	DPACC	Shifts data into and out of the ARM DP Access Register.
1011	APACC	Shifts data into and out of the ARM AC Access Register.
1110	IDCODE	Loads manufacturing information defined by the <i>IEEE Standard 1149.1</i> into the IDCODE chain and shifts it out.
1111	BYPASS	Connects TDI to TDO through a single Shift Register chain.
All Others	Reserved	Defaults to the BYPASS instruction to ensure that TDI is always connected to TDO.

5.4.1.1 EXTEST Instruction

The EXTEST instruction does not have an associated Data Register chain. The EXTEST instruction uses the data that has been preloaded into the Boundary Scan Data Register using the SAMPLE/PRELOAD instruction. When the EXTEST instruction is present in the Instruction Register, the preloaded data in the Boundary Scan Data Register associated with the outputs and output enables are used to drive the GPIO pads rather than the signals coming from the core. This allows

tests to be developed that drive known values out of the controller, which can be used to verify connectivity.

5.4.1.2 INTEST Instruction

The INTEST instruction does not have an associated Data Register chain. The INTEST instruction uses the data that has been preloaded into the Boundary Scan Data Register using the SAMPLE/PRELOAD instruction. When the INTEST instruction is present in the Instruction Register, the preloaded data in the Boundary Scan Data Register associated with the inputs are used to drive the signals going into the core rather than the signals coming from the GPIO pads. This allows tests to be developed that drive known values into the controller, which can be used for testing. It is important to note that although the RST input pin is on the Boundary Scan Data Register chain, it is only observable.

5.4.1.3 SAMPLE/PRELOAD Instruction

The SAMPLE/PRELOAD instruction connects the Boundary Scan Data Register chain between TDI and TDO. This instruction samples the current state of the pad pins for observation and preloads new test data. Each GPIO pad has an associated input, output, and output enable signal. When the TAP controller enters the Capture DR state during this instruction, the input, output, and output-enable signals to each of the GPIO pads are captured. These samples are serially shifted out of TDO while the TAP controller is in the Shift DR state and can be used for observation or comparison in various tests.

While these samples of the inputs, outputs, and output enables are being shifted out of the Boundary Scan Data Register, new data is being shifted into the Boundary Scan Data Register from TDI. Once the new data has been shifted into the Boundary Scan Data Register, the data is saved in the parallel load registers when the TAP controller enters the Update DR state. This update of the parallel load register preloads data into the Boundary Scan Data Register that is associated with each input, output, and output enable. This preloaded data can be used with the EXTEST and INTEST instructions to drive data into or out of the controller. Please see "Boundary Scan Data Register" on page 52 for more information.

5.4.1.4 ABORT Instruction

The ABORT instruction connects the associated ABORT Data Register chain between TDI and TDO. This instruction provides read and write access to the ABORT Register of the ARM Debug Access Port (DAP). Shifting the proper data into this Data Register clears various error bits or initiates a DAP abort of a previous request. Please see the "ABORT Data Register" on page 52 for more information.

5.4.1.5 DPACC Instruction

The DPACC instruction connects the associated DPACC Data Register chain between TDI and TDO. This instruction provides read and write access to the DPACC Register of the ARM Debug Access Port (DAP). Shifting the proper data into this register and reading the data output from this register allows read and write access to the ARM debug and status registers. Please see "DPACC Data Register" on page 52 for more information.

5.4.1.6 APACC Instruction

The APACC instruction connects the associated APACC Data Register chain between TDI and TDO. This instruction provides read and write access to the APACC Register of the ARM Debug Access Port (DAP). Shifting the proper data into this register and reading the data output from this register allows read and write access to internal components and buses through the Debug Port. Please see "APACC Data Register" on page 52 for more information.

5.4.1.7 IDCODE Instruction

The IDCODE instruction connects the associated IDCODE Data Register chain between <code>TDI</code> and <code>TDO</code>. This instruction provides information on the manufacturer, part number, and version of the ARM core. This information can be used by testing equipment and debuggers to automatically configure their input and output data streams. IDCODE is the default instruction that is loaded into the JTAG Instruction Register when a power-on-reset (POR) is asserted, <code>TRST</code> is asserted, or the Test-Logic-Reset state is entered. Please see "IDCODE Data Register" on page 51 for more information.

5.4.1.8 BYPASS Instruction

The BYPASS instruction connects the associated BYPASS Data Register chain between TDI and TDO. This instruction is used to create a minimum length serial path between the TDI and TDO ports. The BYPASS Data Register is a single-bit shift register. This instruction improves test efficiency by allowing components that are not needed for a specific test to be bypassed in the JTAG scan chain by loading them with the BYPASS instruction. Please see "BYPASS Data Register" on page 51 for more information.

5.4.2 Data Registers

The JTAG module contains six Data Registers. These include: IDCODE, BYPASS, Boundary Scan, APACC, DPACC, and ABORT serial Data Register chains. Each of these Data Registers is discussed in the following sections.

5.4.2.1 IDCODE Data Register

The format for the 32-bit IDCODE Data Register defined by the *IEEE Standard 1149.1* is shown in Figure 5-3 on page 51. The standard requires that every JTAG-compliant device implement either the IDCODE instruction or the BYPASS instruction as the default instruction. The LSB of the IDCODE Data Register is defined to be a 1 to distinguish it from the BYPASS instruction, which has an LSB of 0. This allows auto configuration test tools to determine which instruction is the default instruction.

The major uses of the JTAG port are for manufacturer testing of component assembly, and program development and debug. To facilitate the use of auto-configuration debug tools, the IDCODE instruction outputs a value of 0x3BA00477. This value indicates an ARM Cortex-M3, Version 1 processor. This allows the debuggers to automatically configure themselves to work correctly with the Cortex-M3 during debug.

Figure 5-3. IDCODE Register Format



5.4.2.2 BYPASS Data Register

The format for the 1-bit BYPASS Data Register defined by the *IEEE Standard 1149.1* is shown in Figure 5-4 on page 52. The standard requires that every JTAG-compliant device implement either the BYPASS instruction or the IDCODE instruction as the default instruction. The LSB of the BYPASS Data Register is defined to be a 0 to distinguish it from the IDCODE instruction, which has an LSB of 1. This allows auto configuration test tools to determine which instruction is the default instruction.

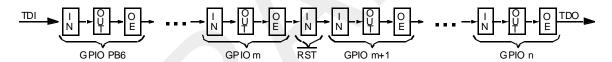
Figure 5-4. BYPASS Register Format

5.4.2.3 Boundary Scan Data Register

The format of the Boundary Scan Data Register is shown in Figure 5-5 on page 52. Each GPIO pin, in a counter-clockwise direction from the JTAG port pins, is included in the Boundary Scan Data Register. Each GPIO pin has three associated digital signals that are included in the chain. These signals are input, output, and output enable, and are arranged in that order as can be seen in the figure. In addition to the GPIO pins, the controller reset pin, RST, is included in the chain. Because the reset pin is always an input, only the input signal is included in the Data Register chain.

When the Boundary Scan Data Register is accessed with the SAMPLE/PRELOAD instruction, the input, output, and output enable from each digital pad are sampled and then shifted out of the chain to be verified. The sampling of these values occurs on the rising edge of TCK in the Capture DR state of the TAP controller. While the sampled data is being shifted out of the Boundary Scan chain in the Shift DR state of the TAP controller, new data can be preloaded into the chain for use with the EXTEST and INTEST instructions. These instructions either force data out of the controller, with the EXTEST instruction, or into the controller, with the INTEST instruction.

Figure 5-5. Boundary Scan Register Format



For detailed information on the order of the input, output, and output enable bits for each of the GPIO ports, please refer to the Stellaris[®] Family Boundary Scan Description Language (BSDL) files, downloadable from www.luminarymicro.com.

5.4.2.4 APACC Data Register

The format for the 35-bit APACC Data Register defined by ARM is described in the *ARM*® *Cortex*™-*M3 Technical Reference Manual*.

5.4.2.5 DPACC Data Register

The format for the 35-bit DPACC Data Register defined by ARM is described in the *ARM*® Cortex™-M3 Technical Reference Manual.

5.4.2.6 ABORT Data Register

The format for the 35-bit ABORT Data Register defined by ARM is described in the *ARM*® *Cortex*™-*M3 Technical Reference Manual*.

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6 System Control

System control determines the overall operation of the device. It provides information about the device, controls the clocking to the core and individual peripherals, and handles reset detection and reporting.

6.1 Functional Description

The System Control module provides the following capabilities:

- Device identification, see "Device Identification" on page 53
- Local control, such as reset (see "Reset Control" on page 53), power (see "Power Control" on page 56) and clock control (see "Clock Control" on page 56)
- System control (Run, Sleep, and Deep-Sleep modes), see "System Control" on page 58

6.1.1 Device Identification

Seven read-only registers provide software with information on the microcontroller, such as version, part number, SRAM size, flash size, and other features. See the **DID0**, **DID1**, and **DC0-DC4** registers.

6.1.2 Reset Control

This section discusses aspects of hardware functions during reset as well as system software requirements following the reset sequence.

6.1.2.1 CMODO and CMOD1 Test-Mode Control Pins

Two pins, CMOD0 and CMOD1, are defined for use by Luminary Micro for testing the devices during manufacture. They have no end-user function and should not be used. The CMOD pins should be connected to ground.

6.1.2.2 Reset Sources

The controller has five sources of reset:

- 1. External reset input pin (RST) assertion, see "RST Pin Assertion" on page 53.
- 2. Power-on reset (POR), see "Power-On Reset (POR)" on page 54.
- 3. Internal brown-out (BOR) detector, see "Brown-Out Reset (BOR)" on page 54.
- 4. Software-initiated reset (with the software reset registers), see "Software Reset" on page 55.
- 5. A watchdog timer reset condition violation, see "Watchdog Timer Reset" on page 55.

After a reset, the **Reset Cause (RESC)** register is set with the reset cause. The bits in this register are sticky and maintain their state across multiple reset sequences, except when an internal POR is the cause, and then all the other bits in the **RESC** register are cleared except for the POR indicator.

6.1.2.3 RST Pin Assertion

The external reset pin (\overline{RST}) resets the controller. This resets the core and all the peripherals except the JTAG TAP controller (see "JTAG Interface" on page 42). The external reset sequence is as follows:

- 1. The external reset pin (RST) is asserted and then de-asserted.
- 2. The internal reset is released and the core loads from memory the initial stack pointer, the initial program counter, the first instruction designated by the program counter, and begins execution. A few clocks cycles from RST de-assertion to the start of the reset sequence is necessary for synchronization.

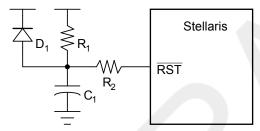
The external reset timing is shown in Figure 19-10 on page 413.

6.1.2.4 Power-On Reset (POR)

The Power-On Reset (POR) circuit monitors the power supply voltage (V_{DD}). The POR circuit generates a reset signal to the internal logic when the power supply ramp reaches a threshold value (V_{TH}). If the application only uses the POR circuit, the $\overline{\tt RST}$ input needs to be connected to the power supply (V_{DD}) through a pull-up resistor (1K to 10K Ω).

The device must be operating within the specified operating parameters at the point when the on-chip power-on reset pulse is complete. The 3.3-V power supply to the device must reach 3.0 V within 10 msec of it crossing 2.0 V to guarantee proper operation. For applications that require the use of an external reset to hold the device in reset longer than the internal POR, the RST input may be used with the circuit as shown in Figure 6-1 on page 54.

Figure 6-1. External Circuitry to Extend Reset



The R_1 and C_1 components define the power-on delay. The R_2 resistor mitigates any leakage from the \overline{RST} input. The diode (D₁) discharges C_1 rapidly when the power supply is turned off.

The Power-On Reset sequence is as follows:

- 1. The controller waits for the later of external reset (RST) or internal POR to go inactive.
- 2. The internal reset is released and the core loads from memory the initial stack pointer, the initial program counter, the first instruction designated by the program counter, and begins execution.

The internal POR is only active on the initial power-up of the controller. The Power-On Reset timing is shown in Figure 19-11 on page 413.

Note: The power-on reset also resets the JTAG controller. An external reset does not.

6.1.2.5 Brown-Out Reset (BOR)

A drop in the input voltage resulting in the assertion of the internal brown-out detector can be used to reset the controller. This is initially disabled and may be enabled by software.

The system provides a brown-out detection circuit that triggers if the power supply (V_{DD}) drops below a brown-out threshold voltage (V_{BTH}) . If a brown-out condition is detected, the system may generate a controller interrupt or a system reset.

Brown-out resets are controlled with the **Power-On and Brown-Out Reset Control (PBORCTL)** register. The BORIOR bit in the **PBORCTL** register must be set for a brown-out condition to trigger a reset.

The brown-out reset is equivelent to an assertion of the external $\overline{\mathtt{RST}}$ input and the reset is held active until the proper V_{DD} level is restored. The **RESC** register can be examined in the reset interrupt handler to determine if a Brown-Out condition was the cause of the reset, thus allowing software to determine what actions are required to recover.

The internal Brown-Out Reset timing is shown in Figure 19-12 on page 413.

6.1.2.6 Software Reset

Software can generate a reset to the entire system or may reset a specific peripheral.

Peripherals can be individually reset by software via three registers that control reset signals to each peripheral (see the **SRCRn** registers). If the bit position corresponding to a peripheral is set, the peripheral is reset. The encoding of the reset registers is consistent with the encoding of the clock gating control for peripherals and on-chip functions (see "System Control" on page 58). Writing a bit lane with a value of 1 initiates a reset of the corresponding unit. Note that all reset signals for all clocks of the specified unit are asserted as a result of a software-initiated reset.

The entire system can be reset by software by setting the SYSRESETREQ bit in the Cortex-M3 Application Interrupt and Reset Control register resets the entire system including the core. The software-initiated system reset sequence is as follows:

- 1. A software system reset is initiated by writing the SYSRESETREQ bit in the ARM Cortex-M3 Application Interrupt and Reset Control register.
- An internal reset is asserted.
- The internal reset is deasserted and the controller loads from memory the initial stack pointer, the initial program counter, and the first instruction designated by the program counter, and then begins execution.

The software-initiated system reset timing is shown in Figure 19-13 on page 414.

6.1.2.7 Watchdog Timer Reset

The watchdog timer module's function is to prevent system hangs. The watchdog timer can be configured to generate an interrupt to the controller on its first time-out, and to generate a reset signal on its second time-out.

After the first time-out event, the 32-bit counter is reloaded with the value of the **Watchdog Timer Load (WDTLOAD)** register, and the timer resumes counting down from that value. If the timer counts down to its zero state again before the first time-out interrupt is cleared, and the reset signal has been enabled, the watchdog timer asserts its reset signal to the system. The watchdog timer reset sequence is as follows:

- 1. The watchdog timer times out for the second time without being serviced.
- 2. An internal reset is asserted.
- The internal reset is released and the controller loads from memory the initial stack pointer, the initial program counter, the first instruction designated by the program counter, and begins execution.

The watchdog reset timing is shown in Figure 19-14 on page 414.

6.1.3 Power Control

The Stellaris $^{@}$ microcontroller provides an integrated LDO regulator that may be used to provide power to the majority of the controller's internal logic. The LDO regulator provides software a mechanism to adjust the regulated value, in small increments (VSTEP), over the range of 2.25 V to 2.75 V (inclusive)—or 2.5 V \pm 10%. The adjustment is made by changing the value of the VADJ field in the **LDO Power Control (LDOPCTL)** register.

Note: The use of the LDO is optional. The internal logic may be supplied by the on-chip LDO or by an external regulator. If the LDO is used, the LDO output pin is connected to the VDD25 pins on the printed circuit board. The LDO requires decoupling capacitors on the printed circuit board. If an external regulator is used, it is strongly recommended that the external regulator supply the controller only and not be shared with other devices on the printed circuit board.

6.1.4 Clock Control

System control determines the control of clocks in this part.

6.1.4.1 Fundamental Clock Sources

There are four clock sources for use in the device:

- Internal Oscillator (IOSC): The internal oscillator is an on-chip clock source. It does not require the use of any external components. The frequency of the internal oscillator is 12 MHz ± 30%. Applications that do not depend on accurate clock sources may use this clock source to reduce system cost. The internal oscillator is the clock source the device uses during and following POR. If the main oscillator is required, software must enable the main oscillator following reset and allow the main oscillator to stabilize before changing the clock reference.
- Main Oscillator: The main oscillator provides a frequency-accurate clock source by one of two means: an external single-ended clock source is connected to the OSC0 input pin, or an external crystal is connected across the OSC0 input and OSC1 output pins. The crystal value allowed depends on whether the main oscillator is used as the clock reference source to the PLL. If so, the crystal must be one of the supported frequencies between 3.579545 MHz through 8.192 MHz (inclusive). If the PLL is not being used, the crystal may be any one of the supported frequencies between 1 MHz and 8.192 MHz. The single-ended clock source range is from DC through the specified speed of the device. The supported crystals are listed in Table 6-3 on page 71.
- Internal 30-kHz oscillator: The internal 30-kHz oscillator is similar to the internal oscillator, except that it provides an operational frequency of 30 kHz ± 30%. It is intended for use during Deep-Sleep power-saving modes. This power-savings mode benefits from reduced internal switching and also allows the main oscillator to be powered down.
- External real-time oscillator: The external real-time oscillator provides a low-frequency, accurate clock reference. It is intended to provide the system with a real-time clock source. The real-time oscillator is part of the Hibernation Module ("Hibernation Module" on page 106) and may also provide an accurate source of Deep-Sleep or Hibernate mode power savings.

The internal system clock (sysclk), is derived from any of the four sources plus two others: the output of the internal PLL, and the internal oscillator divided by four (3 MHz \pm 30%). The frequency of the PLL clock reference must be in the range of 3.579545 MHz to 8.192 MHz (inclusive).

The Run-Mode Clock Configuration (RCC) and Run-Mode Clock Configuration 2 (RCC2) registers provide control for the system clock. The RCC2 register is provided to extend fields that offer additional encodings over the RCC register. When used, the RCC2 register field values are used by the logic over the corresponding field in the RCC register. In particular, RCC2 provides for a larger assortment of clock configuration options.

6.1.4.2 Crystal Configuration for the Main Oscillator (MOSC)

The main oscillator supports the use of a select number of crystals in the range of 1 MHz through 8.192 MHz. This method allows Luminary Micro to provide the best possible PLL settings.

Table 6-3 on page 71 describes the available crystal choices and default programming values.

Software configures the **RCC** register XTAL field with the crystal number. If the PLL is used in the design, the XTAL field value is internally translated to the PLL settings.

6.1.4.3 PLL Frequency Configuration

The PLL is disabled by default during power-on reset and is enabled later by software if required. Software configures the PLL input reference clock source, specifies the output divisor to set the system clock frequency, and enables the PLL to drive the output.

If the main oscillator provides the clock reference to the PLL, the translation provided by hardware and used to program the PLL is available for software in the **XTAL to PLL Translation (PLLCFG)** register (see page 73). The internal translation provides a translation within \pm 1% of the targetted PLL VCO frequency.

Table 6-3 on page 71 describes the available crystal choices and default programming of the **PLLCFG** register. The crystal number is written into the XTAL field of the **Run-Mode Clock Configuration (RCC)** register. Any time the XTAL field changes, the new settings are translated and the internal PLL settings are updated.

6.1.4.4 PLL Modes

The PLL has two modes of operation: Normal and Power-Down

- Normal: The PLL multiplies the input clock reference and drives the output.
- Power-Down: Most of the PLL internal circuitry is disabled and the PLL does not drive the output.

The modes are programmed using the RCC/RCC2 register fields (see page 69 and page 74).

6.1.4.5 PLL Operation

If the PLL configuration is changed, the PLL output frequency is unstable until it reconverges (relocks) to the new setting. The time between the configuration change and relock is T_{READY} (see Table 19-5 on page 406). During this time, the PLL is not usable as a clock reference.

The PLL is changed by one of the following:

- Change to the XTAL value in the RCC register—writes of the same value do not cause a relock.
- Change in the PLL from Power-Down to Normal mode.

A counter is defined to measure the T_{READY} requirement. The counter is clocked by the main oscillator. The range of the main oscillator has been taken into account and the down counter is set to 0x1200 (that is, ~600 μ s at a 8.192 MHz external oscillator clock). Hardware is provided to keep the PLL from being used as a system clock until the T_{READY} condition is met after one of the two

changes above. It is the user's responsibility to have a stable clock source (like the main oscillator) before the **RCC/RCC2** register is switched to use the PLL.

6.1.5 System Control

For power-savings purposes, the **RCGCn**, **SCGCn**, and **DCGCn** registers control the clock gating logic for each peripheral or block in the system while the controller is in Run, Sleep, and Deep-Sleep mode, respectively.

In Run mode, the processor executes code. In Sleep mode, the clock frequency of the active peripherals is unchanged, but the processor is not clocked and therefore no longer executes code. In Deep-Sleep mode, the clock frequency of the active peripherals may change (depending on the Run mode clock configuration) in addition to the processor clock being stopped. An interrupt returns the device to Run mode from one of the sleep modes; the sleep modes are entered on request from the code. Each mode is described in more detail below.

There are four levels of operation for the device defined as:

- Run Mode. Run Mode provides normal operation of the processor and all of the peripherals that are currently enabled by the RCGCn registers. The system clock can be any of the available clock sources including the PLL.
- Sleep Mode. Sleep mode is entered by the Cortex-M3 core executing a WFI (Wait for Interrupt) instruction. Any properly configured interrupt event in the system will bring the processor back into Run mode. See the system control NVIC section of the ARM® Cortex™-M3 Technical Reference Manual for more details.
 - In Sleep Mode, the Cortex-M3 processor core and the memory subsystem are not clocked. Peripherals are clocked that are enabled in the **SCGCn** register when auto-clock gating is enabled (see the **RCC** register) or the **RCGCn** register when the auto-clock gating is disabled. The system clock has the same source and frequency as that during Run mode.
- Deep-Sleep Mode. Deep-Sleep mode is entered by first writing the Deep Sleep Enable bit in the ARM Cortex-M3 NVIC system control register and then executing a WFI instruction. Any properly configured interrupt event in the system will bring the processor back into Run mode. See the system control NVIC section of the ARM® Cortex™-M3 Technical Reference Manual for more details.
 - The Cortex-M3 processor core and the memory subsystem are not clocked. Peripherals are clocked that are enabled in the **DCGCn** register when auto-clock gating is enabled (see the **RCC** register) or the **RCGCn** register when auto-clock gating is disabled. The system clock source is the main oscillator by default or the internal oscillator specified in the **DSLPCLKCFG** register if one is enabled. When the **DSLPCLKCFG** register is used, the internal oscillator is powered up, if necessary, and the main oscillator is powered down. If the PLL is running at the time of the WFI instruction, hardware will power the PLL down and override the SYSDIV field of the active **RCC/RCC2** register to be /16 or /64, respectively. When the Deep-Sleep exit event occurs, hardware brings the system clock back to the source and frequency it had at the onset of Deep-Sleep mode before enabling the clocks that had been stopped during the Deep-Sleep duration.
- **Hibernate Mode.** In this mode, the power supplies are turned off to the main part of the device and only the Hibernation module's circuitry is active. An external wake event or RTC event is required to bring the device back to Run mode. The Cortex-M3 processor and peripherals outside of the Hibernation module see a normal "power on" sequence and the processor starts running

code. It can determine that it has been restarted from Hibernate mode by inspecting the Hibernation module registers.

6.2 Initialization and Configuration

The PLL is configured using direct register writes to the RCC/RCC2 register. If the RCC2 register is being used, the USERCC2 bit must be set and the appropriate RCC2 bit/field is used. The steps required to successfully change the PLL-based system clock are:

- 1. Bypass the PLL and system clock divider by setting the BYPASS bit and clearing the USESYS bit in the RCC register. This configures the system to run off a "raw" clock source (using the main oscillator or internal oscillator) and allows for the new PLL configuration to be validated before switching the system clock to the PLL.
- 2. Select the crystal value (XTAL) and oscillator source (OSCSRC), and clear the PWRDN bit in RCC/RCC2. Setting the XTAL field automatically pulls valid PLL configuration data for the appropriate crystal, and clearing the PWRDN bit powers and enables the PLL and its output.
- 3. Select the desired system divider (SYSDIV) in RCC/RCC2 and set the USESYS bit in RCC. The SYSDIV field determines the system frequency for the microcontroller.
- 4. Wait for the PLL to lock by polling the PLLLRIS bit in the Raw Interrupt Status (RIS) register.
- 5. Enable use of the PLL by clearing the BYPASS bit in RCC/RCC2.

6.3 Register Map

Table 6-1 on page 59 lists the System Control registers, grouped by function. The offset listed is a hexadecimal increment to the register's address, relative to the System Control base address of 0x400F.E000.

Note: Spaces in the System Control register space that are not used are reserved for future or internal use by Luminary Micro, Inc. Software should not modify any reserved memory address.

Note: A BV in the Reset column indicates the reset value is a Build Value and part-specific. See the page number referenced for the reset value description.

Table 6-1. System Control Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	DID0	RO	-	Device Identification 0	61
0x004	DID1	RO	-	Device Identification 1	77
0x008	DC0	RO	0x00FF.007F	Device Capabilities 0	79
0x010	DC1	RO	0x0001.33FF	Device Capabilities 1	80
0x014	DC2	RO	0x000F.5037	Device Capabilities 2	82
0x018	DC3	RO	0x3FFF.0000	Device Capabilities 3	83
0x01C	DC4	RO	0x0000.C0FF	Device Capabilities 4	84
0x030	PBORCTL	R/W	0x0000.7FFD	Brown-Out Reset Control	63

Offset	Name	Туре	Reset	Description	See page
0x034	LDOPCTL	R/W	0x0000.0000	LDO Power Control	64
0x040	SRCR0	R/W	0x00000000	Software Reset Control 0	103
0x044	SRCR1	R/W	0x00000000	Software Reset Control 1	104
0x048	SRCR2	R/W	0x00000000	Software Reset Control 2	105
0x050	RIS	RO	0x0000.0000	Raw Interrupt Status	65
0x054	IMC	R/W	0x0000.0000	Interrupt Mask Control	66
0x058	MISC	R/W1C	0x0000.0000	Masked Interrupt Status and Clear	67
0x05C	RESC	R/W	-	Reset Cause	68
0x060	RCC	R/W	0x07A0.3AD1	Run-Mode Clock Configuration	69
0x064	PLLCFG	RO	-	XTAL to PLL Translation	73
0x070	RCC2	R/W	0x0780.2800	Run-Mode Clock Configuration 2	74
0x100	RCGC0	R/W	0x00000040	Run Mode Clock Gating Control Register 0	85
0x104	RCGC1	R/W	0x00000000	Run Mode Clock Gating Control Register 1	91
0x108	RCGC2	R/W	0x00000000	Run Mode Clock Gating Control Register 2	97
0x110	SCGC0	R/W	0x00000040	Sleep Mode Clock Gating Control Register 0	87
0x114	SCGC1	R/W	0x00000000	Sleep Mode Clock Gating Control Register 1	93
0x118	SCGC2	R/W	0x00000000	Sleep Mode Clock Gating Control Register 2	99
0x120	DCGC0	R/W	0x00000040	Deep Sleep Mode Clock Gating Control Register 0	89
0x124	DCGC1	R/W	0x00000000	Deep Sleep Mode Clock Gating Control Register 1	95
0x128	DCGC2	R/W	0x00000000	Deep Sleep Mode Clock Gating Control Register 2	101
0x144	DSLPCLKCFG	R/W	0x0780.0000	Deep Sleep Clock Configuration	76

6.4 Register Descriptions

All addresses given are relative to the System Control base address of 0x400F.E000.

Register 1: Device Identification 0 (DID0), offset 0x000

Reset

This register identifies the version of the device.

Type

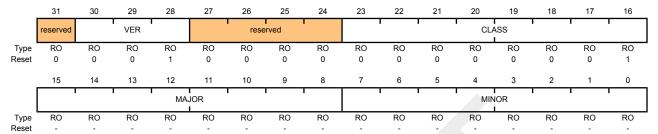
RO

Device Identification 0 (DID0)

Base 0x400F.E000 Offset 0x000 Type RO, reset -

Bit/Field

23:16



Description

31	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
30:28	VER	RO	1	This field defines the ${\bf DID0}$ register format version. The version number is numeric. The value of the VER field is encoded as follows:
				Value Description 1 First revision of the DID0 register format, for Stellaris®

27:24 reserved RO 0

CLASS

Name

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

The CLASS field value identifies the internal design from which all mask sets are generated for all devices in a particular product line. The CLASS field value is changed for new product lines, for changes in fab process (for example, a remap or shrink), or any case where the MAJOR or MINOR fields require differentiation from prior devices. The value of the CLASS field is encoded as follows (all other encodings are reserved):

Value Description

- 0 Stellaris® Sandstorm-class devices.
- Stellaris® Fury-class devices.

Fury-class devices.

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Bit/Field	Name	Туре	Reset	Description	
15:8	MAJOR	RO	-	This field specifies the major revision number of the device. The major revision reflects changes to base layers of the design. The major revision number is indicated in the part number as a letter (A for first revision, for second, and so on). This field is encoded as follows:	
				Value Description	
				0 Revision A (initial device)	
				1 Revision B (first base layer revision)	
				2 Revision C (second base layer revision)	
				and so on.	
7:0	MINOR	RO	-	This field specifies the minor revision number of the device. The minor revision reflects changes to the metal layers of the design. The MINOR field value is reset when the MAJOR field is changed. This field is numeric and is encoded as follows: Value Description 0 Initial device, or a major revision update. 1 First metal layer change.	
				, , , , , , , , , , , , , , , , , , ,	
				2 Second metal layer change.	
				and so on.	

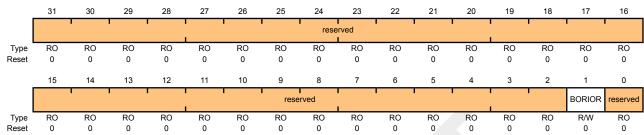
Register 2: Brown-Out Reset Control (PBORCTL), offset 0x030

This register is responsible for controlling reset conditions after initial power-on reset.

Brown-Out Reset Control (PBORCTL)

Base 0x400F.E000

Offset 0x030 Type R/W, reset 0x0000.7FFD



Bit/Field	Name	Туре	Reset	Description
31:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	BORIOR	R/W	0	BOR Interrupt or Reset This bit controls how a BOR event is signaled to the controller. If set, a reset is signaled. Otherwise, an interrupt is signaled.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

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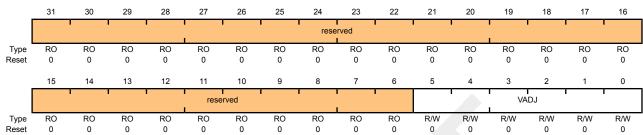
Register 3: LDO Power Control (LDOPCTL), offset 0x034

The \mathtt{VADJ} field in this register adjusts the on-chip output voltage ($\mathsf{V}_{\mathsf{OUT}}$).

LDO Power Control (LDOPCTL)

Base 0x400F.E000 Offset 0x034

Type R/W, reset 0x0000.0000



Bit/Field	name	туре	Reset	Description
31:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5:0	VADJ	R/W	0x0	This field sets the on-chip output voltage. The programming values for

the VADJ field are provided in Table 6-2 on page 64.

Table 6-2. VADJ to VOUT

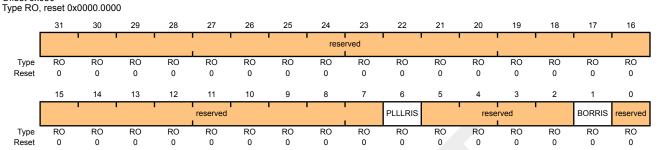
VADJ Value	V _{OUT} (V)	VADJ Value	V _{OUT} (V)	VADJ Value	V _{OUT} (V)
0x1B	2.75	0x1F	2.55	0x03	2.35
0x1C	2.70	0x00	2.50	0x04	2.30
0x1D	2.65	0x01	2.45	0x05	2.25
0x1E	2.60	0x02	2.40	0x06-0x3F	Reserved

Register 4: Raw Interrupt Status (RIS), offset 0x050

Central location for system control raw interrupts. These are set and cleared by hardware.

Raw Interrupt Status (RIS)

Base 0x400F.E000 Offset 0x050



Bit/Field	Name	Type	Reset	Description
31:7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	PLLLRIS	RO	0	PLL Lock Raw Interrupt Status This bit is set when the PLL T _{READY} Timer asserts.
5:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	BORRIS	RO	0	Brown-Out Reset Raw Interrupt Status This bit is the raw interrupt status for any brown-out conditions. If set, a brown-out condition is currently active. This is an unregistered signal from the brown-out detection circuit. An interrupt is reported if the BORIM bit in the IMC register is set and the BORIOR bit in the PBORCTL register is cleared.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

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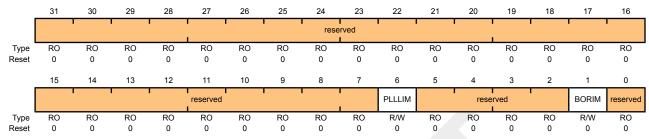
Register 5: Interrupt Mask Control (IMC), offset 0x054

Central location for system control interrupt masks.

Interrupt Mask Control (IMC)

Base 0x400F.E000

Offset 0x054 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	PLLLIM	R/W	0	PLL Lock Interrupt Mask
				This bit specifies whether a current limit detection is promoted to a controller interrupt. If set, an interrupt is generated if PLLLRIS in RIS is set; otherwise, an interrupt is not generated.
5:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	BORIM	R/W	0	Brown-Out Reset Interrupt Mask
				This bit specifies whether a brown-out condition is promoted to a controller interrupt. If set, an interrupt is generated if BORRIS is set; otherwise, an interrupt is not generated.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

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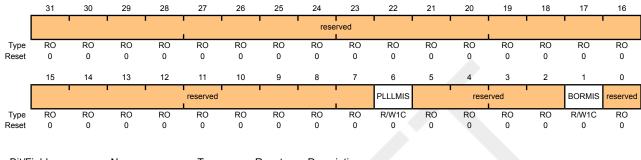
Register 6: Masked Interrupt Status and Clear (MISC), offset 0x058

Central location for system control result of RIS AND IMC to generate an interrupt to the controller. All of the bits are R/W1C and this action also clears the corresponding raw interrupt bit in the RIS register (see page 65).

Masked Interrupt Status and Clear (MISC)

Base 0x400F.E000

Offset 0x058
Type R/W1C, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	PLLLMIS	R/W1C	0	PLL Lock Masked Interrupt Status
				This bit is set when the PLL T_{READY} timer asserts. The interrupt is cleared by writing a 1 to this bit.
5:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	BORMIS	R/W1C	0	The BORMIS is simply the BORRIS ANDed with the mask value, BORIM.
0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

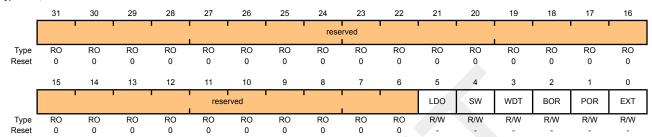
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Register 7: Reset Cause (RESC), offset 0x05C

This register is set with the reset cause after reset. The bits in this register are sticky and maintain their state across multiple reset sequences, except when an external reset is the cause, and then all the other bits in the **RESC** register are cleared.

Reset Cause (RESC)

Base 0x400F.E000 Offset 0x05C Type R/W, reset -



Bit/Field	Name	Type	Reset	Description
31:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	LDO	R/W	-	When set, indicates the LDO circuit has lost regulation and has generated a reset event.
4	SW	R/W	-	When set, indicates a software reset is the cause of the reset event.
3	WDT	R/W	-	When set, indicates a watchdog reset is the cause of the reset event.
2	BOR	R/W		When set, indicates a brown-out reset is the cause of the reset event.
1	POR	R/W	-	When set, indicates a power-on reset is the cause of the reset event.
0	EXT	R/W		When set, indicates an external reset (RST assertion) is the cause of the reset event.

Register 8: Run-Mode Clock Configuration (RCC), offset 0x060

This register is defined to provide source control and frequency speed.

Reset

Run-Mode Clock Configuration (RCC)

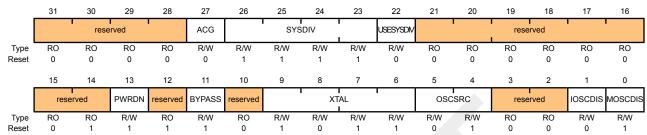
Name

Tyne

Base 0x400F.E000 Offset 0x060

Bit/Field

Type R/W, reset 0x07A0.3AD1



Bitt fold	ranio	1,700	. 10001	Bookipaon
31:28	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
27	ACG	R/W	0	Auto Clock Gating

Description

This bit specifies whether the system uses the Sleep-Mode Clock Gating Control (SCGCn) registers and Deep-Sleep-Mode Clock Gating Control (DCGCn) registers if the controller enters a Sleep or Deep-Sleep mode (respectively). If set, the SCGCn or DCGCn registers are used to control the clocks distributed to the peripherals when the controller is in a sleep mode. Otherwise, the Run-Mode Clock Gating Control (RCGCn) registers are used when the controller enters a sleep

The **RCGCn** registers are always used to control the clocks in Run mode.

This allows peripherals to consume less power when the controller is in a sleep mode and the peripheral is unused.

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Bit/Field	Name	Туре	Reset	Description		
26:23	SYSDIV	R/W	0xF	System Clock	Divisor	
				Specifies which PLL output.	Specifies which divisor is used to generate the system clock from the PLL output.	
				The PLL VCC) frequency is 400 MH	Z.
				Binary Value	Divisor (BYPASS=1)	Frequency (BYPASS=0)
				0000-0010	reserved	reserved
				0011	/8	50 MHz
				0100	/10	40 MHz
				0101	/12	33.33 MHz
				0110	/14	28.57 MHz
				0111	/16	25 MHz
				1000	/18	22.22 MHz
				1001	/20	20 MHz
				1010	/22	18.18 MHz
				1011	/24	16.67 MHz
				1100	/26	15.38 MHz
				1101	/28	14.29 MHz
				1110	/30	13.33 MHz
				1111	/32	12.5 MHz (default)
				page 69), the	SYSDIV value is MING d the PLL is being use	Configuration (RCC) register (see SYSDIV if a lower divider was d. This lower value is allowed to
22	USESYSDIV	R/W	0			source for the system clock. The used when the PLL is selected as
21:14	reserved	RO	1	compatibility v	•	ue of a reserved bit. To provide ne value of a reserved bit should be te operation.
13	PWRDN	R/W	1	PLL Power De	own	
				This bit conne		N input. The reset value of 1 powers
12	reserved	RO	1	compatibility v		ue of a reserved bit. To provide ne value of a reserved bit should be te operation.

Bit/Field	Name	Туре	Reset	Description
11	BYPASS	R/W	1	PLL Bypass
				Chooses whether the system clock is derived from the PLL output or the OSC source. If set, the clock that drives the system is the OSC source. Otherwise, the clock that drives the system is the PLL output clock divided by the system divider.
				Note: The ADC must be clocked from the PLL or directly from a 14-MHz to 18-MHz clock source to operate properly. While the ADC works in a 14-18 MHz range, to maintain a 1 M sample/second rate, the ADC must be provided a 16-MHz clock source.
10	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
9:6	XTAL	R/W	0xB	This field specifies the crystal value attached to the main oscillator. The encoding for this field is provided in Table 6-3 on page 71.
5:4	OSCSRC	R/W	0x1	Picks among the four input sources for the OSC. The values are:
				Value Input Source
				00 Main oscillator (default)
				01 Internal oscillator (default)
				10 Internal oscillator / 4 (this is necessary if used as input to PLL)
				11 reserved
3:2	reserved	RO	0x0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	IOSCDIS	R/W	0	Internal Oscillator (IOSC) Disable
				0: Internal oscillator is enabled.
				1: Internal oscillator is disabled.
0	MOSCDIS	R/W	1	Main Oscillator Disable
				0: Main oscillator is enabled.
				1: Main oscillator is disabled (default).

Table 6-3. Default Crystal Field Values and PLL Programming

Crystal Number (XTAL Binary Value)	Crystal Frequency (MHz) Not Using the PLL	Crystal Frequency (MHz) Using the PLL			
0000	1.000	reserved			
0001	1.8432	reserved			
0010	2.000	reserved			
0011	2.4576	reserved			
0100	3.5795	45 MHz			
0101	3.6864 MHz				
0110	4 MHz				
0111	4.09	6 MHz			

Crystal Number (XTAL Binary Value)	Crystal Frequency (MHz) Not Using the PLL	Crystal Frequency (MHz) Using the PLL
1000	4.9152 MHz	
1001	5 MHz	
1010	5.12 MHz	
1011	6 MHz (reset value)	
1100	6.144 MHz	
1101	7.3728 MHz	
1110	8 MHz	
1111	8.192 MHz	

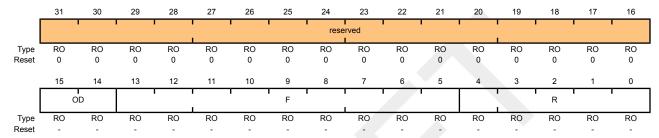
Register 9: XTAL to PLL Translation (PLLCFG), offset 0x064

This register provides a means of translating external crystal frequencies into the appropriate PLL settings. This register is initialized during the reset sequence and updated anytime that the XTAL field changes in the **Run-Mode Clock Configuration (RCC)** register (see page 69).

The PLL frequency is calculated using the PLLCFG field values, as follows:

XTAL to PLL Translation (PLLCFG)

Base 0x400F.E000 Offset 0x064 Type RO, reset -



Bit/Field	Name	Type	Reset	Description
31:16	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:14	OD	RO	-	This field specifies the value supplied to the PLL's OD input.
13:5	F	RO		This field specifies the value supplied to the PLL's F input.
4:0	R	RO	-	This field specifies the value supplied to the PLL's R input.

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Register 10: Run-Mode Clock Configuration 2 (RCC2), offset 0x070

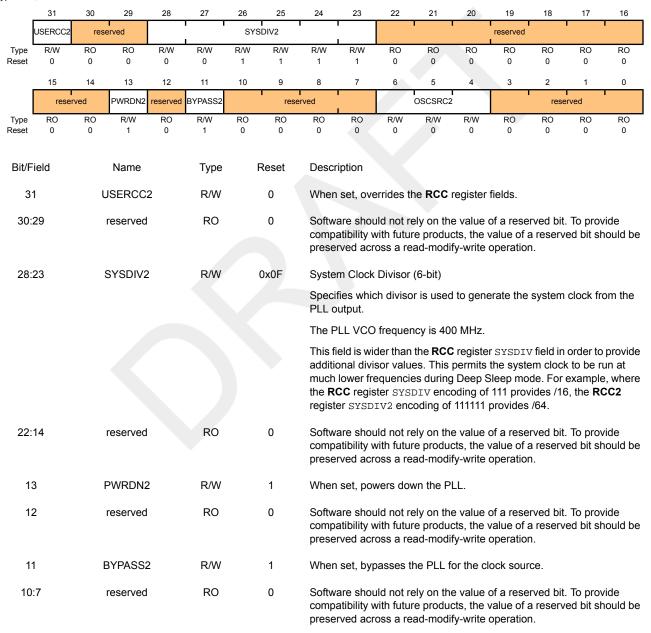
This register overrides the **RCC** equivalent register fields when the USERCC2 bit is set. This allows RCC2 to be used to extend the capabilities, while also providing a means to be backward-compatible to previous parts. The fields within the **RCC2** register occupy the same bit positions as they do within the **RCC** register as LSB-justified.

The SYSDIV2 field is wider so that additional larger divisors are possible. This allows a lower system clock frequency for improved Deep Sleep power consumption.

Run-Mode Clock Configuration 2 (RCC2)

Base 0x400F.E000 Offset 0x070

Type R/W, reset 0x0780.2800



Bit/Field	Name	Туре	Reset	Description
6:4	OSCSRC2	R/W	0	System Clock Source
				Name Value Description
				MOSC 0 Main oscillator
				IOSC 1 Internal oscillator
				IOSC/4 2 Internal oscillator / 4
				30kHz 3 30 kHz internal oscillator
				32kHz 7 32 kHz external oscillator
3:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

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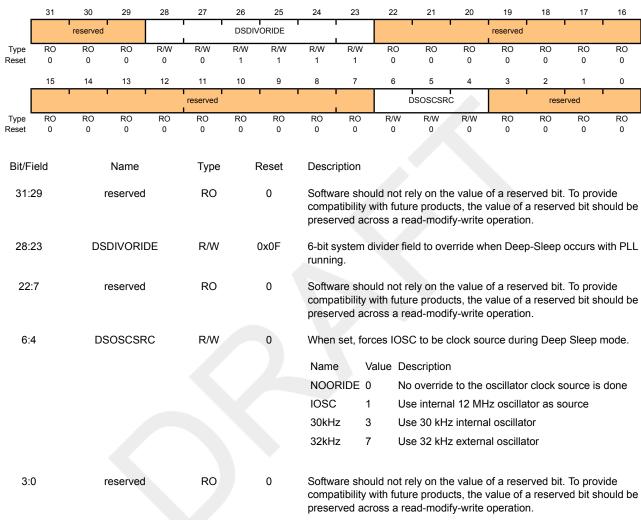
Register 11: Deep Sleep Clock Configuration (DSLPCLKCFG), offset 0x144

This register provides configuration information for the hardware control of Deep Sleep Mode.

Deep Sleep Clock Configuration (DSLPCLKCFG)

Base 0x400F.E000 Offset 0x144

Type R/W, reset 0x0780.0000



Register 12: Device Identification 1 (DID1), offset 0x004

This register identifies the device family, part number, temperature range, pin count, and package type.

Device Identification 1 (DID1)

Base 0x400F.E000 Offset 0x004 Type RO, reset -

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
			ER	ı	ļ		-AM	1					TNO L			<u>'</u>		
Type Reset	RO 0	RO 0	RO 0	RO 1	RO 0	RO 0	RO 0	RO 0	RO 1	RO 0	RO 1	RO 1	RO 1	RO 1	RO 1	RO 0		
_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
		PINCOUN ⁻	I T			reserved	i '	'		TEMP		PI	I KG	ROHS	QL	JAL		
Type Reset	RO 0	RO 1	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 1	RO 0	RO 1	RO 1	RO -	RO -		
Bit/F	ield		Name		Туре		Reset	Descr	ription									
31:	28		VER		RO		0x1	is nun	neric. Th	nes the D ne value of e reserve	of the v							
								Value Description 0x1 First revision of the DID1 register format, indicating a Stel LM3Snnnn device. Family										
27:	24		FAM		RO		0x0	Famil	y									
								Lumir	ary Mic	vides the ro produc gs are re	ct portfo	lio. The						
								Value	Descr	iption								
								0x0		ris family al part nu					vices wi	th		
23:	16	F	PARTNO)	RO		0xBE	Part N	lumber									
										vides the ded as fo								
								Value	Descr	iption								
								0xBE LM3S1958										
15:	13	PI	INCOUN	IT	RO		0x2	Packa	age Pin	Count								
										cifies the		•			-	ne value		
								Value	Descr		10							
								0x2 100-pin package										

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Bit/Field	Name	Туре	Reset	Description
12:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:5	TEMP	RO	0x1	Temperature Range
				This field specifies the temperature rating of the device. The value is encoded as follows (all other encodings are reserved):
				Value Description
				0x1 Industrial temperature range (-40C to 85C)
4:3	PKG	RO	0x1	Package Type
				This field specifies the package type. The value is encoded as follows (all other encodings are reserved):
				Value Description
				0x1 LQFP package
2	ROHS	RO	1	RoHS-Compliance
				This bit specifies whether the device is RoHS-compliant. A 1 indicates the part is RoHS-compliant.
1:0	QUAL	RO	- '	Qualification Status
				This field specifies the qualification status of the device. The value is encoded as follows (all other encodings are reserved):
				Value Description
				0x0 Engineering Sample (unqualified)
				0x1 Pilot Production (unqualified)
				0x2 Fully Qualified

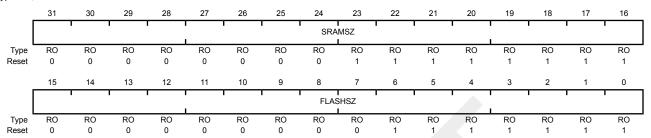
Register 13: Device Capabilities 0 (DC0), offset 0x008

This register is predefined by the part and can be used to verify features.

Device Capabilities 0 (DC0)

Base 0x400F.E000 Offset 0x008

Type RO, reset 0x00FF.007F



Bit/Field	Name	Туре	Reset	Description
31:16	SRAMSZ	RO	0x00FF	SRAM Size

Indicates the size of the on-chip SRAM memory.

Description 0x00FF 64 KB of SRAM

15:0 **FLASHSZ** RO 0x007F Flash Size

Indicates the size of the on-chip flash memory.

Value Description 0x007F 256 KB of Flash

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Register 14: Device Capabilities 1 (DC1), offset 0x010

This register is predefined by the part and can be used to verify features. The PWM, SARADCO, MAXADCSPD, WDT, SWO, SWD, and JTAG bits mask the RCGC0, SCGC0, and DCGC0 registers. Other bits are passed as 0. MAXADCSPD is clipped to the maximum value specified in **DC1**.

Device Capabilities 1 (DC1)

Base 0x400F.E000 Offset 0x010 Type RO, reset 0x0001.33FF

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16				
					'		'	reserved			<u>'</u>					SARADC0				
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 1											
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0				
		SYS	SDIV		•	MAXA	DCSPD	1	MPU	HIB	TEMPSNS	PLL	WDT	SWO	SWD	JTAG				
Type Reset	RO 0	RO 0	RO 1	RO 1	RO 0	RO 0	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1				
Bit/F	ield		Name		Туре	ı	Reset	Descr	iption											
31:	17	r	eserved		RO		0	compa	atibility w	ith futu	ely on the re produce ad-modif	ts, the v	alue of	a reserv						
16	6	S	ARADC	0	RO		1	When	set, indi	cates th	nat genera	al SAR	ADC 0 is	s presen	t.					
15:	12	;	SYSDIV		RO		0x3	Minimum 4-bit divider value for system clock. The reset value is hardware-dependent. See the RCC register for how to change the system clock divisor using the SYSDIV bit. Value Description 0x3 Specifies a 50-MHz CPU clock with a PLL divider of 4.												
								0x3	Specifi	es a 50	-MHz CP	U clock	with a F	LL divid	ler of 4.					
11:	8	MA	XADCS	PD	RO		0x3		Descri		e maximu econd	m rate a	at which	the ADO	C sampl	es data.				
7			MPU		RO		1	modul		ent. See	nat the Co the ARM J.									
6			HIB		RO		1	When	set, indi	cates th	nat the Hi	bernatio	n modu	le is pre	sent.					
5		Т	EMPSN:	S	RO		1	When	set, indi	cates th	nat the on	-chip te	mperatu	ire sens	or is pre	sent.				
4			PLL		RO		1	When set, indicates that the on-chip Phase Locked Loop (PLL) is present.												
3			WDT		RO		1	When	set, indi	cates th	nat a wato	chdog ti	mer is pi	resent.						
2			SWO		RO		1	When prese		cates th	nat the Se	erial Wir	e Outpu	t (SWO)	trace p	ort is				
1			SWD		RO		1	When	set, indi	cates th	nat the Se	erial Wir	e Debug	ger (SW	/D) is pr	esent.				

Bit/Field	Name	Type	Reset	Description
0	JTAG	RO	1	When set, indicates that the JTAG debugger interface is present.



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Register 15: Device Capabilities 2 (DC2), offset 0x014

This register is predefined by the part and can be used to verify features.

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Device Capabilities 2 (DC2)

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Base 0x400F.E000 Offset 0x014 Type RO, reset 0x000F.5037

Type RO, reset 0x000F.5037 31 30

	ı		1 1		,	rese	i I erved				,		TIMER3	TIMER2	TIMER1	TIMER0		
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 1	RO 1	RO 1	RO 1		
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
	reserved	I2C1	reserved	I2C0			rese	rved			SSI1	SSI0	reserved	UART2	UART1	UART0		
Type Reset	RO 0	RO 1	RO 0	RO 1	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 1	RO 1	RO 0	RO 1	RO 1	RO 1		
Bit/Fi	ield		Name		Туре	ſ	Reset	Descr	iption									
31:2	20		reserved		RO		0	compa	atibility v	uld not re vith future oss a rea	e produc	cts, the v	value of	a reserv				
19)		TIMER3		RO		1	When	set, ind	icates tha	at Gene	ral-Purp	ose Tim	er modu	le 3 is p	resent.		
18	3		TIMER2		RO		1	When	set, ind	icates tha	at Gene	ral-Purp	ose Tim	er modu	le 2 is p	resent.		
17	,		TIMER1		RO		1	When	set, ind	icates tha	at Gene	ral-Purp	ose Tim	er modu	le 1 is p	resent.		
16	3		TIMER0		RO		1	When set, indicates that General-Purpose Timer module 0 is present.										
15	5		reserved		RO		0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.										
14	ļ		I2C1		RO		1	When	set, ind	icates tha	at I2C m	odule 1	is prese	ent.				
13	3		reserved		RO		0	compa	atibility v	old not re with future oss a rea	produc	cts, the v	value of	a reserv				
12	2		I2C0		RO		1	When	set, ind	icates tha	at I2C m	odule 0	is prese	ent.				
11:	6		reserved		RO		0	compa	atibility v	ıld not re vith future oss a rea	produc	cts, the v	value of	a reserv				
5			SSI1		RO		1	When	set, ind	icates tha	at SSI m	nodule 1	is prese	ent.				
4			SSI0		RO		1	When	set, ind	icates tha	at SSI m	nodule 0	is prese	ent.				
3			reserved		RO		0	compa	atibility v	old not re with future oss a rea	e produc	cts, the v	value of	a reserv				
2			UART2		RO		1	When	set, ind	icates tha	at UART	module	e 2 is pre	esent.				
1			UART1		RO		1	When	set, ind	icates tha	at UART	module	e 1 is pre	esent.				
0			UART0		RO		1	When	set, ind	icates tha	at UAR1	module	e 0 is pre	esent.				

Register 16: Device Capabilities 3 (DC3), offset 0x018

This register is predefined by the part and can be used to verify features.

Device Capabilities 3 (DC3)

Base 0x400F.E000 Offset 0x018 Type RO, reset 0x3FFF.0000

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
l	rese	erved	CCP5	CCP4	CCP3	CCP2	CCP1	CCP0	ADC7	ADC6	ADC5	ADC4	ADC3	ADC2	ADC1	ADC0		
Type Reset	RO 0	RO 0	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1	RO 1		
_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
		'	1		! !	l	'	rese	rved •	•					'	•		
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0		
Bit/Fi	eld		Name		Type		Reset	Descr	intion									
					,,	'												
31:3	30		reserved		RO		0	comp	atibility v	ıld not re vith futur oss a rea	e produ	cts, the v	alue of	a reserv				
29)		CCP5		RO		1	·		icates th			•		is prese	ent.		
28	3		CCP4		RO		1	When	set, ind	icates th	at Captu	ıre/Com	pare/PW	/M pin 4	is prese	ent.		
27	•		ССР3		RO		1	When set, indicates that Capture/Compare/PWM pin 3 is present.										
26	6	CCP2 RO				1	When	set, ind	icates th	at Captı	ıre/Com	pare/PW	/M pin 2	is prese	ent.			
25				RO		1	When	set, ind	icates th	at Captu	ıre/Com	pare/PW	/M pin 1	is prese	ent.			
24	ļ		CCP0		RO		1	When	set, ind	icates th	at Captı	ure/Com	pare/PW	/M pin 0	is prese	ent.		
23	3		ADC7		RO		1	When	set, ind	icates th	at ADC	pin 7 is į	present.					
22	2		ADC6		RO		1	When	set, ind	icates th	at ADC	pin 6 is _l	present.					
21			ADC5		RO		1	When	set, ind	icates th	at ADC	pin 5 is _l	present.					
20)		ADC4		RO		1	When	set, ind	icates th	at ADC	pin 4 is _l	present.					
19)		ADC3		RO		1	When	set, ind	icates th	at ADC	pin 3 is _l	oresent.					
18	3		ADC2		RO		1	When	set, ind	icates th	at ADC	pin 2 is _l	present.					
17	,		ADC1		RO		1	When set, indicates that ADC pin 1 is present.										
16	3		ADC0		RO		1	When	set, ind	icates th	at ADC	pin 0 is _l	present.					
15:	0		reserved		RO		0	comp	atibility v	uld not re vith futur oss a rea	e produ	cts, the v	alue of	a reserv				

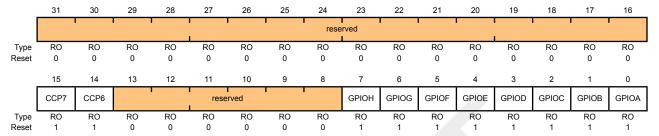
Register 17: Device Capabilities 4 (DC4), offset 0x01C

This register is predefined by the part and can be used to verify features.

Device Capabilities 4 (DC4)

Base 0x400F.E000 Offset 0x01C

Type RO, reset 0x0000.C0FF



Bit/Field	Name	Type	Reset	Description
31:16	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15	CCP7	RO	1	When set, indicates that Capture/Compare/PWM pin 7 is present.
14	CCP6	RO	1	When set, indicates that Capture/Compare/PWM pin 6 is present.
13:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	GPIOH	RO	1	When set, indicates that GPIO Port H is present.
6	GPIOG	RO	1	When set, indicates that GPIO Port G is present.
5	GPIOF	RO	1	When set, indicates that GPIO Port F is present.
4	GPIOE	RO	1	When set, indicates that GPIO Port E is present.
3	GPIOD	RO	1	When set, indicates that GPIO Port D is present.
2	GPIOC	RO	1	When set, indicates that GPIO Port C is present.
1	GPIOB	RO	1	When set, indicates that GPIO Port B is present.
0	GPIOA	RO	1	When set, indicates that GPIO Port A is present.

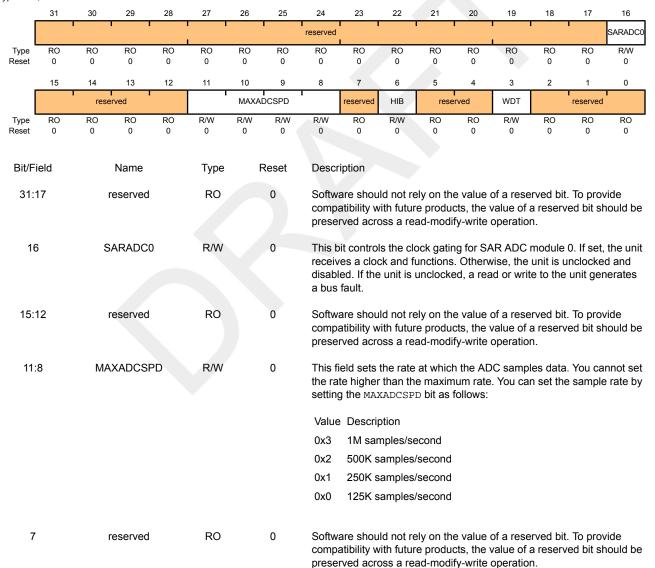
Register 18: Run Mode Clock Gating Control Register 0 (RCGC0), offset 0x100

This register controls the clock gating logic. Each bit controls a clock enable for a given interface, function, or unit. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled (saving power). If the unit is unclocked, reads or writes to the unit will generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional units are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or units to control. This is to assure reasonable code compatibility with other family and future parts. **RCGC0** is the clock configuration register for running operation, **SCGC0** for Sleep operation, and **DCGC0** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Run Mode Clock Gating Control Register 0 (RCGC0)

Base 0x400F.E000 Offset 0x100

Type R/W, reset 0x00000040



Bit/Field	Name	Туре	Reset	Description
6	HIB	R/W	0	This bit controls the clock gating for the Hibernation module. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled.
5:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	WDT	R/W	0	This bit controls the clock gating for the WDT module. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, a read or write to the unit generates a bus fault.
2:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 19: Sleep Mode Clock Gating Control Register 0 (SCGC0), offset 0x110

This register controls the clock gating logic. Each bit controls a clock enable for a given interface, function, or unit. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled (saving power). If the unit is unclocked, reads or writes to the unit will generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional units are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or units to control. This is to assure reasonable code compatibility with other family and future parts. **RCGC0** is the clock configuration register for running operation, **SCGC0** for Sleep operation, and **DCGC0** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes. bit was changed to

23

22

21

19

18

17

16

Sleep Mode Clock Gating Control Register 0 (SCGC0)

28

27

R/W

RO

0

0

26

25

29

MAXADCSPD

reserved

Base 0x400F.E000 Offset 0x110

15:12

11:8

7

Type R/W, reset 0x00000040

30

		'	'	_	'		'	reserved			'	'			'	SARADC0
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		rese	erved		1	MAXA	DCSPD		reserved	HIB	rese	rved	WDT		reserved	
Туре	RO	RO	RO	RO	R/W	R/W	R/W	R/W	RO	R/W	RO	RO	R/W	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bit/F			Name		Туре		Reset		ription						_	
31:	31:17 reserved				RO		0	Software should not rely on the value of a reserved bit. compatibility with future products, the value of a reserved preserved across a read-modify-write operation.								
16	6	S	SARADC	0	R/W		0	the ur	oit contro nit receive isabled. I	es a clo	ck and fu	inctions.	Otherwi	se, the ι	ınit is ur	clocked

24

reserved RO 0 Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

a bus fault.

This field sets the rate at which the ADC samples data. You cannot set the rate higher than the maximum rate. You can set the sample rate by setting the MAXADCSPD bit as follows:

Value	Description
0x3	1M samples/second
0x2	500K samples/second
0x1	250K samples/second
0x0	125K samples/second

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
6	HIB	R/W	0	This bit controls the clock gating for the Hibernation module. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled.
5:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	WDT	R/W	0	This bit controls the clock gating for the WDT module. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, a read or write to the unit generates a bus fault.
2:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

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Register 20: Deep Sleep Mode Clock Gating Control Register 0 (DCGC0), offset 0x120

This register controls the clock gating logic. Each bit controls a clock enable for a given interface, function, or unit. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled (saving power). If the unit is unclocked, reads or writes to the unit will generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional units are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or units to control. This is to assure reasonable code compatibility with other family and future parts. **RCGC0** is the clock configuration register for running operation, **SCGC0** for Sleep operation, and **DCGC0** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes. bit was changed to

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21

Deep Sleep Mode Clock Gating Control Register 0 (DCGC0)

28

27

RO

0

reserved

26

25

24

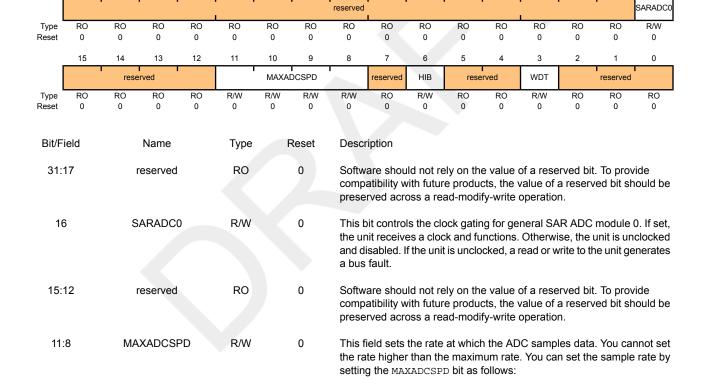
Base 0x400F.E000 Offset 0x120

7

Type R/W, reset 0x00000040

30

29



Value Description

0x3 1M samples/second0x2 500K samples/second0x1 250K samples/second

0x0 125K samples/second

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
6	HIB	R/W	0	This bit controls the clock gating for the Hibernation module. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled.
5:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	WDT	R/W	0	This bit controls the clock gating for the WDT module. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, a read or write to the unit generates a bus fault.
2:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

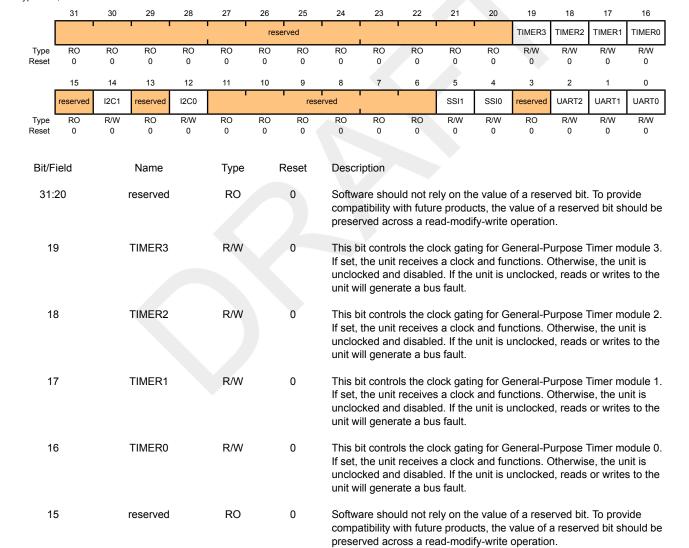
Register 21: Run Mode Clock Gating Control Register 1 (RCGC1), offset 0x104

This register controls the clock gating logic. Each bit controls a clock enable for a given interface, function, or unit. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled (saving power). If the unit is unclocked, reads or writes to the unit will generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional units are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or units to control. This is to assure reasonable code compatibility with other family and future parts. **RCGC1** is the clock configuration register for running operation, **SCGC1** for Sleep operation, and **DCGC1** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Run Mode Clock Gating Control Register 1 (RCGC1)

Base 0x400F.E000 Offset 0x104

Type R/W, reset 0x00000000



Bit/Field	Name	Туре	Reset	Description
14	I2C1	R/W	0	This bit controls the clock gating for I2C module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	I2C0	R/W	0	This bit controls the clock gating for I2C module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
11:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SSI1	R/W	0	This bit controls the clock gating for SSI module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
4	SSI0	R/W	0	This bit controls the clock gating for SSI module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	UART2	R/W	0	This bit controls the clock gating for UART module 2. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
1	UART1	R/W	0	This bit controls the clock gating for UART module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
0	UART0	R/W	0	This bit controls the clock gating for UART module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.

Register 22: Sleep Mode Clock Gating Control Register 1 (SCGC1), offset 0x114

This register controls the clock gating logic. Each bit controls a clock enable for a given interface, function, or unit. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled (saving power). If the unit is unclocked, reads or writes to the unit will generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional units are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or units to control. This is to assure reasonable code compatibility with other family and future parts. **RCGC1** is the clock configuration register for running operation, **SCGC1** for Sleep operation, and **DCGC1** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Sleep Mode Clock Gating Control Register 1 (SCGC1)

Base 0x400F.E000 Offset 0x114

Type R/W, reset 0x00000000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
			'			rese	rved						TIMER3	TIMER2	TIMER1	TIMER0
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	reserved	I2C1	reserved	I2C0			rese	rved	ı		SSI1	SSI0	reserved	UART2	UART1	UART0
Туре	RO	R/W	RO	R/W	RO	RO	RO	RO	RO	RO	R/W	R/W	RO	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:20	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
19	TIMER3	R/W	0	This bit controls the clock gating for General-Purpose Timer module 3. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
18	TIMER2	R/W	0	This bit controls the clock gating for General-Purpose Timer module 2. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
17	TIMER1	R/W	0	This bit controls the clock gating for General-Purpose Timer module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
16	TIMER0	R/W	0	This bit controls the clock gating for General-Purpose Timer module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
15	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Bit/Field	Name	Туре	Reset	Description
14	I2C1	R/W	0	This bit controls the clock gating for I2C module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	I2C0	R/W	0	This bit controls the clock gating for I2C module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
11:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SSI1	R/W	0	This bit controls the clock gating for SSI module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
4	SSI0	R/W	0	This bit controls the clock gating for SSI module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	UART2	R/W	0	This bit controls the clock gating for UART module 2. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
1	UART1	R/W	0	This bit controls the clock gating for UART module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
0	UART0	R/W	0	This bit controls the clock gating for UART module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.

Register 23: Deep Sleep Mode Clock Gating Control Register 1 (DCGC1), offset 0x124

This register controls the clock gating logic. Each bit controls a clock enable for a given interface, function, or unit. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled (saving power). If the unit is unclocked, reads or writes to the unit will generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional units are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or units to control. This is to assure reasonable code compatibility with other family and future parts. **RCGC1** is the clock configuration register for running operation, **SCGC1** for Sleep operation, and **DCGC1** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Deep Sleep Mode Clock Gating Control Register 1 (DCGC1)

Base 0x400F.E000 Offset 0x124 Type R/W, reset 0x00000000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	'		' '			rese	rved					'	TIMER3	TIMER2	TIMER1	TIMER0
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	reserved	I2C1	reserved	I2C0			rese	rved			SSI1	SSI0	reserved	UART2	UART1	UART0
Туре	RO	R/W	RO	R/W	RO	RO	RO	RO	RO	RO	R/W	R/W	RO	R/W	R/W	R/W
Dooot	0	0	0	Λ.	Λ.	0	0	0	0	0	0	0	Λ.	0	Λ.	0

Bit/Field	Name	Туре	Reset	Description
31:20	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
19	TIMER3	R/W	0	This bit controls the clock gating for General-Purpose Timer module 3. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
18	TIMER2	R/W	0	This bit controls the clock gating for General-Purpose Timer module 2. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
17	TIMER1	R/W	0	This bit controls the clock gating for General-Purpose Timer module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
16	TIMER0	R/W	0	This bit controls the clock gating for General-Purpose Timer module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
15	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

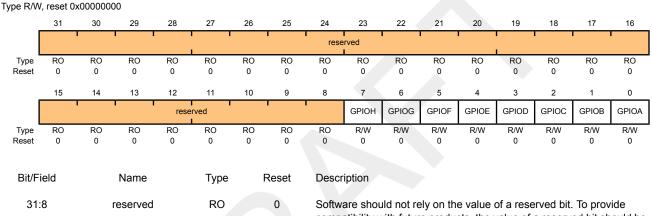
Bit/Field	Name	Туре	Reset	Description
14	I2C1	R/W	0	This bit controls the clock gating for I2C module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	I2C0	R/W	0	This bit controls the clock gating for I2C module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
11:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SSI1	R/W	0	This bit controls the clock gating for SSI module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
4	SSI0	R/W	0	This bit controls the clock gating for SSI module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	UART2	R/W	0	This bit controls the clock gating for UART module 2. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
1	UART1	R/W	0	This bit controls the clock gating for UART module 1. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
0	UART0	R/W	0	This bit controls the clock gating for UART module 0. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.

Register 24: Run Mode Clock Gating Control Register 2 (RCGC2), offset 0x108

This register controls the clock gating logic. Each bit controls a clock enable for a given interface, function, or unit. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled (saving power). If the unit is unclocked, reads or writes to the unit will generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional units are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or units to control. This is to assure reasonable code compatibility with other family and future parts. RCGC2 is the clock configuration register for running operation, SCGC2 for Sleep operation, and DCGC2 for Deep-Sleep operation. Setting the ACG bit in the Run-Mode Clock Configuration (RCC) register specifies that the system uses sleep modes.

Run Mode Clock Gating Control Register 2 (RCGC2)

Base 0x400F.E000 Offset 0x108



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	GPIOH	R/W	0	This bit controls the clock gating for Port H. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
6	GPIOG	R/W	0	This bit controls the clock gating for Port G. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
5	GPIOF	R/W	0	This bit controls the clock gating for Port F. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
4	GPIOE	R/W	0	This bit controls the clock gating for Port E. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
3	GPIOD	R/W	0	This bit controls the clock gating for Port D. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
2	GPIOC	R/W	0	This bit controls the clock gating for Port C. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.

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Bit/Field	Name	Туре	Reset	Description
1	GPIOB	R/W	0	This bit controls the clock gating for Port B. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
0	GPIOA	R/W	0	This bit controls the clock gating for Port A. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.



Register 25: Sleep Mode Clock Gating Control Register 2 (SCGC2), offset 0x118

This register controls the clock gating logic. Each bit controls a clock enable for a given interface, function, or unit. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled (saving power). If the unit is unclocked, reads or writes to the unit will generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional units are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or units to control. This is to assure reasonable code compatibility with other family and future parts. **RCGC2** is the clock configuration register for running operation, **SCGC2** for Sleep operation, and **DCGC2** for Deep-Sleep operation. Setting the ACG bit in the **Run-Mode Clock Configuration (RCC)** register specifies that the system uses sleep modes.

Sleep Mode Clock Gating Control Register 2 (SCGC2)

Base 0x400F.E000 Offset 0x118

Type R/W, reset 0x00000000

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		'	'	'				rese	rved							
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	reserved								GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
Type	RO	RO	RO	RO	RO	RO	RO	RO	R/W							
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	GPIOH	R/W	0	This bit controls the clock gating for Port H. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
6	GPIOG	R/W	0	This bit controls the clock gating for Port G. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
5	GPIOF	R/W	0	This bit controls the clock gating for Port F. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
4	GPIOE	R/W	0	This bit controls the clock gating for Port E. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
3	GPIOD	R/W	0	This bit controls the clock gating for Port D. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
2	GPIOC	R/W	0	This bit controls the clock gating for Port C. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.

Bit/Field	Name	Type	Reset	Description
1	GPIOB	R/W	0	This bit controls the clock gating for Port B. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
0	GPIOA	R/W	0	This bit controls the clock gating for Port A. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.



Register 26: Deep Sleep Mode Clock Gating Control Register 2 (DCGC2), offset 0x128

This register controls the clock gating logic. Each bit controls a clock enable for a given interface, function, or unit. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled (saving power). If the unit is unclocked, reads or writes to the unit will generate a bus fault. The reset state of these bits is 0 (unclocked) unless otherwise noted, so that all functional units are disabled. It is the responsibility of software to enable the ports necessary for the application. Note that these registers may contain more bits than there are interfaces, functions, or units to control. This is to assure reasonable code compatibility with other family and future parts. RCGC2 is the clock configuration register for running operation, SCGC2 for Sleep operation, and DCGC2 for Deep-Sleep operation. Setting the ACG bit in the Run-Mode Clock Configuration (RCC) register specifies that the system uses sleep modes.

Deep Sleep Mode Clock Gating Control Register 2 (DCGC2)

Base 0x400F.E000 Offset 0x128 Type R/W, reset 0x00000000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
				'				rese	rved I							
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
				rese	rved				GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
Туре	RO	RO	RO	RO	RO	RO	RO	RO	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	GPIOH	R/W	0	This bit controls the clock gating for Port H. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
6	GPIOG	R/W	0	This bit controls the clock gating for Port G. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
5	GPIOF	R/W	0	This bit controls the clock gating for Port F. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
4	GPIOE	R/W	0	This bit controls the clock gating for Port E. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
3	GPIOD	R/W	0	This bit controls the clock gating for Port D. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
2	GPIOC	R/W	0	This bit controls the clock gating for Port C. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.

Bit/Field	Name	Type	Reset	Description
1	GPIOB	R/W	0	This bit controls the clock gating for Port B. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.
0	GPIOA	R/W	0	This bit controls the clock gating for Port A. If set, the unit receives a clock and functions. Otherwise, the unit is unclocked and disabled. If the unit is unclocked, reads or writes to the unit will generate a bus fault.



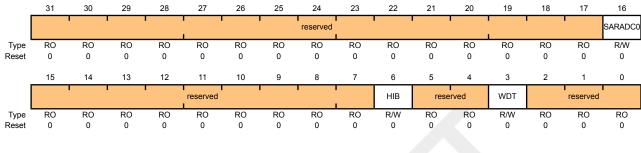
Register 27: Software Reset Control 0 (SRCR0), offset 0x040

Writes to this register are masked by the bits in the Device Capabilities 1 (DC1) register.

Software Reset Control 0 (SRCR0)

Base 0x400F.E000

Offset 0x040 Type R/W, reset 0x00000000



Bit/Field	Name	Туре	Reset	Description
31:17	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
16	SARADC0	R/W	0	Reset control for SAR ADC module 0.
15:7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	HIB	R/W	0	Reset control for the Hibernation module.
5:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	WDT	R/W	0	Reset control for Watchdog unit.
2:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

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Register 28: Software Reset Control 1 (SRCR1), offset 0x044

Writes to this register are masked by the bits in the **Device Capabilities 2 (DC2)** register.

Software Reset Control 1 (SRCR1)

Base 0x400F.E000

Offset 0x044
Type R/W, reset 0x00000000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
			' '			rese	rved	'					TIMER3	TIMER2	TIMER1	TIMER0
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	reserved	I2C1	reserved	I2C0		reserved					SSI1	SSI0	reserved	UART2	UART1	UART0
Type	RO	R/W	RO	R/W	RO	RO	RO	RO	RO	RO	R/W	R/W	RO	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:20	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
19	TIMER3	R/W	0	Reset control for General-Purpose Timer module 3.
18	TIMER2	R/W	0	Reset control for General-Purpose Timer module 2.
17	TIMER1	R/W	0	Reset control for General-Purpose Timer module 1.
16	TIMER0	R/W	0	Reset control for General-Purpose Timer module 0.
15	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
14	I2C1	R/W	0	Reset control for I2C unit 1.
13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	I2C0	R/W	0	Reset control for I2C unit 0.
11:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SSI1	R/W	0	Reset control for SSI unit 1.
4	SSI0	R/W	0	Reset control for SSI unit 0.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	UART2	R/W	0	Reset control for UART unit 2.
1	UART1	R/W	0	Reset control for UART unit 1.
0	UART0	R/W	0	Reset control for UART unit 0.

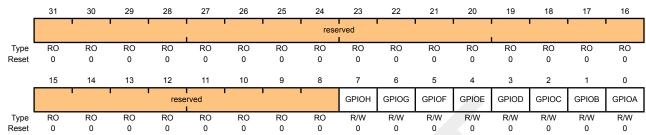
Register 29: Software Reset Control 2 (SRCR2), offset 0x048

Writes to this register are masked by the bits in the Device Capabilities 4 (DC4) register.

Software Reset Control 2 (SRCR2)

Base 0x400F.E000 Offset 0x048

Type R/W, reset 0x00000000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7	GPIOH	R/W	0	Reset control for GPIO Port H.
6	GPIOG	R/W	0	Reset control for GPIO Port G.
5	GPIOF	R/W	0	Reset control for GPIO Port F.
4	GPIOE	R/W	0	Reset control for GPIO Port E.
3	GPIOD	R/W	0	Reset control for GPIO Port D.
2	GPIOC	R/W	0	Reset control for GPIO Port C.
1	GPIOB	R/W	0	Reset control for GPIO Port B.
0	GPIOA	R/W	0	Reset control for GPIO Port A.

7 Hibernation Module

HIB

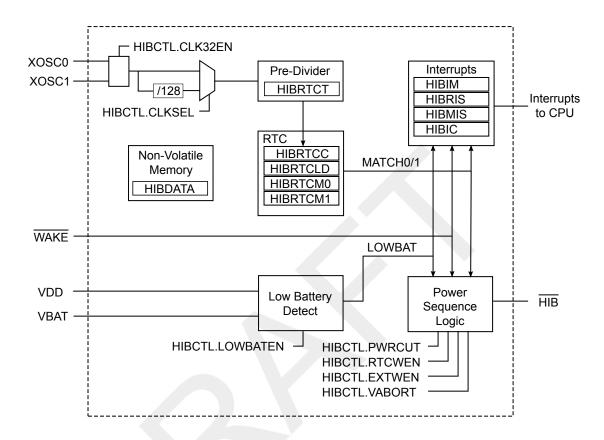
The Hibernation Module manages removal and restoration of power to the rest of the microcontroller to provide a means for reducing power consumption. When the processor and peripherals are idle, power can be completely removed with only the Hibernation Module remaining powered. Power can be restored based on an external signal, or at a certain time using the built-in real-time clock (RTC). The Hibernation module can be independently supplied from a battery or an auxillary power supply.

The Hibernation module has the following features:

- Power-switching logic to discrete external regulator
- Dedicated pin for waking from an external signal
- Low-battery detection, signalling, and interrupt generation
- 32-bit real-time counter (RTC)
- Two 32-bit RTC match registers for timed wake-up and interrupt generation
- Clock source from a 32.768-kHz external oscillator or a 4.194304-MHz crystal
- RTC trim predivider for making fine adjustments to the clock rate
- 64 32-bit words of non-volatile memory
- Programmable interrupts for RTC match, external wake, and low battery events

7.1 Block Diagram

Figure 7-1. Hibernation Module Block Diagram



7.2 Functional Description

The Hibernation module controls the power to the processor with an enable signal ($\overline{\texttt{HIB}}$) that signals an external voltage regulator to turn off. The Hibernation module itself is powered from a separate supply such as a battery or auxillary supply. It also has a separate clock source to maintain a real-time clock (RTC). Once in hibernation, the module signals an external voltage regulator to turn back on the power when an external pin ($\overline{\texttt{WAKE}}$) is asserted, or when the internal RTC reaches a certain value. The Hibernation module can also detect when the battery voltage is low, and optionally prevent hibernation when this occurs.

Power-up from a power cut to code execution is defined as the regulator turn-on time (specifed at 250 µs maximum) plus the normal chip POR (see Figure 19-11 on page 413).

7.2.1 Register Access Timing

Because the Hibernation module has an independent clocking domain, certain registers must be written only with a timing gap between accesses. The delay time is $t_{\rm HIB_REG_WRITE}$, therefore software must guarantee that a delay of $t_{\rm HIB_REG_WRITE}$ is inserted between back-to-back writes to certain Hibernation registers, or between a write followed by a read to those same registers. There is no restriction on timing for back-to-back reads from the Hibernation module. Refer to "Register Descriptions" on page 111 for details about which registers are subject to this timing restriction.

7.2.2 Clock Source

The Hibernation module must be clocked by an external source, even if the RTC feature will not be used. An external oscillator or crystal can be used for this purpose. To use a crystal, a 4.194304-MHz crystal is connected to the XOSCO and XOSCO pins. This clock signal will be divided by 128 internally to produce the 32.768-kHz clock reference. To use a more precise clock source, a 32.768-kHz oscillator can be connected to the XOSCO pin.

The clock source is enabled by setting the CLK32EN bit of the **HIBCTL** register. The type of clock source is selected by setting the CLK3EL bit to 0 for a 4.194304-MHz clock source, and to 1 for a 32.768-kHz clock source. If the bit is set to 0, the input clock is divided by 128, resulting in a 32.768-kHz clock source. If a crystal is used for the clock source, the software must leave a delay of $\texttt{t}_{\texttt{XOSC_SETTLE}}$ after setting the CLK32EN bit and before any other accesses to the Hibernation module registers. The delay allows the crystal to power up and stabilize. If an oscillator is used for the clock source, no delay is needed.

7.2.3 Battery Management

The Hibernation module can be independently powered by a battery or an auxiliary power source. The module can monitor the voltage level of the battery and detect when the voltage becomes too low. When this happens, an interrupt can be generated. The module can also be configured so that it will not go into Hibernate mode if the battery voltage is too low.

Note that the Hibernation module draws power from whichever source (VBAT or VDD) has the higher voltage. Therefore, it is important to design the circuit to ensure that VDD is higher that VBAT under nominal conditions or else the Hibernation module draws power from the battery even when VDD is available.

The Hibernation module can be configured to detect a low battery condition by setting the LOWBATEN bit of the **HIBCTL** register. In this configuration, the LOWBAT bit of the **HIBRIS** register will be set when the battery level is low. If the VABORT bit is also set, then the module is prevented from entering Hibernation mode when a low battery is detected. The module can also be configured to generate an interrupt for the low-battery condition (see "Interrupts and Status" on page 109).

7.2.4 Real-Time Clock

The Hibernation module includes a 32-bit counter that increments once per second with a proper clock source and configuration (see "Clock Source" on page 108). The 32.768-kHz clock signal is fed into a trim predivider which counts down from a nominal value of 0x7FFF to achieve a once per second clock rate for the RTC. The trim predivider register can be adjusted up or down to compensate for inaccuracies in the clock source. The trim predivider should be adjusted up from 0x7FFF in order to slow down the RTC rate, and down from 0x7FFF in order to speed up the RTC rate.

The Hibernation module includes two 32-bit match registers that are compared to the value of the RTC counter. The match registers can be used to wake the processor from hibernation mode, or to generate an interrupt to the processor if it is not in hibernation.

The RTC must be enabled with the RTCEN bit of the **HIBCTL** register. The value of the RTC can be set at any time by writing to the **HIBRTCLD** register. The trim predivider can be adjusted by reading and writing the **HIBRTCT** register. The predivider is updated once every 64 seconds from this register. The two match registers can be set by writing to the **HIBRTCM0** and **HIBRTCM1** registers. The RTC can be configured to generate interrupts by using the interrupt registers (see "Interrupts and Status" on page 109).

7.2.5 Non-Volatile Memory

The Hibernation module contains 64 32-bit words of memory which are retained during hibernation. This memory is powered from the battery or auxillary power supply during hibernation. The processor software can save state information in this memory prior to hibernation, and can then recover the state upon waking. The non-volatile memory can be accessed through the **HIBDATA** registers.

7.2.6 Power Control

The Hibernation module controls power to the processor through the use of the $\overline{\tt HIB}$ pin, which is intended to be connected to the enable signal of the external regulator(s) providing 3.3 V and/or 2.5 V to the microcontroller. When the $\overline{\tt HIB}$ signal is asserted by the Hibernation module, the external regulator is turned off and no longer powers the microcontroller. The Hibernation module remains powered from the VBAT supply, which could be a battery or an auxillary power source. Hibernation mode is initiated by the microcontroller setting the HIBREQ bit of the **HIBCTL** register. Prior to doing this, a wake-up condition must be configured, either from the external $\overline{\tt WAKE}$ pin, or by using an RTC match.

The Hibernation module is configured to wake from the external WAKE pin by setting the PINWEN bit of the **HIBCTL** register. It is configured to wake from RTC match by setting the RTCWEN bit. Either one or both of these bits can be set prior to going into hibernation.

When the Hibernation module wakes, the microcontroller will see a normal power-on reset. It can detect that the power-on was due to a wake from hibernation by examining the raw interrupt status register (see "Interrupts and Status" on page 109) and by looking for state data in the non-volatile memory (see "Non-Volatile Memory" on page 109).

7.2.7 Interrupts and Status

The Hibernation module can generate interrupts when the following conditions occur:

- Assertion of WAKE pin
- RTC match
- Low battery detected

All of the interrupts are ORed together before being sent to the interrupt controller, so the Hibernate module can only generate a single interrupt request to the controller at any given time. The software interrupt handler can service multiple interrupt events by reading the **HIBMIS** register. Software can also read the status of the Hibernation module at any time by reading the **HIBRIS** register which shows all of the pending events. This register can be used at power-on to see if a wake condition is pending, which indicates to the software that a hibernation wake occurred.

The events that can trigger an interrupt are configured by setting the appropriate bits in the **HIBIM** register. Pending interrupts can be cleared by writing the corresponding bit in the **HIBIC** register.

7.3 Initialization and Configuration

The Hibernation module can be configured in several different combinations. The following sections show the recommended programming sequence for various scenarios. The examples below assume that a 32.768-kHz oscillator is used, and thus always show bit 2 (CLKSEL) of the **HIBCTL** register set to 1. If a 4.194304-MHz crystal is used instead, then the CLKSEL bit remains cleared. Because the Hibernation module runs at 32 kHz and is asynchronous to the rest of the system, software must allow a delay of $t_{\rm HIB\ REG\ WRITE}$ after writes to certain registers (see "Register Access

Timing" on page 107). The registers that require a delay are denoted with a footnote in Table 7-1 on page 111.

7.3.1 Initialization

The clock source must be enabled first, even if the RTC will not be used. If a 4.194304-MHz crystal is used, perform the following steps:

- 1. Write 0x40 to the **HIBCTL** register at offset 0x10 to enable the crystal and select the divide-by-128 input path.
- 2. Wait for a time of $t_{\text{XOSC_SETTLE}}$ for the crystal to power up and stabilize before performing any other operations with the Hibernation module.

If a 32.678-kHz oscillator is used, then perform the following steps:

- 1. Write 0x44 to the **HIBCTL** register at offset 0x10 to enable the oscillator input.
- 2. No delay is necessary.

The above is only necessary when the entire system is initialized for the first time. If the processor is powered due to a wake from hibernation, then the Hibernation module has already been powered up and the above steps are not necessary. The software can detect that the Hibernation module and clock are already powered by examining the CLK32EN bit of the **HIBCTL** register.

7.3.2 RTC Match Functionality (No Hibernation)

The following steps are needed to use the RTC match functionality of the Hibernation module:

- 1. Write the required RTC match value to one of the **HIBRTCMn** registers at offset 0x004 or 0x008.
- 2. Write the required RTC load value to the **HIBRTCLD** register at offset 0x00C.
- 3. Set the required RTC match interrupt mask in the RTCALT0 and RTCALT1 bits (bits 1:0) in the HIBIM register at offset 0x014.
- 4. Write 0x0000.0041 to the **HIBCTL** register at offset 0x010 to enable the RTC to begin counting.

7.3.3 RTC Match/Wake-Up from Hibernation

The following steps are needed to use the RTC match and wake-up functionality of the Hibernation module:

- 1. Write the required RTC match value to the **RTCMn** registers at offset 0x004 or 0x008.
- 2. Write the required RTC load value to the **HIBRTCLD** register at offset 0x00C.
- 3. Write any data to be retained during power cut to the **HIBDATA** register at offsets 0x030-0x130.
- 4. Set the RTC Match Wake-Up and start the hibernation sequence by writing 0x0000.004F to the **HIBCTL** register at offset 0x010.

7.3.4 External Wake-Up from Hibernation

The following steps are needed to use the Hibernation module with the external \overline{WAKE} pin as the wake-up source for the microcontroller:

- 1. Write any data to be retained during power cut to the **HIBDATA** register at offsets 0x030-0x130.
- 2. Enable the external wake and start the hibernation sequence by writing 0x0000.0056 to the **HIBCTL** register at offset 0x010.

7.3.5 RTC/External Wake-Up from Hibernation

- 1. Write the required RTC match value to the **RTCMn** registers at offset 0x004 or 0x008.
- 2. Write the required RTC load value to the **HIBRTCLD** register at offset 0x00C.
- 3. Write any data to be retained during power cut to the **HIBDATA** register at offsets 0x030-0x130.
- 4. Set the RTC Match/External Wake-Up and start the hibernation sequence by writing 0x0000.005F to the **HIBCTL** register at offset 0x010.

7.4 Register Map

Note: HIBRTCC, HIBRTCM0, HIBRTCM1, HIBRTCLD, HIBRTCT, and HIBDATA are internal BAPI module registers on the VBAPI voltage domain and the 32-kHz clock domain.

Table 7-1. Hibernation Module Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	HIBRTCC	RO	0x0000.0000	Hibernation RTC Counter	112
0x004	HIBRTCM0	R/W	0xFFFF.FFFF	Hibernation RTC Match 0	113
0x008	HIBRTCM1	R/W	0xFFFF.FFFF	Hibernation RTC Match 1	114
0x00C	HIBRTCLD	R/W	0xFFFF.FFFF	Hibernation RTC Load	115
0x010	HIBCTL	R/W	0x0000.0000	Hibernation Control	116
0x014	HIBIM	R/W	0x0000.0000	Hibernation Interrupt Mask	118
0x018	HIBRIS	RO	0x0000.0000	Hibernation Raw Interrupt Status	119
0x01C	HIBMIS	RO	0x0000.0000	Hibernation Masked Interrupt Status	120
0x020	HIBIC	W1C	0x0000.0000	Hibernation Interrupt Clear	121
0x024	HIBRTCT	R/W	0x0000.0000	Hibernation RTC Trim	122
0x030- 0x12C	HIBDATA	R/W	0x0000.0000	Hibernation Data	123

7.5 Register Descriptions

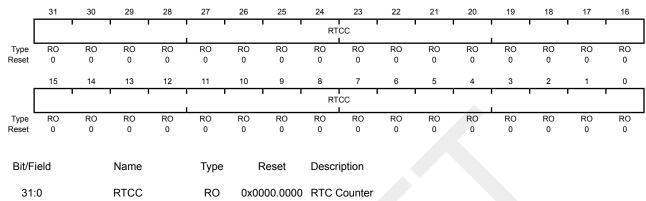
All addresses given are relative to the Hibernation module Base Address at 0x400F.C000.

Register 1: Hibernation RTC Counter (HIBRTCC), offset 0x000

This register is the current 32-bit value of the RTC counter.

Hibernation RTC Counter (HIBRTCC)

Offset 0x000 Type RO, reset 0x0000.0000



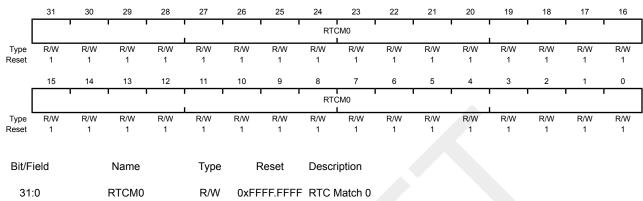
A read returns the 32-bit counter value. This register is read-only. To change the value, use the HIBRTCLD register.

Register 2: Hibernation RTC Match 0 (HIBRTCM0), offset 0x004

This register is the 32-bit match 0 register for the RTC counter.

Hibernation RTC Match 0 (HIBRTCM0)

Offset 0x004 Type R/W, reset 0xFFFF.FFF



A write loads the value into the RTC match register.

A read returns the current match value.

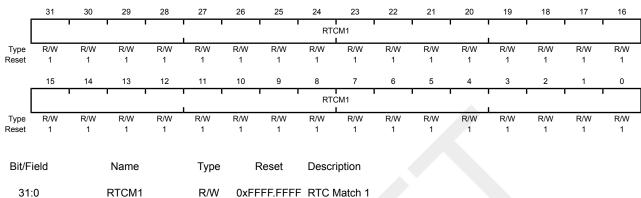
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Register 3: Hibernation RTC Match 1 (HIBRTCM1), offset 0x008

This register is the 32-bit match 1 register for the RTC counter.

Hibernation RTC Match 1 (HIBRTCM1)

Offset 0x008 Type R/W, reset 0xFFFF.FFF



A write loads the value into the RTC match register.

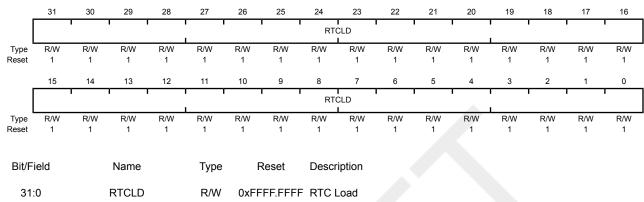
A read returns the current match value.

Register 4: Hibernation RTC Load (HIBRTCLD), offset 0x00C

This register is the 32-bit value loaded into the RTC counter.

Hibernation RTC Load (HIBRTCLD)

Offset 0x00C Type R/W, reset 0xFFFF.FFF



A writes load the current value into the RTC counter (RTCC).

A read returns the 32-bit load value.

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Register 5: Hibernation Control (HIBCTL), offset 0x010

This register is the control register for the Hibernation module.

Hibernation Control (HIBCTL)

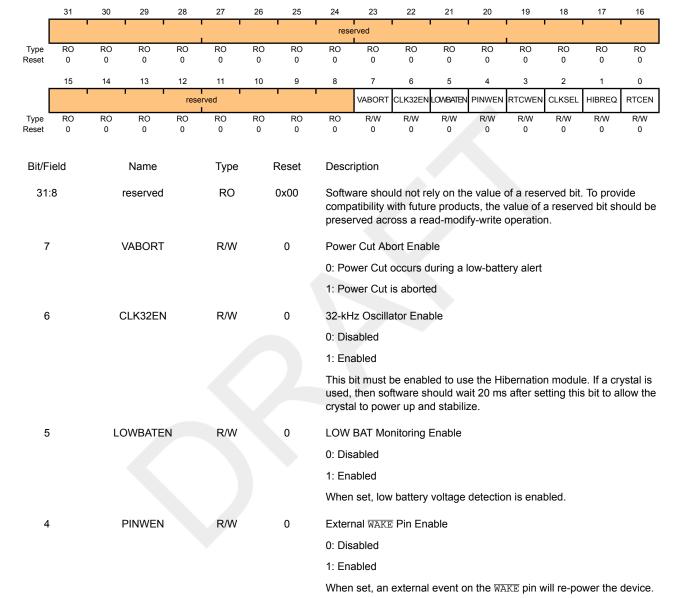
Offset 0x010

3

RTCWEN

R/W

Type R/W, reset 0x0000.0000



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RTC Wake-up Enable

When set, an RTC match event (RTC0 or RTC1) will re-power the device based on the RTC counter value matching the corresponding match

0: Disabled1: Enabled

register 0 or 1.

Bit/Field	Name	Туре	Reset	Description
2	CLKSEL	R/W	0	Hibernation Module Clock Select
				0: Use Divide by 128 output. Use this value for a 4-MHz crystal.
				1: Use raw output. Use this value for a 32-kHz oscillator.
1	HIBREQ	R/W	0	Hibernation Request
				0: Disabled
				1: Hibernation initiated
				After a wake-up event, this bit is cleared by hardware.
0	RTCEN	R/W	0	RTC Timer Enable
				0: Disabled
				1: Enabled

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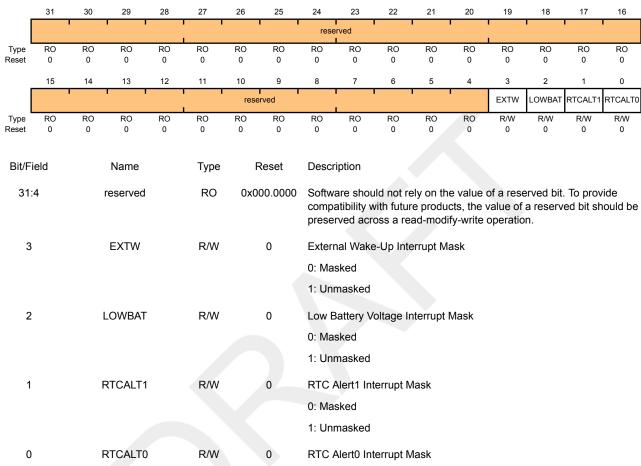
Register 6: Hibernation Interrupt Mask (HIBIM), offset 0x014

This register is the interrupt mask register for the Hibernation module interrupt sources.

Hibernation Interrupt Mask (HIBIM)

Offset 0x014

Type R/W, reset 0x0000.0000



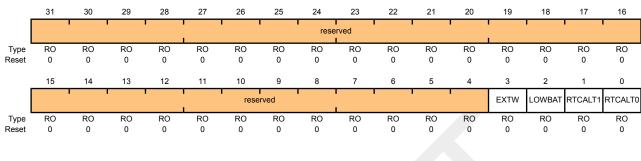
0: Masked1: Unmasked

Register 7: Hibernation Raw Interrupt Status (HIBRIS), offset 0x018

This register is the raw interrupt status for the Hibernation module interrupt sources.

Hibernation Raw Interrupt Status (HIBRIS)

Offset 0x018 Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0x000.0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	EXTW	RO	0	External Wake-Up Raw Interrupt Status
2	LOWBAT	RO	0	Low Battery Voltage Raw Interrupt Status
1	RTCALT1	RO	0	RTC Alert1 Raw Interrupt Status
0	RTCALT0	RO	0	RTC Alert0 Raw Interrupt Status

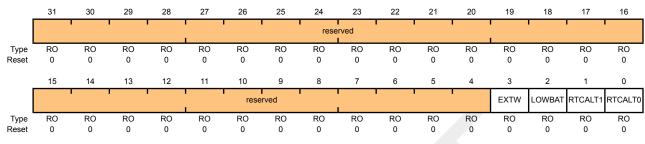
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Register 8: Hibernation Masked Interrupt Status (HIBMIS), offset 0x01C

This register is the masked interrupt status for the Hibernation module interrupt sources.

Hibernation Masked Interrupt Status (HIBMIS)

Offset 0x01C Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:4	reserved	RO	0x000.0000	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	EXTW	RO	0	External Wake-Up Masked Interrupt Status
2	LOWBAT	RO	0	Low Battery Voltage Masked Interrupt Status
1	RTCALT1	RO	0	RTC Alert1 Masked Interrupt Status
0	RTCALT0	RO	0	RTC Alert0 Masked Interrupt Status

Register 9: Hibernation Interrupt Clear (HIBIC), offset 0x020

This register is the interrupt write-one-to-clear register for the Hibernation module interrupt sources.

Hibernation Interrupt Clear (HIBIC)

RTCALT0

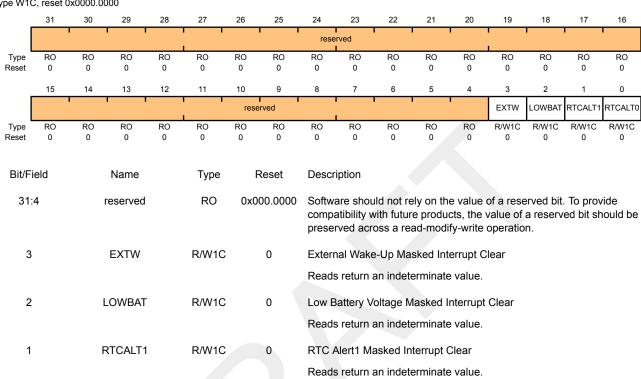
R/W1C

0

Offset 0x020

0

Type W1C, reset 0x0000.0000



Reads, return an indeterminate value.

RTC Alert0 Masked Interrupt Clear

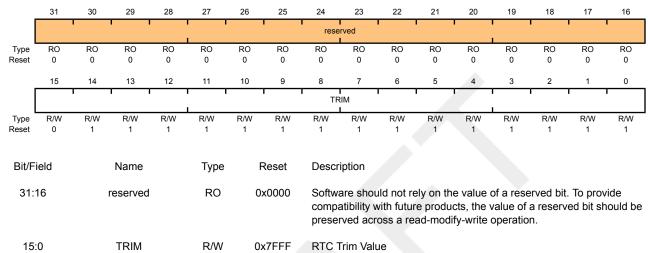
Register 10: Hibernation RTC Trim (HIBRTCT), offset 0x024

This register contains the value that is used to trim the RTC clock predivider. It represents the computed underflow value that is used during the trim cycle. It is represented as $0x7FFF \pm N$ clock cycles.

Hibernation RTC Trim (HIBRTCT)

Offset 0x024

Type R/W, reset 0x0000.0000



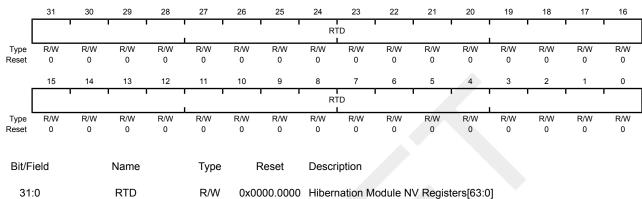
This value is loaded into the RTC predivider every 64 seconds. It is used to adjust the RTC rate to account for drift and inaccuracy in the clock source. The compensation is made by software by adjusting the default value of 0x7FFF up or down.

Register 11: Hibernation Data (HIBDATA), offset 0x030-0x12C

This address space is implemented as a 64x32-bit memory (256 bytes). It can be loaded by the system processor in order to store any non-volatile state data and will not lose power during a power cut operation.

Hibernation Data (HIBDATA)

Offset 0x030-0x12C Type R/W, reset 0x0000.0000



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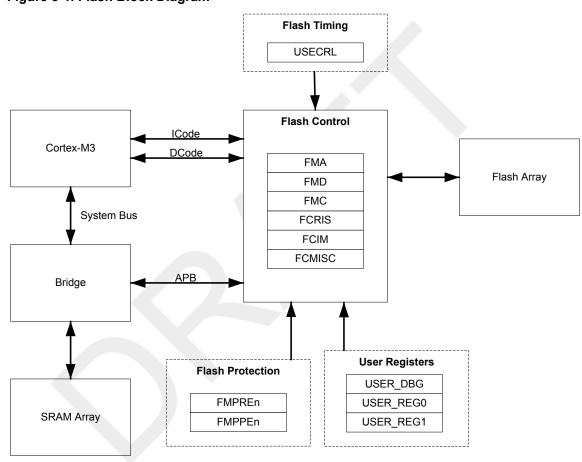
8 Internal Memory

FLASH

The LM3S1958 microcontroller comes with 64 KB of bit-banded SRAM and 256 KB of flash memory. The flash controller provides a user-friendly interface, making flash programming a simple task. Flash protection can be applied to the flash memory on a 2-KB block basis.

8.1 Block Diagram

Figure 8-1. Flash Block Diagram



8.2 Functional Description

This section describes the functionality of both the flash and SRAM memories.

8.2.1 SRAM Memory

The internal SRAM of the Stellaris[®] devices is located at address 0x2000.0000 of the device memory map. To reduce the number of time consuming read-modify-write (RMW) operations, ARM has introduced *bit-banding* technology in the Cortex-M3 processor. With a bit-band-enabled processor, certain regions in the memory map (SRAM and peripheral space) can use address aliases to access individual bits in a single, atomic operation.

The bit-band alias is calculated by using the formula:

```
bit-band alias = bit-band base + (byte offset * 32) + (bit number * 4)
```

For example, if bit 3 at address 0x2000.1000 is to be modified, the bit-band alias is calculated as:

```
0x2200.0000 + (0x1000 * 32) + (3 * 4) = 0x2202.000C
```

With the alias address calculated, an instruction performing a read/write to address 0x2202.000C allows direct access to only bit 3 of the byte at address 0x2000.1000.

For details about bit-banding, please refer to Chapter 4, "Memory Map" in the *ARM*® *Cortex*™-*M3 Technical Reference Manual*.

8.2.2 Flash Memory

The flash is organized as a set of 1-KB blocks that can be individually erased. Erasing a block causes the entire contents of the block to be reset to all 1s. An individual 32-bit word can be programmed to change bits that are currently 1 to a 0. These blocks are paired into a set of 2-KB blocks that can be individually protected. The protection allows blocks to be marked as read-only or execute-only, providing different levels of code protection. Read-only blocks cannot be erased or programmed, protecting the contents of those blocks from being modified. Execute-only blocks cannot be erased or programmed, and can only be read by the controller instruction fetch mechanism, protecting the contents of those blocks from being read by either the controller or by a debugger.

8.2.2.1 Flash Memory Timing

The timing for the flash is automatically handled by the flash controller. However, in order to do so, it must know the clock rate of the system in order to time its internal signals properly. The number of clock cycles per microsecond must be provided to the flash controller for it to accomplish this timing. It is software's responsibility to keep the flash controller updated with this information via the **USec Reload (USECRL)** register.

On reset, the **USECRL** register is loaded with a value that configures the flash timing so that it works with the maximum clock rate of the part. If software changes the system operating frequency, the new operating frequency minus 1 (in MHz) must be loaded into **USECRL** before any flash modifications are attempted. For example, if the device is operating at a speed of 20 MHz, a value of 0x13 (20-1) must be written to the **USECRL** register.

8.2.2.2 Flash Memory Protection

The user is provided two forms of flash protection per 2-KB flash blocks infour pairs of 32-bit wide registers. The protection policy for each form is controlled by individual bits (per policy per block) in the **FMPPEn** and **FMPREn** registers.

- Flash Memory Protection Program Enable (FMPPEn): If set, the block may be programmed (written) or erased. If cleared, the block may not be changed.
- Flash Memory Protection Read Enable (FMPREn): If set, the block may be executed or read by software or debuggers. If cleared, the block may only be executed. The contents of the memory block are prohibited from being accessed as data and traversing the DCode bus.

The policies may be combined as shown in Table 8-1 on page 126.

Table 8-1. Flash Protection Policy Combinations

FMPPEn	FMPREn	Protection
0		Execute-only protection. The block may only be executed and may not be written or erased. This mode is used to protect code.
1	0	The block may be written, erased or executed, but not read. This combination is unlikely to be used.
0		Read-only protection. The block may be read or executed but may not be written or erased. This mode is used to lock the block from further modification while allowing any read or execute access.
1	1	No protection. The block may be written, erased, executed or read.

An access that attempts to program or erase a PE-protected block is prohibited. A controller interrupt may be optionally generated (by setting the AMASK bit in the **FIM** register) to alert software developers of poorly behaving software during the development and debug phases.

An access that attempts to read an RE-protected block is prohibited. Such accesses return data filled with all 0s. A controller interrupt may be optionally generated to alert software developers of poorly behaving software during the development and debug phases.

The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This implements a policy of open access and programmability. The register bits may be changed by writing the specific register bit. The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. Details on programming these bits are discussed in "Nonvolatile Register Programming" on page 127.

8.3 Flash Memory Initialization and Configuration

8.3.1 Flash Programming

The Stellaris[®] devices provide a user-friendly interface for flash programming. All erase/program operations are handled via three registers: **FMA**, **FMD**, and **FMC**.

8.3.1.1 To program a 32-bit word:

- Write source data to the FMD register.
- Write the target address to the FMA register.
- Write the flash write key and the WRITE bit (a value of 0xA442.0001) to the FMC register.
- 4. Poll the **FMC** register until the WRITE bit is cleared.

8.3.1.2 To perform an erase of a 1-KB page:

- 1. Write the page address to the **FMA** register.
- 2. Write the flash write key and the ERASE bit (a value of 0xA442.0002) to the **FMC** register.
- 3. Poll the FMC register until the ERASE bit is cleared.

8.3.1.3 To perform a mass erase of the flash:

- 1. Write the flash write key and the MERASE bit (a value of 0xA442.0004) to the FMC register.
- 2. Poll the FMC register until the MERASE bit is cleared.

8.3.2 Nonvolatile Register Programming

This section discusses how to update registers that are resident within the flash memory itself. These registers exist in a separate space from the main flash array and are not affected by an ERASE or MASS ERASE operation. These nonvolatile registers are updated by using the COMT bit in the **FMC** register to activate a write operation. For the **USER_DBG** register, the data to be written must be loaded into the **FMD** register before it is "committed". All other registers are R/W and can have their operation tried before committing them to nonvolatile memory.

Important: These register can only have bits changed from 1 to 0 by the user and there is no mechanism for the user to erase them back to a 1 value.

In addition, the **USER_REG0**, **USER_REG1**, and **USER_DBG** use bit 31 (NOTWRITTEN) of their respective registers to indicate that they are available for user write. These three registers can only be written once whereas the flash protection registers may be written multiple times. Table 8-2 on page 127 provides the FMA address required for commitment of each of the registers and the source of the data to be written when the COMT bit of the **FMC** register is written with a value of 0xA442.0008. After writing the COMT bit, the user may poll the **FMC** register to wait for the commit operation to complete.

Table 8-2. Flash Resident Registers^a

Register to be Committed	FMA Value	Data Source
FMPRE0	0x0000.0000	FMPRE0
FMPRE1	0x0000.0002	FMPRE1
FMPRE2	0x0000.0004	FMPRE2
FMPRE3	0x0000.0008	FMPRE3
FMPPE0	0x0000.0001	FMPPE0
FMPPE1	0x0000.0003	FMPPE1
FMPPE2	0x0000.0005	FMPPE2
FMPPE3	0x0000.0007	FMPPE3
USER_REG0	0x8000.0000	USER_REG0
USER_REG1	0x8000.0001	USER_REG1
USER_DBG	0x7510.0000	FMD

a. Which **FMPREn** and **FMPPEn** registers are available depend on the flash size of your particular Stellaris[®] device.

8.4 Register Map

Table 8-3 on page 127 lists the Flash memory and control registers. The offset listed is a hexadecimal increment to the register's address. The **FMA**, **FMD**, **FMC**, **FCRIS**, **FCIM**, and **FCMISC** registers are relative to the Flash control base address of 0x400F.D000. The **FMPREn**, **FMPPEn**, **USECRL**, **USER_DBG**, and **USER_REGn** registers are relative to the System Control base address of 0x400F.E000.

Note: A BV in the Reset column indicates the reset is a Build Value and part-specific. See the page number referenced for the reset value description.

Table 8-3. Internal Memory Register Map

Off	fset	Name	Type	Reset	Description	See page
Flash Control Offset						

Offset	Name	Туре	Reset	Description	See page
0x000	FMA	R/W	0x0000.0000	Flash Memory Address	129
0x004	FMD	R/W	0x0000.0000	Flash Memory Data	130
0x008	FMC	R/W	0x0000.0000	Flash Memory Control	131
0x00C	FCRIS	RO	0x0000.0000	Flash Controller Raw Interrupt Status	133
0x010	FCIM	R/W	0x0000.0000	Flash Controller Interrupt Mask	134
0x014	FCMISC	R/W1C	0x0000.0000	Flash Controller Masked Interrupt Status and Clear	135
System C	ontrol Offset			<u> </u>	
0x130	FMPRE0	R/W	BV	Flash Memory Protection Read Enable 0	137
0x200	FMPRE0	R/W	BV	Flash Memory Protection Read Enable 0	137
0x134	FMPPE0	R/W	BV	Flash Memory Protection Program Enable 0	138
0x400	FMPPE0	R/W	BV	Flash Memory Protection Program Enable 0	138
0x140	USECRL	R/W	0x31	USec Reload	136
0x1D0	USER_DBG	R/W	0xFFFF.FFFE	User Debug	139
0x1E0	USER_REG0	R/W	0x8FFF.FFFF	User Register 0	140
0x1E4	USER_REG1	R/W	0x8FFF.FFFF	User Register 1	141
0x204	FMPRE1	R/W	0xFFFF.FFFF	Flash Memory Protection Read Enable 1	142
0x208	FMPRE2	R/W	0xFFFF.FFFF	Flash Memory Protection Read Enable 2	143
0x20C	FMPRE3	R/W	0xFFFF.FFFF	Flash Memory Protection Read Enable 3	144
0x404	FMPPE1	R/W	0xFFFF.FFFF	Flash Memory Protection Program Enable 1	145
0x408	FMPPE2	R/W	0xFFFF.FFFF	Flash Memory Protection Program Enable 2	146
0x40C	FMPPE3	R/W	0xFFFF.FFFF	Flash Memory Protection Program Enable 3	147

8.5 Flash Register Descriptions (Flash Control Offset)

The remainder of this section lists and describes the Flash Memory registers, in numerical order by address offset.

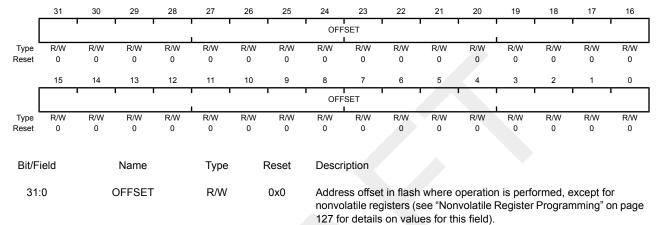
Register 1: Flash Memory Address (FMA), offset 0x000

During a write operation, this register contains a 4-byte-aligned address and specifies where the data is written. During erase operations, this register contains a 1 KB-aligned address and specifies which page is erased. Note that the alignment requirements must be met by software or the results of the operation are unpredictable.

Flash Memory Address (FMA)

Base 0x400F.D000

Offset 0x000 Type R/W, reset 0x0000.0000



Register 2: Flash Memory Data (FMD), offset 0x004

This register contains the data to be written during the programming cycle or read during the read cycle. Note that the contents of this register are undefined for a read access of an execute-only block. This register is not used during the erase cycles.

Flash Memory Data (FMD)

Base 0x400F.D000

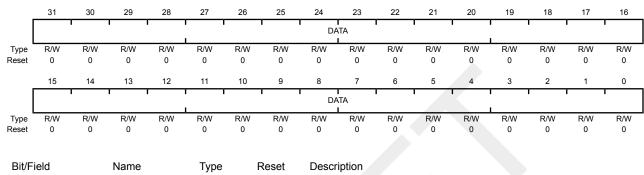
31:0

DATA

R/W

0x0

Offset 0x004 Type R/W, reset 0x0000.0000



Data value for write operation.

Register 3: Flash Memory Control (FMC), offset 0x008

When this register is written, the flash controller initiates the appropriate access cycle for the location specified by the **Flash Memory Address (FMA)** register (see page 129). If the access is a write access, the data contained in the **Flash Memory Data (FMD)** register (see page 130) is written.

This is the final register written and initiates the memory operation. There are four control bits in the lower byte of this register that, when set, initiate the memory operation. The most used of these register bits are the ERASE and WRITE bits.

It is a programming error to write multiple control bits and the results of such an operation are unpredictable.

Flash Memory Control (FMC)

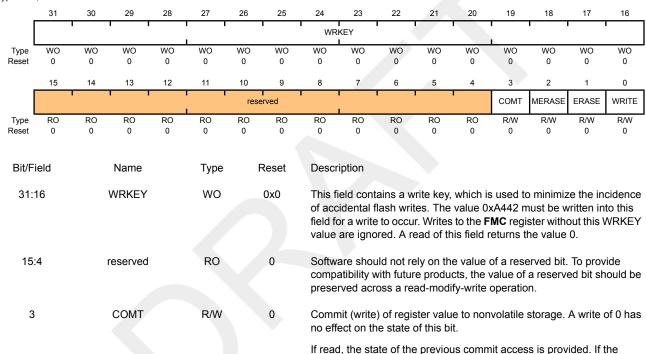
Base 0x400F.D000 Offset 0x008

2

MERASE

R/W

Type R/W, reset 0x0000.0000



This can take up to 50 µs.

commit access is not complete, a 1 is returned.

0 Mass erase flash memory.

If this bit is set, the flash main memory of the device is all erased. A write of 0 has no effect on the state of this bit.

previous commit access is complete, a 0 is returned; otherwise, if the

If read, the state of the previous mass erase access is provided. If the previous mass erase access is complete, a 0 is returned; otherwise, if the previous mass erase access is not complete, a 1 is returned.

This can take up to 250 ms.

Bit/Field	Name	Туре	Reset	Description
1	ERASE	R/W	0	Erase a page of flash memory.
				If this bit is set, the page of flash main memory as specified by the contents of FMA is erased. A write of 0 has no effect on the state of this bit.
				If read, the state of the previous erase access is provided. If the previous erase access is complete, a 0 is returned; otherwise, if the previous erase access is not complete, a 1 is returned.
				This can take up to 25 ms.
0	WRITE	R/W	0	Write a word into flash memory.
				If this bit is set, the data stored in FMD is written into the location as specified by the contents of FMA . A write of 0 has no effect on the state of this bit.
				If read, the state of the previous write update is provided. If the previous write access is complete, a 0 is returned; otherwise, if the write access is not complete, a 1 is returned.
				This can take up to 50 μs.

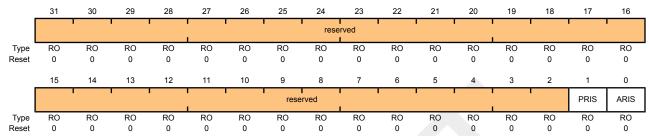
Register 4: Flash Controller Raw Interrupt Status (FCRIS), offset 0x00C

This register indicates that the flash controller has an interrupt condition. An interrupt is only signaled if the corresponding **FCIM** register bit is set.

Flash Controller Raw Interrupt Status (FCRIS)

Base 0x400F.D000

Offset 0x00C Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	PRIS	RO	0	Programming Raw Interrupt Status
				This bit indicates the current state of the programming cycle. If set, the programming cycle completed; if cleared, the programming cycle has not completed. Programming cycles are either write or erase actions generated through the Flash Memory Control (FMC) register bits (see page 131).
0	ARIS	RO	0	Access Raw Interrupt Status

This bit indicates if the flash was improperly accessed. If set, the program tried to access the flash counter to the policy as set in the Flash Memory Protection Read Enable (FMPREn) and Flash Memory Protection Program Enable (FMPPEn) registers. Otherwise, no access has tried to improperly access the flash.

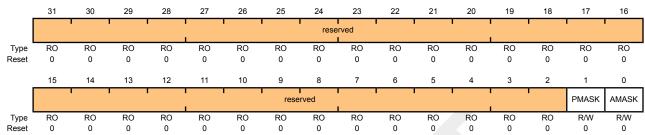
Register 5: Flash Controller Interrupt Mask (FCIM), offset 0x010

This register controls whether the flash controller generates interrupts to the controller.

Flash Controller Interrupt Mask (FCIM)

Base 0x400F.D000 Offset 0x010

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	PMASK	R/W	0	Programming Interrupt Mask
				This bit controls the reporting of the programming raw interrupt status to the controller. If set, a programming-generated interrupt is promoted to the controller. Otherwise, interrupts are recorded but suppressed from the controller.
0	AMASK	R/W	0	Access Interrupt Mask

This bit controls the reporting of the access raw interrupt status to the controller. If set, an access-generated interrupt is promoted to the controller. Otherwise, interrupts are recorded but suppressed from the controller.

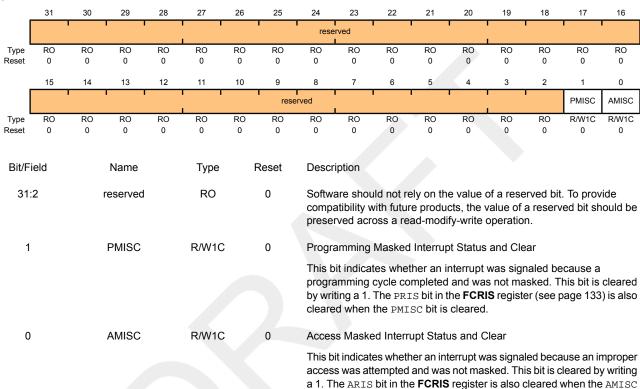
Register 6: Flash Controller Masked Interrupt Status and Clear (FCMISC), offset 0x014

This register provides two functions. First, it reports the cause of an interrupt by indicating which interrupt source or sources are signalling the interrupt. Second, it serves as the method to clear the interrupt reporting.

Flash Controller Masked Interrupt Status and Clear (FCMISC)

Base 0x400F.D000

Offset 0x014
Type R/W1C, reset 0x0000.0000



Flash Register Descriptions (System Control Offset) 8.6

The remainder of this section lists and describes the Flash Memory registers, in numerical order by address offset.

bit is cleared.

Register 7: USec Reload (USECRL), offset 0x140

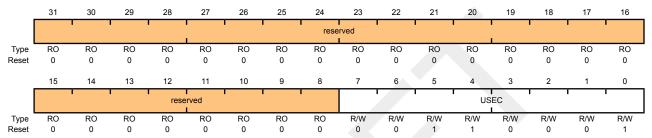
Note: Offset is relative to System Control base address of 0x400F.E000

This register is provided as a means of creating a 1-µs tick divider reload value for the flash controller. The internal flash has specific minimum and maximum requirements on the length of time the high voltage write pulse can be applied. It is required that this register contain the operating frequency (in MHz -1) whenever the flash is being erased or programmed. The user is required to change this value if the clocking conditions are changed for a flash erase/program operation.

USec Reload (USECRL)

Base 0x400F.E000 Offset 0x140 Type R/W, reset 0x31

D:4/E: -1-4



Bit/Field	Name	туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	USEC	R/W	0x31	MHz -1 of the controller clock when the flash is being erased or

programmed.

USEC should be set to 0x31 (50 MHz) whenever the flash is being erased or programmed.

Register 8: Flash Memory Protection Read Enable 0 (FMPRE0), offset 0x130 and 0x200

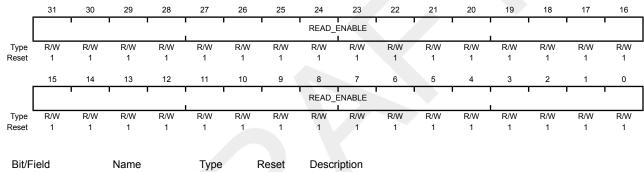
Note: This register is aliased for backwards compatability.

Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the read-only protection bits for each 2-KB flash block (**FMPPEn** stores the execute-only bits). This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. For additional information, see the "Flash Memory Protection" section.

Flash Memory Protection Read Enable 0 (FMPRE0)

Base 0x400F.D000 Offset 0x130 and 0x200 Type R/W, reset 0xFFFF.FFFF



31:0 READ_ENABLE R/W 0xFFFFFFF Enables 2-KB flash blocks to be executed or read. The policies may be combined as shown in the table "Flash Protection Policy Combinations".

Value Description

0xFFFFFFF Enables 256 KB of flash.

Register 9: Flash Memory Protection Program Enable 0 (FMPPE0), offset 0x134 and 0x400

This register is aliased for backwards compatability.

Offset is relative to System Control base address of 0x400FE000.

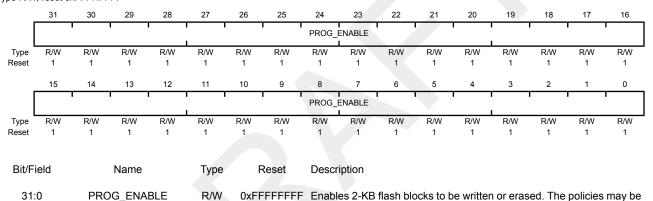
This register stores the execute-only protection bits for each 2-KB flash block (FMPREn stores the execute-only bits). This register is loaded during the power-on reset sequence. The factory settings for the FMPREn and FMPPEn registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. For additional information, see the "Flash Memory Protection" section.

Flash Memory Protection Program Enable 0 (FMPPE0)

R/W

0xFFFFFFF

Base 0x400F.D000 Offset 0x134 and 0x400 Type R/W, reset 0xFFF.FFFF



Value Description

0xFFFFFFF Enables 256 KB of flash.

combined as shown in the table "Flash Protection Policy Combinations".

Register 10: User Debug (USER DBG), offset 0x1D0

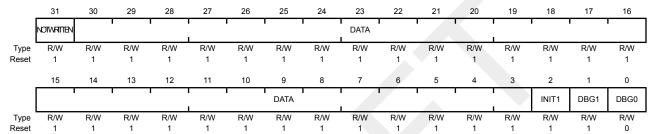
Note: Offset is relative to System Control base address of 0x400FE000.

This register provides a write-once mechanism to disable external debugger access to the device in addition to 27 additional bits of user-defined data. The DBG0 bit (bit 0) is set to 0 from the factory and the DBG1 bit (bit 1) is set to 1, which enables external debuggers. Changing the DBG1 bit to 0 disables any external debugger access to the device permanently, starting with the next power-up cycle of the device. The NOTWRITTEN bit (bit 31) indicates that the register is available to be written and is controlled through hardware to ensure that the register is only written once.

User Debug (USER DBG)

Base 0x400F.E000 Offset 0x1D0

Type R/W, reset 0xFFFF.FFFE



Bit/Field	Name	Type	Reset	Description
31	NOTWRITTEN	R/W	1	Specifies that this 32-bit dword has not been written.
30:3	DATA	R/W	0xFFFFFFF	Contains the user data value. This field is initialized to all 1s and can only be written once.
2	INIT1	R/W	1	User data initialized to 1.
1	DBG1	R/W	1	The DBG1 bit must be 1 and DBG0 must be 0 for debug to be available.
0	DBG0	R/W	0	The $\mathtt{DBG1}$ bit must be 1 and $\mathtt{DBG0}$ must be 0 for debug to be available.

Register 11: User Register 0 (USER_REG0), offset 0x1E0

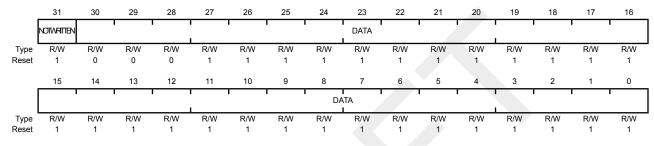
Note: Offset is relative to System Control base address of 0x400FE000.

This register provides 31 bits of user-defined data that is non-volatile and can only be written once. Bit 31 indicates that the register is available to be written and is controlled through hardware to ensure that the register is only written once. The write-once characteristics of this register are useful for keeping static information like communication addresses that need to be unique per part and would otherwise require an external EEPROM or other non-volatile device.

User Register 0 (USER_REG0)

Base 0x400F.E000 Offset 0x1E0

Type R/W, reset 0x8FFF.FFFF



Bit/Field	Name	Туре	Reset	Description
31	NOTWRITTEN	R/W	1	Specifies that this 32-bit dword has not been written.
30:0	DATA	R/W	0xFFFFFF	Contains the user data value. This field is initialized to all 1s and can only be written once.

Register 12: User Register 1 (USER_REG1), offset 0x1E4

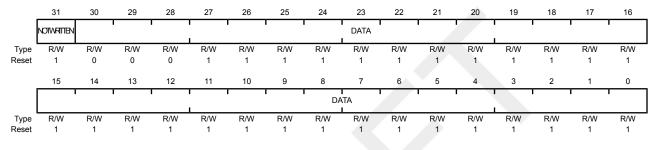
Note: Offset is relative to System Control base address of 0x400FE000.

This register provides 31 bits of user-defined data that is non-volatile and can only be written once. Bit 31 indicates that the register is available to be written and is controlled through hardware to ensure that the register is only written once. The write-once characteristics of this register are useful for keeping static information like communication addresses that need to be unique per part and would otherwise require an external EEPROM or other non-volatile device.

User Register 1 (USER_REG1)

Base 0x400F.E000 Offset 0x1E4

Type R/W, reset 0x8FFF.FFFF



Bit/Field	Name	Type	Reset	Description
31	NOTWRITTEN	R/W	1	Specifies that this 32-bit dword has not been written.
30:0	DATA	R/W	0xFFFFFF	Contains the user data value. This field is initialized to all 1s and can only be written once.

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Register 13: Flash Memory Protection Read Enable 1 (FMPRE1), offset 0x204

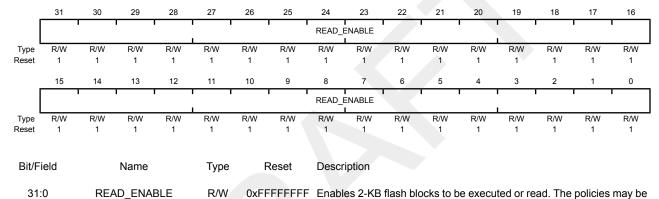
Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the read-only protection bits for each 2-KB flash block (**FMPPEn** stores the execute-only bits). This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. For additional information, see the "Flash Memory Protection" section.

Flash Memory Protection Read Enable 1 (FMPRE1)

Base 0x400F.E000 Offset 0x204

Type R/W, reset 0xFFFF.FFFF



Value Description

0xFFFFFFF Enables 256 KB of flash.

combined as shown in the table "Flash Protection Policy Combinations".

Register 14: Flash Memory Protection Read Enable 2 (FMPRE2), offset 0x208

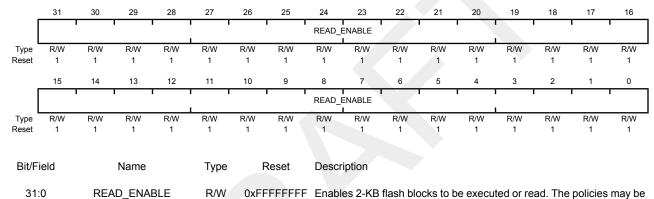
Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the read-only protection bits for each 2-KB flash block (**FMPPEn** stores the execute-only bits). This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. For additional information, see the "Flash Memory Protection" section.

Flash Memory Protection Read Enable 2 (FMPRE2)

Base 0x400F.E000 Offset 0x208

Type R/W, reset 0xFFFF.FFFF



Value Description

0xFFFFFFF Enables 256 KB of flash.

combined as shown in the table "Flash Protection Policy Combinations".

Register 15: Flash Memory Protection Read Enable 3 (FMPRE3), offset 0x20C

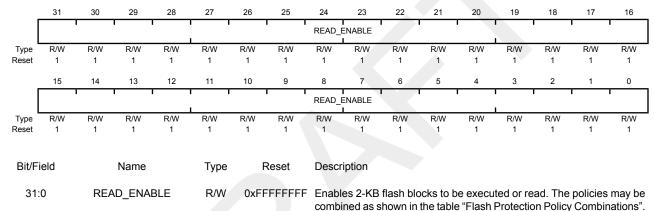
Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the read-only protection bits for each 2-KB flash block (**FMPPEn** stores the execute-only bits). This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. For additional information, see the "Flash Memory Protection" section.

Flash Memory Protection Read Enable 3 (FMPRE3)

Base 0x400F.E000 Offset 0x20C

Type R/W, reset 0xFFFF.FFFF



Value Description

0xFFFFFFF Enables 256 KB of flash.

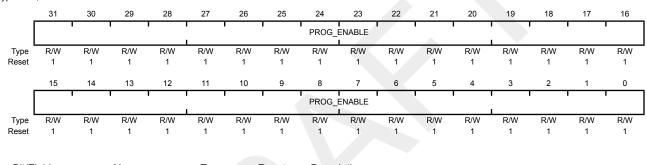
Register 16: Flash Memory Protection Program Enable 1 (FMPPE1), offset 0x404

Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the execute-only protection bits for each 2-KB flash block (**FMPREn** stores the execute-only bits). This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. For additional information, see the "Flash Memory Protection" section.

Flash Memory Protection Program Enable 1 (FMPPE1)

Base 0x400F.E000 Offset 0x404 Type R/W, reset 0xFFFF.FFFF



Bit/Field Name Type Reset Description

31:0 PROG_ENABLE R/W 0xFFFFFFF Enables 2-KB flash blocks to be written or erased. The policies may be combined as shown in the table "Flash Protection Policy Combinations".

Value Description

0xFFFFFFF Enables 256 KB of flash.

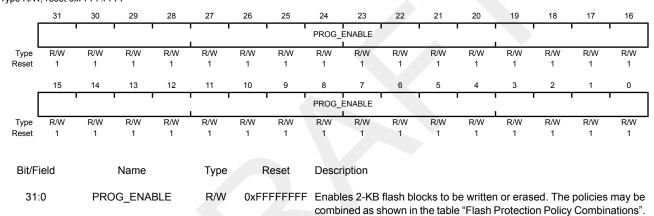
Register 17: Flash Memory Protection Program Enable 2 (FMPPE2), offset 0x408

Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the execute-only protection bits for each 2-KB flash block (**FMPREn** stores the execute-only bits). This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. For additional information, see the "Flash Memory Protection" section.

Flash Memory Protection Program Enable 2 (FMPPE2)

Base 0x400F.E000 Offset 0x408 Type R/W, reset 0xFFFF.FFFF



Value Description

0xFFFFFFF Enables 256 KB of flash.

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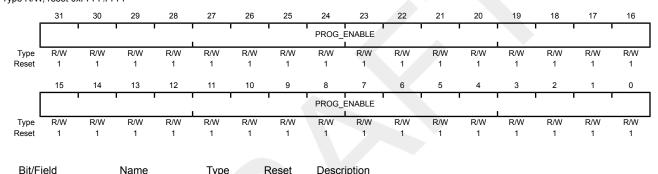
Register 18: Flash Memory Protection Program Enable 3 (FMPPE3), offset 0x40C

Note: Offset is relative to System Control base address of 0x400FE000.

This register stores the execute-only protection bits for each 2-KB flash block (**FMPREn** stores the execute-only bits). This register is loaded during the power-on reset sequence. The factory settings for the **FMPREn** and **FMPPEn** registers are a value of 1 for all implemented banks. This achieves a policy of open access and programmability. The register bits may be changed by writing the specific register bit. However, this register is R/W0; the user can only change the protection bit from a 1 to a 0 (and may NOT change a 0 to a 1). The changes are not permanent until the register is committed (saved), at which point the bit change is permanent. If a bit is changed from a 1 to a 0 and not committed, it may be restored by executing a power-on reset sequence. For additional information, see the "Flash Memory Protection" section.

Flash Memory Protection Program Enable 3 (FMPPE3)

Base 0x400F.E000 Offset 0x40C Type R/W, reset 0xFFFF.FFFF



31:0 PROG_ENABLE R/W 0xFFFFFFF Enables 2-KB flash blocks to be written or erased. The policies may be combined as shown in the table "Flash Protection Policy Combinations".

Value Description
0xFFFFFFF Enables 256 KB of flash.

9 General-Purpose Input/Outputs (GPIOs)

GPIO

The GPIO module is composed of eight physical GPIO blocks, each corresponding to an individual GPIO port (Port A, Port B, Port C, Port D, Port E, Port F, Port G, and Port H). The GPIO module is FiRM-compliant and supports 21-52 programmable input/output pins, depending on the peripherals being used.

The GPIO module has the following features:

- Programmable control for GPIO interrupts
 - Interrupt generation masking
 - Edge-triggered on rising, falling, or both
 - Level-sensitive on High or Low values
- 5-V-tolerant input/outputs
- Bit masking in both read and write operations through address lines
- Programmable control for GPIO pad configuration
 - Weak pull-up or pull-down resistors
 - 2-mA, 4-mA, and 8-mA pad drive
 - Slew rate control for the 8-mA drive
 - Open drain enables
 - Digital input enables

9.1 Function Description

Important: All GPIO pins are tri-stated by default (GPIOAFSEL=0, GPIODEN=0, GPIOPDR=0, and GPIOPUR=0), with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). The JTAG/SWD pins default to their JTAG/SWD functionality (GPIOAFSEL=1, GPIODEN=1 and GPIOPUR=1). A Power-On-Reset (POR) or asserting RST puts both groups of pins back to their default state.

Each GPIO port is a separate hardware instantiation of the same physical block. The LM3S1958 microcontroller contains eight ports and thus eight of these physical GPIO blocks.

9.1.1 Data Control

The data control registers allow software to configure the operational modes of the GPIOs. The data direction register configures the GPIO as an input or an output while the data register either captures incoming data or drives it out to the pads.

9.1.1.1 Data Direction Operation

The **GPIO Direction (GPIODIR)** register (see page 156) is used to configure each individual pin as an input or output. When the data direction bit is set to 0, the GPIO is configured as an input and

the corresponding data register bit will capture and store the value on the GPIO port. When the data direction bit is set to 1, the GPIO is configured as an output and the corresponding data register bit will be driven out on the GPIO port.

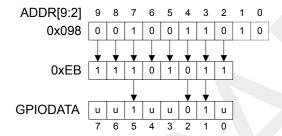
9.1.1.2 Data Register Operation

To aid in the efficiency of software, the GPIO ports allow for the modification of individual bits in the **GPIO Data (GPIODATA)** register (see page 155) by using bits [9:2] of the address bus as a mask. This allows software drivers to modify individual GPIO pins in a single instruction, without affecting the state of the other pins. This is in contrast to the "typical" method of doing a read-modify-write operation to set or clear an individual GPIO pin. To accommodate this feature, the **GPIODATA** register covers 256 locations in the memory map.

During a write, if the address bit associated with that data bit is set to 1, the value of the **GPIODATA** register is altered. If it is cleared to 0, it is left unchanged.

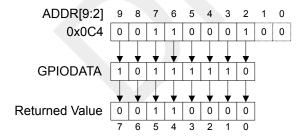
For example, writing a value of 0xEB to the address GPIODATA + 0x098 would yield as shown in Figure 9-1 on page 149, where u is data unchanged by the write.

Figure 9-1. GPIODATA Write Example



During a read, if the address bit associated with the data bit is set to 1, the value is read. If the address bit associated with the data bit is set to 0, it is read as a zero, regardless of its actual value. For example, reading address GPIODATA + 0x0C4 yields as shown in Figure 9-2 on page 149.

Figure 9-2. GPIODATA Read Example



9.1.2 Interrupt Control

The interrupt capabilities of each GPIO port are controlled by a set of seven registers. With these registers, it is possible to select the source of the interrupt, its polarity, and the edge properties. When one or more GPIO inputs cause an interrupt, a single interrupt output is sent to the interrupt controller for the entire GPIO port. For edge-triggered interrupts, software must clear the interrupt to enable any further interrupts. For a level-sensitive interrupt, it is assumed that the external source holds the level constant for the interrupt to be recognized by the controller.

Three registers are required to define the edge or sense that causes interrupts:

- GPIO Interrupt Sense (GPIOIS) register (see page 157)
- GPIO Interrupt Both Edges (GPIOIBE) register (see page 158)
- GPIO Interrupt Event (GPIOIEV) register (see page 159)

Interrupts are enabled/disabled via the GPIO Interrupt Mask (GPIOIM) register (see page 160).

When an interrupt condition occurs, the state of the interrupt signal can be viewed in two locations: the **GPIO Raw Interrupt Status (GPIORIS)** and **GPIO Masked Interrupt Status (GPIOMIS)** registers (see page 161 and page 162). As the name implies, the **GPIOMIS** register only shows interrupt conditions that are allowed to be passed to the controller. The **GPIORIS** register indicates that a GPIO pin meets the conditions for an interrupt, but has not necessarily been sent to the controller.

In addition to providing GPIO functionality, PB4 can also be used as an external trigger for the ADC. If PB4 is configured as a non-masked interrupt pin (GPIOIM is set to 1), not only is an interrupt for PortB generated, but an external trigger signal is sent to the ADC. If the **ADC Event Multiplexer Select (ADCEMUX)** register is configured to use the external trigger, an ADC conversion is initiated.

If no other PortB pins are being used to generate interrupts, the ARM Integrated Nested Vectored Interrupt Controller (NVIC) Interrupt Set Enable (SETNA) register can disable the PortB interrupts and the ADC interrupt can be used to read back the converted data. Otherwise, the PortB interrupt handler needs to ignore and clear interrupts on B4, and wait for the ADC interrupt or the ADC interrupt needs to be disabled in the SETNA register and the PortB interrupt handler polls the ADC registers until the conversion is completed.

Interrupts are cleared by writing a 1 to the GPIO Interrupt Clear (GPIOICR) register (see page 163).

When programming the following interrupt control registers, the interrupts should be masked (**GPIOIM** set to 0). Writing any value to an interrupt control register (**GPIOIS**, **GPIOIBE**, or **GPIOIEV**) can generate a spurious interrupt if the corresponding bits are enabled.

9.1.3 Mode Control

The GPIO pins can be controlled by either hardware or software. When hardware control is enabled via the **GPIO Alternate Function Select (GPIOAFSEL)** register (see page 164), the pin state is controlled by its alternate function (that is, the peripheral). Software control corresponds to GPIO mode, where the **GPIODATA** register is used to read/write the corresponding pins.

9.1.4 Commit Control

The commit control registers provide a layer of protection against accidental programming of critical hardware peripherals. Writes to protected bits of the **GPIO Alternate Function Select (GPIOAFSEL)** register (see page 164) are not committed to storage unless the **GPIO Lock (GPIOLOCK)** register (see page 174) has been unlocked and the appropriate bits of the **GPIO Commit (GPIOCR)** register (see page 175) have been set to 1.

9.1.5 Pad Control

The pad control registers allow for GPIO pad configuration by software based on the application requirements. The pad control registers include the GPIODR2R, GPIODR4R, GPIODR8R, GPIODDR, GPIOPUR, GPIOPDR, GPIOPDR, and GPIODEN registers.

9.1.6 Identification

The identification registers configured at reset allow software to detect and identify the module as a GPIO block. The identification registers include the **GPIOPeriphID0-GPIOPeriphID7** registers as well as the **GPIOPCeIIID0-GPIOPCeIIID3** registers.

9.2 Initialization and Configuration

To use the GPIO, the peripheral clock must be enabled by setting the appropriate GPIO Port bit field (GPIOn) in the **RCGC2** register.

On reset, all GPIO pins (except for the five JTAG pins) are configured out of reset to be undriven (tristate): **GPIOAFSEL**=0, **GPIODEN**=0, **GPIOPDR**=0, and **GPIOPUR**=0. Table 9-1 on page 151 shows all possible configurations of the GPIO pads and the control register settings required to achieve them. Table 9-2 on page 151 shows how a rising edge interrupt would be configured for pin 2 of a GPIO port.

Table 9-1. GPIO Pad Configuration Examples

Configuration	GPIO Reg	GPIO Register Bit Value ^a											
	AFSEL	DIR	ODR	DEN	PUR	PDR	DR2R	DR4R	DR8R	SLR			
Digital Input (GPIO)	0	0	0	1	?	?	Х	Х	Х	Х			
Digital Output (GPIO)	0	1	0	1	?	?	?	?	?	?			
Open Drain Input (GPIO)	0	0	1	1	Х	Х	Х	Х	Х	Х			
Open Drain Output (GPIO)	0	1	1	1	Х	Х	?	?	?	?			
Open Drain Input/Output (I ² C)	1	Х	1	1	Х	Х	?	?	?	?			
Digital Input (Timer CCP)	1	Х	0	1	?	?	Х	Х	Х	Х			
Digital Output (Timer PWM)	1	Х	0	1	?	?	?	?	?	?			
Digital Input/Output (SSI)	1	Х	0	1	?	?	?	?	?	?			
Digital Input/Output (UART)	1	Х	0	1	?	?	?	?	?	?			

a. X=Ignored (don't care bit)

Table 9-2. GPIO Interrupt Configuration Example

Register Desired Interrupt Event Trigger		Pin 2 Bit Value ^a									
	Event	7	6	5	4	3	2	1	0		
GPIOIS	0=edge 1=level	Х	Х	Х	Х	Х	0	Х	Х		
GPIOIBE	0=single edge 1=both edges	X	X	X	Х	Х	0	Х	Х		

^{?=}Can be either 0 or 1, depending on the configuration

Register	Desired Interrupt Event Trigger	Pin 2 Bit Val	Pin 2 Bit Value ^a									
		7	6	5	4	3	2	1	0			
GPIOIEV	0=Low level, or negative edge 1=High level, or positive edge		Х	Х	Х	X	1	Х	Х			
GPIOIM	0=masked 1=not masked	0	0	0	0	0	1	0	0			

a. X=Ignored (don't care bit)

9.3 Register Map

Table 9-3 on page 153 lists the GPIO registers. The offset listed is a hexadecimal increment to the register's address, relative to that GPIO port's base address:

GPIO Port A: 0x4000.4000

GPIO Port B: 0x4000.5000

GPIO Port C: 0x4000.6000

GPIO Port D: 0x4000.7000

GPIO Port E: 0x4002.4000

GPIO Port F: 0x4002.5000

GPIO Port G: 0x4002.6000

GPIO Port H: 0x4002.7000

Important: The GPIO registers in this chapter are duplicated in each GPIO block, however, depending on the block, all eight bits may not be connected to a GPIO pad. In those cases, writing to those unconnected bits has no effect and reading those unconnected bits returns no meaningful data.

Note: The default reset value for the **GPIOAFSEL**, **GPIOPUR**, and **GPIODEN** registers are 0x0000.0000 for all GPIO pins, with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). These five pins default to JTAG/SWD functionality. Because of this, the default reset value of these registers for GPIO Port B is 0x0000.0080 while the default reset value for Port C is 0x0000.000F.

The default register type for the **GPIOCR** register is RO for all GPIO pins, with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). These five pins are currently the only GPIOs that are protected by the **GPIOCR** register. Because of this, the register type for GPIO Port B7 and GPIO Port C[3:0] is R/W.

The default reset value for the **GPIOCR** register is 0x0000.00FF for all GPIO pins, with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). To ensure that the JTAG port is not accidentally programmed as a GPIO, these five pins default to non-commitable.

Because of this, the default reset value of **GPIOCR** for GPIO Port B is 0x0000.007F while the default reset value of **GPIOCR** for Port C is 0x0000.00F0.

Table 9-3. GPIO Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	GPIODATA	R/W	0x0000.0000	GPIO Data	155
0x400	GPIODIR	R/W	0x0000.0000	GPIO Direction	156
0x404	GPIOIS	R/W	0x0000.0000	GPIO Interrupt Sense	157
0x408	GPIOIBE	R/W	0x0000.0000	GPIO Interrupt Both Edges	158
0x40C	GPIOIEV	R/W	0x0000.0000	GPIO Interrupt Event	159
0x410	GPIOIM	R/W	0x0000.0000	GPIO Interrupt Mask	160
0x414	GPIORIS	RO	0x0000.0000	GPIO Raw Interrupt Status	161
0x418	GPIOMIS	RO	0x0000.0000	GPIO Masked Interrupt Status	162
0x41C	GPIOICR	W1C	0x0000.0000	GPIO Interrupt Clear	163
0x420	GPIOAFSEL	R/W	-	GPIO Alternate Function Select	164
0x500	GPIODR2R	R/W	0x0000.00FF	GPIO 2-mA Drive Select	166
0x504	GPIODR4R	R/W	0x0000.0000	GPIO 4-mA Drive Select	167
0x508	GPIODR8R	R/W	0x0000.0000	GPIO 8-mA Drive Select	168
0x50C	GPIOODR	R/W	0x0000.0000	GPIO Open Drain Select	169
0x510	GPIOPUR	R/W		GPIO Pull-Up Select	170
0x514	GPIOPDR	R/W	0x0000.0000	GPIO Pull-Down Select	171
0x518	GPIOSLR	R/W	0x0000.0000	GPIO Slew Rate Control Select	172
0x51C	GPIODEN	R/W	-	GPIO Digital Enable	173
0x520	GPIOLOCK	R/W	0x0000.0001	GPIO Lock	174
0x524	GPIOCR	-	-	GPIO Commit	175
0xFD0	GPIOPeriphID4	RO	0x0x0000.0000	GPIO Peripheral Identification 4	177
0xFD4	GPIOPeriphID5	RO	0x0x0000.0000	GPIO Peripheral Identification 5	178
0xFD8	GPIOPeriphID6	RO	0x0x0000.0000	GPIO Peripheral Identification 6	179
0xFDC	GPIOPeriphID7	RO	0x0x0000.0000	GPIO Peripheral Identification 7	180
0xFE0	GPIOPeriphID0	RO	0x0x0000.0061	GPIO Peripheral Identification 0	181
0xFE4	GPIOPeriphID1	RO	0x0x0000.0000	GPIO Peripheral Identification 1	182
0xFE8	GPIOPeriphID2	RO	0x0x0000.0018	GPIO Peripheral Identification 2	183
0xFEC	GPIOPeriphID3	RO	0x0x0000.0001	GPIO Peripheral Identification 3	184
0xFF0	GPIOPCellID0	RO	0x0x0000.000D	GPIO PrimeCell Identification 0	185
0xFF4	GPIOPCellID1	RO	0x0x0000.00F0	GPIO PrimeCell Identification 1	186

Offset	Name	Туре	Reset	Description	See page
0xFF8	GPIOPCellID2	RO	0x0x0000.0005	GPIO PrimeCell Identification 2	187
0xFFC	GPIOPCellID3	RO	0x0x0000.00B1	GPIO PrimeCell Identification 3	188

9.4 Register Descriptions

The remainder of this section lists and describes the GPIO registers, in numerical order by address offset.

Register 1: GPIO Data (GPIODATA), offset 0x000

The **GPIODATA** register is the data register. In software control mode, values written in the **GPIODATA** register are transferred onto the GPIO port pins if the respective pins have been configured as outputs through the **GPIO Direction (GPIODIR)** register (see page 156).

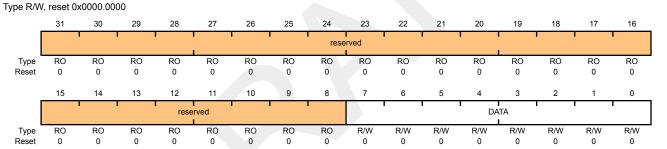
In order to write to **GPIODATA**, the corresponding bits in the mask, resulting from the address bus bits [9:2], must be High. Otherwise, the bit values remain unchanged by the write.

Similarly, the values read from this register are determined for each bit by the mask bit derived from the address used to access the data register, bits [9:2]. Bits that are 1 in the address mask cause the corresponding bits in **GPIODATA** to be read, and bits that are 0 in the address mask cause the corresponding bits in **GPIODATA** to be read as 0, regardless of their value.

A read from **GPIODATA** returns the last bit value written if the respective pins are configured as outputs, or it returns the value on the corresponding input pin when these are configured as inputs. All bits are cleared by a reset.

GPIO Data (GPIODATA)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DATA	DAM	0	CDIO Dete

This register is virtually mapped to 256 locations in the address space. To facilitate the reading and writing of data to these registers by independent drivers, the data read from and the data written to the registers are masked by the eight address lines <code>ipaddr[9:2]</code>. Reads from this register return its current state. Writes to this register only affect bits that are not masked by <code>ipaddr[9:2]</code> and are configured as outputs. See "Data Register Operation" on page 149 for examples of reads and writes.

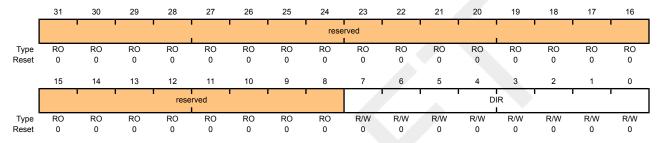
Register 2: GPIO Direction (GPIODIR), offset 0x400

The **GPIODIR** register is the data direction register. Bits set to 1 in the **GPIODIR** register configure the corresponding pin to be an output, while bits set to 0 configure the pins to be inputs. All bits are cleared by a reset, meaning all GPIO pins are inputs by default.

GPIO Direction (GPIODIR)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x400

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DIR	R/W	0×00	GPIO Data Direction

^{0:} Pins are inputs.

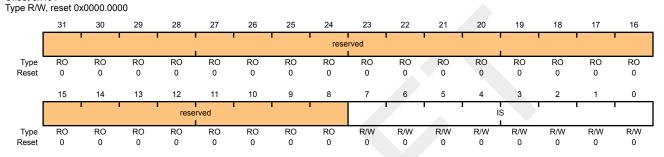
^{1:} Pins are outputs.

Register 3: GPIO Interrupt Sense (GPIOIS), offset 0x404

The **GPIOIS** register is the interrupt sense register. Bits set to 1 in **GPIOIS** configure the corresponding pins to detect levels, while bits set to 0 configure the pins to detect edges. All bits are cleared by a reset.

GPIO Interrupt Sense (GPIOIS)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x40404



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IS	R/W	0x00	GPIO Interrupt Sense

0: Edge on corresponding pin is detected (edge-sensitive).

1: Level on corresponding pin is detected (level-sensitive).

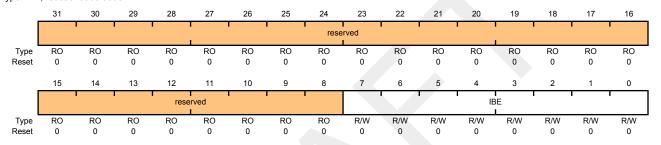
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Register 4: GPIO Interrupt Both Edges (GPIOIBE), offset 0x408

The GPIOIBE register is the interrupt both-edges register. When the corresponding bit in the GPIO Interrupt Sense (GPIOIS) register (see page 157) is set to detect edges, bits set to High in GPIOIBE configure the corresponding pin to detect both rising and falling edges, regardless of the corresponding bit in the GPIO Interrupt Event (GPIOIEV) register (see page 159). Clearing a bit configures the pin to be controlled by **GPIOIEV**. All bits are cleared by a reset.

GPIO Interrupt Both Edges (GPIOIBE)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x408 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IBE	R/W	0x00	GPIO Interrupt Both Edges
				0: Interrupt generation is controlled by the GPIO Interrupt Event (GPIOIEV)register (see page 142).

1: Both edges on the corresponding pin trigger an interrupt.

Single edge is determined by the corresponding bit in GPIOIEV.

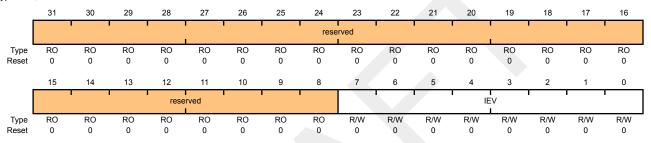
Register 5: GPIO Interrupt Event (GPIOIEV), offset 0x40C

The **GPIOIEV** register is the interrupt event register. Bits set to High in **GPIOIEV** configure the corresponding pin to detect rising edges or high levels, depending on the corresponding bit value in the **GPIO Interrupt Sense (GPIOIS)** register (see page 157). Clearing a bit configures the pin to detect falling edges or low levels, depending on the corresponding bit value in **GPIOIS**. All bits are cleared by a reset.

GPIO Interrupt Event (GPIOIEV)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x400C

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IFV	R/W	0x00	GPIO Interrupt Event

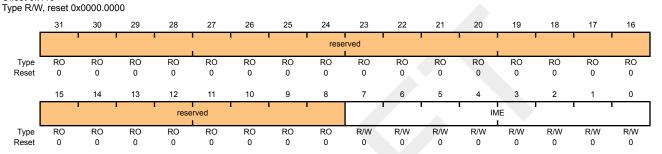
- 0: Falling edge or Low levels on corresponding pins trigger interrupts.
- 1: Rising edge or High levels on corresponding pins trigger interrupts.

Register 6: GPIO Interrupt Mask (GPIOIM), offset 0x410

The **GPIOIM** register is the interrupt mask register. Bits set to High in **GPIOIM** allow the corresponding pins to trigger their individual interrupts and the combined GPIOINTR line. Clearing a bit disables interrupt triggering on that pin. All bits are cleared by a reset.

GPIO Interrupt Mask (GPIOIM)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x410



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IME	R/W	0x00	GPIO Interrupt Mask Enable

^{0:} Corresponding pin interrupt is masked.

^{1:} Corresponding pin interrupt is not masked.

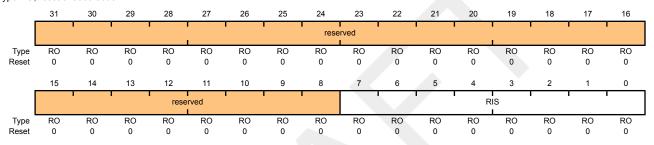
Register 7: GPIO Raw Interrupt Status (GPIORIS), offset 0x414

The GPIORIS register is the raw interrupt status register. Bits read High in GPIORIS reflect the status of interrupt trigger conditions detected (raw, prior to masking), indicating that all the requirements have been met, before they are finally allowed to trigger by the GPIO Interrupt Mask (GPIOIM) register (see page 160). Bits read as zero indicate that corresponding input pins have not initiated an interrupt. All bits are cleared by a reset.

GPIO Raw Interrupt Status (GPIORIS)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x414

Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	RIS	RO	0x00	GPIO Interrupt Raw Status

Reflect the status of interrupt trigger condition detection on pins (raw, prior to masking).

- 0: Corresponding pin interrupt requirements not met.
- 1: Corresponding pin interrupt has met requirements.

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Register 8: GPIO Masked Interrupt Status (GPIOMIS), offset 0x418

The **GPIOMIS** register is the masked interrupt status register. Bits read High in **GPIOMIS** reflect the status of input lines triggering an interrupt. Bits read as Low indicate that either no interrupt has been generated, or the interrupt is masked.

In addition to providing GPIO functionality, PB4 can also be used as an external trigger for the ADC. If PB4 is configured as a non-masked interrupt pin (GPIOIM is set to 1), not only is an interrupt for PortB generated, but an external trigger signal is sent to the ADC. If the **ADC Event Multiplexer Select (ADCEMUX)** register is configured to use the external trigger, an ADC conversion is initiated.

If no other PortB pins are being used to generate interrupts, the ARM Integrated Nested Vectored Interrupt Controller (NVIC) Interrupt Set Enable (SETNA) register can disable the PortB interrupts and the ADC interrupt can be used to read back the converted data. Otherwise, the PortB interrupt handler needs to ignore and clear interrupts on B4, and wait for the ADC interrupt or the ADC interrupt needs to be disabled in the SETNA register and the PortB interrupt handler polls the ADC registers until the conversion is completed.

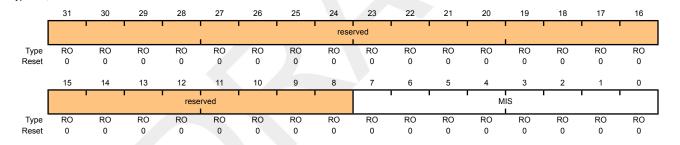
GPIOMIS is the state of the interrupt after masking.

GPIO Masked Interrupt Status (GPIOMIS)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x418

Type RO, reset 0x0000.0000

Dit/Eiold



DIVI ICIU	Name	туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	MIS	RO	0x00	GPIO Masked Interrupt Status

Description

Masked value of interrupt due to corresponding pin.

0: Corresponding GPIO line interrupt not active.

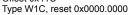
1: Corresponding GPIO line asserting interrupt.

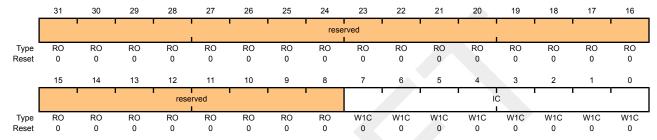
Register 9: GPIO Interrupt Clear (GPIOICR), offset 0x41C

The **GPIOICR** register is the interrupt clear register. Writing a 1 to a bit in this register clears the corresponding interrupt edge detection logic register. Writing a 0 has no effect.

GPIO Interrupt Clear (GPIOICR)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x41C





Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	IC	W1C	0x00	GPIO Interrupt Clear

- 0: Corresponding interrupt is unaffected.
- 1: Corresponding interrupt is cleared.

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Register 10: GPIO Alternate Function Select (GPIOAFSEL), offset 0x420

The GPIOAFSEL register is the mode control select register. Writing a 1 to any bit in this register selects the hardware control for the corresponding GPIO line. All bits are cleared by a reset, therefore no GPIO line is set to hardware control by default.

The commit control registers provide a layer of protection against accidental programming of critical hardware peripherals. Writes to protected bits of the GPIO Alternate Function Select (GPIOAFSEL) register (see page 164) are not committed to storage unless the GPIO Lock (GPIOLOCK) register (see page 174) has been unlocked and the appropriate bits of the GPIO Commit (GPIOCR) register (see page 175) have been set to 1.

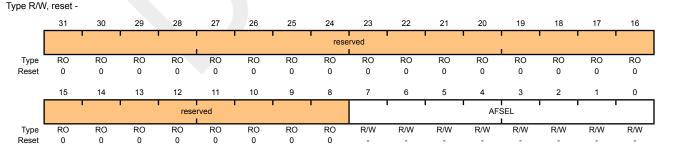
Important: All GPIO pins are tri-stated by default (GPIOAFSEL=0, GPIODEN=0, GPIOPDR=0, and GPIOPUR=0), with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). The JTAG/SWD pins default to their JTAG/SWD functionality (GPIOAFSEL=1. GPIODEN=1 and GPIOPUR=1). A Power-On-Reset (FOR) or asserting RST puts both groups of pins back to their default state.

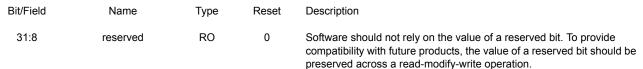
Caution – If the JTAG pins are used as GPIOs in a design, PB7 and PC2 cannot have external pull-down resistors connected to both of them at the same time. If both pins are pulled Low during reset, the controller has unpredictable behavior. If this happens, remove one or both of the pull-down resistors, and apply RST or power-cycle the part.

In addition, it is possible to create a software sequence that prevents the debugger from connecting to the Stellaris® microcontroller. If the program code loaded into flash immediately changes the JTAG pins to their GPIO functionality, the debugger may not have enough time to connect and halt the controller before the JTAG pin functionality switches. This may lock the debugger out of the part. This can be avoided with a software routine that restores JTAG functionality based on an external or software trigger.

GPIO Alternate Function Select (GPIOAFSEL)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x420





Bit/Field	Name	Type	Reset	Description
7:0	AFSEL	R/W	-	GPIO Alternate Function Select

0: Software control of corresponding GPIO line (GPIO mode).

1: Hardware control of corresponding GPIO line (alternate hardware function).

Note:

The default reset value for the **GPIOAFSEL**, **GPIOPUR**, and **GPIODEN** registers are 0x0000.0000 for all GPIO pins, with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). These five pins default to JTAG/SWD functionality. Because of this, the default reset value of these registers for GPIO Port B is 0x0000.0080 while the default reset value for Port C is 0x0000.000F.

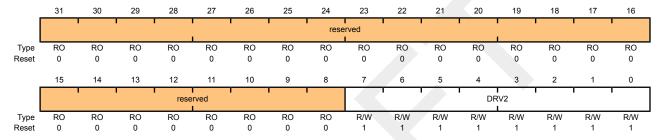
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Register 11: GPIO 2-mA Drive Select (GPIODR2R), offset 0x500

The **GPIODR2R** register is the 2-mA drive control register. It allows for each GPIO signal in the port to be individually configured without affecting the other pads. When writing a DRV2 bit for a GPIO signal, the corresponding DRV4 bit in the **GPIODR4R** register and the DRV8 bit in the **GPIODR8R** register are automatically cleared by hardware.

GPIO 2-mA Drive Select (GPIODR2R)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x500 Type R/W, reset 0x0000.00FF



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DRV2	R/W	0xFF	Output Pad 2-mA Drive Enable

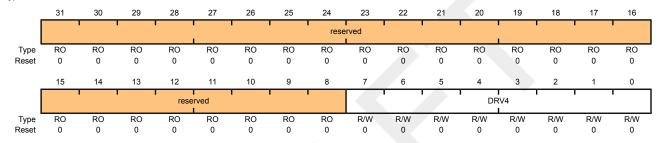
A write of 1 to either **GPIODR4[n]** or **GPIODR8[n]**clears the corresponding 2-mA enable bit. The change is effective on the second clock cycle after the write.

Register 12: GPIO 4-mA Drive Select (GPIODR4R), offset 0x504

The **GPIODR4R** register is the 4-mA drive control register. It allows for each GPIO signal in the port to be individually configured without affecting the other pads. When writing the DRV4 bit for a GPIO signal, the corresponding DRV2 bit in the **GPIODR2R** register and the DRV8 bit in the **GPIODR8R** register are automatically cleared by hardware.

GPIO 4-mA Drive Select (GPIODR4R)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x504 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DRV4	R/W	0x00	Output Pad 4-mA Drive Enable

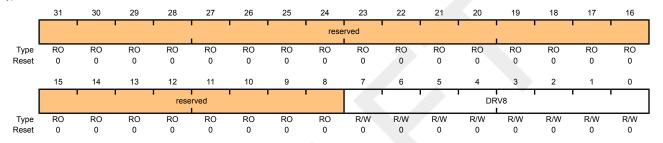
A write of 1 to either **GPIODR2[n]** or **GPIODR8[n]**clears the corresponding 4-mA enable bit. The change is effective on the second clock cycle after the write.

Register 13: GPIO 8-mA Drive Select (GPIODR8R), offset 0x508

The **GPIODR8R** register is the 8-mA drive control register. It allows for each GPIO signal in the port to be individually configured without affecting the other pads. When writing the DRV8 bit for a GPIO signal, the corresponding DRV2 bit in the **GPIODR2R** register and the DRV4 bit in the **GPIODR4R** register are automatically cleared by hardware.

GPIO 8-mA Drive Select (GPIODR8R)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.7000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x508 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DRV8	R/W	0x00	Output Pad 8-mA Drive Enable

A write of 1 to either **GPIODR2[n]** or **GPIODR4[n]**clears the corresponding 8-mA enable bit. The change is effective on the second clock cycle after the write.

Register 14: GPIO Open Drain Select (GPIOODR), offset 0x50C

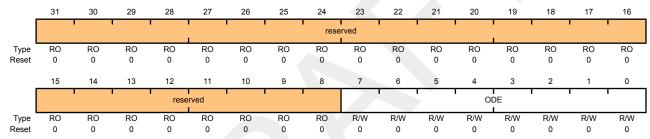
The **GPIOODR** register is the open drain control register. Setting a bit in this register enables the open drain configuration of the corresponding GPIO pad. When open drain mode is enabled, the corresponding bit should also be set in the **GPIO Digital Input Enable (GPIODEN)** register (see page 173). Corresponding bits in the drive strength registers (**GPIODR2R**, **GPIODR4R**, **GPIODR8R**, and **GPIOSLR**) can be set to achieve the desired rise and fall times. The GPIO acts as an open drain input if the corresponding bit in the **GPIODIR** register is set to 0; and as an open drain output when set to 1.

When using the I²C module, the **GPIO Alternate Function Select (GPIOAFSEL)** register bit for PB2 and PB3 should be set to 1 (see examples in "Initialization and Configuration" on page 151).

GPIO Open Drain Select (GPIOODR)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 OFISE 0x50C

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	ODE	R/W	0x00	Output Pad Open Drain Enable

0: Open drain configuration is disabled.

1: Open drain configuration is enabled.

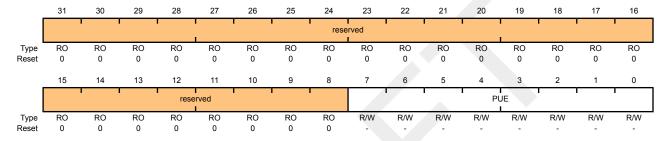
Register 15: GPIO Pull-Up Select (GPIOPUR), offset 0x510

The **GPIOPUR** register is the pull-up control register. When a bit is set to 1, it enables a weak pull-up resistor on the corresponding GPIO signal. Setting a bit in **GPIOPUR** automatically clears the corresponding bit in the **GPIO Pull-Down Select (GPIOPDR)** register (see page 171).

GPIO Pull-Up Select (GPIOPUR)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000

Offset 0x510 Type R/W, reset -



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PUE	R/W	-	Pad Weak Pull-Up Enable

A write of 1 to **GPIOPDR**[n]clears the corresponding **GPIOPUR**[n]enables. The change is effective on the second clock cycle after the write.

Note:

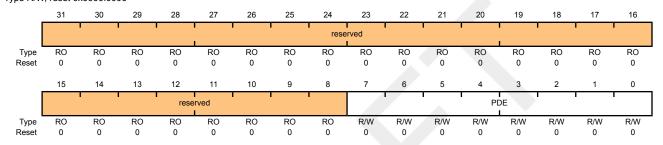
The default reset value for the **GPIOAFSEL**, **GPIOPUR**, and **GPIODEN** registers are 0x0000.0000 for all GPIO pins, with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). These five pins default to JTAG/SWD functionality. Because of this, the default reset value of these registers for GPIO Port B is 0x0000.0080 while the default reset value for Port C is 0x0000.000F.

Register 16: GPIO Pull-Down Select (GPIOPDR), offset 0x514

The **GPIOPDR** register is the pull-down control register. When a bit is set to 1, it enables a weak pull-down resistor on the corresponding GPIO signal. Setting a bit in **GPIOPDR** automatically clears the corresponding bit in the **GPIO Pull-Up Select (GPIOPUR)** register (see page 170).

GPIO Pull-Down Select (GPIOPDR)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x514 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PDE	R/W	0x00	Pad Weak Pull-Down Enable

A write of 1 to **GPIOPUR[n]**clears the corresponding **GPIOPDR[n]**enables. The change is effective on the second clock cycle after the write.

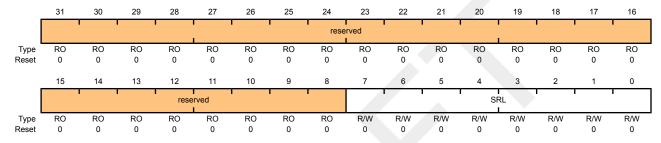
Register 17: GPIO Slew Rate Control Select (GPIOSLR), offset 0x518

The **GPIOSLR** register is the slew rate control register. Slew rate control is only available when using the 8-mA drive strength option via the **GPIO 8-mA Drive Select (GPIODR8R)** register (see page 168).

GPIO Slew Rate Control Select (GPIOSLR)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000

Offset 0x518 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	SRL	R/W	0	Slew Rate Limit Enable (8-mA drive only)

^{0:} Slew rate control disabled.

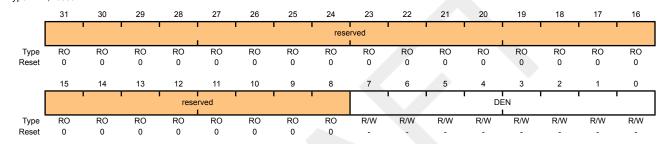
^{1:} Slew rate control enabled.

Register 18: GPIO Digital Enable (GPIODEN), offset 0x51C

The **GPIODEN** register is the digital enable register. By default, with the exception of the GPIO signals used for JTAG/SWD function, all other GPIO signals are configured out of reset to be undriven (tristate). Their digital function is disabled; they do not drive a logic value on the pin and they do not allow the pin voltage into the GPIO receiver. To use the pin in a digital function (either GPIO or alternate function), the corresponding GPIODEN bit must be set.

GPIO Digital Enable (GPIODEN)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x51C Type RW, reset -



Bit/Field	Name	Type	Reset
31:8	reserved	RO	0
7:0	DEN	R/W	

Description

Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Digital Enable

0: Digital functions disabled.

1: Digital functions enabled.

Note:

The default reset value for the **GPIOAFSEL**, **GPIOPUR**, and **GPIODEN** registers are 0x0000.0000 for all GPIO pins, with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). These five pins default to JTAG/SWD functionality. Because of this, the default reset value of these registers for GPIO Port B is 0x0000.0080 while the default reset value for Port C is 0x0000.000F.

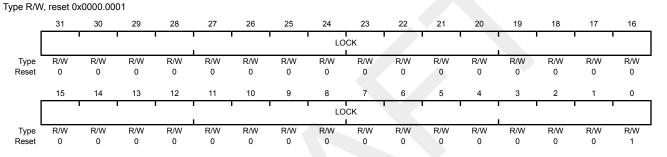
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Register 19: GPIO Lock (GPIOLOCK), offset 0x520

The **GPIOLOCK** register enables write access to the **GPIOCR** register (see page 175). Writing 0x1ACCE551 to the **GPIOLOCK** register will unlock the **GPIOCR** register. Writing any other value to the **GPIOLOCK** register re-enables the locked state. Reading the **GPIOLOCK** register returns the lock status rather than the 32-bit value that was previously written. Therefore, when write accesses are disabled, or locked, reading the **GPIOLOCK** register returns 0x00000001. When write accesses are enabled, or unlocked, reading the **GPIOLOCK** register returns 0x000000000.

GPIO Lock (GPIOLOCK)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0x520



Bit/Field	Name	Type	Reset	Description
31:0	LOCK	R/W	0x00000001	GPIO Lock

A write of the value 0x1ACCE551 unlocks the GPIO Commit register for write access. A write of any other value reapplies the lock, preventing any register updates. A read of this register returns the following values:

locked: 0x00000001 unlocked: 0x00000000

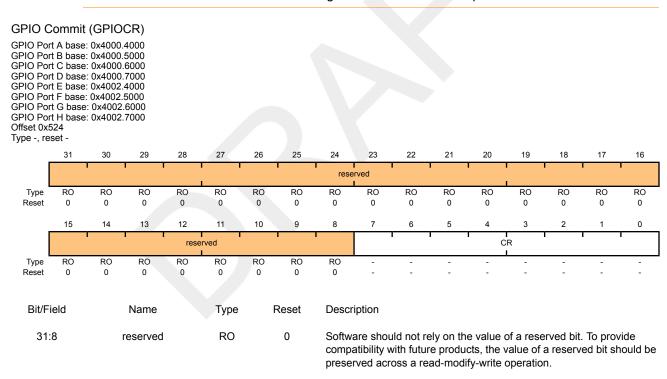
Register 20: GPIO Commit (GPIOCR), offset 0x524

The **GPIOCR** register is the commit register. The value of the **GPIOCR** register determines which bits of the **GPIOAFSEL** register will be committed when a write to the **GPIOAFSEL** register is performed. If a bit in the **GPIOCR** register is a zero, the data being written to the corresponding bit in the **GPIOAFSEL** register will not be committed and will retain its previous value. If a bit in the **GPIOCR** register is a one, the data being written to the corresponding bit of the **GPIOAFSEL** register will be committed to the register and will reflect the new value.

The contents of the **GPIOCR** register can only be modified if the **GPIOLOCK** register is unlocked. Writes to the GPIOCR register will be ignored if the **GPIOLOCK** register is locked.

Important: This register is designed to prevent accidental programming of the **GPIOAFSEL** registers that control connectivity to the JTAG/SWD debug hardware. By initializing the bits of the **GPIOCR** register to 0 for PB7 and PC[3:0], the JTAG/SWD debug port can only be converted to GPIOs through a deliberate set of writes to the **GPIOLOCK**, **GPIOCR**, and **GPIOAFSEL** registers.

Because this protection is currently only implemented on the JTAG/SWD pins on PB7 and PC[3:0], all of the other bits in the **GPIOCR** registers cannot be written with 0x0. These bits are hardwired to 0x1, ensuring that it is always possible to commit new values to the **GPIOAFSEL** register bits of these other pins.



Bit/Field	Name	Type	Reset	Description
7:0	CR	_	_	GPIO Commit

On a bit-wise basis, any bit set allows the corresponding <code>GPIOAFSEL</code> bit to be set to its alternate function.

Note:

The default register type for the **GPIOCR** register is RO for all GPIO pins, with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). These five pins are currently the only GPIOs that are protected by the **GPIOCR** register. Because of this, the register type for GPIO Port B7 and GPIO Port C[3:0] is R/W.

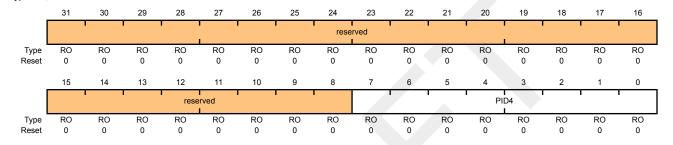
The default reset value for the **GPIOCR** register is 0x0000.00FF for all GPIO pins, with the exception of the five JTAG/SWD pins (PB7 and PC[3:0]). To ensure that the JTAG port is not accidentally programmed as a GPIO, these five pins default to non-commitable. Because of this, the default reset value of **GPIOCR** for GPIO Port B is 0x0000.007F while the default reset value of **GPIOCR** for Port C is 0x0000.00FO.

Register 21: GPIO Peripheral Identification 4 (GPIOPeriphID4), offset 0xFD0

The **GPIOPeriphID4**, **GPIOPeriphID5**, **GPIOPeriphID6**, and **GPIOPeriphID7** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 4 (GPIOPeriphID4)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFDO Type RO, reset 0x0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID4	RO	0x00	GPIO Peripheral ID Register[7:0]

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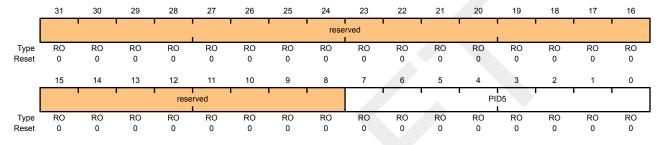
Register 22: GPIO Peripheral Identification 5 (GPIOPeriphID5), offset 0xFD4

The **GPIOPeriphID4**, **GPIOPeriphID5**, **GPIOPeriphID6**, and **GPIOPeriphID7** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 5 (GPIOPeriphID5)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000

Offset 0xFD4 Type RO, reset 0x0x0000.0000



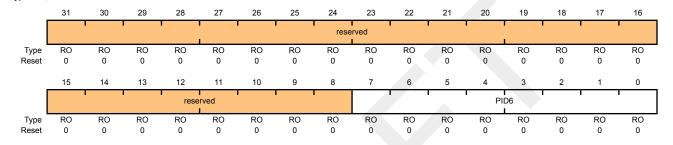
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID5	RO	0x00	GPIO Peripheral ID Register[15:8]

Register 23: GPIO Peripheral Identification 6 (GPIOPeriphID6), offset 0xFD8

The **GPIOPeriphID4**, **GPIOPeriphID5**, **GPIOPeriphID6**, and **GPIOPeriphID7** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 6 (GPIOPeriphID6)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFD8 Type RO, reset 0x0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID6	RO	0x00	GPIO Peripheral ID Register[23:16]

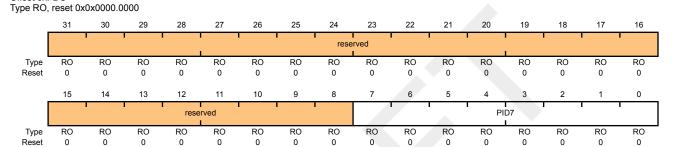
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Register 24: GPIO Peripheral Identification 7 (GPIOPeriphID7), offset 0xFDC

The **GPIOPeriphID4**, **GPIOPeriphID5**, **GPIOPeriphID6**, and **GPIOPeriphID7** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 7 (GPIOPeriphID7)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFDC



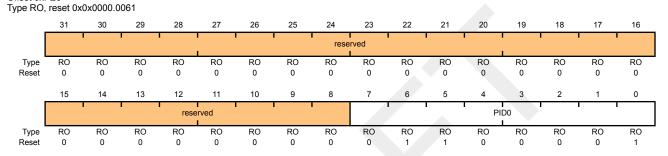
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID7	RO	0x00	GPIO Peripheral ID Register[31:24]

Register 25: GPIO Peripheral Identification 0 (GPIOPeriphID0), offset 0xFE0

The **GPIOPeriphID0**, **GPIOPeriphID1**, **GPIOPeriphID2**, and **GPIOPeriphID3** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 0 (GPIOPeriphID0)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFEO



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID0	RO	0x61	GPIO Peripheral ID Register[7:0]

Can be used by software to identify the presence of this peripheral.

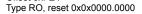
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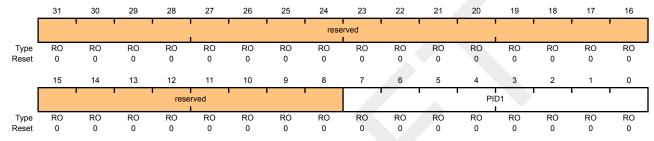
Register 26: GPIO Peripheral Identification 1(GPIOPeriphID1), offset 0xFE4

The **GPIOPeriphID0**, **GPIOPeriphID1**, **GPIOPeriphID2**, and **GPIOPeriphID3** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 1 (GPIOPeriphID1)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFE4





Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID1	RO	0x00	GPIO Peripheral ID Register[15:8]

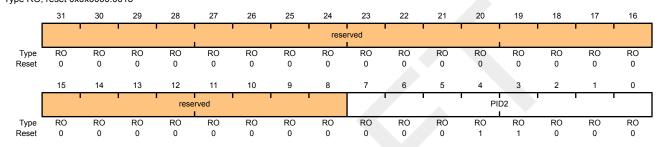
Can be used by software to identify the presence of this peripheral.

Register 27: GPIO Peripheral Identification 2 (GPIOPeriphID2), offset 0xFE8

The **GPIOPeriphID0**, **GPIOPeriphID1**, **GPIOPeriphID2**, and **GPIOPeriphID3** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 2 (GPIOPeriphID2)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFE8 Type RO, reset 0x0x0000.0018



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID2	RO	0x18	GPIO Peripheral ID Register[23:16]

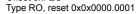
Can be used by software to identify the presence of this peripheral.

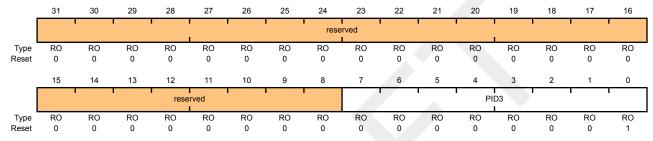
Register 28: GPIO Peripheral Identification 3 (GPIOPeriphID3), offset 0xFEC

The **GPIOPeriphID0**, **GPIOPeriphID1**, **GPIOPeriphID2**, and **GPIOPeriphID3** registers can conceptually be treated as one 32-bit register; each register contains eight bits of the 32-bit register, used by software to identify the peripheral.

GPIO Peripheral Identification 3 (GPIOPeriphID3)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFEC





Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID3	RO	0x01	GPIO Peripheral ID Register[31:24]

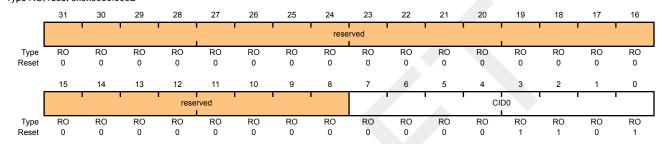
Can be used by software to identify the presence of this peripheral.

Register 29: GPIO PrimeCell Identification 0 (GPIOPCellID0), offset 0xFF0

The **GPIOPCeIIID1**, **GPIOPCeIIID1**, and **GPIOPCeIIID3** registers are four 8-bit wide registers, that can conceptually be treated as one 32-bit register. The register is used as a standard cross-peripheral identification system.

GPIO PrimeCell Identification 0 (GPIOPCellID0)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFF0 Type RO, reset 0x0x0000.000D



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID0	RO	0x0D	GPIO PrimeCell ID Register[7:0]

 $\label{provides} \mbox{Provides software a standard cross-peripheral identification system.}$

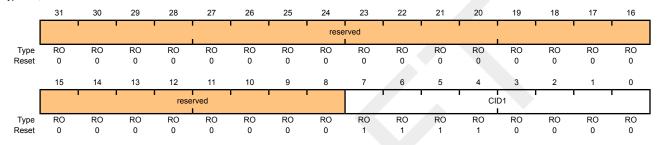
Register 30: GPIO PrimeCell Identification 1 (GPIOPCellID1), offset 0xFF4

The **GPIOPCeIIID1**, **GPIOPCeIIID1**, and **GPIOPCeIIID3** registers are four 8-bit wide registers, that can conceptually be treated as one 32-bit register. The register is used as a standard cross-peripheral identification system.

GPIO PrimeCell Identification 1 (GPIOPCellID1)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000

Offset 0xFF4
Type RO, reset 0x0x0000.00F0



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID1	RO	0xF0	GPIO PrimeCell ID Register[15:8]

Provides software a standard cross-peripheral identification system.

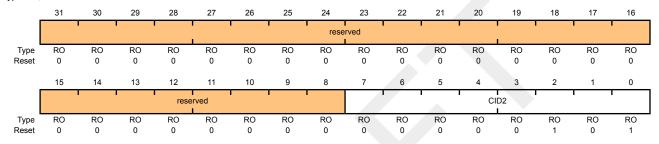
Register 31: GPIO PrimeCell Identification 2 (GPIOPCellID2), offset 0xFF8

The **GPIOPCeIIID1**, **GPIOPCeIIID1**, and **GPIOPCeIIID3** registers are four 8-bit wide registers, that can conceptually be treated as one 32-bit register. The register is used as a standard cross-peripheral identification system.

GPIO PrimeCell Identification 2 (GPIOPCellID2)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFF8

Type RO, reset 0x0x0000.0005



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID2	RO	0x05	GPIO PrimeCell ID Register[23:16]

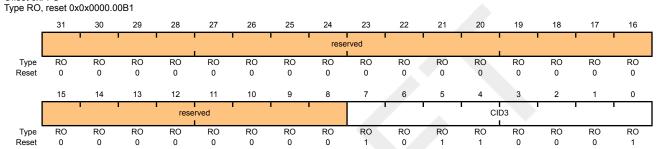
Provides software a standard cross-peripheral identification system.

Register 32: GPIO PrimeCell Identification 3 (GPIOPCellID3), offset 0xFFC

The **GPIOPCeIIID1**, **GPIOPCeIIID1**, and **GPIOPCeIIID3** registers are four 8-bit wide registers, that can conceptually be treated as one 32-bit register. The register is used as a standard cross-peripheral identification system.

GPIO PrimeCell Identification 3 (GPIOPCellID3)

GPIO Port A base: 0x4000.4000 GPIO Port B base: 0x4000.5000 GPIO Port C base: 0x4000.6000 GPIO Port D base: 0x4000.7000 GPIO Port E base: 0x4002.4000 GPIO Port F base: 0x4002.5000 GPIO Port G base: 0x4002.6000 GPIO Port H base: 0x4002.7000 Offset 0xFFC



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID3	RO	0xB1	GPIO PrimeCell ID Register[31:24]

 $\label{provides} \mbox{Provides software a standard cross-peripheral identification system.}$

10 General-Purpose Timers

GPTM

Programmable timers can be used to count or time external events that drive the Timer input pins.

The Stellaris[®] General-Purpose Timer Module (GPTM) contains four GPTM blocks (Timer0, Timer1, Timer 2, and Timer 3). Each GPTM block provides two 16-bit timer/counters (referred to as TimerA and TimerB) that can be configured to operate independently as timers or event counters, or configured to operate as one 32-bit timer or one 32-bit Real-Time Clock (RTC). Timers can also be used to trigger analog-to-digital (ADC) conversions. The trigger signals from all of the general-purpose timers are ORed together before reaching the ADC module, so only one timer should be used to trigger ADC events.

Note: Timer2 is an internal timer and can only be used to generate internal interrupts or trigger ADC events.

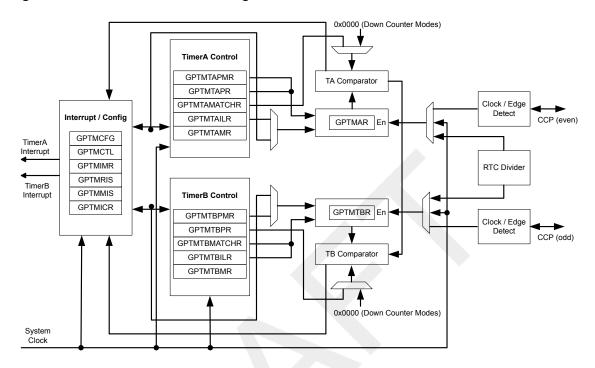
The General-Purpose Timer Module is one timing resource available on the Stellaris[®] microcontrollers. Other timer resources include the System Timer (SysTick) (see "System Timer (SysTick)" on page 34).

The following modes are supported:

- 32-bit Timer modes
 - Programmable one-shot timer
 - Programmable periodic timer
 - Real-Time Clock using 32.768-KHz input clock
 - Software-controlled event stalling (excluding RTC mode)
- 16-bit Timer modes
 - General-purpose timer function with an 8-bit prescaler (for one-shot and periodic modes only)
 - Programmable one-shot timer
 - Programmable periodic timer
 - Software-controlled event stalling
- 16-bit Input Capture modes
 - Input edge count capture
 - Input edge time capture
- 16-bit PWM mode
 - Simple PWM mode with software-programmable output inversion of the PWM signal

10.1 Block Diagram

Figure 10-1. GPTM Module Block Diagram



10.2 Functional Description

The main components of each GPTM block are two free-running 16-bit up/down counters (referred to as TimerA and TimerB), two 16-bit match registers, two prescaler match registers, and two 16-bit load/initialization registers and their associated control functions. The exact functionality of each GPTM is controlled by software and configured through the register interface.

Software configures the GPTM using the **GPTM Configuration (GPTMCFG)** register (see page 201), the **GPTM TimerA Mode (GPTMTAMR)** register (see page 202), and the **GPTM TimerB Mode (GPTMTBMR)** register (see page 203). When in one of the 32-bit modes, the timer can only act as a 32-bit timer. However, when configured in 16-bit mode, the GPTM can have its two 16-bit timers configured in any combination of the 16-bit modes.

10.2.1 GPTM Reset Conditions

After reset has been applied to the GPTM module, the module is in an inactive state, and all control registers are cleared and in their default states. Counters TimerA and TimerB are initialized to 0xFFFF, along with their corresponding load registers: the GPTM TimerA Interval Load (GPTMTBILR) register (see page 212) and the GPTM TimerB Interval Load (GPTMTBILR) register (see page 213). The prescale counters are initialized to 0x00: the GPTM TimerA Prescale (GPTMTAPR) register (see page 216) and the GPTM TimerB Prescale (GPTMTBPR) register (see page 217).

10.2.2 32-Bit Timer Operating Modes

Note: Both the odd- and even-numbered CCP pins are used for 16-bit mode. Only the even-numbered CCP pins are used for 32-bit mode.

This section describes the three GPTM 32-bit timer modes (One-Shot, Periodic, and RTC) and their configuration.

The GPTM is placed into 32-bit mode by writing a 0 (One-Shot/Periodic 32-bit timer mode) or a 1 (RTC mode) to the **GPTM Configuration (GPTMCFG)** register. In both configurations, certain GPTM registers are concatenated to form pseudo 32-bit registers. These registers include:

- GPTM TimerA Interval Load (GPTMTAILR) register [15:0], see page 212
- GPTM TimerB Interval Load (GPTMTBILR) register [15:0], see page 213
- GPTM TimerA (GPTMTAR) register [15:0], see page 220
- GPTM TimerB (GPTMTBR) register [15:0], see page 221

In the 32-bit modes, the GPTM translates a 32-bit write access to **GPTMTAILR** into a write access to both **GPTMTAILR** and **GPTMTBILR**. The resulting word ordering for such a write operation is:

```
GPTMTBILR[15:0]:GPTMTAILR[15:0]
```

Likewise, a read access to **GPTMTAR** returns the value:

GPTMTBR[15:0]:GPTMTAR[15:0]

10.2.2.1 32-Bit One-Shot/Periodic Timer Mode

In 32-bit one-shot and periodic timer modes, the concatenated versions of the TimerA and TimerB registers are configured as a 32-bit down-counter. The selection of one-shot or periodic mode is determined by the value written to the TAMR field of the **GPTM TimerA Mode (GPTMTAMR)** register (see page 202), and there is no need to write to the GPTM TimerB Mode (GPTMTBMR) register.

When software writes the TAEN bit in the **GPTM Control (GPTMCTL)** register (see page 204), the timer begins counting down from its preloaded value. Once the 0x0000.0000 state is reached, the timer reloads its start value from the concatenated **GPTMTAILR** on the next cycle. If configured to be a one-shot timer, the timer stops counting and clears the TAEN bit in the **GPTMCTL** register. If configured as a periodic timer, it continues counting.

In addition to reloading the count value, the GPTM generates interrupts and output triggers when it reaches the 0x0000000 state. The GPTM sets the TATORIS bit in the GPTM Raw Interrupt Status (GPTMRIS) register (see page 208), and holds it until it is cleared by writing the GPTM Interrupt Clear (GPTMICR) register (see page 210). If the time-out interrupt is enabled in the GPTM Interrupt Mask (GPTIMR) register (see page 206), the GPTM also sets the TATOMIS bit in the GPTM Masked Interrupt Status (GPTMMIS) register (see page 209).

The output trigger is a one-clock-cycle pulse that is asserted when the counter hits the 0x0000.0000 state, and deasserted on the following clock cycle. It is enabled by setting the TAOTE bit in **GPTMCTL**, and can trigger SoC-level events such as ADC conversions.

If software reloads the **GPTMTAILR** register while the counter is running, the counter loads the new value on the next clock cycle and continues counting from the new value.

If the TASTALL bit in the **GPTMCTL** register is asserted, the timer freezes counting until the signal is deasserted.

10.2.2.2 32-Bit Real-Time Clock Timer Mode

In Real-Time Clock (RTC) mode, the concatenated versions of the TimerA and TimerB registers are configured as a 32-bit up-counter. When RTC mode is selected for the first time, the counter is

loaded with a value of 0x0000.0001. All subsequent load values must be written to the **GPTM TimerA Match (GPTMTAMATCHR)** register (see page 214) by the controller.

The input clock on the CCP0, CCP2 or CCP4 pins is required to be 32.768 KHz in RTC mode. The clock signal is then divided down to a 1 Hz rate and is passed along to the input of the 32-bit counter.

When software writes the TAEN bit inthe **GPTMCTL** register, the counter starts counting up from its preloaded value of 0x0000.0001. When the current count value matches the preloaded value in the **GPTMTAMATCHR** register, it rolls over to a value of 0x0000.0000 and continues counting until either a hardware reset, or it is disabled by software (clearing the TAEN bit). When a match occurs, the GPTM asserts the RTCRIS bit in **GPTMRIS**. If the RTC interrupt is enabled in **GPTIMR**, the GPTM also sets the RTCMIS bit in **GPTMISR** and generates a controller interrupt. The status flags are cleared by writing the RTCCINT bit in **GPTMICR**.

If the TASTALL and/or TBSTALL bits in the **GPTMCTL** register are set, the timer does not freeze if the RTCEN bit is set in **GPTMCTL**.

10.2.3 16-Bit Timer Operating Modes

The GPTM is placed into global 16-bit mode by writing a value of 0x4 to the **GPTM Configuration** (**GPTMCFG**) register (see page 201). This section describes each of the GPTM 16-bit modes of operation. TimerA and TimerB have identical modes, so a single description is given using an *n* to reference both.

10.2.3.1 16-Bit One-Shot/Periodic Timer Mode

In 16-bit one-shot and periodic timer modes, the timer is configured as a 16-bit down-counter with an optional 8-bit prescaler that effectively extends the counting range of the timer to 24 bits. The selection of one-shot or periodic mode is determined by the value written to the TnMR field of the **GPTMTnMR** register. The optional prescaler is loaded into the **GPTM Timern Prescale (GPTMTnPR)** register.

When software writes the TnEN bit in the **GPTMCTL** register, the timer begins counting down from its preloaded value. Once the 0x0000 state is reached, the timer reloads its start value from **GPTMTnILR** and **GPTMTnPR** on the next cycle. If configured to be a one-shot timer, the timer stops counting and clears the TnEN bit in the **GPTMCTL** register. If configured as a periodic timer, it continues counting.

In addition to reloading the count value, the timer generates interrupts and output triggers when it reaches the 0x0000 state. The GPTM sets the TnTORIS bit in the **GPTMRIS** register, and holds it until it is cleared by writing the **GPTMICR** register. If the time-out interrupt is enabled in **GPTIMR**, the GPTM also sets the TnTOMIS bit in **GPTMISR** and generates a controller interrupt.

The output trigger is a one-clock-cycle pulse that is asserted when the counter hits the 0x0000 state, and deasserted on the following clock cycle. It is enabled by setting the ThOTE bit in the **GPTMCTL** register, and can trigger SoC-level events such as ADC conversions.

If software reloads the **GPTMTAILR** register while the counter is running, the counter loads the new value on the next clock cycle and continues counting from the new value.

If the TnSTALL bit in the **GPTMCTL** register is enabled, the timer freezes counting until the signal is deasserted.

The following example shows a variety of configurations for a 16-bit free running timer while using the prescaler. All values assume a 50-MHz clock with Tc=20 ns (clock period).

Table 10-1. 16-Bit Timer With Prescaler Configurations

Prescale	#Clock (T c) ^a	Max Time	Units
00000000	1	1.3107	mS
00000001	2	2.6214	mS
00000010	3	23.9321	mS
11111100	254	332.9229	mS
11111110	255	334.2336	mS
11111111	256	335.5443	mS

a. Tc is the clock period.

10.2.3.2 16-Bit Input Edge Count Mode

In Edge Count mode, the timer is configured as a down-counter capable of capturing three types of events: rising edge, falling edge, or both. To place the timer in Edge Count mode, the TnCMR bit of the GPTMTnMR register must be set to 0. The type of edge that the timer counts is determined by the TnEVENT fields of the GPTMCTL register. During initialization, the GPTM Timern Match (GPTMTnMATCHR) register is configured so that the difference between the value in the GPTMTnILR register and the GPTMTnMATCHR register equals the number of edge events that must be counted.

When software writes the TnEN bit in the **GPTM Control (GPTMCTL)** register, the timer is enabled for event capture. Each input event on the CCP pin decrements the counter by 1 until the event count matches **GPTMTnMATCHR**. When the counts match, the GPTM asserts the CnMRIS bit in the **GPTMRIS** register (and the CnMMIS bit, if the interrupt is not masked). The counter is then reloaded using the value in **GPTMTnILR**, and stopped since the GPTM automatically clears the TnEN bit in the **GPTMCTL** register. Once the event count has been reached, all further events are ignored until TnEN is re-enabled by software.

Figure 10-2 on page 194 shows how input edge count mode works. In this case, the timer start value is set to **GPTMnILR** =0x000A and the match value is set to **GPTMnMATCHR** =0x0006 so that four edge events are counted. The counter is configured to detect both edges of the input signal.

Note that the last two edges are not counted since the timer automatically clears the \mathtt{TnEN} bit after the current count matches the value in the **GPTMnMR** register.

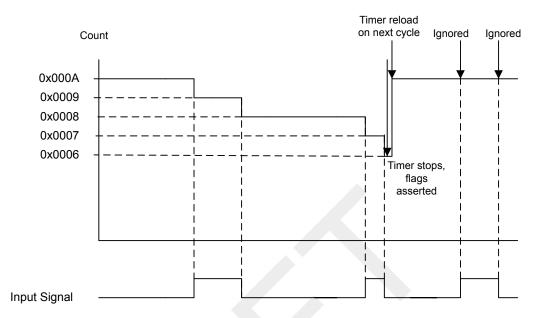


Figure 10-2. 16-Bit Input Edge Count Mode Example

10.2.3.3 16-Bit Input Edge Time Mode

Note: The prescaler is not available in 16-Bit Input Edge Time mode.

In Edge Time mode, the timer is configured as a free-running down-counter initialized to the value loaded in the **GPTMTnILR** register (or 0xFFFF at reset). This mode allows for event capture of both rising and falling edges. The timer is placed into Edge Time mode by setting the TnCMR bit in the **GPTMTnMR** register, and the type of event that the timer captures is determined by the TnEVENT fields of the **GPTMCnTL** register.

When software writes the TnEN bit in the **GPTMCTL** register, the timer is enabled for event capture. When the selected input event is detected, the current **Tn** counter value is captured in the **GPTMTnR** register and is available to be read by the controller. The GPTM then asserts the CnERIS bit (and the CnEMIS bit, if the interrupt is not masked).

After an event has been captured, the timer does not stop counting. It continues to count until the ${\tt TnEN}$ bit is cleared. When the timer reaches the 0x0000 state, it is reloaded with the value from the **GPTMnILR** register.

Figure 10-3 on page 195 shows how input edge timing mode works. In the diagram, it is assumed that the start value of the timer is the default value of 0xFFFF, and the timer is configured to capture rising edge events.

Each time a rising edge event is detected, the current count value is loaded into the **GPTMTnR** register, and is held there until another rising edge is detected (at which point the new count value is loaded into **GPTMTnR**).

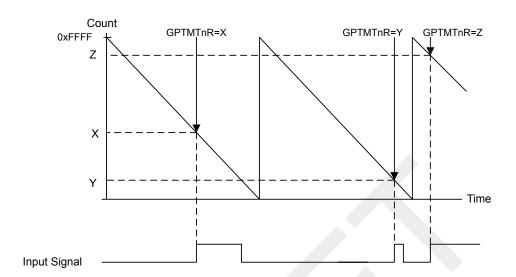


Figure 10-3. 16-Bit Input Edge Time Mode Example

10.2.3.4 16-Bit PWM Mode

The GPTM supports a simple PWM generation mode. In PWM mode, the timer is configured as a down-counter with a start value (and thus period) defined by **GPTMTnILR**. PWM mode is enabled with the **GPTMTnMR** register by setting the TnAMS bit to 0x1, the TnCMR bit to 0x0, and the TnMR field to 0x2.

When software writes the TnEN bit in the **GPTMCTL** register, the counter begins counting down until it reaches the 0x0000 state. On the next counter cycle, the counter reloads its start value from **GPTMTnILR** (and **GPTMTnPR** if using a prescaler) and continues counting until disabled by software clearing the TnEN bit in the **GPTMCTL** register. No interrupts or status bits are asserted in PWM mode.

The output PWM signal asserts when the counter is at the value of the **GPTMTnILR** register (its start state), and is deasserted when the counter value equals the value in the **GPTM Timern Match Register (GPTMnMATCHR)**. Software has the capability of inverting the output PWM signal by setting the TnPWML bit in the **GPTMCTL** register.

Figure 10-4 on page 196 shows how to generate an output PWM with a 1-ms period and a 66% duty cycle assuming a 50-MHz input clock and **TnPWML** =0 (duty cycle would be 33% for the **TnPWML** =1 configuration). For this example, the start value is **GPTMnIRL**=0xC350 and the match value is **GPTMnMR**=0x411A.

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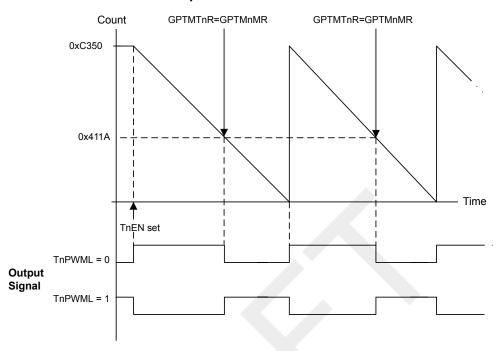


Figure 10-4. 16-Bit PWM Mode Example

10.3 Initialization and Configuration

To use the general-purpose timers, the peripheral clock must be enabled by setting the TIMERO, TIMER1, TIMER2, and TIMER3 bits in the **RCGC1** register.

This section shows module initialization and configuration examples for each of the supported timer modes.

10.3.1 32-Bit One-Shot/Periodic Timer Mode

The GPTM is configured for 32-bit One-Shot and Periodic modes by the following sequence:

- 1. Ensure the timer is disabled (the TAEN bit in the **GPTMCTL** register is cleared) before making any changes.
- 2. Write the **GPTM Configuration Register (GPTMCFG)** with a value of 0x0.
- 3. Set the TAMR field in the GPTM TimerA Mode Register (GPTMTAMR):
 - a. Write a value of 0x1 for One-Shot mode.
 - b. Write a value of 0x2 for Periodic mode.
- 4. Load the start value into the GPTM TimerA Interval Load Register (GPTMTAILR).
- If interrupts are required, set the TATOIM bit in the GPTM Interrupt Mask Register (GPTMIMR).
- 6. Set the TAEN bit in the **GPTMCTL** register to enable the timer and start counting.

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7. Poll the TATORIS bit in the GPTMRIS register or wait for the interrupt to be generated (if enabled). In both cases, the status flags are cleared by writing a 1 to the TATOCINT bit of the GPTM Interrupt Clear Register (GPTMICR).

In One-Shot mode, the timer stops counting after 7 on page 197. To re-enable the timer, repeat the sequence. A timer configured in Periodic mode does not stop counting after it times out.

10.3.2 32-Bit Real-Time Clock (RTC) Mode

To use the RTC mode, the timer must have a 32.768-KHz input signal on its CCP0, CCP2 or CCP4 pins. To enable the RTC feature, follow these steps:

- Ensure the timer is disabled (the TAEN bit is cleared) before making any changes.
- 2. Write the GPTM Configuration Register (GPTMCFG) with a value of 0x1.
- Write the desired match value to the GPTM TimerA Match Register (GPTMTAMATCHR).
- 4. Set/clear the RTCEN bit in the GPTM Control Register (GPTMCTL) as desired.
- If interrupts are required, set the RTCIM bit in the GPTM Interrupt Mask Register (GPTMIMR).
- 6. Set the TAEN bit in the **GPTMCTL** register to enable the timer and start counting.

When the timer count equals the value in the **GPTMTAMATCHR** register, the counter is re-loaded with 0x0000.0000 and begins counting. If an interrupt is enabled, it does not have to be cleared.

10.3.3 16-Bit One-Shot/Periodic Timer Mode

A timer is configured for 16-bit One-Shot and Periodic modes by the following sequence:

- Ensure the timer is disabled (the TnEN bit is cleared) before making any changes.
- 2. Write the GPTM Configuration Register (GPTMCFG) with a value of 0x4.
- 3. Set the TnMR field in the **GPTM Timer Mode (GPTMTnMR)** register:
 - a. Write a value of 0x1 for One-Shot mode.
 - b. Write a value of 0x2 for Periodic mode.
- If a prescaler is to be used, write the prescale value to the GPTM Timern Prescale Register (GPTMTnPR).
- Load the start value into the GPTM Timer Interval Load Register (GPTMTnILR).
- If interrupts are required, set the Thtolm bit in the GPTM Interrupt Mask Register (GPTMIMR).
- Set the TnEN bit in the GPTM Control Register (GPTMCTL) to enable the timer and start counting.
- 8. Poll the TnTORIS bit in the GPTMRIS register or wait for the interrupt to be generated (if enabled). In both cases, the status flags are cleared by writing a 1 to the TnTOCINT bit of the GPTM Interrupt Clear Register (GPTMICR).

In One-Shot mode, the timer stops counting after 8 on page 197. To re-enable the timer, repeat the sequence. A timer configured in Periodic mode does not stop counting after it times out.

10.3.4 16-Bit Input Edge Count Mode

A timer is configured to Input Edge Count mode by the following sequence:

- 1. Ensure the timer is disabled (the THEN bit is cleared) before making any changes.
- 2. Write the **GPTM Configuration (GPTMCFG)** register with a value of 0x4.
- 3. In the **GPTM Timer Mode (GPTMTnMR)** register, write the TnCMR field to 0x0 and the TnMR field to 0x3.
- 4. Configure the type of event(s) that the timer captures by writing the Tnevent field of the GPTM Control (GPTMCTL) register.
- Load the timer start value into the GPTM Timern Interval Load (GPTMTnILR) register.
- Load the desired event count into the GPTM Timern Match (GPTMTnMATCHR) register.
- 7. If interrupts are required, set the CnMIM bit in the GPTM Interrupt Mask (GPTMIMR) register.
- 8. Set the TnEN bit in the **GPTMCTL** register to enable the timer and begin waiting for edge events.
- 9. Poll the CnMRIS bit in the GPTMRIS register or wait for the interrupt to be generated (if enabled). In both cases, the status flags are cleared by writing a 1 to the CnMCINT bit of the GPTM Interrupt Clear (GPTMICR) register.

In Input Edge Count Mode, the timer stops after the desired number of edge events has been detected. To re-enable the timer, ensure that the TnEN bit is cleared and repeat steps 4 on page 198-9 on page 198.

10.3.5 16-Bit Input Edge Timing Mode

A timer is configured to Input Edge Timing mode by the following sequence:

- 1. Ensure the timer is disabled (the TnEN bit is cleared) before making any changes.
- 2. Write the **GPTM Configuration (GPTMCFG)** register with a value of 0x4.
- In the GPTM Timer Mode (GPTMTnMR) register, write the TnCMR field to 0x1 and the TnMR field to 0x3.
- 4. Configure the type of event that the timer captures by writing the Tnevent field of the **GPTM** Control (GPTMCTL) register.
- 5. Load the timer start value into the GPTM Timern Interval Load (GPTMTnILR) register.
- 6. If interrupts are required, set the Cneim bit in the GPTM Interrupt Mask (GPTMIMR) register.
- 7. Set the Then bit in the GPTM Control (GPTMCTL) register to enable the timer and start counting.
- 8. Poll the Cners bit in the **GPTMRIS** register or wait for the interrupt to be generated (if enabled). In both cases, the status flags are cleared by writing a 1 to the Cnecint bit of the **GPTM**

Interrupt Clear (GPTMICR) register. The time at which the event happened can be obtained by reading the **GPTM Timern (GPTMTnR)** register.

In Input Edge Timing mode, the timer continues running after an edge event has been detected, but the timer interval can be changed at any time by writing the **GPTMTnILR** register. The change takes effect at the next cycle after the write.

10.3.6 16-Bit PWM Mode

A timer is configured to PWM mode using the following sequence:

- 1. Ensure the timer is disabled (the TnEN bit is cleared) before making any changes.
- 2. Write the **GPTM Configuration (GPTMCFG)** register with a value of 0x4.
- 3. In the **GPTM Timer Mode (GPTMTnMR)** register, set the TnAMS bit to 0x1, the TnCMR bit to 0x0, and the TnMR field to 0x2.
- 4. Configure the output state of the PWM signal (whether or not it is inverted) in the TREVENT field of the GPTM Control (GPTMCTL) register.
- Load the timer start value into the GPTM Timern Interval Load (GPTMTnILR) register.
- 6. Load the GPTM Timern Match (GPTMTnMATCHR) register with the desired value.
- 7. Set the TnEN bit in the **GPTM Control (GPTMCTL)** register to enable the timer and begin generation of the output PWM signal.

In PWM Timing mode, the timer continues running after the PWM signal has been generated. The PWM period can be adjusted at any time by writing the **GPTMTnILR** register, and the change takes effect at the next cycle after the write.

10.4 Register Map

Table 10-2 on page 199 lists the GPTM registers. The offset listed is a hexadecimal increment to the register's address, relative to that timer's base address:

Timer0: 0x4003.0000 0x4003.0000

Timer1: 0x4003.1000 0x4003.1000

Timer2: 0x4003.2000 0x4003.2000

Timer3: 0x4003.3000 0x4003.3000

Table 10-2. Timers Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	GPTMCFG	R/W	0x0x0000.0000	GPTM Configuration	201
0x004	GPTMTAMR	R/W	0x0x0000.0000	GPTM TimerA Mode	202
0x008	GPTMTBMR	R/W	0x0x0000.0000	GPTM TimerB Mode	203
0x00C	GPTMCTL	R/W	0x0x0000.0000	GPTM Control	204

Offset	Name	Туре	Reset	Description	See page
0x018	GPTMIMR	R/W	0x0x0000.0000	GPTM Interrupt Mask	206
0x01C	GPTMRIS	RO	0x0x0000.0000	GPTM Raw Interrupt Status	208
0x020	GPTMMIS	RO	0x0x0000.0000	GPTM Masked Interrupt Status	209
0x024	GPTMICR	W1C	0x0x0000.0000	GPTM Interrupt Clear	210
0x028	GPTMTAILR	R/W	0x0000.FFFF (16-bit mode) 0xFFFF.FFFF (32-bit mode)	GPTM TimerA Interval Load	212
0x02C	GPTMTBILR	R/W	0x0000.FFFF	GPTM TimerB Interval Load	213
0x030	GPTMTAMATCHR	R/W	0x0000.FFFF (16-bit mode) 0xFFFF.FFFF (32-bit mode)	GPTM TimerA Match	214
0x034	GPTMTBMATCHR	R/W	0x0000.FFFF	GPTM TimerB Match	215
0x038	GPTMTAPR	R/W	0x0000.0000	GPTM TimerA Prescale	216
0x03C	GPTMTBPR	R/W	0x0000.0000	GPTM TimerB Prescale	217
0x040	GPTMTAPMR	R/W	0x0000.0000	GPTM TimerA Prescale Match	218
0x044	GPTMTBPMR	R/W	0x0000.0000	GPTM TimerB Prescale Match	219
0x048	GPTMTAR	RO	0x0000.FFFF (16-bit mode) 0xFFFF.FFFF (32-bit mode)	GPTM TimerA	220
0x04C	GPTMTBR	RO	0x0000.FFFF	GPTM TimerB	221

10.5 Register Descriptions

The remainder of this section lists and describes the GPTM registers, in numerical order by address offset.

Register 1: GPTM Configuration (GPTMCFG), offset 0x000

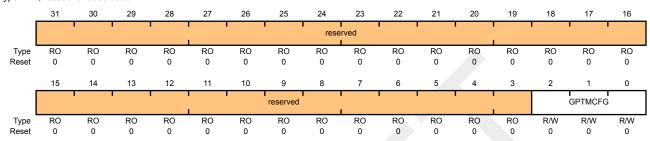
This register configures the global operation of the GPTM module. The value written to this register determines whether the GPTM is in 32- or 16-bit mode.

GPTM Configuration (GPTMCFG)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x000

Type R/W, reset 0x0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2:0	GPTMCFG	R/W	0	GPTM Configuration

0x0: 32-bit timer configuration.

0x1: 32-bit real-time clock (RTC) counter configuration.

0x2: Reserved.

0x3: Reserved.

0x4-0x7: 16-bit timer configuration, function is controlled by bits 1:0 of **GPTMTAMR** and **GPTMTBMR**.

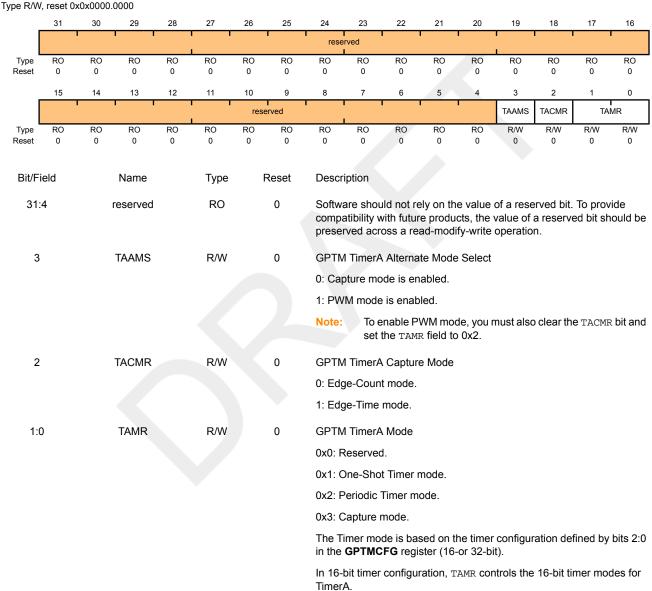
Register 2: GPTM TimerA Mode (GPTMTAMR), offset 0x004

This register configures the GPTM based on the configuration selected in the GPTMCFG register. When in 16-bit PWM mode, set the TAAMS bit to 0x1, the TACMR bit to 0x0, and the TAMR field to 0x2.

GPTM TimerA Mode (GPTMTAMR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x004



In 32-bit timer configuration, this register controls the mode and the

contents of GPTMTBMR are ignored.

Register 3: GPTM TimerB Mode (GPTMTBMR), offset 0x008

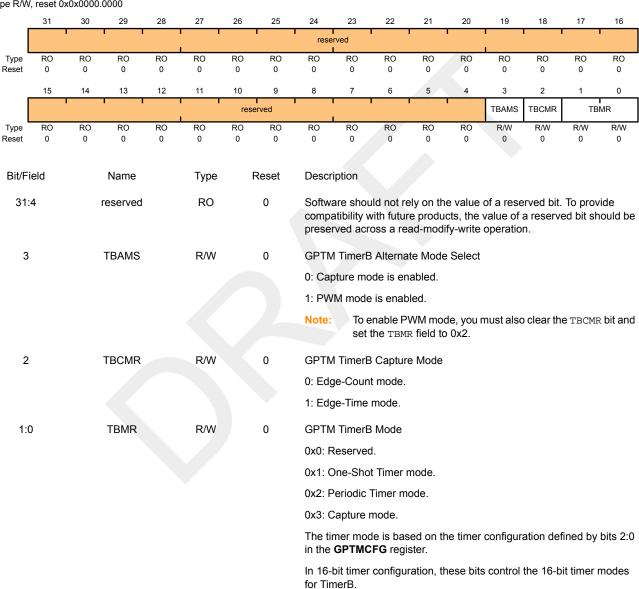
This register configures the GPTM based on the configuration selected in the GPTMCFG register. When in 16-bit PWM mode, set the TBAMS bit to 0x1, the TBCMR bit to 0x0, and the TBMR field to 0x2.

GPTM TimerB Mode (GPTMTBMR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x008

Type R/W, reset 0x0x0000.0000



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GPTMTAMR is used.

In 32-bit timer configuration, this register's contents are ignored and

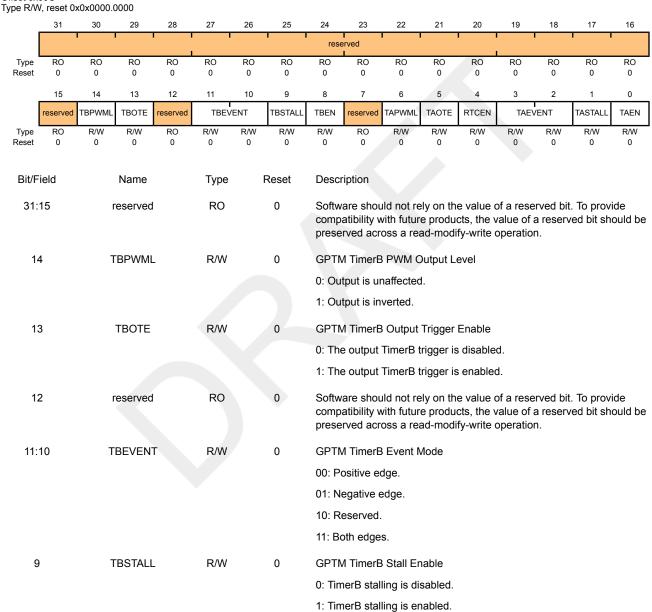
Register 4: GPTM Control (GPTMCTL), offset 0x00C

This register is used alongside the **GPTMCFG** and **GMTMTnMR** registers to fine-tune the timer configuration, and to enable other features such as timer stall and the output trigger. The output trigger can be used to initiate transfers on the ADC module.

GPTM Control (GPTMCTL)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x00C



Bit/Field	Name	Туре	Reset	Description
8	TBEN	R/W	0	GPTM TimerB Enable
				0: TimerB is disabled.
				1: TimerB is enabled and begins counting or the capture logic is enabled based on the GPTMCFG register.
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	TAPWML	R/W	0	GPTM TimerA PWM Output Level
				0: Output is unaffected.
				1: Output is inverted.
5	TAOTE	R/W	0	GPTM TimerA Output Trigger Enable
				0: The output TimerA trigger is disabled.
				1: The output TimerA trigger is enabled.
4	RTCEN	R/W	0	GPTM RTC Enable
				0: RTC counting is disabled.
				1: RTC counting is enabled.
3:2	TAEVENT	R/W	0	GPTM TimerA Event Mode
				00: Positive edge.
				01: Negative edge.
				10: Reserved.
				11: Both edges.
1	TASTALL	R/W	0	GPTM TimerA Stall Enable
				0: TimerA stalling is disabled.
				1: TimerA stalling is enabled.
0	TAEN	R/W	0	GPTM TimerA Enable
				0: TimerA is disabled.
				1: TimerA is enabled and begins counting or the capture logic is enabled based on the GPTMCFG register.

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Register 5: GPTM Interrupt Mask (GPTMIMR), offset 0x018

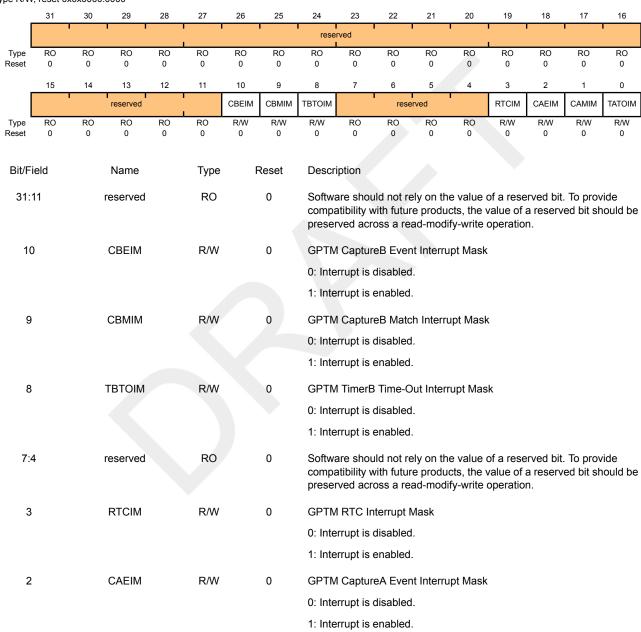
This register allows software to enable/disable GPTM controller-level interrupts. Writing a 1 enables the interrupt, while writing a 0 disables it.

GPTM Interrupt Mask (GPTMIMR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x018

Type R/W, reset 0x0x0000.0000



Bit/Field	Name	Type	Reset	Description
1	CAMIM	R/W	0	GPTM CaptureA Match Interrupt Mask
				0: Interrupt is disabled.
				1: Interrupt is enabled.
0	TATOIM	R/W	0	GPTM TimerA Time-Out Interrupt Mask
				0: Interrupt is disabled.
				1: Interrupt is enabled.



Register 6: GPTM Raw Interrupt Status (GPTMRIS), offset 0x01C

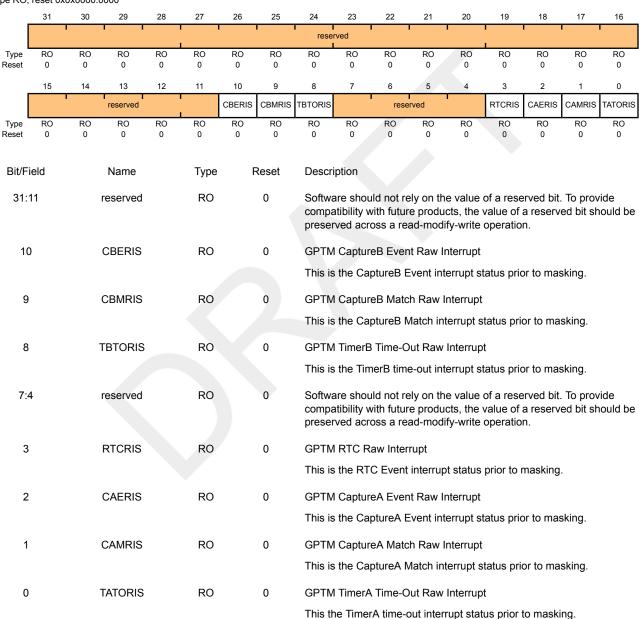
This register shows the state of the GPTM's internal interrupt signal. These bits are set whether or not the interrupt is masked in the **GPTMIMR** register. Each bit can be cleared by writing a 1 to its corresponding bit in **GPTMICR**.

GPTM Raw Interrupt Status (GPTMRIS)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x01C

Type RO, reset 0x0x0000.0000



Register 7: GPTM Masked Interrupt Status (GPTMMIS), offset 0x020

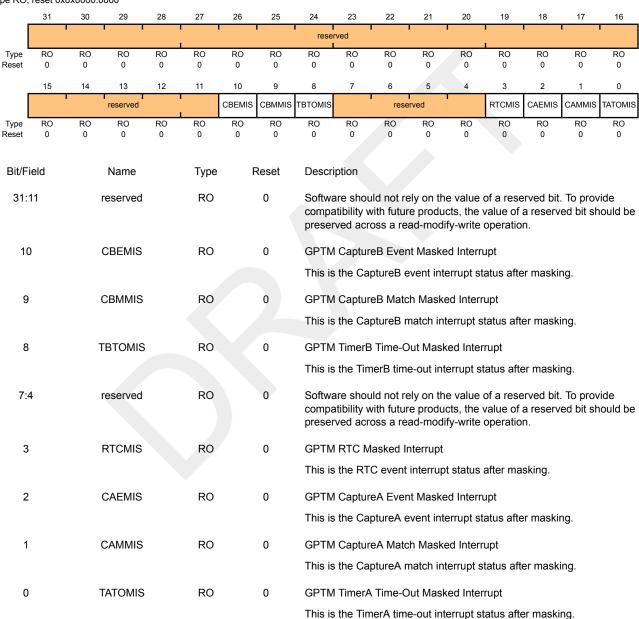
This register show the state of the GPTM's controller-level interrupt. If an interrupt is unmasked in **GPTMIMR**, and there is an event that causes the interrupt to be asserted, the corresponding bit is set in this register. All bits are cleared by writing a 1 to the corresponding bit in **GPTMICR**.

GPTM Masked Interrupt Status (GPTMMIS)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x020

Type RO, reset 0x0x0000.0000



Register 8: GPTM Interrupt Clear (GPTMICR), offset 0x024

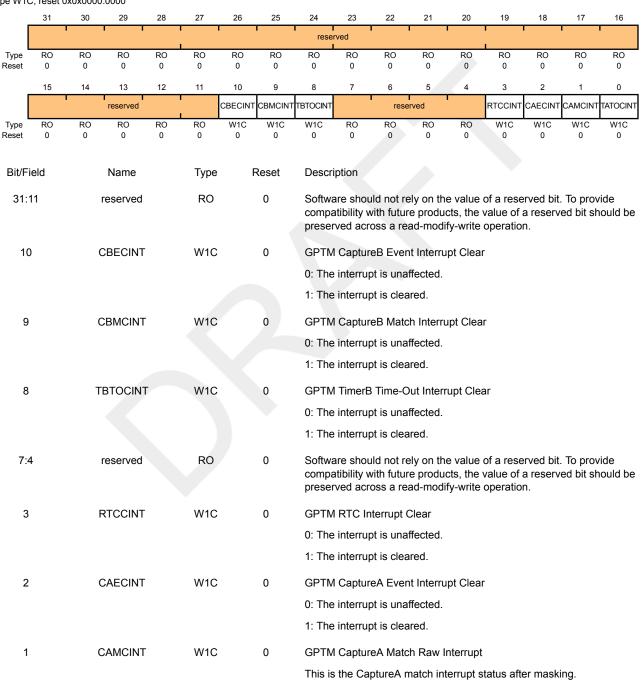
This register is used to clear the status bits in the **GPTMRIS** and **GPTMMIS** registers. Writing a 1 to a bit clears the corresponding bit in the **GPTMRIS** and **GPTMMIS** registers.

GPTM Interrupt Clear (GPTMICR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x024

Type W1C, reset 0x0x0000.0000



Bit/Field	Name	Туре	Reset	Description
0	TATOCINT	W1C	0	GPTM TimerA Time-Out Raw Interrupt
				0: The interrupt is unaffected.
				1: The interrupt is cleared.



Register 9: GPTM TimerA Interval Load (GPTMTAILR), offset 0x028

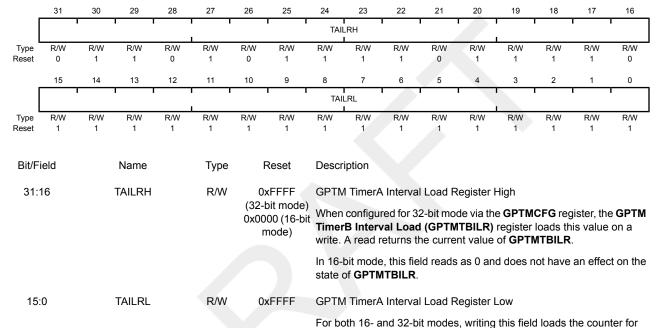
This register is used to load the starting count value into the timer. When GPTM is configured to one of the 32-bit modes, **GPTMTAILR** appears as a 32-bit register (the upper 16-bits correspond to the contents of the **GPTM TimerB Interval Load (GPTMTBILR)** register). In 16-bit mode, the upper 16 bits of this register read as 0s and have no effect on the state of **GPTMTBILR**.

GPTM TimerA Interval Load (GPTMTAILR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x028

Type R/W, reset 0x0000.FFFF (16-bit mode) and 0xFFFF.FFFF (32-bit mode)



TimerA. A read returns the current value of **GPTMTAILR**.

Register 10: GPTM TimerB Interval Load (GPTMTBILR), offset 0x02C

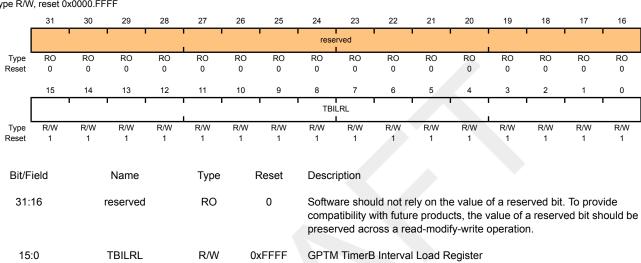
This register is used to load the starting count value into TimerB. When the GPTM is configured to a 32-bit mode, **GPTMTBILR** returns the current value of TimerB and ignores writes.

GPTM TimerB Interval Load (GPTMTBILR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x02C

Type R/W, reset 0x0000.FFFF



When the GPTM is not configured as a 32-bit timer, a write to this field updates GPTMTBILR. In 32-bit mode, writes are ignored, and reads return the current value of **GPTMTBILR**.

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Register 11: GPTM TimerA Match (GPTMTAMATCHR), offset 0x030

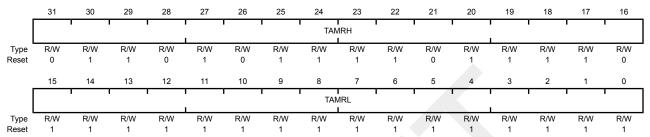
This register is used in 32-bit Real-Time Clock mode and 16-bit PWM and Input Edge Count modes.

GPTM TimerA Match (GPTMTAMATCHR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x030

Type R/W, reset 0x0000.FFFF (16-bit mode) and 0xFFFF.FFFF (32-bit mode)



Bit/Field Type Reset Description Name 31:16 **TAMRH** R/W 0xFFFF **GPTM TimerA Match Register High**

R/W

(32-bit mode) 0x0000 (16-bit mode)

0xFFFF

When configured for 32-bit Real-Time Clock (RTC) mode via the GPTMCFG register, this value is compared to the upper half of

GPTMTAR, to determine match events.

In 16-bit mode, this field reads as 0 and does not have an effect on the state of GPTMTBMATCHR.

GPTM TimerA Match Register Low

When configured for 32-bit Real-Time Clock (RTC) mode via the GPTMCFG register, this value is compared to the lower half of **GPTMTAR**, to determine match events.

When configured for PWM mode, this value along with GPTMTAILR, determines the duty cycle of the output PWM signal.

When configured for Edge Count mode, this value along with GPTMTAILR, determines how many edge events are counted. The total number of edge events counted is equal to the value in GPTMTAILR minus this value.

Register 12: GPTM TimerB Match (GPTMTBMATCHR), offset 0x034

This register is used in 32-bit Real-Time Clock mode and 16-bit PWM and Input Edge Count modes.

GPTM TimerB Match (GPTMTBMATCHR)

TBMRL

R/W

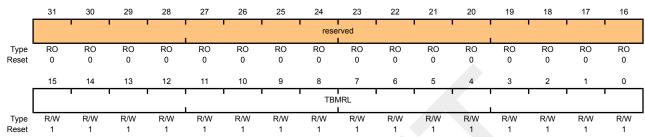
0xFFFF

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x034

15:0

Type R/W, reset 0x0000.FFFF



Bit/Field	Name	Туре	Reset	Description
31:16	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

GPTM TimerB Match Register Low

When configured for PWM mode, this value along with **GPTMTBILR**, determines the duty cycle of the output PWM signal.

When configured for Edge Count mode, this value along with **GPTMTBILR**, determines how many edge events are counted. The total number of edge events counted is equal to the value in **GPTMTBILR** minus this value.

Register 13: GPTM TimerA Prescale (GPTMTAPR), offset 0x038

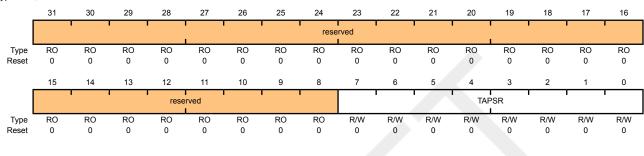
This register allows software to extend the range of the 16-bit timers when operating in one-shot or periodic mode.

GPTM TimerA Prescale (GPTMTAPR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x038

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	TAPSR	R/W	0	GPTM TimerA Prescale

The register loads this value on a write. A read returns the current value of the register.

Refer to Table 10-1 on page 193 for more details and an example.

Register 14: GPTM TimerB Prescale (GPTMTBPR), offset 0x03C

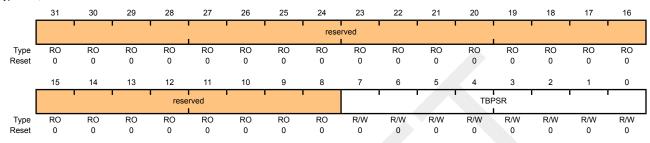
This register allows software to extend the range of the 16-bit timers when operating in one-shot or periodic mode.

GPTM TimerB Prescale (GPTMTBPR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x03C

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	TBPSR	R/W	0	GPTM TimerB Prescale

The register loads this value on a write. A read returns the current value of this register.

Refer to Table 10-1 on page 193 for more details and an example.

Register 15: GPTM TimerA Prescale Match (GPTMTAPMR), offset 0x040

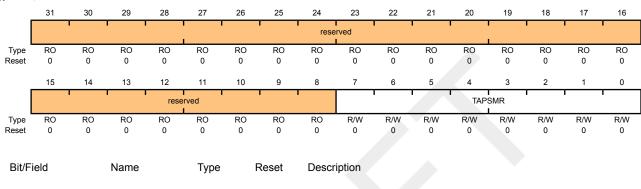
This register effectively extends the range of **GPTMTAMATCHR** to 24 bits when operating in 16-bit one-shot or periodic mode.

GPTM TimerA Prescale Match (GPTMTAPMR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x040

Type R/W, reset 0x0000.0000



31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	TAPSMR	R/W	0	GPTM TimerA Prescale Match

This value is used alongside **GPTMTAMATCHR** to detect timer match events while using a prescaler.

Register 16: GPTM TimerB Prescale Match (GPTMTBPMR), offset 0x044

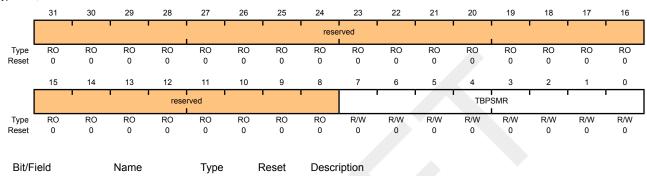
This register effectively extends the range of **GPTMTBMATCHR** to 24 bits when operating in 16-bit one-shot or periodic mode.

GPTM TimerB Prescale Match (GPTMTBPMR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x044

Type R/W, reset 0x0000.0000



31:8 reserved RO 0 Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

7:0 TBPSMR R/W 0 GPTM TimerB Prescale Match

This value is used alongside **GPTMTBMATCHR** to detect timer match events while using a prescaler.

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Register 17: GPTM TimerA (GPTMTAR), offset 0x048

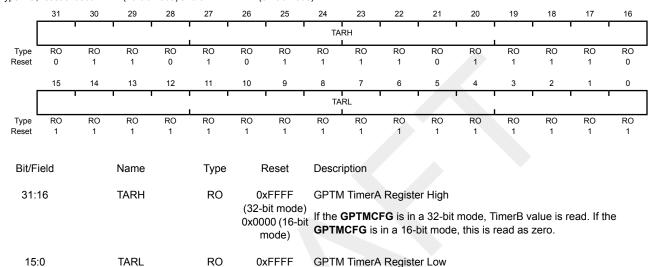
This register shows the current value of the TimerA counter in all cases except for Input Edge Count mode. When in this mode, this register contains the time at which the last edge event took place.

GPTM TimerA (GPTMTAR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x048

Type RO, reset 0x0000.FFFF (16-bit mode) and 0xFFFF.FFFF (32-bit mode)



A read returns the current value of the **GPTM TimerA Count Register**, except in Input Edge Count mode, when it returns the timestamp from the last edge event.

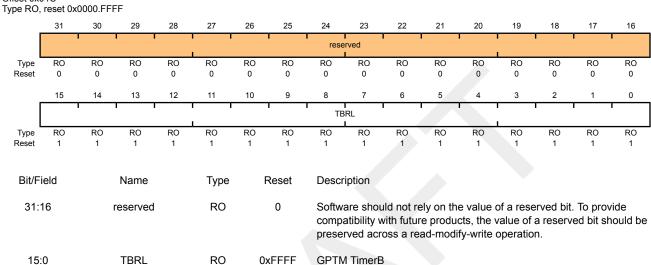
Register 18: GPTM TimerB (GPTMTBR), offset 0x04C

This register shows the current value of the TimerB counter in all cases except for Input Edge Count mode. When in this mode, this register contains the time at which the last edge event took place.

GPTM TimerB (GPTMTBR)

Timer0 base: 0x4003.0000 Timer1 base: 0x4003.1000 Timer2 base: 0x4003.2000 Timer3 base: 0x4003.3000

Offset 0x04C



A read returns the current value of the GPTM TimerB Count Register, except in Input Edge Count mode, when it returns the timestamp from the last edge event.

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11 Watchdog Timer

WDT

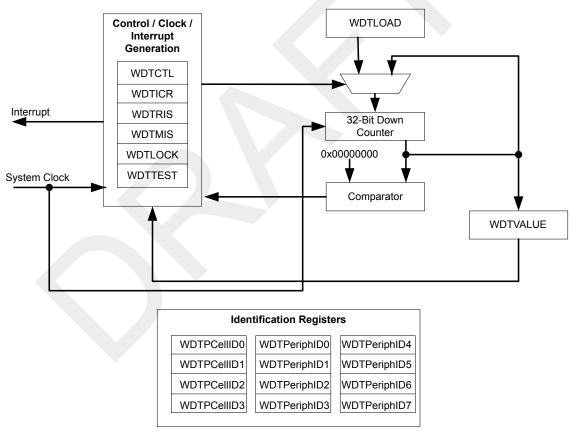
A watchdog timer can generate nonmaskable interrupts (NMIs) or a reset when a time-out value is reached. The watchdog timer is used to regain control when a system has failed due to a software error or due to the failure of an external device to respond in the expected way.

The Stellaris[®] Watchdog Timer module consists of a 32-bit down counter, a programmable load register, interrupt generation logic, a locking register, and user-enabled stalling.

The Watchdog Timer can be configured to generate an interrupt to the controller on its first time-out, and to generate a reset signal on its second time-out. Once the Watchdog Timer has been configured, the lock register can be written to prevent the timer configuration from being inadvertently altered.

11.1 Block Diagram

Figure 11-1. WDT Module Block Diagram



11.2 Functional Description

The Watchdog Timer module consists of a 32-bit down counter, a programmable load register, interrupt generation logic, and a locking register. Once the Watchdog Timer has been configured,

the **Watchdog Timer Lock (WDTLOCK)** register is written, which prevents the timer configuration from being inadvertently altered by software.

The Watchdog Timer module generates the first time-out signal when the 32-bit counter reaches the zero state after being enabled; enabling the counter also enables the watchdog timer interrupt. After the first time-out event, the 32-bit counter is re-loaded with the value of the **Watchdog Timer Load (WDTLOAD)** register, and the timer resumes counting down from that value.

If the timer counts down to its zero state again before the first time-out interrupt is cleared, and the reset signal has been enabled (via the WatchdogResetEnable function), the Watchdog timer asserts its reset signal to the system. If the interrupt is cleared before the 32-bit counter reaches its second time-out, the 32-bit counter is loaded with the value in the **WDTLOAD** register, and counting resumes from that value.

If **WDTLOAD** is written with a new value while the Watchdog Timer counter is counting, then the counter is loaded with the new value and continues counting.

Writing to **WDTLOAD** does not clear an active interrupt. An interrupt must be specifically cleared by writing to the **Watchdog Interrupt Clear (WDTICR)** register.

The Watchdog module interrupt and reset generation can be enabled or disabled as required. When the interrupt is re-enabled, the 32-bit counter is preloaded with the load register value and not its last state.

11.3 Initialization and Configuration

To use the WDT, its peripheral clock must be enabled by setting the WDT bit in the **RCGC0** register. The Watchdog Timer is configured using the following sequence:

- 1. Load the **WDTLOAD** register with the desired timer load value.
- If the Watchdog is configured to trigger system resets, set the RESEN bit in the WDTCTL register.
- Set the INTEN bit in the WDTCTL register to enable the Watchdog and lock the control register.

If software requires that all of the watchdog registers are locked, the Watchdog Timer module can be fully locked by writing any value to the **WDTLOCK** register. To unlock the Watchdog Timer, write a value of 0x1ACCF551.

11.4 Register Map

Table 11-1 on page 223 lists the Watchdog registers. The offset listed is a hexadecimal increment to the register's address, relative to the Watchdog Timer base address of 0x4000.0000.

Table 11-1. Watchdog Timer Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	WDTLOAD	R/W	0xFFFF.FFFF	Watchdog Load	225
0x004	WDTVALUE	RO	0xFFFF.FFFF	Watchdog Value	226
0x008	WDTCTL	R/W	0x0000.0000	Watchdog Control	227
0x00C	WDTICR	WO	-	Watchdog Interrupt Clear	228
0x010	WDTRIS	RO	0x0000.0000	Watchdog Raw Interrupt Status	229

Offset	Name	Туре	Reset	Description	See page
0x014	WDTMIS	RO	0x0000.0000	Watchdog Masked Interrupt Status	230
0x418	WDTTEST	R/W	0x0000.0000	Watchdog Test	231
0xC00	WDTLOCK	R/W	0x0000.0000	Watchdog Lock	232
0xFD0	WDTPeriphID4	RO	0x0000.0000	Watchdog Peripheral Identification 4	233
0xFD4	WDTPeriphID5	RO	0x0000.0000	Watchdog Peripheral Identification 5	234
0xFD8	WDTPeriphID6	RO	0x0000.0000	Watchdog Peripheral Identification 6	235
0xFDC	WDTPeriphID7	RO	0x0000.0000	Watchdog Peripheral Identification 7	236
0xFE0	WDTPeriphID0	RO	0x0000.0005	Watchdog Peripheral Identification 0	237
0xFE4	WDTPeriphID1	RO	0x0000.0018	Watchdog Peripheral Identification 1	238
0xFE8	WDTPeriphID2	RO	0x0000.0018	Watchdog Peripheral Identification 2	239
0xFEC	WDTPeriphID3	RO	0x0000.0001	Watchdog Peripheral Identification 3	240
0xFF0	WDTPCellID0	RO	0x0000.000D	Watchdog PrimeCell Identification 0	241
0xFF4	WDTPCellID1	RO	0x0000.00F0	Watchdog PrimeCell Identification 1	242
0xFF8	WDTPCellID2	RO	0x0000.0005	Watchdog PrimeCell Identification 2	243
0xFFC	WDTPCellID3	RO	0x0000.00B1	Watchdog PrimeCell Identification 3	244

11.5 Register Descriptions

The remainder of this section lists and describes the WDT registers, in numerical order by address offset.

Register 1: Watchdog Load (WDTLOAD), offset 0x000

This register is the 32-bit interval value used by the 32-bit counter. When this register is written, the value is immediately loaded and the counter restarts counting down from the new value. If the **WDTLOAD** register is loaded with 0x0000.0000, an interrupt is immediately generated.

Watchdog Load (WDTLOAD)

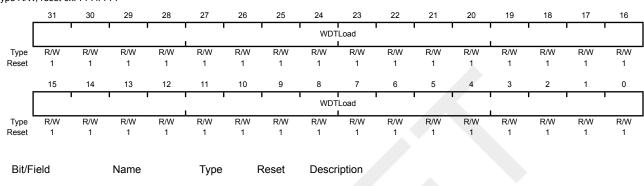
Base 0x4000.0000

31:0

WDTLoad

R/W

Offset 0x000 Type R/W, reset 0xFFFF.FFF



0xFFFF.FFFF Watchdog Load Value

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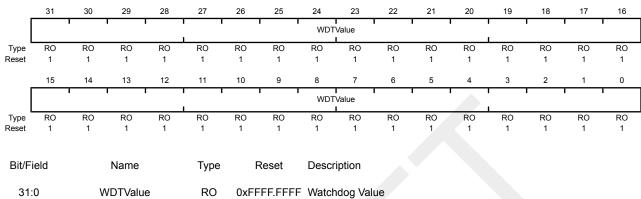
Register 2: Watchdog Value (WDTVALUE), offset 0x004

This register contains the current count value of the timer.

Watchdog Value (WDTVALUE)

Base 0x4000.0000

Offset 0x004
Type RO, reset 0xFFFF.FFF



Current value of the 32-bit down counter.

Register 3: Watchdog Control (WDTCTL), offset 0x008

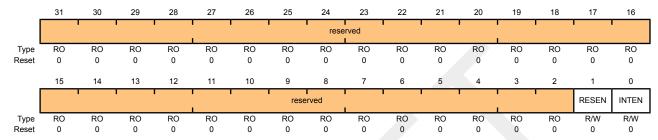
This register is the watchdog control register. The watchdog timer can be configured to generate a reset signal (on second time-out) or an interrupt on time-out.

When the watchdog interrupt has been enabled, all subsequent writes to the control register are ignored. The only mechanism that can re-enable writes is a hardware reset.

Watchdog Control (WDTCTL)

Base 0x4000.0000 Offset 0x008

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	RESEN	R/W	0	Watchdog Reset Enable
				0: Disabled.
				1: Enable the Watchdog module reset output.
0	INTEN	R/W	0	Watchdog Interrupt Enable

0: Interrupt event disabled (once this bit is set, it can only be cleared by a hardware reset).

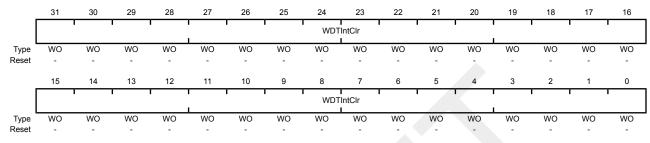
^{1:} Interrupt event enabled. Once enabled, all writes are ignored.

Register 4: Watchdog Interrupt Clear (WDTICR), offset 0x00C

This register is the interrupt clear register. A write of any value to this register clears the Watchdog interrupt and reloads the 32-bit counter from the **WDTLOAD** register. Value for a read or reset is indeterminate.

Watchdog Interrupt Clear (WDTICR)

Base 0x4000.0000 Offset 0x00C Type WO, reset -



Bit/Field	Name	Type	Reset	Description
31:0	WDTIntClr	WO	-	Watchdog Interrupt Clear

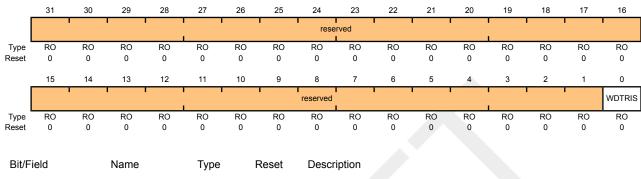
Register 5: Watchdog Raw Interrupt Status (WDTRIS), offset 0x010

This register is the raw interrupt status register. Watchdog interrupt events can be monitored via this register if the controller interrupt is masked.

Watchdog Raw Interrupt Status (WDTRIS)

Base 0x4000.0000

Offset 0x010 Type RO, reset 0x0000.0000



31:1 reserved RO 0 Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

0 WDTRIS RO 0 Watchdog Raw Interrupt Status

Gives the raw interrupt state (prior to masking) of WDTINTR.

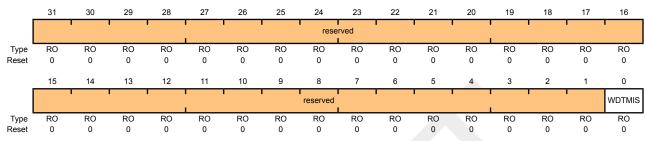
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Register 6: Watchdog Masked Interrupt Status (WDTMIS), offset 0x014

This register is the masked interrupt status register. The value of this register is the logical AND of the raw interrupt bit and the Watchdog interrupt enable bit.

Watchdog Masked Interrupt Status (WDTMIS)

Base 0x4000.0000 Offset 0x014 Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	WDTMIS	RO	0	Watchdog Masked Interrupt Status

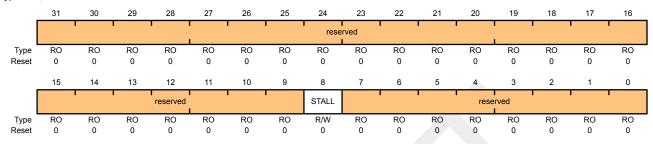
Gives the masked interrupt state (after masking) of the WDTINTR interrupt.

Register 7: Watchdog Test (WDTTEST), offset 0x418

This register provides user-enabled stalling when the microcontroller asserts the CPU halt flag during debug.

Watchdog Test (WDTTEST)

Base 0x4000.0000 Offset 0x418 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:9	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	STALL	R/W	0	Watchdog Stall Enable When set to 1, if the Stellaris® microcontroller is stopped with a debugger, the watchdog timer stops counting. Once the microcontroller is restarted, the watchdog timer resumes counting.
7:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be

preserved across a read-modify-write operation.

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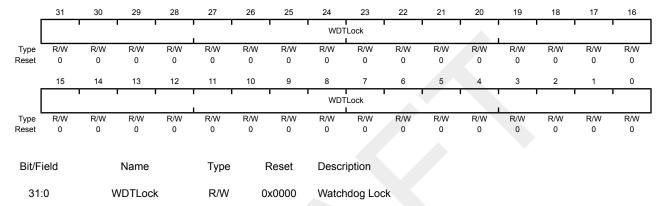
Register 8: Watchdog Lock (WDTLOCK), offset 0xC00

Writing 0x1ACCE551 to the **WDTLOCK** register enables write access to all other registers. Writing any other value to the **WDTLOCK** register re-enables the locked state for register writes to all the other registers. Reading the **WDTLOCK** register returns the lock status rather than the 32-bit value written. Therefore, when write accesses are disabled, reading the **WDTLOCK** register returns 0x0000.0001 (when locked; otherwise, the returned value is 0x0000.0000 (unlocked)).

Watchdog Lock (WDTLOCK)

Base 0x4000.0000 Offset 0xC00

Type R/W, reset 0x0000.0000



A write of the value 0x1ACCE551 unlocks the watchdog registers for write access. A write of any other value reapplies the lock, preventing any register updates.

A read of this register returns the following values:

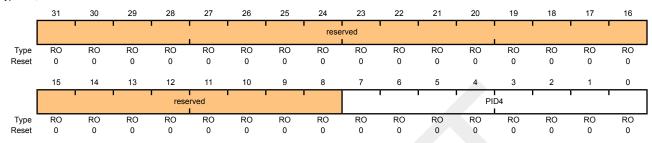
Locked: 0x0000.0001 Unlocked: 0x0000.0000

Register 9: Watchdog Peripheral Identification 4 (WDTPeriphID4), offset 0xFD0

The WDTPeriphIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 4 (WDTPeriphID4)

Base 0x4000.0000 Offset 0xFD0 Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID4	RO	0x00	WDT Peripheral ID Register[7:0]

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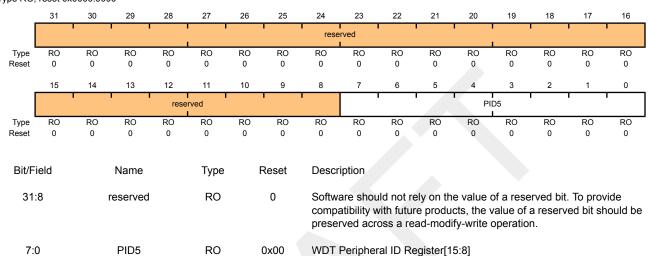
Register 10: Watchdog Peripheral Identification 5 (WDTPeriphID5), offset 0xFD4

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 5 (WDTPeriphID5)

Base 0x4000.0000

Offset 0xFD4
Type RO, reset 0x0000.0000



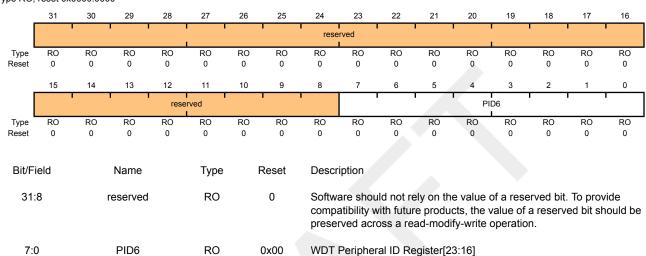
Register 11: Watchdog Peripheral Identification 6 (WDTPeriphID6), offset 0xFD8

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 6 (WDTPeriphID6)

Base 0x4000.0000

Offset 0xFD8
Type RO, reset 0x0000.0000



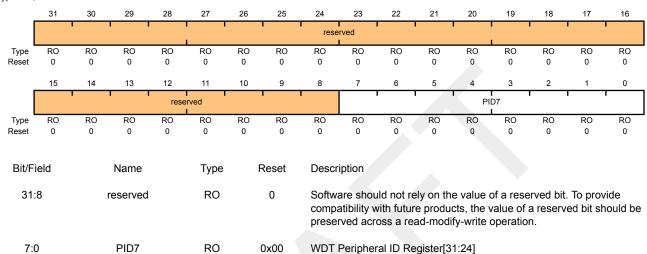
Register 12: Watchdog Peripheral Identification 7 (WDTPeriphID7), offset 0xFDC

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 7 (WDTPeriphID7)

Base 0x4000.0000

Offset 0xFDC Type RO, reset 0x0000.0000



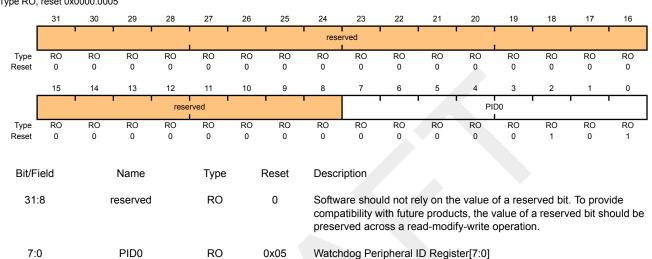
Register 13: Watchdog Peripheral Identification 0 (WDTPeriphID0), offset 0xFE0

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 0 (WDTPeriphID0)

Base 0x4000.0000

Offset 0xFE0
Type RO, reset 0x0000.0005



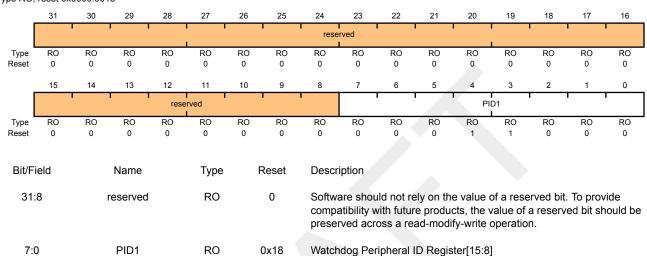
Register 14: Watchdog Peripheral Identification 1 (WDTPeriphID1), offset 0xFE4

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 1 (WDTPeriphID1)

Base 0x4000.0000

Offset 0xFE4
Type RO, reset 0x0000.0018



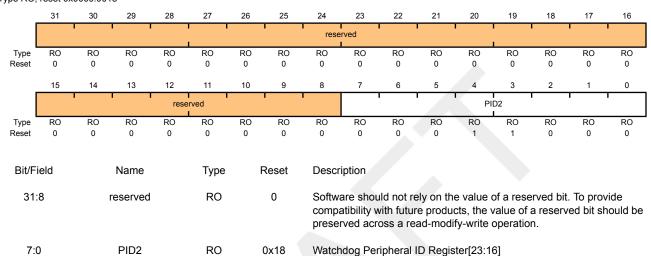
Register 15: Watchdog Peripheral Identification 2 (WDTPeriphID2), offset 0xFE8

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 2 (WDTPeriphID2)

Base 0x4000.0000

Offset 0xFE8
Type RO, reset 0x0000.0018



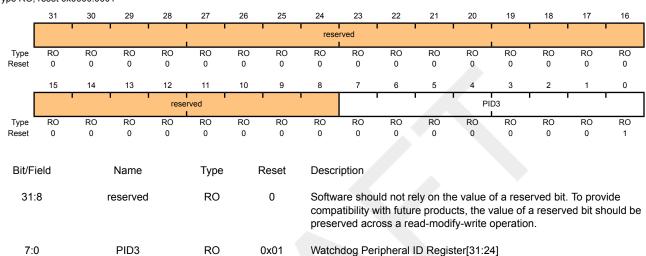
Register 16: Watchdog Peripheral Identification 3 (WDTPeriphID3), offset 0xFEC

The **WDTPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

Watchdog Peripheral Identification 3 (WDTPeriphID3)

Base 0x4000.0000

Offset 0xFEC Type RO, reset 0x0000.0001

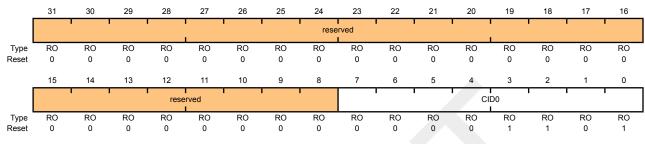


Register 17: Watchdog PrimeCell Identification 0 (WDTPCellID0), offset 0xFF0

The WDTPCellIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog PrimeCell Identification 0 (WDTPCellID0)

Base 0x4000.0000 Offset 0xFF0 Type RO, reset 0x0000.000D



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID0	RO	0x0D	Watchdog PrimeCell ID Register[7:0]

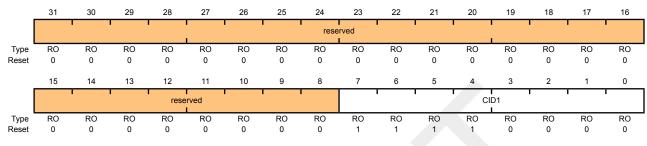
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Register 18: Watchdog PrimeCell Identification 1 (WDTPCellID1), offset 0xFF4

The WDTPCellIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog PrimeCell Identification 1 (WDTPCellID1)

Base 0x4000.0000 Offset 0xFF4 Type RO, reset 0x0000.00F0



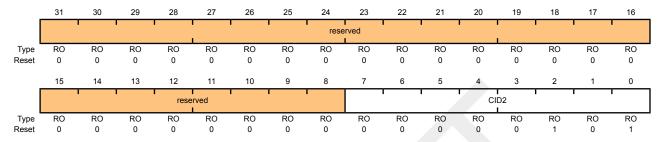
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID1	RO	0xF0	Watchdog PrimeCell ID Register[15:8]

Register 19: Watchdog PrimeCell Identification 2 (WDTPCellID2), offset 0xFF8

The WDTPCellIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog PrimeCell Identification 2 (WDTPCellID2)

Base 0x4000.0000 Offset 0xFF8 Type RO, reset 0x0000.0005



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID2	RO	0x05	Watchdog PrimeCell ID Register[23:16]

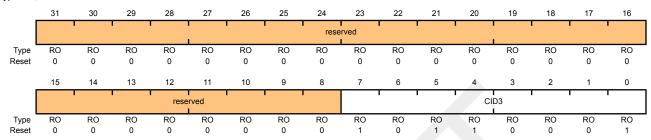
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Register 20: Watchdog PrimeCell Identification 3 (WDTPCellID3), offset 0xFFC

The WDTPCellIDn registers are hard-coded and the fields within the register determine the reset value.

Watchdog PrimeCell Identification 3 (WDTPCellID3)

Base 0x4000.0000 Offset 0xFFC Type RO, reset 0x0000.00B1



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID3	RO	0xB1	Watchdog PrimeCell ID Register[31:24]

12 Analog-to-Digital Converter (ADC)

ADC

An analog-to-digital converter (ADC) is a peripheral that converts a continuous analog voltage to a discrete digital number.

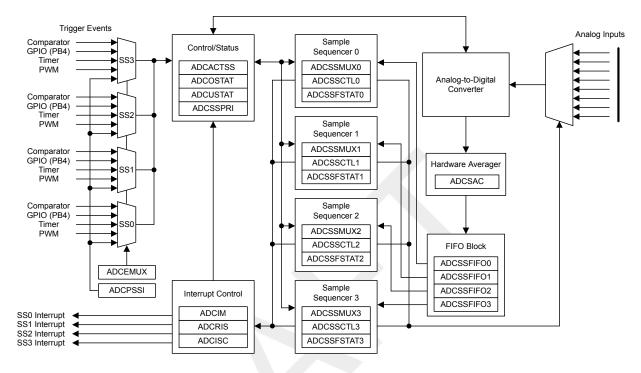
The Stellaris[®] ADC module features 10-bit conversion resolution and supports eight input channels, plus an internal temperature sensor. The ADC module contains a programmable sequencer which allows for the sampling of multiple analog input sources without controller intervention. Each sample sequence provides flexible programming with fully configurable input source, trigger events, interrupt generation, and sequence priority.

The Stellaris® ADC provides the following features:

- Eight analog input channels
- Single-ended and differential-input configurations
- Internal temperature sensor
- Sample rate of one million samples/second
- Four programmable sample conversion sequences from one to eight entries long, with corresponding conversion result FIFOs
- Flexible trigger control
 - Controller (software)
 - Timers
 - GPIO
- Hardware averaging of up to 64 samples for improved accuracy

12.1 Block Diagram

Figure 12-1. ADC Module Block Diagram



12.2 Functional Description

The Stellaris[®] ADC collects sample data by using a programmable sequence-based approach instead of the traditional single or double-sampling approach found on many ADC modules. Each *sample sequence* is a fully programmed series of consecutive (back-to-back) samples, allowing the ADC to collect data from multiple input sources without having to be re-configured or serviced by the controller. The programming of each sample in the sample sequence includes parameters such as the input source and mode (differential versus single-ended input), interrupt generation on sample completion, and the indicator for the last sample in the sequence.

12.2.1 Sample Sequencers

The sampling control and data capture is handled by the Sample Sequencers. All of the sequencers are identical in implementation except for the number of samples that can be captured and the depth of the FIFO. Table 12-1 on page 246 shows the maximum number of samples that each Sequencer can capture and its corresponding FIFO depth. In this implementation, each FIFO entry is a 32-bit word, with the lower 10 bits containing the conversion result.

Table 12-1. Samples and FIFO Depth of Sequencers

Sequencer	Number of Samples	Depth of FIFO
SS3	1	1
SS2	4	4
SS1	4	4
SS0	8	8

For a given sample sequence, each sample is defined by two 4-bit nibbles in the ADC Sample Sequence Input Multiplexer Select (ADCSSMUXn) and ADC Sample Sequence Control (ADCSSCTLn) registers, where "n" corresponds to the sequence number. The ADCSSMUXn nibbles select the input pin, while the ADCSSCTLn nibbles contain the sample control bits corresponding to parameters such as temperature sensor selection, interrupt enable, end of sequence, and differential input mode. Sample Sequencers are enabled by setting the respective ASENn bit in the ADC Active Sample Sequencer (ADCACTSS) register, but can be configured before being enabled.

When configuring a sample sequence, multiple uses of the same input pin within the same sequence is allowed. In the **ADCSSCTLn** register, the Interrupt Enable (IE) bits can be set for any combination of samples, allowing interrupts to be generated after every sample in the sequence if necessary. Also, the END bit can be set at any point within a sample sequence. For example, if Sequencer 0 is used, the END bit can be set in the nibble associated with the fifth sample, allowing Sequencer 0 to complete execution of the sample sequence after the fifth sample.

After a sample sequence completes execution, the result data can be retrieved from the **ADC Sample Sequence Result FIFO (ADCSSFIFOn)** registers. The FIFOs are simple circular buffers that read a single address to "pop" result data. For software debug purposes, the positions of the FIFO head and tail pointers are visible in the **ADC Sample Sequence FIFO Status (ADCSSFSTATn)** registers along with FULL and EMPTY status flags. Overflow and underflow conditions are monitored using the **ADCOSTAT** and **ADCUSTAT** registers.

12.2.2 Module Control

Outside of the Sample Sequencers, the remainder of the control logic is responsible for tasks such as interrupt generation, sequence prioritization, and trigger configuration.

Most of the ADC control logic runs at the ADC clock rate of 14-18 MHz. The internal ADC divider is configured automatically by hardware when the system XTAL is selected. The automatic clock divider configuration targets 16.667 MHz operation for all Stellaris[®] devices.

12.2.2.1 Interrupts

The Sample Sequencers dictate the events that cause interrupts, but they don't have control over whether the interrupt is actually sent to the interrupt controller. The ADC module's interrupt signal is controlled by the state of the MASK bits in the ADC Interrupt Mask (ADCIM) register. Interrupt status can be viewed at two locations: the ADC Raw Interrupt Status (ADCRIS) register, which shows the raw status of a Sample Sequencer's interrupt signal, and the ADC Interrupt Status and Clear (ADCISC) register, which shows the logical AND of the ADCRIS register's INR bit and the ADCIM register's MASK bits. Interrupts are cleared by writing a 1 to the corresponding IN bit in ADCISC.

12.2.2.2 Prioritization

When sampling events (triggers) happen concurrently, they are prioritized for processing by the values in the **ADC Sample Sequencer Priority (ADCSSPRI)** register. Valid priority values are in the range of 0-3, with 0 being the highest priority and 3 being the lowest. Multiple active Sample Sequencer units with the same priority do not provide consistent results, so software must ensure that all active Sample Sequencer units have a unique priority value.

12.2.2.3 Sampling Events

Sample triggering for each Sample Sequencer is defined in the **ADC Event Multiplexer Select** (**ADCEMUX**) register. The external peripheral triggering sources vary by Stellaris[®] family member,

but all devices share the "Controller" and "Always" triggers. Software can initiate sampling by setting the CH bits in the ADC Processor Sample Sequence Initiate (ADCPSSI) register.

When using the "Always" trigger, care must be taken. If a sequence's priority is too high, it is possible to starve other lower priority sequences.

12.2.3 Hardware Sample Averaging Circuit

Higher precision results can be generated using the hardware averaging circuit, however, the improved results are at the cost of throughput. Up to 64 samples can be accumulated and averaged to form a single data entry in the sequencer FIFO. Throughput is decreased proportionally to the number of samples in the averaging calculation. For example, if the averaging circuit is configured to average 16 samples, the throughput is decreased by a factor of 16.

By default the averaging circuit is off and all data from the converter passes through to the sequencer FIFO. The averaging hardware is controlled by the **ADC Sample Averaging Control (ADCSAC)** register (see page 261). There is a single averaging circuit and all input channels receive the same amount of averaging whether they are single-ended or differential.

12.2.4 Analog-to-Digital Converter

The converter itself generates a 10-bit output value for selected analog input. Special analog pads are used to minimize the distortion on the input.

12.2.5 Test Modes

There is a user-available test mode that allows for loopback operation within the digital portion of the ADC module. This can be useful for debugging software without having to provide actual analog stimulus. This mode is available through the **ADC Test Mode Loopback (ADCTMLB)** register (see page 276).

12.2.6 Internal Temperature Sensor

The internal temperature sensor provides an analog temperature reading as well as a reference voltage. The voltage at the output terminal SENSO is given by the following equation:

$$SENSO = 2.7 - ((T + 55) / 75)$$

This relation is shown in Figure 12-2 on page 249.

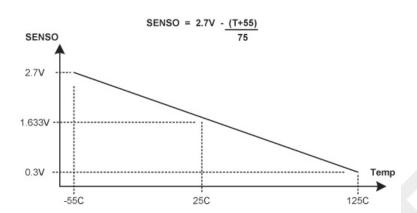


Figure 12-2. Internal Temperature Sensor Characteristic

12.3 Initialization and Configuration

In order for the ADC module to be used, the PLL must be enabled and using a supported crystal frequency (see the **RCC** register). Using unsupported frequencies can cause faulty operation in the ADC module.

12.3.1 Module Initialization

Initialization of the ADC module is a simple process with very few steps. The main steps include enabling the clock to the ADC and reconfiguring the Sample Sequencer priorities (if needed).

The initialization sequence for the ADC is as follows:

- 1. Enable the ADC clock by writing a value of 0x0001.0000 to the RCGC1 register (see page 91).
- If required by the application, reconfigure the Sample Sequencer priorities in the ADCSSPRI
 register. The default configuration has Sample Sequencer 0 with the highest priority, and Sample
 Sequencer 3 as the lowest priority.

12.3.2 Sample Sequencer Configuration

Configuration of the Sample Sequencers is slightly more complex than the module initialization since each sample sequence is completely programmable.

The configuration for each Sample Sequencer should be as follows:

- Ensure that the Sample Sequencer is disabled by writing a 0 to the corresponding ASEN bit in the ADCACTSS register. Programming of the Sample Sequencers is allowed without having them enabled. Disabling the Sequencer during programming prevents erroneous execution if a trigger event were to occur during the configuration process.
- 2. Configure the trigger event for the Sample Sequencer in the ADCEMUX register.
- For each sample in the sample sequence, configure the corresponding input source in the ADCSSMUXn register.

- 4. For each sample in the sample sequence, configure the sample control bits in the corresponding nibble in the ADCSSCTLn register. When programming the last nibble, ensure that the END bit is set. Failure to set the END bit causes unpredictable behavior.
- If interrupts are to be used, write a 1 to the corresponding MASK bit in the ADCIM register.
- 6. Enable the Sample Sequencer logic by writing a 1 to the corresponding ASEN bit in the ADCACTSS register.

12.4 Register Map

Table 12-2 on page 250 lists the ADC registers. The offset listed is a hexadecimal increment to the register's address, relative to the ADC base address of 0x4003.8000.

Table 12-2. ADC Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	ADCACTSS	R/W	0x0000.0000	ADC Active Sample Sequencer	252
0x004	ADCRIS	RO	0x0000.0000	ADC Raw Interrupt Status	253
0x008	ADCIM	R/W	0x0000.0000	ADC Interrupt Mask	254
0x00C	ADCISC	R/W1C	0x0000.0000	ADC Interrupt Status and Clear	255
0x010	ADCOSTAT	R/W1C	0x0000.0000	ADC Overflow Status	256
0x014	ADCEMUX	R/W	0x0000.0000	ADC Event Multiplexer Select	257
0x018	ADCUSTAT	R/W1C	0x0000.0000	ADC Underflow Status	258
0x020	ADCSSPRI	R/W	0x0000.3210	ADC Sample Sequencer Priority	259
0x028	ADCPSSI	WO	-	ADC Processor Sample Sequence Initiate	260
0x030	ADCSAC	R/W	0x0000.0000	ADC Sample Averaging Control	261
0x040	ADCSSMUX0	R/W	0x0000.0000	ADC Sample Sequence Input Multiplexer Select 0	262
0x044	ADCSSCTL0	R/W	0x0000.0000	ADC Sample Sequence Control 0	264
0x048	ADCSSFIFO0	RO	0x0000.0000	ADC Sample Sequence Result FIFO 0	266
0x04C	ADCSSFSTAT0	RO	0x0000.0100	ADC Sample Sequence FIFO 0 Status	267
0x060	ADCSSMUX1	R/W	0x0000.0000	ADC Sample Sequence Input Multiplexer Select 1	268
0x064	ADCSSCTL1	R/W	0x0000.0000	ADC Sample Sequence Control 1	269
0x068	ADCSSFIFO1	RO	0x0000.0000	ADC Sample Sequence Result FIFO 1	266
0x06C	ADCSSFSTAT1	RO	0x0000.0100	ADC Sample Sequence FIFO 1 Status	267
0x080	ADCSSMUX2	R/W	0x0000.0000	ADC Sample Sequence Input Multiplexer Select 2	270
0x084	ADCSSCTL2	R/W	0x0000.0000	ADC Sample Sequence Control 2	271
0x088	ADCSSFIFO2	RO	0x0000.0000	ADC Sample Sequence Result FIFO 2	266
0x08C	ADCSSFSTAT2	RO	0x0000.0100	ADC Sample Sequence FIFO 2 Status	267
0x0A0	ADCSSMUX3	R/W	0x0000.0000	ADC Sample Sequence Input Multiplexer Select 3	272

Offset	Name	Туре	Reset	Description	See page
0x0A4	ADCSSCTL3	R/W	0x0000.0002	ADC Sample Sequence Control 3	273
0x0A8	ADCSSFIFO3	RO	0x0000.0000	ADC Sample Sequence Result FIFO 3	274
0x0AC	ADCSSFSTAT3	RO	0x0000.0100	ADC Sample Sequence FIFO 3 Status	275
0x100	ADCTMLB	R/W	0x0000.0000	ADC Test Mode Loopback	276

12.5 Register Descriptions

The remainder of this section lists and describes the ADC registers, in numerical order by address offset.

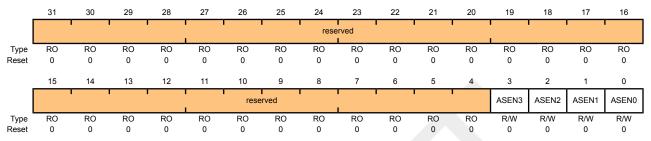


Register 1: ADC Active Sample Sequencer (ADCACTSS), offset 0x000

This register controls the activation of the Sample Sequencers. Each Sample Sequencer can be enabled/disabled independently.

ADC Active Sample Sequencer (ADCACTSS)

Base 0x4003.8000 Offset 0x000 Type R/W, reset 0x0000.0000



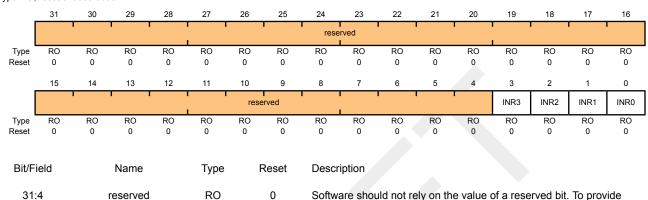
Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	ASEN3	R/W	0	Specifies whether Sample Sequencer 3 is enabled. If set, the sample sequence logic for Sequencer 3 is active. Otherwise, the Sequencer is inactive.
2	ASEN2	R/W	0	Specifies whether Sample Sequencer 2 is enabled. If set, the sample sequence logic for Sequencer 2 is active. Otherwise, the Sequencer is inactive.
1	ASEN1	R/W	0	Specifies whether Sample Sequencer 1 is enabled. If set, the sample sequence logic for Sequencer 1 is active. Otherwise, the Sequencer is inactive.
0	ASEN0	R/W	0	Specifies whether Sample Sequencer 0 is enabled. If set, the sample sequence logic for Sequencer 0 is active. Otherwise, the Sequencer is inactive.

Register 2: ADC Raw Interrupt Status (ADCRIS), offset 0x004

This register shows the status of the raw interrupt signal of each Sample Sequencer. These bits may be polled by software to look for interrupt conditions without having to generate controller interrupts.

ADC Raw Interrupt Status (ADCRIS)

Base 0x4003.8000 Offset 0x004 Type RO, reset 0x0000.0000



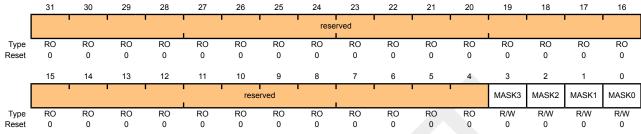
	10001100	110	ŭ	compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	INR3	RO	0	Set by hardware when a sample with its respective ADCSSCTL3 IE bit has completed conversion. This bit is cleared by writing a 1 to the ADCISC IN3 bit.
2	INR2	RO	0	Set by hardware when a sample with its respective ADCSSCTL2 IE bit has completed conversion. This bit is cleared by writing a 1 to the ADCISC IN2 bit.
1	INR1	RO	0	Set by hardware when a sample with its respective ADCSSCTL1 IE bit has completed conversion. This bit is cleared by writing a 1 to the ADCISC IN1 bit.
0	INR0	RO	0	Set by hardware when a sample with its respective ADCSSCTL0 IE bit has completed conversion. This bit is cleared by writing a 1 to the ADCISC IN0 bit.

Register 3: ADC Interrupt Mask (ADCIM), offset 0x008

This register controls whether the Sample Sequencer raw interrupt signals are promoted to controller interrupts. The raw interrupt signal for each Sample Sequencer can be masked independently.

ADC Interrupt Mask (ADCIM)

Base 0x4003.8000 Offset 0x008 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	MASK3	R/W	0	Specifies whether the raw interrupt signal from Sample Sequencer 3 (ADCRIS register INR3 bit) is promoted to a controller interrupt. If set, the raw interrupt signal is promoted to a controller interrupt. Otherwise, it is not.
2	MASK2	R/W	0	Specifies whether the raw interrupt signal from Sample Sequencer 2 (ADCRIS register INR2 bit) is promoted to a controller interrupt. If set, the raw interrupt signal is promoted to a controller interrupt. Otherwise, it is not.
1	MASK1	R/W	0	Specifies whether the raw interrupt signal from Sample Sequencer 1 (ADCRIS register INR1 bit) is promoted to a controller interrupt. If set, the raw interrupt signal is promoted to a controller interrupt. Otherwise, it is not.
0	MASK0	R/W	0	Specifies whether the raw interrupt signal from Sample Sequencer 0 (ADCRIS register INR0 bit) is promoted to a controller interrupt. If set, the raw interrupt signal is promoted to a controller interrupt. Otherwise, it is not.

Register 4: ADC Interrupt Status and Clear (ADCISC), offset 0x00C

This register provides the mechanism for clearing interrupt conditions, and shows the status of controller interrupts generated by the Sample Sequencers. When read, each bit field is the logical AND of the respective INR and MASK bits. Interrupts are cleared by writing a 1 to the corresponding bit position. If software is polling the ADCRIS instead of generating interrupts, the INR bits are still cleared via the ADCISC register, even if the IN bit is not set.

ADC Interrupt Status and Clear (ADCISC)

Base 0x4003.8000 Offset 0x00C Type R/W1C, reset 0x0000.0000

71	-,															
_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1	, ,		' '		1	rese	rved							
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		1	1 1			res	erved	' '					IN3	IN2	IN1	IN0
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W1C	R/W1C	R/W1C	R/W1C
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bit/F	ield		Name		Type		Reset	Descri	ption							
31:	4		reserved		RO		0	compa	atibility w	ith futur	e produc	cts, the	of a rese value of operation	a reserv		
3			IN3		R/W1C		0	provid	ing a lev	el-base		pt to the	ASK3 an controlle			-
2			IN2		R/W1C		0	provid	ing a lev	el based		ot to the	ASK2 an			
1			IN1		R/W1C		0	provid	ing a lev	el based		ot to the	ASK1 an			-
0			IN0		R/W1C		0	provid	ing a lev	el based		ot to the	ASKO an			-

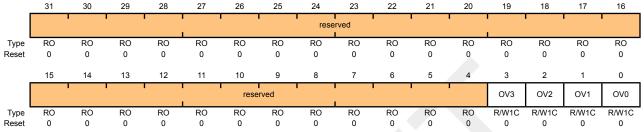
Register 5: ADC Overflow Status (ADCOSTAT), offset 0x010

This register indicates overflow conditions in the Sample Sequencer FIFOs. Once the overflow condition has been handled by software, the condition can be cleared by writing a 1 to the corresponding bit position.

ADC Overflow Status (ADCOSTAT)

Base 0x4003.8000

Offset 0x010
Type R/W1C, reset 0x0000.0000



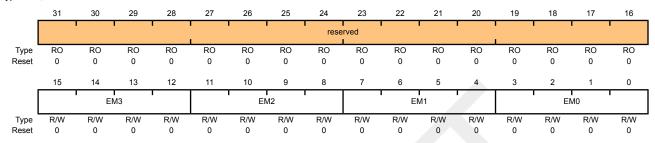
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bit/Fie	eld		Name		Туре		Reset	Descri	iption							
31:4	1	re	reserved RO				0	compa	Software should not rely on the value of a reserved bit. To provid compatibility with future products, the value of a reserved bit should preserve across a read-modify-write operation.							
3			OV3		R/W1C		0	overflow When bit is s	ow cond an over	ition who flow is d ardware	ere the letected, to indica	O for Sam FIFO is fu the most ate the oc	ill and a	write wa	as reque Iropped	ested. and this
2			OV2		R/W1C		0	overflo When bit is s	ow cond an over	ition who flow is d ardware	ere the letected, to indica	O for Sam FIFO is fu the most ate the oc	ill and a	write wa	as reque Iropped	ested. and this
1			OV1		R/W1C		0	overflo When bit is s	ow cond an over	ition who flow is d ardware	ere the letected, to indica	O for Sam FIFO is fu the most ate the oc	ill and a	write wa	as reque Iropped	ested. and this
0			OV0		R/W1C		0	overflow When bit is s	ow cond an over	ition who flow is d ardware	ere the letected, to indica	o for Sam FIFO is fu the most ate the oc	ill and a	write wa	as reque Iropped	ested. and this

Register 6: ADC Event Multiplexer Select (ADCEMUX), offset 0x014

The ADCEMUX selects the event (trigger) that initiates sampling for each Sample Sequencer. Each Sample Sequencer can be configured with a unique trigger source.

ADC Event Multiplexer Select (ADCEMUX)

Base 0x4003.8000 Offset 0x014 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:16	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:12	EM3	R/W	0	This field selects the trigger source for Sample Sequencer 3.

The valid configurations for this field are:

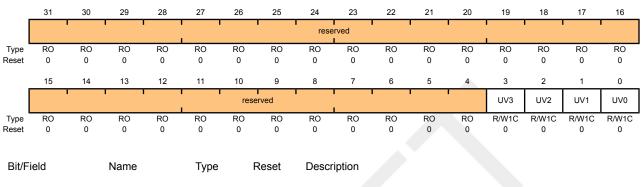
			EM Binary Value	Event
			0000	Controller (default)
			0001	Reserved
			0010	Reserved
			0011	Reserved
			0100	External (GPIO PB4)
			0101	Timer
			0110	Reserved
			0111	Reserved
			1000	Reserved
			1001-1110	reserved
			1111	Always (continuously sample)
11:8	EM2	R/W 0		the trigger source for Sample Sequencer 2. The same as those for EM3.
7:4	EM1	R/W 0		the trigger source for Sample Sequencer 1. The esame as those for EM3.
3:0	EM0	R/W 0		the trigger source for Sample Sequencer 0. The e same as those for EM3.

Register 7: ADC Underflow Status (ADCUSTAT), offset 0x018

This register indicates underflow conditions in the Sample Sequencer FIFOs. The corresponding underflow condition can be cleared by writing a 1 to the relevant bit position.

ADC Underflow Status (ADCUSTAT)

Base 0x4003.8000 Offset 0x018 Type R/W1C, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	UV3	R/W1C	0	This bit specifies that the FIFO for Sample Sequencer 3 has hit an underflow condition where the FIFO is empty and a read was requested. The problematic read does not move the FIFO pointers, and 0s are returned. This bit is cleared by writing a 1.
2	UV2	R/W1C	0	This bit specifies that the FIFO for Sample Sequencer 2 has hit an underflow condition where the FIFO is empty and a read was requested. The problematic read does not move the FIFO pointers, and 0s are returned. This bit is cleared by writing a 1.
1	UV1	R/W1C	0	This bit specifies that the FIFO for Sample Sequencer 1 has hit an underflow condition where the FIFO is empty and a read was requested. The problematic read does not move the FIFO pointers, and 0s are returned. This bit is cleared by writing a 1.
0	UV0	R/W1C	0	This bit specifies that the FIFO for Sample Sequencer 0 has hit an underflow condition where the FIFO is empty and a read was requested. The problematic read does not move the FIFO pointers, and 0s are

returned. This bit is cleared by writing a 1.

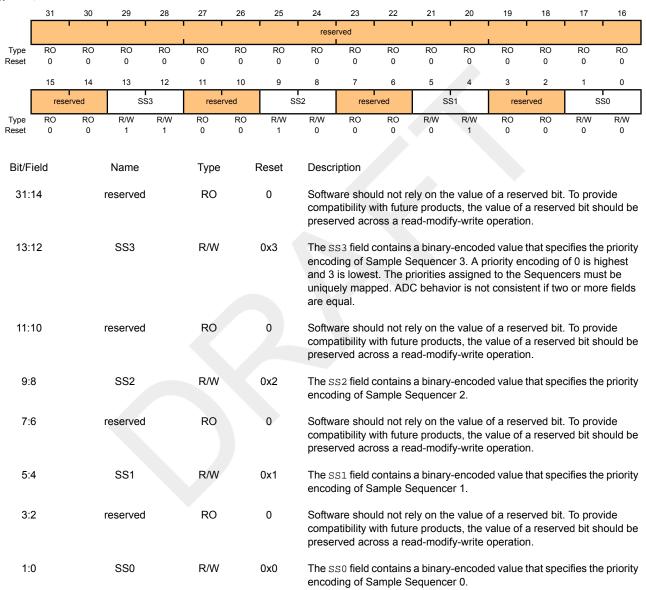
Register 8: ADC Sample Sequencer Priority (ADCSSPRI), offset 0x020

This register sets the priority for each of the Sample Sequencers. Out of reset, Sequencer 0 has the highest priority, and sample sequence 3 has the lowest priority. When reconfiguring sequence priorities, each sequence must have a unique priority or the ADC behavior is inconsistent.

ADC Sample Sequencer Priority (ADCSSPRI)

Base 0x4003.8000 Offset 0x020

Type R/W, reset 0x0000.3210



30

Register 9: ADC Processor Sample Sequence Initiate (ADCPSSI), offset 0x028

This register provides a mechanism for application software to initiate sampling in the Sample Sequencers. Sample sequences can be initiated individually or in any combination. When multiple sequences are triggered simultaneously, the priority encodings in **ADCSSPRI** dictate execution order.

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ADC Processor Sample Sequence Initiate (ADCPSSI)

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SS₁

SS0

WO

WO

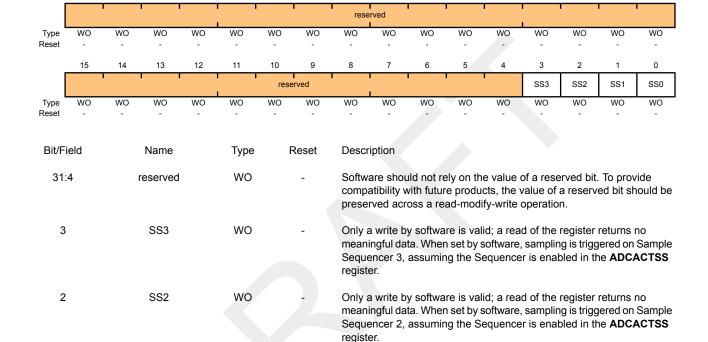
28

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Base 0x4003.8000 Offset 0x028 Type WO, reset -



Only a write by software is valid; a read of the register returns no meaningful data. When set by software, sampling is triggered on Sample Sequencer 1, assuming the Sequencer is enabled in the **ADCACTSS** register.

Only a write by software is valid; a read of the register returns no meaningful data. When set by software, sampling is triggered on Sample Sequencer 0, assuming the Sequencer is enabled in the **ADCACTSS** register.

0

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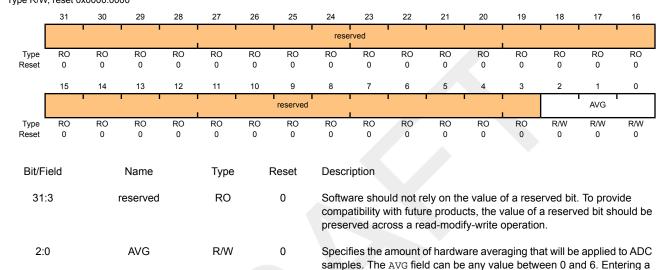
17

Register 10: ADC Sample Averaging Control (ADCSAC), offset 0x030

This register controls the amount of hardware averaging applied to conversion results. The final conversion result stored in the FIFO is averaged from 2 AVG consecutive ADC samples at the specified ADC speed. If AVG is 0, the sample is passed directly through without any averaging. If AVG=6, then 64 consecutive ADC samples are averaged to generate one result in the sequencer FIFO. An AVG = 7 provides unpredictable results.

ADC Sample Averaging Control (ADCSAC)

Base 0x4003.8000 Offset 0x030 Type R/W, reset 0x0000.0000



value of 7 creates unpredictable results.

Register 11: ADC Sample Sequence Input Multiplexer Select 0 (ADCSSMUX0), offset 0x040

This register defines the analog input configuration for each sample in a sequence executed with Sample Sequencer 0.

This register is 32-bits wide and contains information for eight possible samples.

ADC Sample Sequence Input Multiplexer Select 0 (ADCSSMUX0)

Base 0x4003.8000

Offset 0x040

Type R/W reset 0x0000 0000

Type R/V	V, reset 0x	0000.00	00													
	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	reserved		MUX7		reserved		MUX6		reserved		MUX5		reserved		MUX4	
Type Reset	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	reserved		MUX3		reserved		MUX2		reserved		MUX1		reserved		MUX0	
Type Reset	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0	RO 0	R/W 0	R/W 0	R/W 0
Bit/F	ield		Name		Туре	ا	Reset	Desci	ription							
3	1		reserved		RO		0	comp	rare shoul atibility w rved acro	ith futur	e produc	cts, the	value of a	reserv		
30:	28		MUX7		R/W		0	The MUX7 field is used during the eighth sample of a sequence with the Sample Sequencer. It specifies which of the analog sampled for the analog-to-digital conversion. The value set here the corresponding pin, for example, a value of 1 indicates the ADC1.					nalog inp et here in	uts is dicates		
2	7		reserved		RO		0	comp	rare shoul atibility w rved acro	ith futur	e produc	cts, the	value of a	reserv		
26:	24		MUX6		R/W		0	execu	IUX6 field uted with t s is sampl	he San	nple Seq	uencer	and speci	fies wh		
2	3		reserved		RO		0	comp	rare shoul atibility w rved acro	ith futur	e produc	cts, the	value of a	reserv		
22:	20		MUX5		R/W		0	with t	IUX5 field he Sampl led for the	e Sequ	encer an	ıd speci	fies which			
1	9		reserved		RO		0	comp	are shoul atibility w rved acro	ith futur	e produc	cts, the	value of a	reserv		
18:	16		MUX4		R/W		0	with t	IUX4 field he Sampl led for the	e Sequ	encer an	ıd speci	fies which			

Bit/Field	Name	Туре	Reset	Description
15	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
14:12	MUX3	R/W	0	The MUX3 field is used during the fourth sample of a sequence executed with the Sample Sequencer and specifies which of the analog inputs is sampled for the analog-to-digital conversion.
11	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
10:8	MUX2	R/W	0	The MUX2 field is used during the third sample of a sequence executed with the Sample Sequencer and specifies which of the analog inputs is sampled for the analog-to-digital conversion.
7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6:4	MUX1	R/W	0	The MUX1 field is used during the second sample of a sequence executed with the Sample Sequencer and specifies which of the analog inputs is sampled for the analog-to-digital conversion.
3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2:0	MUX0	R/W	0	The MUX0 field is used during the first sample of a sequence executed with the Sample Sequencer and specifies which of the analog inputs is sampled for the analog-to-digital conversion.

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Register 12: ADC Sample Sequence Control 0 (ADCSSCTL0), offset 0x044

This register contains the configuration information for each sample for a sequence executed with Sample Sequencer 0. When configuring a sample sequence, the END bit must be set at some point, whether it be after the first sample, last sample, or any sample in between.

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This register is 32-bits wide and contains information for eight possible samples.

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ADC Sample Sequence Control 0 (ADCSSCTL0)

Base 0x4003.8000 Offset 0x044

Type R/W, reset 0x0000.0000 31

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	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	TS7	IE7	END7	D7	TS6	IE6	END6	D6	TS5	IE5	END5	D5	TS4	IE4	END4	D4
Type Reset	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0							
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0
Type Reset	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0							
Bit/F	ield		Name		Туре	F	Reset	Descr	iption							
31	I		TS7		R/W		0	and sp senso	oecifies t	the input	source	of the sa	ample. If	set, the	mple sed tempera e ADCS	ature
30)		IE7		R/W		0	and specified the error than error t	pecifies of the er is set, this bit i	whether sample' the inte s set, th	the raw s conver rrupt is p e raw int	interrupt rsion. If to promoted terrupt is	t signal (the MASI d to a co asserte	(INRO bi (O bit in Introller-led, other	mple sec it) is asse the ADC level inte wise it is erate inte	erted at IM rrupt. not. It
29)		END7		R/W		0	possible after the even the EN which the EN	ble to end he samp hough th ID bit so only has IDO bit so	d the sec le conta le fields mewhere s a single et.)	quence c ining a s may be r e within e sample	on any sa et END a non-zero the sequ e in the s	ample po are not re to it is requence. (S sequence	osition. Sequested puired the Sample Segment of the Sample Segment	e sequent Samples of for contact softwates Sequence dwired to	defined version re write er 3, o have
28	3		D7		R/W		0	The co "i", wh does i	orrespon ere the p	ding AD paired ir a differe	CSSMU puts are	Xx nibble "2i and	e must b 2i+1". T	e set to he temp	entially sa the pair i perature s og inputs	number sensor
27	7		TS6		R/W		0	Same	definitio	n as TS	7 but us	ed durin	g the se	venth sa	imple.	
26	6		IE6		R/W		0	Same	definitio	n as IE	7 but us	ed durin	g the se	venth sa	imple.	
25	5		END6		R/W		0	Same	definitio	n as EN	D7 but u	sed duri	ng the s	eventh s	sample.	
24	1		D6		R/W		0	Same	definitio	n as D7	but use	d during	the seve	enth san	nple.	
23	3		TS5		R/W		0	Same	definitio	n as TS	7 but us	ed durin	g the six	th samp	le.	

Bit/Field	Name	Туре	Reset	Description
22	IE5	R/W	0	Same definition as IE7 but used during the sixth sample.
21	END5	R/W	0	Same definition as ${\tt END7}$ but used during the sixth sample.
20	D5	R/W	0	Same definition as D7 but used during the sixth sample.
19	TS4	R/W	0	Same definition as ${\tt TS7}$ but used during the fifth sample.
18	IE4	R/W	0	Same definition as IE7 but used during the fifth sample.
17	END4	R/W	0	Same definition as END7 but used during the fifth sample.
16	D4	R/W	0	Same definition as D7 but used during the fifth sample.
15	TS3	R/W	0	Same definition as TS7 but used during the fourth sample.
14	IE3	R/W	0	Same definition as IE7 but used during the fourth sample.
13	END3	R/W	0	Same definition as $\mathtt{END7}$ but used during the fourth sample.
12	D3	R/W	0	Same definition as D7 but used during the fourth sample.
11	TS2	R/W	0	Same definition as TS7 but used during the third sample.
10	IE2	R/W	0	Same definition as IE7 but used during the third sample.
9	END2	R/W	0	Same definition as END7 but used during the third sample.
8	D2	R/W	0	Same definition as D7 but used during the third sample.
7	TS1	R/W	0	Same definition as ${\tt TS7}$ but used during the second sample.
6	IE1	R/W	0	Same definition as IE7 but used during the second sample.
5	END1	R/W	0	Same definition as END7 but used during the second sample.
4	D1	R/W	0	Same definition as ${\tt D7}$ but used during the second sample.
3	TS0	R/W	0	Same definition as ${\tt TS7}$ but used during the first sample.
2	IE0	R/W	0	Same definition as IE7 but used during the first sample.
1	END0	R/W	0	Same definition as ${\tt END7}$ but used during the first sample.
				Since this sequencer has only one entry, this bit must be set.
0	D0	R/W	0	Same definition as ${\tt D7}$ but used during the first sample.

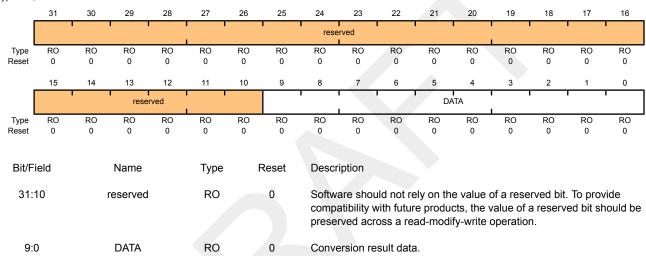
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Register 13: ADC Sample Sequence Result FIFO 0 (ADCSSFIFO0), offset 0x048 Register 14: ADC Sample Sequence Result FIFO 1 (ADCSSFIFO1), offset 0x068 Register 15: ADC Sample Sequence Result FIFO 2 (ADCSSFIFO2), offset 0x088

This register contains the conversion results for samples collected with the Sample Sequencer (the ADCSSFIF0 register is used for Sample Sequencer 0, ADCSSFIF01 for Sequencer 1, and ADCSSFIF02 for Sequencer 2). Reads of this register return conversion result data in the order sample 0, sample 1, and so on, until the FIFO is empty. If the FIFO is not properly handled by software, overflow and underflow conditions are registered in the ADCOSTAT and ADCUSTAT registers.

ADC Sample Sequence Result FIFO 0 (ADCSSFIFO0)

Base 0x4003.8000 Offset 0x048 Type RO, reset 0x0000.0000



Register 16: ADC Sample Sequence FIFO 0 Status (ADCSSFSTAT0), offset 0x04C

Register 17: ADC Sample Sequence FIFO 1 Status (ADCSSFSTAT1), offset 0x06C

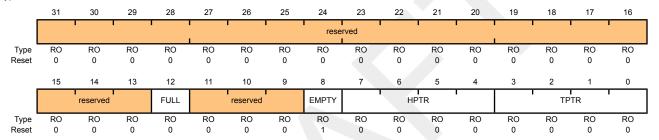
Register 18: ADC Sample Sequence FIFO 2 Status (ADCSSFSTAT2), offset 0x08C

This register provides a window into the Sample Sequencer, providing full/empty status information as well as the positions of the head and tail pointers. The reset value of 0x100 indicates an empty FIFO. The ADCSSFSTAT0 register provides status on FIF0, ADCSSFSTAT1 on FIFO1, and ADCSSFSTAT2 on FIFO2.

ADC Sample Sequence FIFO 0 Status (ADCSSFSTAT0)

Base 0x4003.8000

Offset 0x04C Type RO, reset 0x0000.0100



Bit/Field	Name	Туре	Reset	Description
31:13	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
12	FULL	RO	0	When set, indicates that the FIFO is currently full.
11:9	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
8	EMPTY	RO	1	When set, indicates that the FIFO is currently empty.
7:4	HPTR	RO	0	This field contains the current "head" pointer index for the FIFO, that is, the next entry to be written.
3:0	TPTR	RO	0	This field contains the current "tail" pointer index for the FIFO, that is, the next entry to be read.

Register 19: ADC Sample Sequence Input Multiplexer Select 1 (ADCSSMUX1). offset 0x060

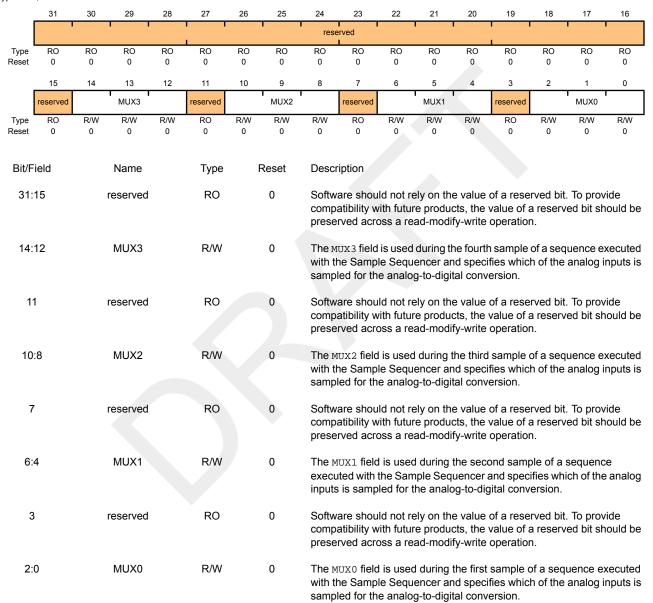
This register defines the analog input configuration for each sample in a sequence executed with Sample Sequencer 1. This register is 16-bits wide and contains information for four possible samples.

ADC Sample Sequence Input Multiplexer Select 1 (ADCSSMUX1)

Base 0x4003.8000

Offset 0x060

Type R/W, reset 0x0000.0000



Register 20: ADC Sample Sequence Control 1 (ADCSSCTL1), offset 0x064

This register contains the configuration information for each sample for a sequence executed with Sample Sequencer 1. When configuring a sample sequence, the END bit must be set at some point, whether it be after the first sample, last sample, or any sample in between. This register is 16-bits wide and contains information for four possible samples.

ADC Sample Sequence Control 1 (ADCSSCTL1)

Base 0x4003.8000

Offset 0x064
Type R/W, reset 0x0000.0000

,,	31	30	20	20	27	26	25	24	23	22	21	20	10	10	17	16	
	31	30	29	28	21	20	Z5 1	1	rved	22	21	20	19 I	18	17	10	
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0									
Neset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0	
Type Reset	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0									
Bit/F	eld		Name		Туре	F	Reset	Descr	iption								
31:	16	ı	reserved		RO		0	compa		vith futur	e produc	cts, the	value of	a reserv	. To prov ed bit sh		
15	;		TS3		R/W		0	Same	definitio	n as TS	7 but use	ed durin	g the fo	urth sam	ple.		
14	ļ		IE3		R/W		0	Same	definitio	n as IE	7 but us	ed durin	g the fo	urth sam	ple.		
13	3		END3		R/W		0	Same	definitio	n as EN	D7 but u	sed dur	ing the f	ourth sa	mple.		
12	2		D3		R/W		0	Same	definitio	n as D7	but used	d during	the four	th samp	le.		
11			TS2		R/W		0	Same	definitio	n as TS	7 but us	ed durin	g the thi	rd samp	le.		
10)		IE2		R/W		0	Same	definitio	n as IE	7 but us	ed durin	g the thi	rd samp	le.		
9			END2		R/W		0	Same	definitio	n as EN	D7 but u	sed dur	ing the t	hird sam	ple.		
8			D2		R/W		0	Same	definitio	n as D7	but used	d during	the third	d sample	e .		
7			TS1		R/W		0	Same	definitio	n as TS	7 but use	ed durin	g the se	cond sa	mple.		
6			IE1		R/W		0	Same	definitio	n as IE	7 but use	ed durin	g the se	cond sa	mple.		
5			END1		R/W		0	Same	definitio	n as EN	D7 but u	sed dur	ing the s	econd s	ample.		
4			D1		R/W		0	Same	definitio	n as D7	but used	d during	the sec	ond sam	ple.		
3			TS0		R/W		0	Same	definitio	n as TS	7 but us	ed durin	g the fire	st sampl	e.		
2			IE0		R/W		0	Same	definitio	n as IE	7 but us	ed durin	g the fire	st sampl	e.		
1			END0		R/W		0	Same	definitio	n as EN	D7 but u	sed dur	ing the f	irst samı	ole.		
								Since	this seq	uencer l	nas only	one ent	ry, this b	oit must l	oe set.		
0			D0		R/W		0	Same	definitio	n as D7	but used	d during	the first	sample	•		

Register 21: ADC Sample Sequence Input Multiplexer Select 2 (ADCSSMUX2). offset 0x080

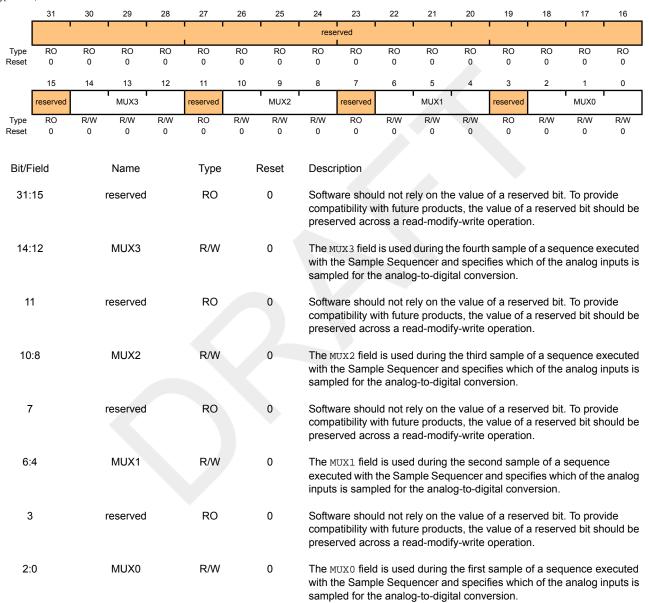
This register defines the analog input configuration for each sample in a sequence executed with Sample Sequencer 2. This register is 16-bits wide and contains information for four possible samples.

ADC Sample Sequence Input Multiplexer Select 2 (ADCSSMUX2)

Base 0x4003.8000

Offset 0x080

Type R/W, reset 0x0000.0000



Register 22: ADC Sample Sequence Control 2 (ADCSSCTL2), offset 0x084

This register contains the configuration information for each sample for a sequence executed with Sample Sequencer 2. When configuring a sample sequence, the END bit must be set at some point, whether it be after the first sample, last sample, or any sample in between. This register is 16-bits wide and contains information for four possible samples.

ADC Sample Sequence Control 2 (ADCSSCTL2)

Base 0x4003.8000

Offset 0x084
Type R/W, reset 0x0000.0000

,,	. 04	20	00	00	07	00	05	0.4	00	00	04	00	40	40	47	40
ſ	31	30	29	28	27	26	25	24 rese	23 rved	22	21	20	19	18	17	16
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
[15 TS3	14 IE3	13 END3	12 D3	11 TS2	10 IE2	9 END2	8 D2	7 TS1	6 IE1	5 END1	4 D1	3 TS0	2 IE0	1 END0	0 D0
Type Reset	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0	R/W 0
Bit/F	eld		Name		Туре	ſ	Reset	Descr	iption							
31:	16	ı	reserved		RO		0	compa		ith futur	e produc	cts, the v	value of	a reserv	. To prov ed bit sh	
15	5		TS3		R/W		0	Same	definitio	n as TS	7 but us	ed durin	g the fo	urth sam	ıple.	
14	ļ		IE3		R/W		0	Same	definitio	n as IE	7 but us	ed durin	g the fo	urth sam	ıple.	
13	3		END3		R/W		0	Same	definitio	n as EN	D7 but u	sed duri	ing the f	ourth sa	mple.	
12	2		D3		R/W		0	Same	definitio	n as D7	but use	d during	the four	th samp	le.	
11			TS2		R/W		0	Same	definitio	n as TS	7 but us	ed durin	g the thi	rd samp	le.	
10)		IE2		R/W		0	Same	definitio	n as IE	7 but us	ed durin	g the thi	rd samp	le.	
9			END2		R/W		0	Same	definitio	n as EN	D7 but u	sed duri	ing the t	hird sam	ıple.	
8			D2		R/W		0	Same	definitio	n as D7	but use	d during	the third	d sample	Э.	
7			TS1		R/W		0	Same	definitio	n as TS	7 but us	ed durin	g the se	cond sa	mple.	
6			IE1		R/W		0	Same	definitio	n as IE	7 but us	ed durin	g the se	cond sa	mple.	
5			END1		R/W		0	Same	definitio	n as EN	D7 but u	sed duri	ing the s	econd s	ample.	
4			D1		R/W		0	Same	definitio	n as D7	but use	d during	the sec	ond sam	nple.	
3			TS0		R/W		0	Same	definitio	n as TS	7 but us	ed durin	g the fire	st sampl	e.	
2			IE0		R/W		0	Same	definitio	n as IE	7 but us	ed durin	g the fire	st sampl	e.	
1			END0		R/W		0	Same	definitio	n as EN	D7 but u	sed duri	ing the f	irst samı	ole.	
								Since	this seq	uencer I	nas only	one ent	ry, this b	oit must l	be set.	
0			D0		R/W		0	Same	definitio	n as D7	but used	d during	the first	sample	-	

Register 23: ADC Sample Sequence Input Multiplexer Select 3 (ADCSSMUX3), offset 0x0A0

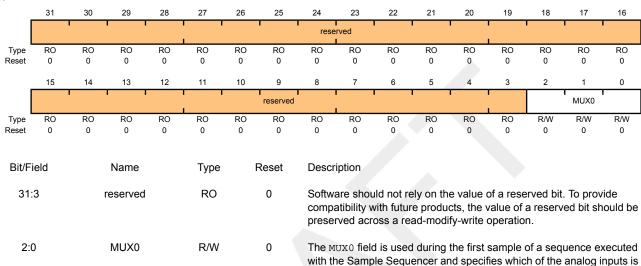
This register defines the analog input configuration for each sample in a sequence executed with Sample Sequencer 3. This register is 4-bits wide and contains information for one possible sample.

ADC Sample Sequence Input Multiplexer Select 3 (ADCSSMUX3)

Base 0x4003.8000

Offset 0x0A0

Type R/W, reset 0x0000.0000



sampled for the analog-to-digital conversion.

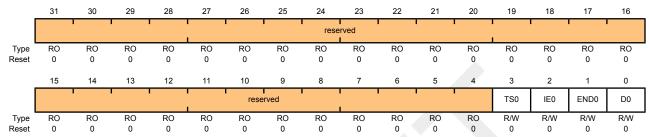
Register 24: ADC Sample Sequence Control 3 (ADCSSCTL3), offset 0x0A4

This register contains the configuration information for each sample for a sequence executed with Sample Sequencer 3. The END bit is always set since there is only one sample in this sequencer. This register is 4-bits wide and contains information for one possible sample.

ADC Sample Sequence Control 3 (ADCSSCTL3)

Base 0x4003.8000 Offset 0x0A4

Type R/W, reset 0x0000.0002



Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	TS0	R/W	0	Same definition as TS7 but used during the first sample.
2	IE0	R/W	0	Same definition as IE7 but used during the first sample.
1	END0	R/W	0	Same definition as END7 but used during the first sample.
				Since this sequencer has only one entry, this bit must be set.
0	D0	R/W	0	Same definition as D7 but used during the first sample.

Register 25: ADC Sample Sequence Result FIFO 3 (ADCSSFIFO3), offset 0x0A8

This register contains the conversion results for samples collected with Sample Sequencer 3. Reads of this register return the conversion result data. If the FIFO is not properly handled by software, overflow and underflow conditions are registered in the **ADCOSTAT** and **ADCUSTAT** registers.

Bit fields and definitions are the same as ADCSSFIFO0 (see page 266) but are for FIFO 3.

Register 26: ADC Sample Sequence FIFO 3 Status (ADCSSFSTAT3), offset 0x0AC

This register provides a window into the Sample Sequencer FIFO 3, providing full/empty status information as well as the positions of the head and tail pointers. The reset value of 0x100 indicates an empty FIFO.

This register has the same bit fields and definitions as **ADCSSFSTAT0** (see page 267) but is for FIFO 3.



Register 27: ADC Test Mode Loopback (ADCTMLB), offset 0x100

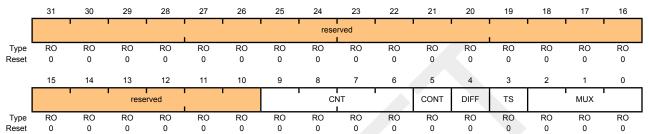
This register provides loopback operation within the digital logic of the ADC, which can be useful in debugging software without having to provide actual analog stimulus. This test mode is entered by writing a value of 0x0000.0001 to this register. When data is read from the FIFO in loopback mode, the read-only portion of this register is returned.

Read-Only Register

ADC Test Mode Loopback (ADCTMLB)

Base 0x4003.8000

Offset 0x100 Type R/W, reset 0x0000.0000



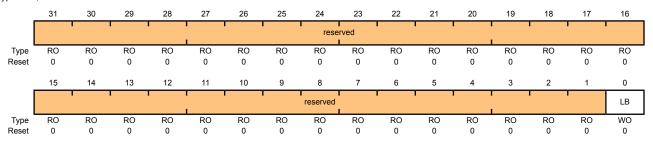
Bit/Field	Name	Туре	Reset	Description
31:10	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
9:6	CNT	RO	0	Continuous sample counter that is initialized to 0 and counts each sample as it processed. This helps provide a unique value for the data received.
5	CONT	RO	0	When set, indicates that this is a continuation sample. For example if two sequencers were to run back-to-back, this indicates that the controller kept continuously sampling at full rate.
4	DIFF	RO	0	When set, indicates that this is a differential sample.
3	TS	RO	0	When set, indicates that this is a temperature sensor sample.
2:0	MUX	RO	0	Indicates which analog input is to be sampled.

Write-Only Register

ADC Test Mode Loopback (ADCTMLB)

Base 0x4003.8000 Offset 0x100

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	LB	WO	0	When set, forces a loopback within the digital block to provide information on input and unique numbering.
				The 10-bit loopback data is defined as shown in the read for bits 9:0 below.



13 Universal Asynchronous Receivers/Transmitters (UARTs)

UART

The Stellaris[®] Universal Asynchronous Receiver/Transmitter (UART) provides fully programmable, 16C550-type serial interface characteristics. The LM3S1958 controller is equipped with three UART modules.

Each UART has the following features:

- Separate transmit and receive FIFOs
- Programmable FIFO length, including 1-byte deep operation providing conventional double-buffered interface
- FIFO trigger levels of 1/8, 1/4, 1/2, 3/4, and 7/8
- Programmable baud-rate generator allowing rates up to 460.8 Kbps
- Standard asynchronous communication bits for start, stop and parity
- False start bit detection
- Line-break generation and detection
- Fully programmable serial interface characteristics:
 - 5, 6, 7, or 8 data bits
 - Even, odd, stick, or no-parity bit generation/detection
 - 1 or 2 stop bit generation
- IrDA serial-IR (SIR) encoder/decoder providing:
 - Programmable use of IrDA Serial InfraRed (SIR) or UART input/output
 - Support of IrDA SIR encoder/decoder functions for data rates up to 115.2 Kbps half-duplex
 - Support of normal 3/16 and low-power (1.41-2.23 µs) bit durations
 - Programmable internal clock generator enabling division of reference clock by 1 to 256 for low-power mode bit duration

13.1 Block Diagram

System Clock TXFIFO Interrupt Control Interrupt 16x8 UARTIFLS UARTIM UARTMIS **UARTRIS** Identification Registers **UARTICR** Transmitter UnTx UARTPCellID0 **Baud Rate** UARTPCellID1 **UARTDR** Generator UARTPCellID2 **UARTIBRD** UARTPCellID3 UARTFBRD UARTPeriphID0 Receiver UnRx UARTPeriphID1 UARTPeriphID2 UARTPeriphID3 Control / Status UART PeriphID4 **RXFIFO** UARTRSR/ECR 16x8 UARTPeriphID5 UARTER UARTPeriphID6 UARTLCRH UARTPeriphID7 UARTCTL UARTILPR

Figure 13-1. UART Module Block Diagram

13.2 Functional Description

Each Stellaris[®] UART performs the functions of parallel-to-serial and serial-to-parallel conversions. It is similar in functionality to a 16C550 UART, but is not register compatible.

The UART is configured for transmit and/or receive via the TXE and RXE bits of the **UART Control** (**UARTCTL**) register (see page 297). Transmit and receive are both enabled out of reset. Before any control registers are programmed, the UART must be disabled by clearing the UARTEN bit in **UARTCTL**. If the UART is disabled during a TX or RX operation, the current transaction is completed prior to the UART stopping.

The UART peripheral also includes a serial IR (SIR) encoder/decoder block that can be connected to an infrared transceiver to implement an IrDA SIR physical layer. The SIR function is programmed using the UARTCTL register.

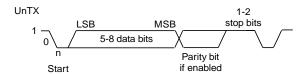
13.2.1 Transmit/Receive Logic

The transmit logic performs parallel-to-serial conversion on the data read from the transmit FIFO. The control logic outputs the serial bit stream beginning with a start bit, and followed by the data

bits (LSB first), parity bit, and the stop bits according to the programmed configuration in the control registers. See Figure 13-2 on page 280 for details.

The receive logic performs serial-to-parallel conversion on the received bit stream after a valid start pulse has been detected. Overrun, parity, frame error checking, and line-break detection are also performed, and their status accompanies the data that is written to the receive FIFO.

Figure 13-2. UART Character Frame



13.2.2 Baud-Rate Generation

The baud-rate divisor is a 22-bit number consisting of a 16-bit integer and a 6-bit fractional part. The number formed by these two values is used by the baud-rate generator to determine the bit period. Having a fractional baud-rate divider allows the UART to generate all the standard baud rates.

The 16-bit integer is loaded through the **UART Integer Baud-Rate Divisor (UARTIBRD)** register (see page 293) and the 6-bit fractional part is loaded with the **UART Fractional Baud-Rate Divisor (UARTFBRD)** register (see page 294). The baud-rate divisor (BRD) has the following relationship to the system clock (where *BRDI* is the integer part of the *BRD* and *BRDF* is the fractional part, separated by a decimal place.):

```
BRD = BRDI + BRDF = SysClk / (16 * Baud Rate)
```

The 6-bit fractional number (that is to be loaded into the DIVFRAC bit field in the **UARTFBRD** register) can be calculated by taking the fractional part of the baud-rate divisor, multiplying it by 64, and adding 0.5 to account for rounding errors:

```
UARTFBRD[DIVFRAC] = integer(BRDF * 64 + 0.5)
```

The UART generates an internal baud-rate reference clock at 16x the baud-rate (referred to as Baud16). This reference clock is divided by 16 to generate the transmit clock, and is used for error detection during receive operations.

Along with the **UART Line Control**, **High Byte (UARTLCRH)** register (see page 295), the **UARTIBRD** and **UARTFBRD** registers form an internal 30-bit register. This internal register is only updated when a write operation to **UARTLCRH** is performed, so any changes to the baud-rate divisor must be followed by a write to the **UARTLCRH** register for the changes to take effect.

To update the baud-rate registers, there are four possible sequences:

- UARTIBRD write, UARTFBRD write, and UARTLCRH write
- UARTFBRD write, UARTIBRD write, and UARTLCRH write
- UARTIBRD write and UARTLCRH write
- UARTFBRD write and UARTLCRH write

13.2.3 Data Transmission

Data received or transmitted is stored in two 16-byte FIFOs, though the receive FIFO has an extra four bits per character for status information. For transmission, data is written into the transmit FIFO. If the UART is enabled, it causes a data frame to start transmitting with the parameters indicated in the **UARTLCRH** register. Data continues to be transmitted until there is no data left in the transmit FIFO. The BUSY bit in the **UART Flag (UARTFR)** register (see page 290) is asserted as soon as data is written to the transmit FIFO (that is, if the FIFO is non-empty) and remains asserted while data is being transmitted. The BUSY bit is negated only when the transmit FIFO is empty, and the last character has been transmitted from the shift register, including the stop bits. The UART can indicate that it is busy even though the UART may no longer be enabled.

When the receiver is idle (the UnRx is continuously 1) and the data input goes Low (a start bit has been received), the receive counter begins running and data is sampled on the eighth cycle of Baud16 (described in "Transmit/Receive Logic" on page 279).

The start bit is valid if UnRx is still low on the eighth cycle of Baud16, otherwise a false start bit is detected and it is ignored. Start bit errors can be viewed in the **UART Receive Status (UARTRSR)** register (see page 288). If the start bit was valid, successive data bits are sampled on every 16th cycle of Baud16 (that is, one bit period later) according to the programmed length of the data characters. The parity bit is then checked if parity mode was enabled. Data length and parity are defined in the **UARTLCRH** register.

Lastly, a valid stop bit is confirmed if UnRx is High, otherwise a framing error has occurred. When a full word is received, the data is stored in the receive FIFO, with any error bits associated with that word.

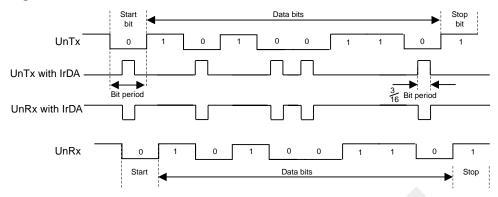
13.2.4 **Serial IR (SIR)**

The UART peripheral includes an IrDA serial-IR (SIR) encoder/decoder block. The IrDA SIR block provides functionality that converts between an asynchronous UART data stream, and half-duplex serial SIR interface. No analog processing is performed on-chip. The role of the SIR block is to provide a digital encoded output, and decoded input to the UART. The UART signal pins can be connected to an infrared transceiver to implement an IrDA SIR physical layer link. The SIR block has two modes of operation:

- In normal IrDA mode, a zero logic level is transmitted as high pulse of 3/16th duration of the selected baud rate bit period on the output pin, while logic one levels are transmitted as a static LOW signal. These levels control the driver of an infrared transmitter, sending a pulse of light for each zero. On the reception side, the incoming light pulses energize the photo transistor base of the receiver, pulling its output LOW. This drives the UART input pin LOW.
- In low-power IrDA mode, the width of the transmitted infrared pulse is set to three times the period of the internally generated IrLPBaud16 signal (1.63 μs, assuming a nominal 1.8432 MHz frequency) by changing the appropriate bit in the UARTCR register.

Figure 13-3 on page 282 shows the UART transmit and receive signals, with and without IrDA modulation.

Figure 13-3. IrDA Data Modulation



In both normal and low-power IrDA modes:

- During transmission, the UART data bit is used as the base for encoding
- During reception, the decoded bits are transferred to the UART receive logic

The IrDA SIR physical layer specifies a half-duplex communication link, with a minimum 10 ms delay between transmission and reception. This delay must be generated by software because it is not automatically supported by the UART. The delay is required because the infrared receiver electronics might become biased, or even saturated from the optical power coupled from the adjacent transmitter LED. This delay is known as latency, or receiver setup time.

13.2.5 FIFO Operation

The UART has two 16-entry FIFOs; one for transmit and one for receive. Both FIFOs are accessed via the **UART Data (UARTDR)** register (see page 286). Read operations of the **UARTDR** register return a 12-bit value consisting of 8 data bits and 4 error flags while write operations place 8-bit data in the transmit FIFO.

Out of reset, both FIFOs are disabled and act as 1-byte-deep holding registers. The FIFOs are enabled by setting the FEN bit in **UARTLCRH** (page 295).

FIFO status can be monitored via the **UART Flag (UARTFR)** register (see page 290) and the **UART Receive Status (UARTRSR)** register. Hardware monitors empty, full and overrun conditions. The **UARTFR** register contains empty and full flags (TXFE, TXFF, RXFE and RXFF bits) and the **UARTRSR** register shows overrun status via the OE bit.

The trigger points at which the FIFOs generate interrupts is controlled via the **UART Interrupt FIFO Level Select (UARTIFLS)** register (see page 299). Both FIFOs can be individually configured to trigger interrupts at different levels. Available configurations include 1/8, ½, ½, ¾, and 7/8. For example, if the ¼ option is selected for the receive FIFO, the UART generates a receive interrupt after 4 data bytes are received. Out of reset, both FIFOs are configured to trigger an interrupt at the ½ mark.

13.2.6 Interrupts

The UART can generate interrupts when the following conditions are observed:

- Overrun Error
- Break Error

- Parity Error
- Framing Error
- Receive Timeout
- Transmit (when condition defined in the TXIFLSEL bit in the UARTIFLS register is met)
- Receive (when condition defined in the RXIFLSEL bit in the UARTIFLS register is met)

All of the interrupt events are ORed together before being sent to the interrupt controller, so the UART can only generate a single interrupt request to the controller at any given time. Software can service multiple interrupt events in a single interrupt service routine by reading the **UART Masked Interrupt Status (UARTMIS)** register (see page 303).

The interrupt events that can trigger a controller-level interrupt are defined in the **UART Interrupt Mask (UARTIM**) register (see page 300) by setting the corresponding IM bit to 1. If interrupts are not used, the raw interrupt status is always visible via the **UART Raw Interrupt Status (UARTRIS)** register (see page 302).

Interrupts are always cleared (for both the **UARTMIS** and **UARTRIS** registers) by setting the corresponding bit in the **UART Interrupt Clear (UARTICR)** register (see page 304).

13.2.7 Loopback Operation

The UART can be placed into an internal loopback mode for diagnostic or debug work. This is accomplished by setting the LBE bit in the **UARTCTL** register (see page 297). In loopback mode, data transmitted on UnTx is received on the UnRx input.

13.2.8 IrDA SIR block

The IrDA SIR block contains an IrDA serial IR (SIR) protocol encoder/decoder. When enabled, the SIR block uses the \mathtt{UnTx} and \mathtt{UnRx} pins for the SIR protocol, which should be connected to an IR transceiver.

The SIR block can receive and transmit, but it is only half-duplex so it cannot do both at the same time. Transmission must be stopped before data can be received. The IrDA SIR physcial layer specifies a minimum 10-ms delay between transmission and reception.

13.3 Initialization and Configuration

To use the UARTs, the peripheral clock must be enabled by setting the <code>UART0</code>, <code>UART1</code>, or <code>UART2</code> bits in the **RCGC1** register.

This section discusses the steps that are required for using a UART module. For this example, the system clock is assumed to be 20 MHz and the desired UART configuration is:

- 115200 baud rate
- Data length of 8 bits
- One stop bit
- No parity
- FIFOs disabled

No interrupts

The first thing to consider when programming the UART is the baud-rate divisor (BRD), since the **UARTIBRD** and **UARTFBRD** registers must be written before the **UARTLCRH** register. Using the equation described in "Baud-Rate Generation" on page 280, the BRD can be calculated:

```
BRD = 20,000,000 / (16 * 115,200) = 10.8507
```

which means that the DIVINT field of the **UARTIBRD** register (see page 293) should be set to 10. The value to be loaded into the **UARTFBRD** register (see page 294) is calculated by the equation:

```
UARTFBRD[DIVFRAC] = integer(0.8507 * 64 + 0.5) = 54
```

With the BRD values in hand, the UART configuration is written to the module in the following order:

- Disable the UART by clearing the UARTEN bit in the UARTCTL register.
- Write the integer portion of the BRD to the UARTIBRD register.
- 3. Write the fractional portion of the BRD to the **UARTFBRD** register.
- **4.** Write the desired serial parameters to the **UARTLCRH** register (in this case, a value of 0x0000.0060).
- 5. Enable the UART by setting the UARTEN bit in the UARTCTL register.

13.4 Register Map

Table 13-1 on page 284 lists the UART registers. The offset listed is a hexadecimal increment to the register's address, relative to that UART's base address:

UART0: 0x4000.C000

UART1: 0x4000.D000

UART2: 0x4000.E000

Note: The UART must be disabled (see the UARTEN bit in the **UARTCTL** register on page 297) before any of the control registers are reprogrammed. When the UART is disabled during a TX or RX operation, the current transaction is completed prior to the UART stopping.

Table 13-1. UART Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	UARTDR	RO	0x0000.0000	UART Data	286
0x004	UARTRSR/UARTECR	R/W	0x0000.0000	UART Receive Status/Error Clear	288
0x018	UARTFR	RO	0x0000.0090	UART Flag	290
0x020	UARTILPR	R/W	0x0000.0000	UART IrDA Low-Power Register	292
0x024	UARTIBRD	R/W	0x0000.0000	UART Integer Baud-Rate Divisor	293
0x028	UARTFBRD	R/W	0x0000.0000	UART Fractional Baud-Rate Divisor	294

Offset	Name	Туре	Reset	Description	See page
0x02C	UARTLCRH	R/W	0x0000.0000	UART Line Control	295
0x030	UARTCTL	R/W	0x0000.0300	UART Control	297
0x034	UARTIFLS	R/W	0x0000.0012	UART Interrupt FIFO Level Select	299
0x038	UARTIM	R/W	0x0000.0000	UART Interrupt Mask	300
0x03C	UARTRIS	RO	0x0000.000F	UART Raw Interrupt Status	302
0x040	UARTMIS	RO	0x0000.0000	UART Masked Interrupt Status	303
0x044	UARTICR	W1C	0x0000.0000	UART Interrupt Clear	304
0xFD0	UARTPeriphID4	RO	0x0000.0000	UART Peripheral Identification 4	306
0xFD4	UARTPeriphID5	RO	0x0000.0000	UART Peripheral Identification 5	307
0xFD8	UARTPeriphID6	RO	0x0000.0000	UART Peripheral Identification 6	308
0xFDC	UARTPeriphID7	RO	0x0000.0000	UART Peripheral Identification 7	309
0xFE0	UARTPeriphID0	RO	0x0000.0011	UART Peripheral Identification 0	310
0xFE4	UARTPeriphID1	RO	0x0000.0000	UART Peripheral Identification 1	311
0xFE8	UARTPeriphID2	RO	0x0000.0018	UART Peripheral Identification 2	312
0xFEC	UARTPeriphID3	RO	0x0000.0001	UART Peripheral Identification 3	313
0xFF0	UARTPCellID0	RO	0x0000.000D	UART PrimeCell Identification 0	314
0xFF4	UARTPCellID1	RO	0x0000.00F0	UART PrimeCell Identification 1	315
0xFF8	UARTPCellID2	RO	0x0000.0005	UART PrimeCell Identification 2	316
0xFFC	UARTPCellID3	RO	0x0000.00B1	UART PrimeCell Identification 3	317

13.5 Register Descriptions

The remainder of this section lists and describes the UART registers, in numerical order by address offset.

Register 1: UART Data (UARTDR), offset 0x000

This register is the data register (the interface to the FIFOs).

When FIFOs are enabled, data written to this location is pushed onto the transmit FIFO. If FIFOs are disabled, data is stored in the transmitter holding register (the bottom word of the transmit FIFO). A write to this register initiates a transmission from the UART.

For received data, if the FIFO is enabled, the data byte and the 4-bit status (break, frame, parity and overrun) is pushed onto the 12-bit wide receive FIFO. If FIFOs are disabled, the data byte and status are stored in the receiving holding register (the bottom word of the receive FIFO). The received data can be retrieved by reading this register.

UART Data (UARTDR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x000

Type RO, reset 0x0000.0000

Bit/Field

9

Name

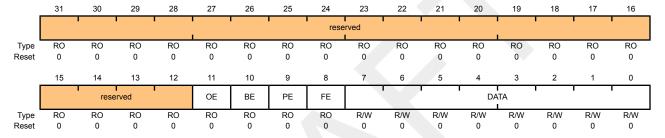
PΕ

Type

RO

Reset

0



Description

31:12	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
11	OE	RO	0	UART Overrun Error
				1=New data was received when the FIFO was full, resulting in data loss.
				0=There has been no data loss due to a FIFO overrun.
10	BE	RO	0	UART Break Error
				This bit is set to 1 when a break condition is detected, indicating that the receive data input was held Low for longer than a full-word transmission time (defined as start, data, parity, and stop bits).
				In FIFO mode, this error is associated with the character at the top of the FIFO. When a break occurs, only one 0 character is loaded into the FIFO. The next character is only enabled after the received data input goes to a 1 (marking state) and the next valid start bit is received.

UART Parity Error

This bit is set to 1 when the parity of the received data character does not match the parity defined by bits 2 and 7 of the **UARTLCRH** register.

In FIFO mode, this error is associated with the character at the top of the FIFO.

Bit/Field	Name	Type	Reset	Description
8	FE	RO	0	UART Framing Error
				This bit is set to 1 when the received character does not have a valid stop bit (a valid stop bit is 1).
7:0	DATA	R/W	0	When written, the data that is to be transmitted via the UART. When read, the data that was received by the UART.



Register 2: UART Receive Status/Error Clear (UARTRSR/UARTECR), offset 0x004

The **UARTRSR/UARTECR** register is the receive status register/error clear register.

In addition to the **UARTDR** register, receive status can also be read from the **UARTRSR** register. If the status is read from this register, then the status information corresponds to the entry read from **UARTDR** prior to reading **UARTRSR**. The status information for overrun is set immediately when an overrun condition occurs.

A write of any value to the **UARTECR** register clears the framing, parity, break, and overrun errors. All the bits are cleared to 0 on reset.

Read-Only Receive Status (UARTRSR) Register

UART Receive Status/Error Clear (UARTRSR/UARTECR)

Name

ΒE

Type

RO

Reset

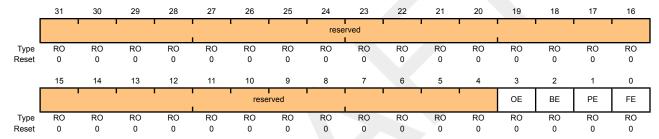
0

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x004

Type R/W, reset 0x0000.0000

Bit/Field

2



		71	7	
31:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
				The UARTRSR register cannot be written.
3	OE	RO	0	UART Overrun Error
				When this bit is set to 1, data is received and the FIFO is already full.

Description

This bit is cleared to 0 by a write to **UARTECR**.

The FIFO contents remain valid since no further data is written when the FIFO is full, only the contents of the shift register are overwritten.

the FIFO is full, only the contents of the shift register are overwritten. The CPU must now read the data in order to empty the FIFO.

UART Break Error

This bit is set to 1 when a break condition is detected, indicating that the received data input was held Low for longer than a full-word transmission time (defined as start, data, parity, and stop bits).

This bit is cleared to 0 by a write to **UARTECR**.

In FIFO mode, this error is associated with the character at the top of the FIFO. When a break occurs, only one 0 character is loaded into the FIFO. The next character is only enabled after the receive data input goes to a 1 (marking state) and the next valid start bit is received.

Bit/Field	Name	Type	Reset	Description
1	PE	RO	0	UART Parity Error
				This bit is set to 1 when the parity of the received data character does not match the parity defined by bits 2 and 7 of the UARTLCRH register.
				This bit is cleared to 0 by a write to UARTECR .
0	FE	RO	0	UART Framing Error
				This bit is set to 1 when the received character does not have a valid stop bit (a valid stop bit is 1).

This bit is cleared to 0 by a write to **UARTECR**.

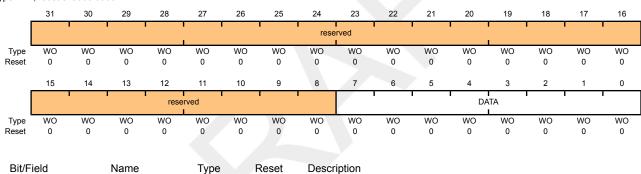
In FIFO mode, this error is associated with the character at the top of the FIFO.

Write-Only Error Clear (UARTECR) Register

UART Receive Status/Error Clear (UARTRSR/UARTECR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x004

Type R/W, reset 0x0000.0000



31:8	reservea	WO	U	compatibility with future products, the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	DATA	WO	0	A write to this register of any data clears the framing, parity, break and overrun flags.

Register 3: UART Flag (UARTFR), offset 0x018

The **UARTFR** register is the flag register. After reset, the TXFF, RXFF, and BUSY bits are 0, and TXFE and RXFE bits are 1.

UART Flag (UARTFR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x018

Offset 0x018 Type RO, reset 0x0000.0090

rype ICO,	, reset ux	0000.008	90													
	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
							'	rese	rved					'		
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ı	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
					erved				TXFE	RXFF	TXFF	RXFE	BUSY		reserved	
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 1	RO 0	RO 0	RO 1	RO 0	RO 0	RO 0	RO 0
Bit/F	ield		Name		Туре		Reset	Descr	ription							
31:	:8		reserved	d RO		0	comp	atibility v		e produ	cts, the	value of	a reserv	t. To prov ved bit sh		
7			TXFE		RO		1	UART	Transm	it FIFO	Empty					
							neaning F LCRH r		t depen	ds on the	e state o	f the FE	EN bit in th	ne		
									FIFO is o er is em		(FEN is C)), this bi	t is set w	hen the	transmit	holding
								If the		enabled	(FEN is	1), this t	oit is set	when th	ne transm	nit FIFO
6	i		RXFF		RO		0	UART Receive FIFO Full								
									neaning LCRH r		t depen	ds on the	e state o	f the FE	EN bit in th	ne
								If the is full.		disabled	, this bit	is set w	hen the	receive	holding r	egister
								If the	FIFO is	enabled,	this bit	is set wl	nen the r	eceive	FIFO is f	ull.
5	j		TXFF		RO		0	UART	Transm	nit FIFO	Full					
									neaning F LCRH r		t depen	ds on the	e state o	f the FE	EN bit in th	ne
								If the is full.		disabled	, this bit	is set w	hen the	transmi	t holding	register

If the FIFO is enabled, this bit is set when the transmit FIFO is full.

Bit/Field	Name	Туре	Reset	Description
4	RXFE	RO	1	UART Receive FIFO Empty
				The meaning of this bit depends on the state of the ${\tt FEN}$ bit in the ${\tt UARTLCRH}$ register.
				If the FIFO is disabled, this bit is set when the receive holding register is empty.
				If the FIFO is enabled, this bit is set when the receive FIFO is empty.
3	BUSY	RO	0	UART Busy
				When this bit is 1, the UART is busy transmitting data. This bit remains set until the complete byte, including all stop bits, has been sent from the shift register.
				This bit is set as soon as the transmit FIFO becomes non-empty (regardless of whether UART is enabled).
2:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

Register 4: UART IrDA Low-Power Register (UARTILPR), offset 0x020

The **UARTILPR** register is an 8-bit read/write register that stores the low-power counter divisor value used to generate the <code>IrlPBaud16</code> signal by dividing down the system clock (SysClk). All the bits are cleared to 0 when reset.

The IrlpBaud16 internal signal is generated by dividing down the UARTCLK signal according to the low-power divisor value written to **UARTILPR**. The low-power divisor value is calculated as follows:

 $ILPDVSR = SysClk / F_{IrLPBaud16}$

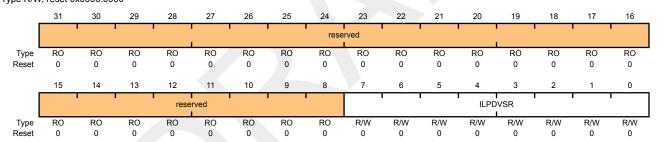
where ${\tt F_{IrLPBaud16}}$ is nominally 1.8432 MHz.

IrlpBaud16 is an internal signal used for SIR pulse generation when low-power mode is used. You must choose the divisor so that $1.42\,\mathrm{MHz} < \mathrm{F_{IrlpBaud16}} < 2.12\,\mathrm{MHz}$, which results in a low-power pulse duration of $1.41-2.11\,\mu\mathrm{s}$ (three times the period of IrlpBaud16). The minimum frequency of IrlpBaud16 ensures that pulses less than one period of IrlpBaud16 are rejected, but that pulses greater than $1.4\,\mu\mathrm{s}$ are accepted as valid pulses.

Note: Zero is an illegal value. Programming a zero value results in no IrlpBaud16 pulses being generated.

UART IrDA Low-Power Register (UARTILPR)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x020 Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	ILPDVSR	R/W	0x0000	IrDA Low-Power Divisor

This is an 8-bit low-power divisor value.

Register 5: UART Integer Baud-Rate Divisor (UARTIBRD), offset 0x024

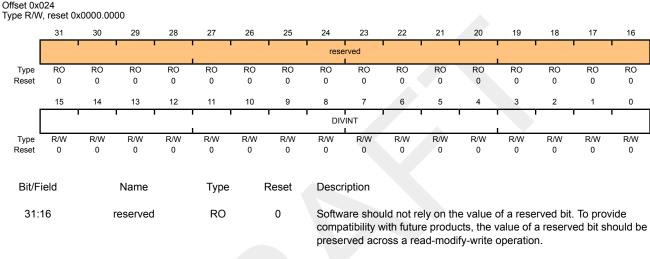
The **UARTIBRD** register is the integer part of the baud-rate divisor value. All the bits are cleared on reset. The minimum possible divide ratio is 1 (when UARTIBRD=0), in which case the UARTFBRD register is ignored. When changing the **UARTIBRD** register, the new value does not take effect until transmission/reception of the current character is complete. Any changes to the baud-rate divisor must be followed by a write to the **UARTLCRH** register. See "Baud-Rate Generation" on page 280 for configuration details.

UART Integer Baud-Rate Divisor (UARTIBRD)

DIVINT

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

15:0



Integer Baud-Rate Divisor

0x0000

R/W

Register 6: UART Fractional Baud-Rate Divisor (UARTFBRD), offset 0x028

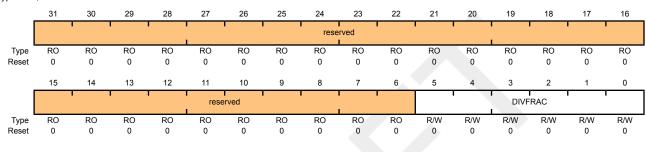
The **UARTFBRD** register is the fractional part of the baud-rate divisor value. All the bits are cleared on reset. When changing the **UARTFBRD** register, the new value does not take effect until transmission/reception of the current character is complete. Any changes to the baud-rate divisor must be followed by a write to the **UARTLCRH** register. See "Baud-Rate Generation" on page 280 for configuration details.

UART Fractional Baud-Rate Divisor (UARTFBRD)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x028

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:6	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5:0	DIVFRAC	R/W	0x00	Fractional Baud-Rate Divisor

Register 7: UART Line Control (UARTLCRH), offset 0x02C

The **UARTLCRH** register is the line control register. Serial parameters such as data length, parity and stop bit selection are implemented in this register.

When updating the baud-rate divisor (**UARTIBRD** and/or **UARTIFRD**), the **UARTLCRH** register must also be written. The write strobe for the baud-rate divisor registers is tied to the **UARTLCRH** register.

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UART Line Control (UARTLCRH)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0x02C

Type R/W	l, reset 0	k0000.00	00		
	31	30	20	28	

27

26

25

24

		1	1 1	· · · · · · · · · · · · · · · · · · ·	1		1	rese	erved		1	1				
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
reset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	15	17	1 1	reser	1	10	1	•	SPS	WL		FEN	STP2	EPS	PEN	BRK
Туре	RO	RO	RO	RO	RO	RO	RO	RO	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bit/F	ield		Name		Туре		Reset	Descr	ription							
31:	8	ı	reserved		RO	RO 0			atibility w	ith futur	e produ	cts, the v	of a rese value of a operation	a reserv	•	
												iy-wiile i	operation	1.		
7			SPS		R/W		0		Stick Pa	-						
								and cl		as a 0. V	Vhen bits	s 1 and	e set, the 7 are set s a 1.			
								When	this bit i	s cleare	d, stick ¡	parity is	disabled			
6:	5		WLEN		R/W		0	UART	Word L	ength						
								The bits indicate the number of data bits transmitted or received in a frame as follows:								
								0x3: 8 bits								
								0x2: 7	bits							
								0x1: 6	bits							
								0x0: 5	bits (de	fault)						
4			FEN		R/W		0	UART	Enable	FIFOs						
								If this mode		to 1, trar	nsmit and	d receive	e FIFO bi	uffers ar	e enable	d (FIFO
									cleared ne 1-byte				d (Chara ·	cter mod	de). The	FIFOs
3			STP2		R/W		0	UART	Two Sto	op Bits S	Select					
													ansmitte vo stop t			

Bit/Field	Name	Туре	Reset	Description
2	EPS	R/W	0	UART Even Parity Select
				If this bit is set to 1, even parity generation and checking is performed during transmission and reception, which checks for an even number of 1s in data and parity bits.
				When cleared to 0, then odd parity is performed, which checks for an odd number of 1s.
				This bit has no effect when parity is disabled by the \mathtt{PEN} bit.
1	PEN	R/W	0	UART Parity Enable
				If this bit is set to 1, parity checking and generation is enabled; otherwise, parity is disabled and no parity bit is added to the data frame.
0	BRK	R/W	0	UART Send Break
				If this bit is set to 1, a Low level is continually output on the ${\tt UnTX}$ output, after completing transmission of the current character. For the proper execution of the break command, the software must set this bit for at least two frames (character periods). For normal use, this bit must be cleared to 0.

Register 8: UART Control (UARTCTL), offset 0x030

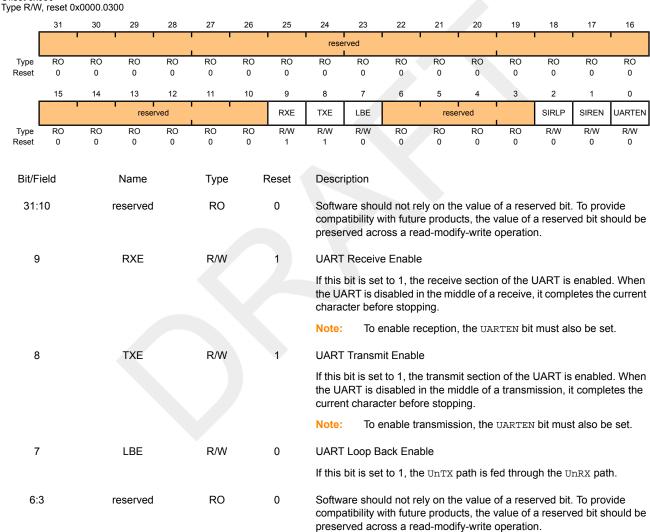
The **UARTCTL** register is the control register. All the bits are cleared on reset except for the Transmit Enable (TXE) and Receive Enable (RXE) bits, which are set to 1.

To enable the UART module, the UARTEN bit must be set to 1. If software requires a configuration change in the module, the UARTEN bit must be cleared before the configuration changes are written. If the UART is disabled during a transmit or receive operation, the current transaction is completed prior to the UART stopping.

UART Control (UARTCTL)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x030



Bit/Field	Name	Туре	Reset	Description
2	SIRLP	R/W	0	UART SIR Low Power Mode
				This bit selects the IrDA encoding mode. If this bit is cleared to 0, low-level bits are transmitted as an active High pulse with a width of 3/16th of the bit period. If this bit is set to 1, low-level bits are transmitted with a pulse width which is 3 times the period of the IrLPBaud16 input signal, regardless of the selected bit rate. Setting this bit uses less power, but might reduce transmission distances. See page 292 for more information.
1	SIREN	R/W	0	UART SIR Enable
				If this bit is set to 1, the IrDA SIR block is enabled, and the UART will transmit and receive data using SIR protocol.
0	UARTEN	R/W	0	UART Enable
				If this bit is set to 1, the UART is enabled. When the UART is disabled in the middle of transmission or reception, it completes the current character before stopping.

Register 9: UART Interrupt FIFO Level Select (UARTIFLS), offset 0x034

The **UARTIFLS** register is the interrupt FIFO level select register. You can use this register to define the FIFO level at which the TXRIS and RXRIS bits in the **UARTRIS** register are triggered.

The interrupts are generated based on a transition through a level rather than being based on the level. That is, the interrupts are generated when the fill level progresses through the trigger level. For example, if the receive trigger level is set to the half-way mark, the interrupt is triggered as the module is receiving the 9th character.

Out of reset, the TXIFLSEL and RXIFLSEL bits are configured so that the FIFOs trigger an interrupt at the half-way mark.

UART Interrupt FIFO Level Select (UARTIFLS)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0x034

Type R/W, reset 0x0000.0012

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		'			<u>'</u>		'	rese	rved	' '	l	•		'	' '	
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
[1			reser	ved	1	'		_		RXIFLSEL TXIFLS			TXIFLSEL	
Type	RO 0	RO 0	RO 0	RO 0	RO	RO 0	RO	RO 0	RO 0	RO 0	R/W	R/W	R/W	R/W	R/W	R/W
Reset	U	U	U	U	0	U	0	U	U	U	0	1	0	0	1	0
Bit/Fi	eld		Name		Туре		Reset	Descr	iption							
31:	6	r	eserved		RO 0		Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.									
5:3	3	R	XIFLSEI	L	R/W		0x2					Level Se				
						The trigger points for the receive interrupt are as follows:										
								000: RX FIFO ≥ 1/8 full								
								001: F	RX FIFO	≥ ¼ full						
								010: F	RX FIFO	≥½ full	(default	t)				
										≥ ¾ full	`	,				
										≥ 7/8 fu	II					
									11: Rese							
		_														
2:0)	Т	XIFLSEI	_	R/W		0x2				•	Level S				
												smit inter	rupt are	as follo	WS:	
										≤ 1/8 ful	I					
									X FIFO							
								010: 7	X FIFO	≤ ½ full	(default)				
								011: T	X FIFO	≤¾ full						
								100: 7	X FIFO	≤ 7/8 ful	I					

101-111: Reserved

Register 10: UART Interrupt Mask (UARTIM), offset 0x038

The **UARTIM** register is the interrupt mask set/clear register.

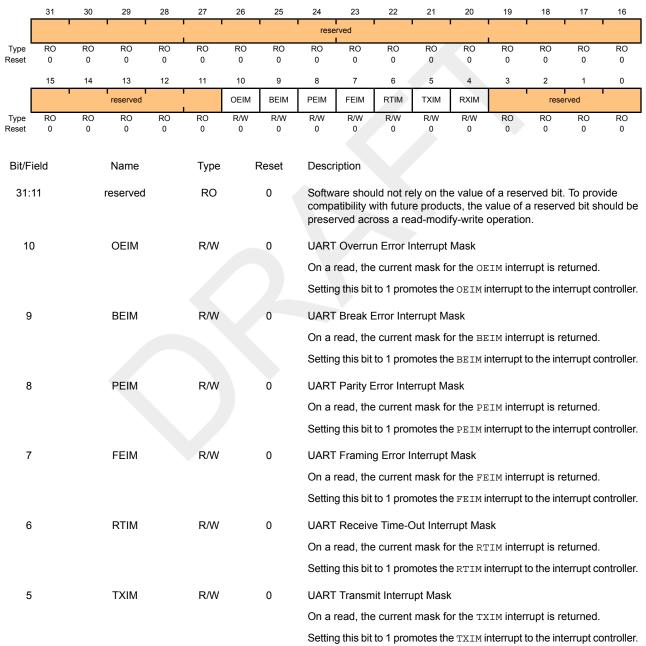
On a read, this register gives the current value of the mask on the relevant interrupt. Writing a 1 to a bit allows the corresponding raw interrupt signal to be routed to the interrupt controller. Writing a 0 prevents the raw interrupt signal from being sent to the interrupt controller.

UART Interrupt Mask (UARTIM)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000

Offset 0x038

Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
4	RXIM	R/W	0	UART Receive Interrupt Mask
				On a read, the current mask for the ${\tt RXIM}$ interrupt is returned.
				Setting this bit to 1 promotes the ${\tt RXIM}$ interrupt to the interrupt controller.
3:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.



Register 11: UART Raw Interrupt Status (UARTRIS), offset 0x03C

The **UARTRIS** register is the raw interrupt status register. On a read, this register gives the current raw status value of the corresponding interrupt. A write has no effect.

UART Raw Interrupt Status (UARTRIS)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0x03C
Type RO, reset 0x0000.000F

.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
['	1 1				1	rese	rved						1	
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Г	15	14	13	12	11	10	9	8	7	6	5 TVD10	4 DVDIO	3	2	1	0
Type	RO	RO	reserved	RO	RO	OERIS	BERIS RO	PERIS RO	FERIS RO	RTRIS	TXRIS	RXRIS	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1
Bit/Fi	eld		Name		Type	F	Reset	Descr	iption							
31:1	11		reserved		RO		0								. To prov	
												cts, the v			ed bit sh	ould be
												•		1.		
10)		OERIS		RO		0					rrupt Sta				
								Gives	the raw	interrup	t state (p	orior to n	nasking)	of this i	nterrupt.	
9			BERIS		RO		0	UART	Break E	Error Ra	w Interru	ıpt Statu	s			
								Gives	the raw	interrup	t state (p	orior to n	nasking)	of this i	nterrupt.	
8			PERIS		RO		0	LIART	Parity F	Frror Ray	w Intern	ıpt Statu	s			
Ü			LINIO		110				,			•		of this i	nterrupt.	
														OI IIIIS I	interrupt.	
7			FERIS		RO		0	UART	Framin	g Error F	Raw Inte	rrupt Sta	atus			
								Gives	the raw	interrup	t state (p	orior to n	nasking)	of this i	nterrupt.	
6			RTRIS		RO		0	UART	Receive	e Time-C	Out Raw	Interrup	t Status			
								Gives	the raw	interrup	t state (p	orior to n	nasking)	of this i	nterrupt.	
5			TXRIS		RO		0	LIART	Transm	nit Raw I	nterrunt	Status				
Ū			17440		110		Ü						naekina)	of this i	nterrupt.	
													iaskii ig)	01 11113 1	interrupt.	
4			RXRIS		RO		0	UART	Receive	e Raw Ir	nterrupt (Status				
								Gives	the raw	interrup	t state (p	orior to n	nasking)	of this i	nterrupt.	
3:0)		reserved		RO		0xF	compa	atibility v	vith futur	e produ		alue of	a reserv	. To prov ed bit sh	

Register 12: UART Masked Interrupt Status (UARTMIS), offset 0x040

The **UARTMIS** register is the masked interrupt status register. On a read, this register gives the current masked status value of the corresponding interrupt. A write has no effect.

UART Masked Interrupt Status (UARTMIS)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0x040
Type RO, reset 0x0000.0000

ypc ito,	TCSCI OX	.0000.000	,0													
	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1	1	'		1		rese	rved I					'		'
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		'	reserved	'	1	OEMIS	BEMIS	PEMIS	FEMIS	RTMIS	TXMIS	RXMIS		rese	rved	•
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO

Reset	0	0 ()	0	0	0	0	0	0	0	0	0	0	0	0	0
Bit/Fie	ld	Naı	me		Туре		Reset	Descri	ption							
31:11		rese	rved		RO		0	compa	atibility w	ith futur	e produ	e value o cts, the va fy-write o	alue of a	a reserve	•	
10		OEM	MIS		RO		0					nterrupt s		ot.		
9		BEN	MIS		RO		0					errupt State		ot.		
8		PEN	MIS		RO		0					errupt Sta		ot.		
7		FEN	MIS		RO		0					nterrupt :		ot.		
6		RTM	MIS		RO		0					ked Interr	•			
5		TXN	MIS		RO		0					upt Status		ot.		
4		RXI	MIS		RO		0					pt Status		ot.		
3:0		rese	rved		RO		0	compa	atibility w	ith futur	e produ	e value o cts, the va fy-write o	alue of a	a reserve		

Register 13: UART Interrupt Clear (UARTICR), offset 0x044

The **UARTICR** register is the interrupt clear register. On a write of 1, the corresponding interrupt (both raw interrupt and masked interrupt, if enabled) is cleared. A write of 0 has no effect.

UART Interrupt Clear (UARTICR)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0x044
Type W1C, reset 0x0000.0000

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								rese	rved I						'	
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		'	reserved			OEIC	BEIC	PEIC	FEIC	RTIC	TXIC	RXIC		rese	erved	
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	W1C 0	W1C 0	W1C 0	W1C 0	W1C 0	W1C 0	W1C 0	RO 0	RO 0	RO 0	RO 0
Bit/F	ield		Name		Туре	F	Reset	Descr	iption							
31:	11		reserved		RO		0	compa	atibility v	vith futur	e produ	e value o cts, the v fy-write o	alue of	a reserv		
10)		OEIC		W1C		0	Overr	un Error	Interrup	t Clear					
								0: No	effect or	n the inte	errupt.					
								1: Cle	ars inter	rupt.						
9	BEIC		W1C 0			Break Error Interrupt Clear 0: No effect on the interrupt.										
									errupt.							
									ars inter							
8			PEIC		W1C		0	-		terrupt C						
									ars inter	n the inte	errupt.					
7			FEIC		W1C		0			Interrup	t Clear					
,			1 LIO		WIO		Ü		-	the inte						
									ars inter		·					
6			RTIC		W1C		0	Recei	ve Time	-Out Inte	errupt Cle	ear				
								0: No	effect or	n the inte	errupt.					
								1: Cle	ars inter	rupt.						
5			TXIC		W1C		0	Trans	mit Inter	rupt Clea	ar					
								0: No	effect or	the inte	errupt.					
								1: Cle	ars inter	rupt.						

Bit/Field	Name	Type	Reset	Description
4	RXIC	W1C	0	Receive Interrupt Clear
				0: No effect on the interrupt.
				1: Clears interrupt.
3:0	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

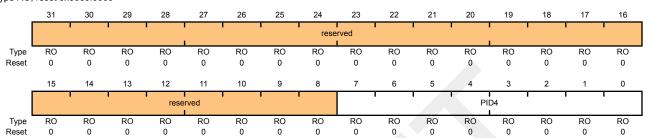


Register 14: UART Peripheral Identification 4 (UARTPeriphID4), offset 0xFD0

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 4 (UARTPeriphID4)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0xFD0
Type RO, reset 0x0000.0000



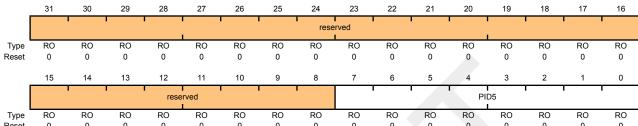
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID4	RO	0x00	UART Peripheral ID Register[7:0]

Register 15: UART Peripheral Identification 5 (UARTPeriphID5), offset 0xFD4

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 5 (UARTPeriphID5)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFD4 Type RO, reset 0x0000.0000



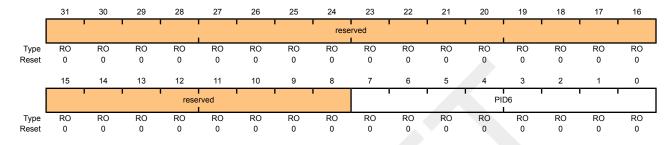
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bit/Fie	ld		Name		Туре		Reset	Descr	iption							
31:8		l	reserved		RO		0	comp	atibility v	vith futu	re produ	e value of cts, the vify-write of	alue of	a reserv	•	
7:0			PID5		RO		0x00	UART	Periphe	eral ID F	Register[15:8]				

Register 16: UART Peripheral Identification 6 (UARTPeriphID6), offset 0xFD8

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 6 (UARTPeriphID6)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0xFD8
Type RO, reset 0x0000.0000



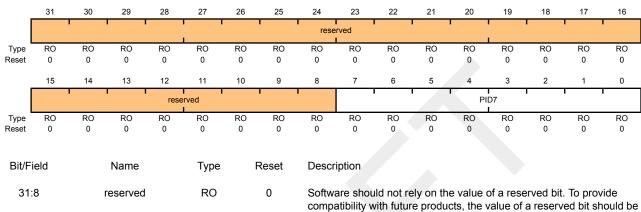
Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID6	RO	0x00	UART Peripheral ID Register[23:16]

Register 17: UART Peripheral Identification 7 (UARTPeriphID7), offset 0xFDC

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 7 (UARTPeriphID7)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFDC Type RO, reset 0x0000.0000

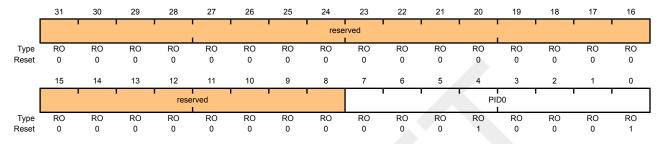


Register 18: UART Peripheral Identification 0 (UARTPeriphID0), offset 0xFE0

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 0 (UARTPeriphID0)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0xFE0
Type RO, reset 0x0000.0011



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID0	RO	0x11	UART Peripheral ID Register[7:0]

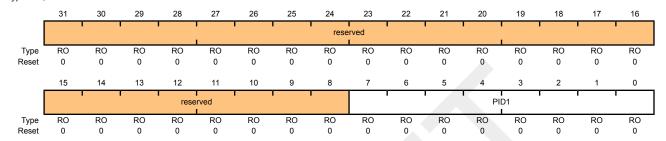
Can be used by software to identify the presence of this peripheral.

Register 19: UART Peripheral Identification 1 (UARTPeriphID1), offset 0xFE4

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 1 (UARTPeriphID1)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFE4 Type RO, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID1	RO	0x00	UART Peripheral ID Register[15:8]

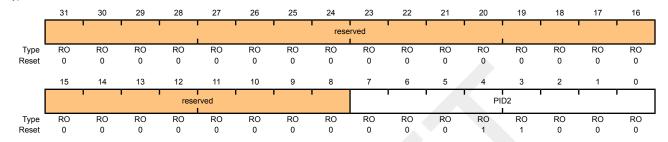
Can be used by software to identify the presence of this peripheral.

Register 20: UART Peripheral Identification 2 (UARTPeriphID2), offset 0xFE8

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 2 (UARTPeriphID2)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0xFE8
Type RO, reset 0x0000.0018



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID2	RO	0x18	UART Peripheral ID Register[23:16]

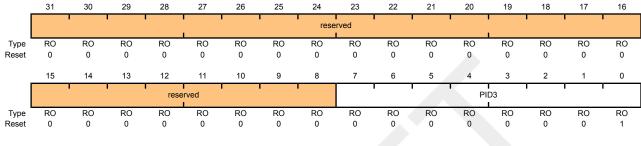
Can be used by software to identify the presence of this peripheral.

Register 21: UART Peripheral Identification 3 (UARTPeriphID3), offset 0xFEC

The **UARTPeriphIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART Peripheral Identification 3 (UARTPeriphID3)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFEC Type RO, reset 0x0000.0001



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	PID3	RO	0x01	UART Peripheral ID Register[31:24]

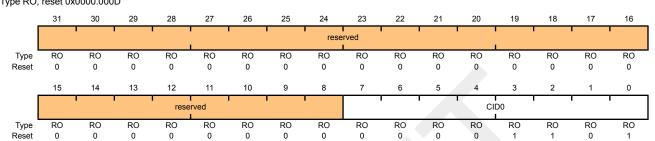
Can be used by software to identify the presence of this peripheral.

Register 22: UART PrimeCell Identification 0 (UARTPCellID0), offset 0xFF0

The **UARTPCellIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART PrimeCell Identification 0 (UARTPCellID0)

UART0 base: 0x4000.C000
UART1 base: 0x4000.D000
UART2 base: 0x4000.E000
Offset 0xFF0
Type RO, reset 0x0000.000D



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID0	RO	0x0D	UART PrimeCell ID Register[7:0]

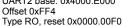
Provides software a standard cross-peripheral identification system.

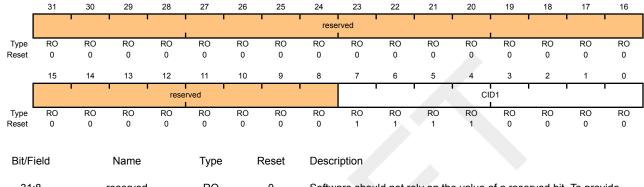
Register 23: UART PrimeCell Identification 1 (UARTPCellID1), offset 0xFF4

The **UARTPCellIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART PrimeCell Identification 1 (UARTPCellID1)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000





Software should not rely on the value of a reserved bit. To provide RO 0 31:8 reserved compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

7:0 CID1 RO 0xF0 UART PrimeCell ID Register[15:8]

Provides software a standard cross-peripheral identification system.

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Register 24: UART PrimeCell Identification 2 (UARTPCellID2), offset 0xFF8

The **UARTPCellIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART PrimeCell Identification 2 (UARTPCellID2)

CID2

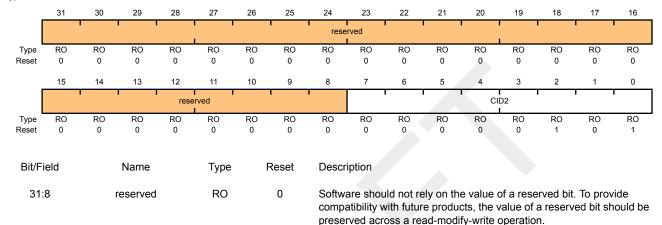
RO

0x05

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFF8

Type RO, reset 0x0000.0005

7:0



Provides software a standard cross-peripheral identification system.

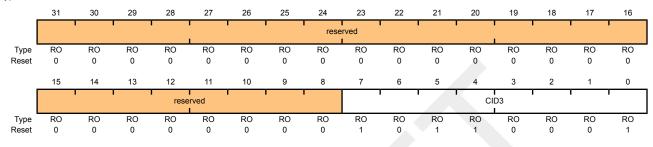
UART PrimeCell ID Register[23:16]

Register 25: UART PrimeCell Identification 3 (UARTPCellID3), offset 0xFFC

The **UARTPCellIDn** registers are hard-coded and the fields within the registers determine the reset values.

UART PrimeCell Identification 3 (UARTPCellID3)

UART0 base: 0x4000.C000 UART1 base: 0x4000.D000 UART2 base: 0x4000.E000 Offset 0xFFC Type RO, reset 0x0000.00B1



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CID3	RO	0xB1	UART PrimeCell ID Register[31:24]

Provides software a standard cross-peripheral identification system.

14 Synchronous Serial Interface (SSI)

SSI

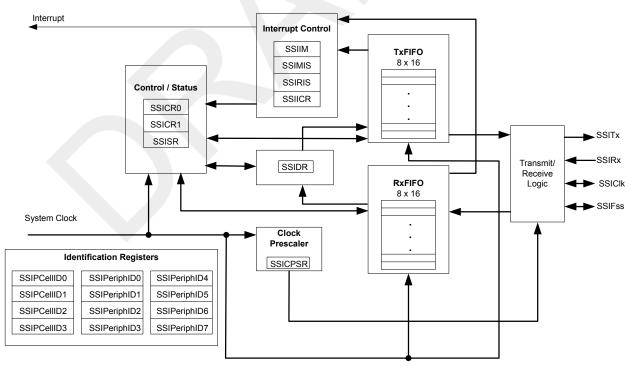
The Stellaris[®] microcontroller includes two Synchronous Serial Interface (SSI) modules. Each SSI is a master or slave interface for synchronous serial communication with peripheral devices that have either Freescale SPI, MICROWIRE, or Texas Instruments synchronous serial interfaces.

Each Stellaris® SSI module has the following features:

- Master or slave operation
- Programmable clock bit rate and prescale
- Separate transmit and receive FIFOs, 16 bits wide, 8 locations deep
- Programmable interface operation for Freescale SPI, MICROWIRE, or Texas Instruments synchronous serial interfaces
- Programmable data frame size from 4 to 16 bits
- Internal loopback test mode for diagnostic/debug testing

14.1 Block Diagram

Figure 14-1. SSI Module Block Diagram



14.2 Functional Description

The SSI performs serial-to-parallel conversion on data received from a peripheral device. The CPU accesses data, control, and status information. The transmit and receive paths are buffered with internal FIFO memories allowing up to eight 16-bit values to be stored independently in both transmit and receive modes.

14.2.1 Bit Rate Generation

The SSI includes a programmable bit rate clock divider and prescaler to generate the serial output clock. Bit rates are supported to 2 MHz and higher, although maximum bit rate is determined by peripheral devices.

The serial bit rate is derived by dividing down the 50-MHz input clock. The clock is first divided by an even prescale value CPSDVSR from 2 to 254, which is programmed in the **SSI Clock Prescale** (**SSICPSR**) register (see page 336). The clock is further divided by a value from 1 to 256, which is 1 + SCR, where SCR is the value programmed in the **SSI Control0** (**SSICR0**) register (see page 330).

The frequency of the output clock SSIClk is defined by:

```
FSSIClk = FSysClk / (CPSDVSR * (1 + SCR))
```

Note that although the SSIClk transmit clock can theoretically be 25 MHz, the module may not be able to operate at that speed. For master mode, the system clock must be at least two times faster than the SSIClk. For slave mode, the system clock must be at least 12 times faster than the SSIClk.

See "Electrical Characteristics" on page 404 to view SSI timing parameters.

14.2.2 FIFO Operation

14.2.2.1 Transmit FIFO

The common transmit FIFO is a 16-bit wide, 8-locations deep, first-in, first-out memory buffer. The CPU writes data to the FIFO by writing the **SSI Data (SSIDR)** register (see page 334), and data is stored in the FIFO until it is read out by the transmission logic.

When configured as a master or a slave, parallel data is written into the transmit FIFO prior to serial conversion and transmission to the attached slave or master, respectively, through the SSITX pin.

14.2.2.2 Receive FIFO

The common receive FIFO is a 16-bit wide, 8-locations deep, first-in, first-out memory buffer. Received data from the serial interface is stored in the buffer until read out by the CPU, which accesses the read FIFO by reading the **SSIDR** register.

When configured as a master or slave, serial data received through the SSIRx pin is registered prior to parallel loading into the attached slave or master receive FIFO, respectively.

14.2.3 Interrupts

The SSI can generate interrupts when the following conditions are observed:

- Transmit FIFO service
- Receive FIFO service
- Receive FIFO time-out

Receive FIFO overrun

All of the interrupt events are ORed together before being sent to the interrupt controller, so the SSI can only generate a single interrupt request to the controller at any given time. You can mask each of the four individual maskable interrupts by setting the appropriate bits in the **SSI Interrupt Mask** (**SSIIM**) register (see page 337). Setting the appropriate mask bit to 1 enables the interrupt.

Provision of the individual outputs, as well as a combined interrupt output, allows use of either a global interrupt service routine, or modular device drivers to handle interrupts. The transmit and receive dynamic dataflow interrupts have been separated from the status interrupts so that data can be read or written in response to the FIFO trigger levels. The status of the individual interrupt sources can be read from the **SSI Raw Interrupt Status (SSIRIS)** and **SSI Masked Interrupt Status (SSIMIS)** registers (see page 338 and page 339, respectively).

14.2.4 Frame Formats

Each data frame is between 4 and 16 bits long, depending on the size of data programmed, and is transmitted starting with the MSB. There are three basic frame types that can be selected:

- Texas Instruments synchronous serial
- Freescale SPI
- MICROWIRE

For all three formats, the serial clock (SSIClk) is held inactive while the SSI is idle, and SSIClk transitions at the programmed frequency only during active transmission or reception of data. The idle state of SSIClk is utilized to provide a receive timeout indication that occurs when the receive FIFO still contains data after a timeout period.

For Freescale SPI and MICROWIRE frame formats, the serial frame (SSIFss) pin is active Low, and is asserted (pulled down) during the entire transmission of the frame.

For Texas Instruments synchronous serial frame format, the SSIFss pin is pulsed for one serial clock period starting at its rising edge, prior to the transmission of each frame. For this frame format, both the SSI and the off-chip slave device drive their output data on the rising edge of SSIClk, and latch data from the other device on the falling edge.

Unlike the full-duplex transmission of the other two frame formats, the MICROWIRE format uses a special master-slave messaging technique, which operates at half-duplex. In this mode, when a frame begins, an 8-bit control message is transmitted to the off-chip slave. During this transmit, no incoming data is received by the SSI. After the message has been sent, the off-chip slave decodes it and, after waiting one serial clock after the last bit of the 8-bit control message has been sent, responds with the requested data. The returned data can be 4 to 16 bits in length, making the total frame length anywhere from 13 to 25 bits.

14.2.4.1 Texas Instruments Synchronous Serial Frame Format

Figure 14-2 on page 321 shows the Texas Instruments synchronous serial frame format for a single transmitted frame.

Figure 14-2. TI Synchronous Serial Frame Format (Single Transfer)

In this mode, SSIC1k and SSIFSS are forced Low, and the transmit data line SSITX is tristated whenever the SSI is idle. Once the bottom entry of the transmit FIFO contains data, SSIFSS is pulsed High for one SSIC1k period. The value to be transmitted is also transferred from the transmit FIFO to the serial shift register of the transmit logic. On the next rising edge of SSIC1k, the MSB of the 4 to 16-bit data frame is shifted out on the SSITX pin. Likewise, the MSB of the received data is shifted onto the SSIRX pin by the off-chip serial slave device.

Both the SSI and the off-chip serial slave device then clock each data bit into their serial shifter on the falling edge of each SSIClk. The received data is transferred from the serial shifter to the receive FIFO on the first rising edge of SSIClk after the LSB has been latched.

Figure 14-3 on page 321 shows the Texas Instruments synchronous serial frame format when back-to-back frames are transmitted.

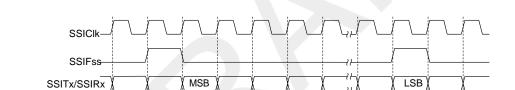


Figure 14-3. TI Synchronous Serial Frame Format (Continuous Transfer)

14.2.4.2 Freescale SPI Frame Format

The Freescale SPI interface is a four-wire interface where the SSIFss signal behaves as a slave select. The main feature of the Freescale SPI format is that the inactive state and phase of the SSIClk signal are programmable through the SPO and SPH bits within the **SSISCRO** control register.

4 to 16 bits

SPO Clock Polarity Bit

When the SPO clock polarity control bit is Low, it produces a steady state Low value on the SSIClk pin. If the SPO bit is High, a steady state High value is placed on the SSIClk pin when data is not being transferred.

SPH Phase Control Bit

The SPH phase control bit selects the clock edge that captures data and allows it to change state. It has the most impact on the first bit transmitted by either allowing or not allowing a clock transition before the first data capture edge. When the SPH phase control bit is Low, data is captured on the first clock edge transition. If the SPH bit is High, data is captured on the second clock edge transition.

14.2.4.3 Freescale SPI Frame Format with SPO=0 and SPH=0

Single and continuous transmission signal sequences for Freescale SPI format with SPO=0 and SPH=0 are shown in Figure 14-4 on page 322 and Figure 14-5 on page 322.

Figure 14-4. Freescale SPI Format (Single Transfer) with SPO=0 and SPH=0

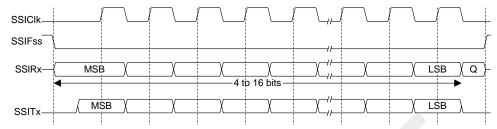
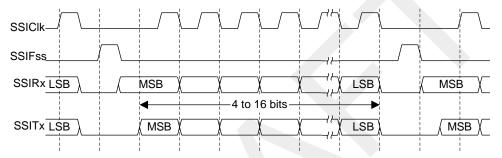


Figure 14-5. Freescale SPI Format (Continuous Transfer) with SPO=0 and SPH=0



Note: Q is undefined.

In this configuration, during idle periods:

- SSIC1k is forced Low
- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low
- When the SSI is configured as a master, it enables the SSIClk pad
- When the SSI is configured as a slave, it disables the SSIClk pad

If the SSI is enabled and there is valid data within the transmit FIFO, the start of transmission is signified by the SSIFss master signal being driven Low. This causes slave data to be enabled onto the SSIRx input line of the master. The master SSITx output pad is enabled.

One half SSIC1k period later, valid master data is transferred to the SSITx pin. Now that both the master and slave data have been set, the SSIC1k master clock pin goes High after one further half SSIC1k period.

The data is now captured on the rising and propagated on the falling edges of the SSIClk signal.

In the case of a single word transmission, after all bits of the data word have been transferred, the SSIFss line is returned to its idle High state one SSIC1k period after the last bit has been captured.

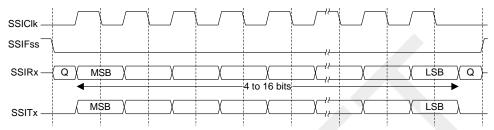
However, in the case of continuous back-to-back transmissions, the ${\tt SSIFss}$ signal must be pulsed High between each data word transfer. This is because the slave select pin freezes the data in its

serial peripheral register and does not allow it to be altered if the SPH bit is logic zero. Therefore, the master device must raise the SSIFss pin of the slave device between each data transfer to enable the serial peripheral data write. On completion of the continuous transfer, the SSIFss pin is returned to its idle state one SSIClk period after the last bit has been captured.

14.2.4.4 Freescale SPI Frame Format with SPO=0 and SPH=1

The transfer signal sequence for Freescale SPI format with SPO=0 and SPH=1 is shown in Figure 14-6 on page 323, which covers both single and continuous transfers.

Figure 14-6. Freescale SPI Frame Format with SPO=0 and SPH=1



Note: Q is undefined.

In this configuration, during idle periods:

- SSIC1k is forced Low
- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low
- When the SSI is configured as a master, it enables the SSIClk pad
- When the SSI is configured as a slave, it disables the SSIClk pad

If the SSI is enabled and there is valid data within the transmit FIFO, the start of transmission is signified by the SSIFss master signal being driven Low. The master SSITx output is enabled. After a further one half SSIClk period, both master and slave valid data is enabled onto their respective transmission lines. At the same time, the SSIClk is enabled with a rising edge transition.

Data is then captured on the falling edges and propagated on the rising edges of the SSIC1k signal.

In the case of a single word transfer, after all bits have been transferred, the SSIFss line is returned to its idle High state one SSIClk period after the last bit has been captured.

For continuous back-to-back transfers, the SSIFss pin is held Low between successive data words and termination is the same as that of the single word transfer.

14.2.4.5 Freescale SPI Frame Format with SPO=1 and SPH=0

Single and continuous transmission signal sequences for Freescale SPI format with SPO=1 and SPH=0 are shown in Figure 14-7 on page 324 and Figure 14-8 on page 324.

SSICIK

SSIFss

SSIRx

MSB

4 to 16 bits

SSITx

MSB

LSB
Q

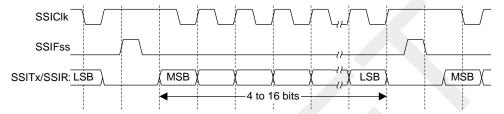
LSB

LSB

Figure 14-7. Freescale SPI Frame Format (Single Transfer) with SPO=1 and SPH=0

Note: Q is undefined.

Figure 14-8. Freescale SPI Frame Format (Continuous Transfer) with SPO=1 and SPH=0



In this configuration, during idle periods:

- SSIC1k is forced High
- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low
- When the SSI is configured as a master, it enables the SSIClk pad
- When the SSI is configured as a slave, it disables the SSIClk pad

If the SSI is enabled and there is valid data within the transmit FIFO, the start of transmission is signified by the SSIFss master signal being driven Low, which causes slave data to be immediately transferred onto the SSIRx line of the master. The master SSITx output pad is enabled.

One half period later, valid master data is transferred to the \mathtt{SSITx} line. Now that both the master and slave data have been set, the \mathtt{SSIClk} master clock pin becomes Low after one further half \mathtt{SSIClk} period. This means that data is captured on the falling edges and propagated on the rising edges of the \mathtt{SSIClk} signal.

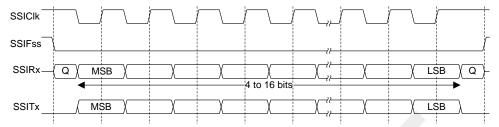
In the case of a single word transmission, after all bits of the data word are transferred, the SSIFss line is returned to its idle High state one SSIClk period after the last bit has been captured.

However, in the case of continuous back-to-back transmissions, the SSIFss signal must be pulsed High between each data word transfer. This is because the slave select pin freezes the data in its serial peripheral register and does not allow it to be altered if the SPH bit is logic zero. Therefore, the master device must raise the SSIFss pin of the slave device between each data transfer to enable the serial peripheral data write. On completion of the continuous transfer, the SSIFss pin is returned to its idle state one SSIClk period after the last bit has been captured.

14.2.4.6 Freescale SPI Frame Format with SPO=1 and SPH=1

The transfer signal sequence for Freescale SPI format with SPO=1 and SPH=1 is shown in Figure 14-9 on page 325, which covers both single and continuous transfers.

Figure 14-9. Freescale SPI Frame Format with SPO=1 and SPH=1



Note: Q is undefined.

In this configuration, during idle periods:

- SSIC1k is forced High
- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low
- When the SSI is configured as a master, it enables the SSIClk pad
- When the SSI is configured as a slave, it disables the SSIClk pad

If the SSI is enabled and there is valid data within the transmit FIFO, the start of transmission is signified by the SSIFss master signal being driven Low. The master SSITx output pad is enabled. After a further one-half SSIClk period, both master and slave data are enabled onto their respective transmission lines. At the same time, SSIClk is enabled with a falling edge transition. Data is then captured on the rising edges and propagated on the falling edges of the SSIClk signal.

After all bits have been transferred, in the case of a single word transmission, the SSIFss line is returned to its idle high state one SSIClk period after the last bit has been captured.

For continuous back-to-back transmissions, the SSIFss pin remains in its active Low state, until the final bit of the last word has been captured, and then returns to its idle state as described above.

For continuous back-to-back transfers, the SSIFss pin is held Low between successive data words and termination is the same as that of the single word transfer.

14.2.4.7 MICROWIRE Frame Format

Figure 14-10 on page 326 shows the MICROWIRE frame format, again for a single frame. Figure 14-11 on page 327 shows the same format when back-to-back frames are transmitted.

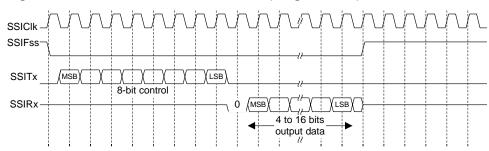


Figure 14-10. MICROWIRE Frame Format (Single Frame)

MICROWIRE format is very similar to SPI format, except that transmission is half-duplex instead of full-duplex, using a master-slave message passing technique. Each serial transmission begins with an 8-bit control word that is transmitted from the SSI to the off-chip slave device. During this transmission, no incoming data is received by the SSI. After the message has been sent, the off-chip slave decodes it and, after waiting one serial clock after the last bit of the 8-bit control message has been sent, responds with the required data. The returned data is 4 to 16 bits in length, making the total frame length anywhere from 13 to 25 bits.

In this configuration, during idle periods:

- SSIC1k is forced Low
- SSIFss is forced High
- The transmit data line SSITx is arbitrarily forced Low

A transmission is triggered by writing a control byte to the transmit FIFO. The falling edge of SSIFss causes the value contained in the bottom entry of the transmit FIFO to be transferred to the serial shift register of the transmit logic, and the MSB of the 8-bit control frame to be shifted out onto the SSITxpin. SSIFss remains Low for the duration of the frame transmission. The SSIRxpin pin remains tristated during this transmission.

The off-chip serial slave device latches each control bit into its serial shifter on the rising edge of each SSIClk. After the last bit is latched by the slave device, the control byte is decoded during a one clock wait-state, and the slave responds by transmitting data back to the SSI. Each bit is driven onto the SSIRx line on the falling edge of SSIClk. The SSI in turn latches each bit on the rising edge of SSIClk. At the end of the frame, for single transfers, the SSIFss signal is pulled High one clock period after the last bit has been latched in the receive serial shifter, which causes the data to be transferred to the receive FIFO.

Note: The off-chip slave device can tristate the receive line either on the falling edge of SSIC1k after the LSB has been latched by the receive shifter, or when the SSIFss pin goes High.

For continuous transfers, data transmission begins and ends in the same manner as a single transfer. However, the SSIFSS line is continuously asserted (held Low) and transmission of data occurs back-to-back. The control byte of the next frame follows directly after the LSB of the received data from the current frame. Each of the received values is transferred from the receive shifter on the falling edge of SSIClk, after the LSB of the frame has been latched into the SSI.

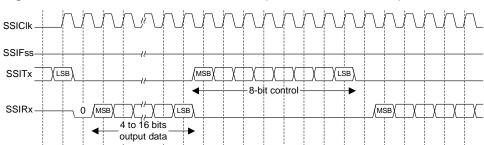


Figure 14-11. MICROWIRE Frame Format (Continuous Transfer)

In the MICROWIRE mode, the SSI slave samples the first bit of receive data on the rising edge of SSIClk after SSIFss has gone Low. Masters that drive a free-running SSIClk must ensure that the SSIFss signal has sufficient setup and hold margins with respect to the rising edge of SSIClk.

Figure 14-12 on page 327 illustrates these setup and hold time requirements. With respect to the SSIClk rising edge on which the first bit of receive data is to be sampled by the SSI slave, SSIFss must have a setup of at least two times the period of SSIClk on which the SSI operates. With respect to the SSIClk rising edge previous to this edge, SSIFss must have a hold of at least one SSIClk period.

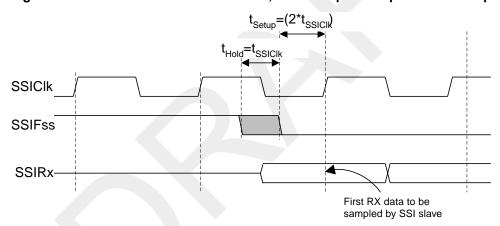


Figure 14-12. MICROWIRE Frame Format, SSIFss Input Setup and Hold Requirements

14.3 Initialization and Configuration

To use the SSI, its peripheral clock must be enabled by setting the SSI bit in the **RCGC1** register. For each of the frame formats, the SSI is configured using the following steps:

- 1. Ensure that the SSE bit in the **SSICR1** register is disabled before making any configuration changes.
- 2. Select whether the SSI is a master or slave:
 - a. For master operations, set the **SSICR1** register to 0x00000000.
 - b. For slave mode (output enabled), set the **SSICR1** register to 0x00000004.
 - c. For slave mode (output disabled), set the **SSICR1** register to 0x0000000C.
- 3. Configure the clock prescale divisor by writing the **SSICPSR** register.

- 4. Write the **SSICR0** register with the following configuration:
 - Serial clock rate (SCR)
 - Desired clock phase/polarity, if using Freescale SPI mode (SPH and SPO)
 - The protocol mode: Freescale SPI, TI SSF, MICROWIRE (FRF)
 - The data size (DSS)
- 5. Enable the SSI by setting the SSE bit in the SSICR1 register.

As an example, assume the SSI must be configured to operate with the following parameters:

- Master operation
- Freescale SPI mode (SPO=1, SPH=1)
- 1 Mbps bit rate
- 8 data bits

Assuming the system clock is 20 MHz, the bit rate calculation would be:

```
FSSIClk = FSysClk / (CPSDVSR * (1 + SCR))
1x106 = 20x106 / (CPSDVSR * (1 + SCR))
```

In this case, if CPSDVSR=2, SCR must be 9.

The configuration sequence would be as follows:

- Ensure that the SSE bit in the SSICR1 register is disabled.
- Write the SSICR1 register with a value of 0x00000000.
- 3. Write the **SSICPSR** register with a value of 0x00000002.
- 4. Write the **SSICR0** register with a value of 0x000009C7.
- 5. The SSI is then enabled by setting the SSE bit in the SSICR1 register to 1.

14.4 Register Map

Table 14-1 on page 329 lists the SSI registers. The offset listed is a hexadecimal increment to the register's address, relative to that SSI module's base address:

- SSI0: 0x4000.8000
- SSI1: 0x4000.9000

Note: The SSI must be disabled (see the SSE bit in the **SSICR1** register) before any of the control registers are reprogrammed.

Table 14-1. SSI Register Map

Offset	Name	Туре	Reset	Description	See page
0x000	SSICR0	R/W	0x0000.0000	SSI Control 0	330
0x004	SSICR1	R/W	0x0000.0000	SSI Control 1	332
0x008	SSIDR	R/W	0x0000.0000	SSI Data	334
0x00C	SSISR	RO	0x0000.0003	SSI Status	335
0x010	SSICPSR	R/W	0x0000.0000	SSI Clock Prescale	336
0x014	SSIIM	R/W	0x0000.0000	SSI Interrupt Mask	337
0x018	SSIRIS	RO	0x0000.0008	SSI Raw Interrupt Status	338
0x01C	SSIMIS	RO	0x0000.0000	SSI Masked Interrupt Status	339
0x020	SSIICR	W1C	0x0000.0000	SSI Interrupt Clear	340
0xFD0	SSIPeriphID4	RO	0x0000.0000	SSI Peripheral Identification 4	341
0xFD4	SSIPeriphID5	RO	0x0000.0000	SSI Peripheral Identification 5	342
0xFD8	SSIPeriphID6	RO	0x0000.0000	SSI Peripheral Identification 6	343
0xFDC	SSIPeriphID7	RO	0x0000.0000	SSI Peripheral Identification 7	344
0xFE0	SSIPeriphID0	RO	0x0000.0022	SSI Peripheral Identification 0	345
0xFE4	SSIPeriphID1	RO	0x0000.0000	SSI Peripheral Identification 1	346
0xFE8	SSIPeriphID2	RO	0x0000.0018	SSI Peripheral Identification 2	347
0xFEC	SSIPeriphID3	RO	0x0000.0001	SSI Peripheral Identification 3	348
0xFF0	SSIPCelIID0	RO	0x0000.000D	SSI PrimeCell Identification 0	349
0xFF4	SSIPCellID1	RO	0x0000.00F0	SSI PrimeCell Identification 1	350
0xFF8	SSIPCelIID2	RO	0x0000.0005	SSI PrimeCell Identification 2	351
0xFFC	SSIPCelIID3	RO	0x0000.00B1	SSI PrimeCell Identification 3	352

14.5 Register Descriptions

The remainder of this section lists and describes the SSI registers, in numerical order by address offset.

Register 1: SSI Control 0 (SSICR0), offset 0x000

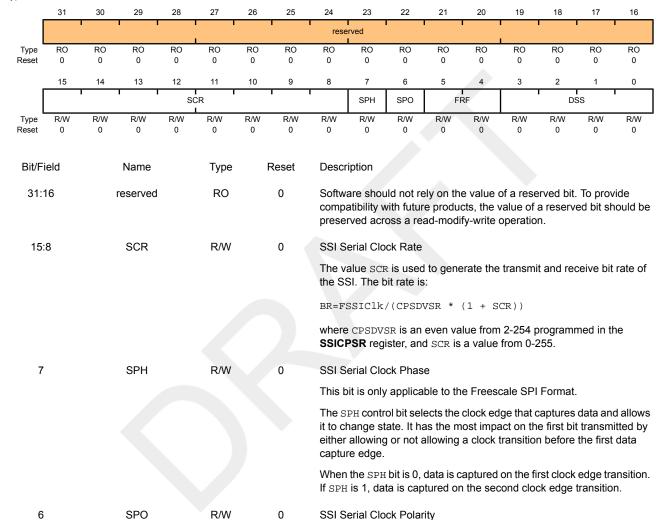
SSICR0 is control register 0 and contains bit fields that control various functions within the SSI module. Functionality such as protocol mode, clock rate and data size are configured in this register.

SSI Control 0 (SSICR0)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x000

Type R/W, reset 0x0000.0000



When the SPO bit is 0, it produces a steady state Low value on the SSIClk pin. If SPO is 1, a steady state High value is placed on the

SSIC1k pin when data is not being transferred.

This bit is only applicable to the Freescale SPI Format.

Bit/Field	Name	Туре	Reset	Description
5:4	FRF	R/W	0	SSI Frame Format Select
				The FRF values are defined as follows:
				FRF Value Frame Format
				00 Freescale SPI Frame Format
				01 Texas Intruments Synchronous Serial Frame Format
				10 MICROWIRE Frame Format
				11 Reserved
3:0	DSS	R/W	0	SSI Data Size Select
				The DSS values are defined as follows:
				DSS Value Data Size
				0000-0010 Reserved
				0011 4-bit data
				0100 5-bit data
				0101 6-bit data
				0110 7-bit data
				0111 8-bit data
				1000 9-bit data
				1001 10-bit data
				1010 11-bit data
				1011 12-bit data
				1100 13-bit data
				1101 14-bit data
				1110 15-bit data
				1111 16-bit data

Register 2: SSI Control 1 (SSICR1), offset 0x004

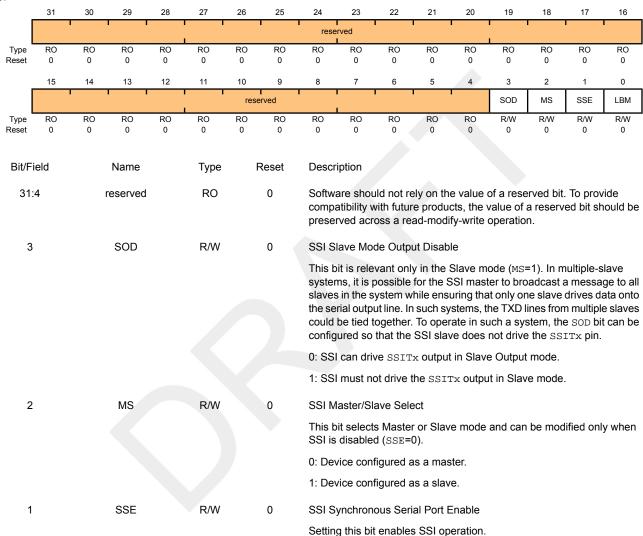
SSICR1 is control register 1 and contains bit fields that control various functions within the SSI module. Master and slave mode functionality is controlled by this register.

SSI Control 1 (SSICR1)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x004

Type R/W, reset 0x0000.0000



0: SSI operation disabled.

1: SSI operation enabled.

Note: This bit must be set to 0 before any control registers are

reprogrammed.

Bit/Field	Name	Туре	Reset	Description
0	LBM	R/W	0	SSI Loopback Mode
				Setting this bit enables Loopback Test mode.
				0: Normal serial port operation enabled.
				1: Output of the transmit serial shift register is connected internally to the input of the receive serial shift register.



Register 3: SSI Data (SSIDR), offset 0x008

SSIDR is the data register and is 16-bits wide. When **SSIDR** is read, the entry in the receive FIFO (pointed to by the current FIFO read pointer) is accessed. As data values are removed by the SSI receive logic from the incoming data frame, they are placed into the entry in the receive FIFO (pointed to by the current FIFO write pointer).

When **SSIDR** is written to, the entry in the transmit FIFO (pointed to by the write pointer) is written to. Data values are removed from the transmit FIFO one value at a time by the transmit logic. It is loaded into the transmit serial shifter, then serially shifted out onto the SSITX pin at the programmed bit rate.

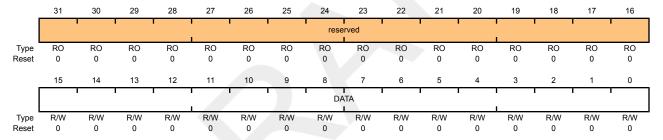
When a data size of less than 16 bits is selected, the user must right-justify data written to the transmit FIFO. The transmit logic ignores the unused bits. Received data less than 16 bits is automatically right-justified in the receive buffer.

When the SSI is programmed for MICROWIRE frame format, the default size for transmit data is eight bits (the most significant byte is ignored). The receive data size is controlled by the programmer. The transmit FIFO and the receive FIFO are not cleared even when the SSE bit in the **SSICR1** register is set to zero. This allows the software to fill the transmit FIFO before enabling the SSI.

SSI Data (SSIDR)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0x008

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:16	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
15:0	DATA	R/W	0	SSI Receive/Transmit Data

A read operation reads the receive FIFO. A write operation writes the transmit FIFO.

Software must right-justify data when the SSI is programmed for a data size that is less than 16 bits. Unused bits at the top are ignored by the transmit logic. The receive logic automatically right-justifies the data.

Register 4: SSI Status (SSISR), offset 0x00C

SSISR is a status register that contains bits that indicate the FIFO fill status and the SSI busy status.

SSI Status (SSISR)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0x00C Type RO, reset 0x0000.0003

ype RO,	/pe RO, reset 0x0000.0003															
	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								rese	rved		· ·					•
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		ı				reserved				•		BSY	RFF	RNE	TNF	TFE
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 1	R0 1
Bit/F	ield		Name		Туре	F	teset	Descr	iption							
31:	5		reserved		RO		0	compa	atibility w	ith futur	e produc	e value of cts, the v fy-write of	alue of	a reserv		
4			BSY		RO		0	SSI B	usy Bit							
								0: SSI	is idle.							
									is curre is not en		smitting	and/or r	eceiving	a frame	, or the t	ransmit
3			RFF		RO		0	SSIR	eceive F	IFO Full						
								0: Red	ceive FIF	O is not	full.					
								1: Red	ceive FIF	O is full						
2			RNE		RO		0	SSIR	eceive F	IFO Not	Empty					
								0: Red	ceive FIF	O is em	pty.					
								1: Red	ceive FIF	O is not	empty.					
1			TNF		RO		1	SSI Tı	ransmit I	FIFO No	t Full					
								0: Tra	nsmit FI	FO is ful	l.					
								1: Tra	nsmit FI	FO is no	t full.					
0			TFE		R0		1	SSI Tı	ransmit I	FIFO Em	pty					
								0: Tra	nsmit FI	FO is no	t empty.					
								1: Tra	nsmit FI	FO is em	npty.					

Register 5: SSI Clock Prescale (SSICPSR), offset 0x010

SSICPSR is the clock prescale register and specifies the division factor by which the system clock must be internally divided before further use.

The value programmed into this register must be an even number between 2 and 254. The least-significant bit of the programmed number is hard-coded to zero. If an odd number is written to this register, data read back from this register has the least-significant bit as zero.

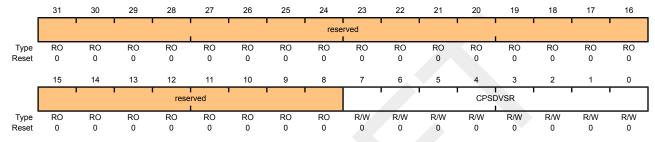
SSI Clock Prescale (SSICPSR)

Namo

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0x010

Dit/Eiold

Type R/W, reset 0x0000.0000



Dit/Fielu	Name	туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	CPSDVSR	R/W	0	SSI Clock Prescale Divisor

Description

Docot

This value must be an even number from 2 to 254, depending on the frequency of ${\tt SSIClk}.$ The LSB always returns 0 on reads.

Register 6: SSI Interrupt Mask (SSIIM), offset 0x014

The **SSIIM** register is the interrupt mask set or clear register. It is a read/write register and all bits are cleared to 0 on reset.

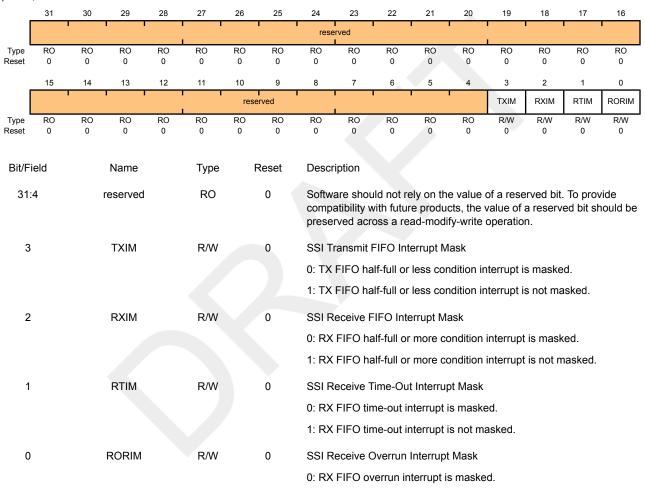
On a read, this register gives the current value of the mask on the relevant interrupt. A write of 1 to the particular bit sets the mask, enabling the interrupt to be read. A write of 0 clears the corresponding mask.

SSI Interrupt Mask (SSIIM)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x014

Type R/W, reset 0x0000.0000



1: RX FIFO overrun interrupt is not masked.

Register 7: SSI Raw Interrupt Status (SSIRIS), offset 0x018

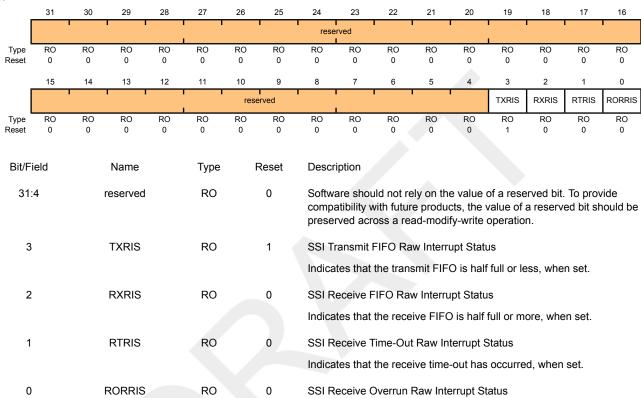
The **SSIRIS** register is the raw interrupt status register. On a read, this register gives the current raw status value of the corresponding interrupt prior to masking. A write has no effect.

SSI Raw Interrupt Status (SSIRIS)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x018

Type RO, reset 0x0000.0008



Indicates that the receive FIFO has overflowed, when set.

Register 8: SSI Masked Interrupt Status (SSIMIS), offset 0x01C

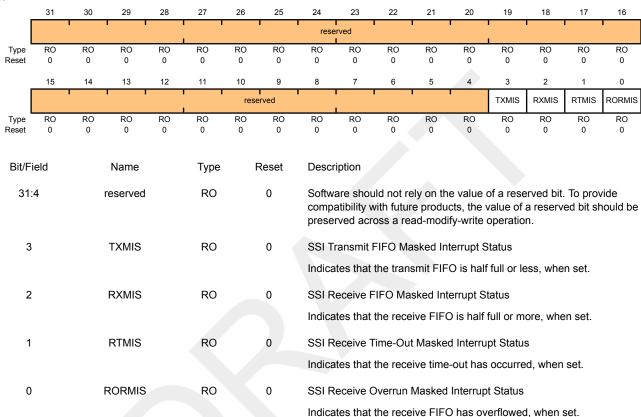
The **SSIMIS** register is the masked interrupt status register. On a read, this register gives the current masked status value of the corresponding interrupt. A write has no effect.

SSI Masked Interrupt Status (SSIMIS)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0x01C

Type RO, reset 0x0000.0000

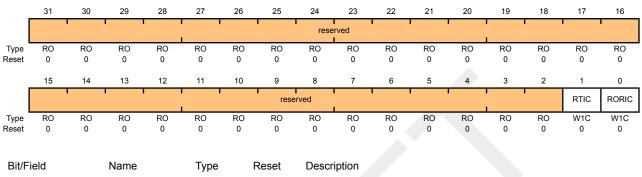


Register 9: SSI Interrupt Clear (SSIICR), offset 0x020

The SSIICR register is the interrupt clear register. On a write of 1, the corresponding interrupt is cleared. A write of 0 has no effect.

SSI Interrupt Clear (SSIICR)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0x020 Type W1C, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:2	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
1	RTIC	W1C	0	SSI Receive Time-Out Interrupt Clear 0: No effect on interrupt. 1: Clears interrupt.
0	RORIC	W1C	0	SSI Receive Overrun Interrupt Clear 0: No effect on interrupt.

1: Clears interrupt.

Register 10: SSI Peripheral Identification 4 (SSIPeriphID4), offset 0xFD0

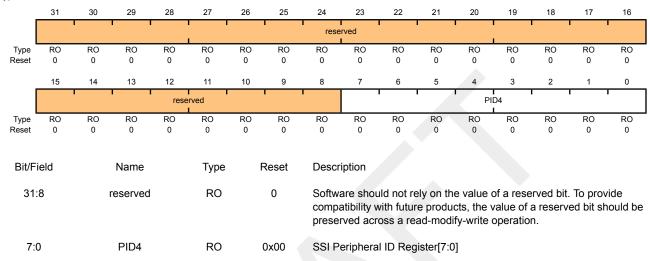
The **SSIPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 4 (SSIPeriphID4)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0xFD0

Type RO, reset 0x0000.0000



Can be used by software to identify the presence of this peripheral.

Register 11: SSI Peripheral Identification 5 (SSIPeriphID5), offset 0xFD4

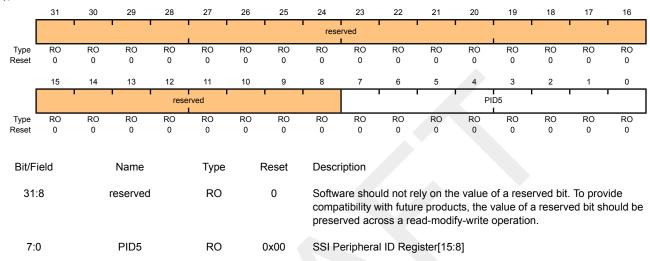
The **SSIPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 5 (SSIPeriphID5)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0xFD4

Type RO, reset 0x0000.0000



Can be used by software to identify the presence of this peripheral.

Register 12: SSI Peripheral Identification 6 (SSIPeriphID6), offset 0xFD8

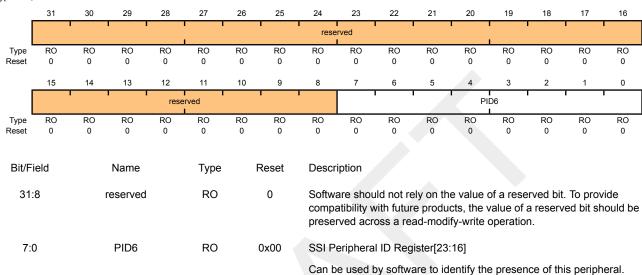
The **SSIPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 6 (SSIPeriphID6)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0xFD8

Type RO, reset 0x0000.0000



Register 13: SSI Peripheral Identification 7 (SSIPeriphID7), offset 0xFDC

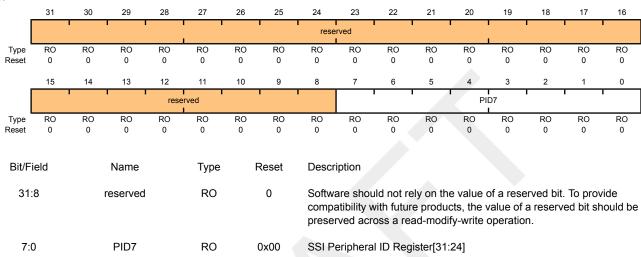
The **SSIPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 7 (SSIPeriphID7)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0xFDC

Type RO, reset 0x0000.0000



Can be used by software to identify the presence of this peripheral.

Register 14: SSI Peripheral Identification 0 (SSIPeriphID0), offset 0xFE0

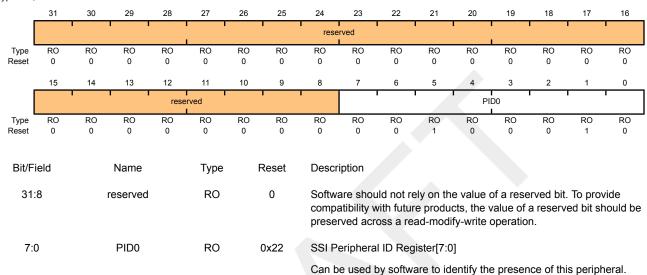
The **SSIPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 0 (SSIPeriphID0)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0xFE0

Type RO, reset 0x0000.0022



Register 15: SSI Peripheral Identification 1 (SSIPeriphID1), offset 0xFE4

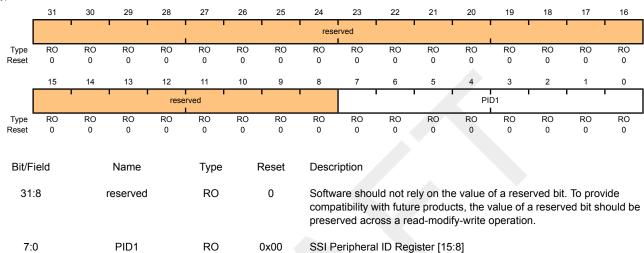
The **SSIPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 1 (SSIPeriphID1)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0xFE4

Type RO, reset 0x0000.0000



Can be used by software to identify the presence of this peripheral.

Register 16: SSI Peripheral Identification 2 (SSIPeriphID2), offset 0xFE8

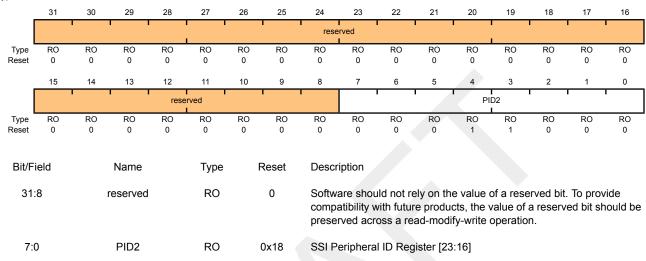
The **SSIPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 2 (SSIPeriphID2)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0xFE8

Type RO, reset 0x0000.0018



Can be used by software to identify the presence of this peripheral.

Register 17: SSI Peripheral Identification 3 (SSIPeriphID3), offset 0xFEC

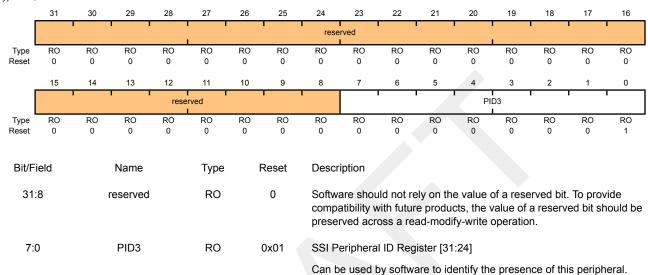
The **SSIPeriphIDn** registers are hard-coded and the fields within the register determine the reset value.

SSI Peripheral Identification 3 (SSIPeriphID3)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0xFEC

Type RO, reset 0x0000.0001



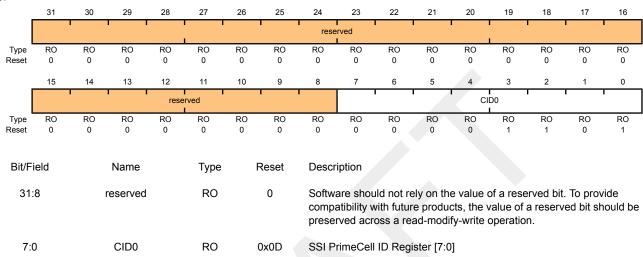
Register 18: SSI PrimeCell Identification 0 (SSIPCellID0), offset 0xFF0

The SSIPCeIIIDn registers are hard-coded and the fields within the register determine the reset value.

SSI PrimeCell Identification 0 (SSIPCellID0)

SSI0 base: 0x4000.8000 SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFF0

Type RO, reset 0x0000.000D



Register 19: SSI PrimeCell Identification 1 (SSIPCellID1), offset 0xFF4

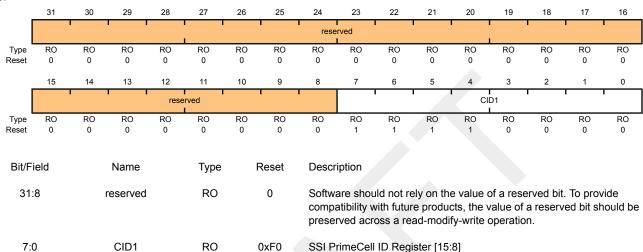
The **SSIPCeIIIDn** registers are hard-coded and the fields within the register determine the reset value.

SSI PrimeCell Identification 1 (SSIPCellID1)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000

Offset 0xFF4

Type RO, reset 0x0000.00F0



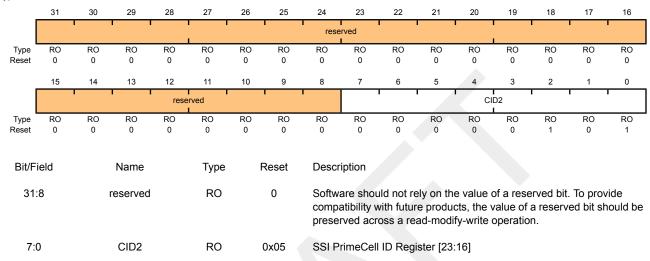
Register 20: SSI PrimeCell Identification 2 (SSIPCellID2), offset 0xFF8

The SSIPCeIIIDn registers are hard-coded and the fields within the register determine the reset value.

SSI PrimeCell Identification 2 (SSIPCelIID2)

SSI0 base: 0x4000.8000 SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFF8

Type RO, reset 0x0000.0005



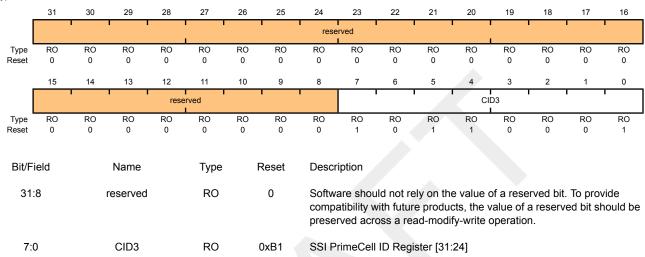
Register 21: SSI PrimeCell Identification 3 (SSIPCellID3), offset 0xFFC

The SSIPCellIDn registers are hard-coded and the fields within the register determine the reset value.

SSI PrimeCell Identification 3 (SSIPCelIID3)

SSI0 base: 0x4000.8000 SSI1 base: 0x4000.9000 Offset 0xFFC

Type RO, reset 0x0000.00B1



15 Inter-Integrated Circuit (I²C) Interface

I2C

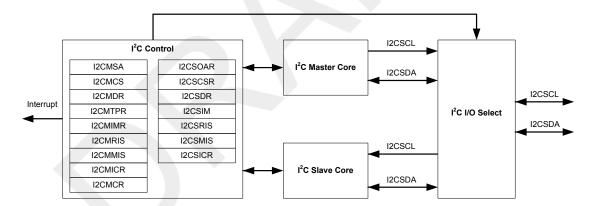
The Inter-Integrated Circuit (I²C) bus provides bi-directional data transfer through a two-wire design (a serial data line SDA and a serial clock line SCL), and interfaces to external I²C devices such as serial memory (RAMs and ROMs), networking devices, LCDs, tone generators, and so on. The I²C bus may also be used for system testing and diagnostic purposes in product development and manufacture. The LM3S1958 microcontroller includes two I²C modules, providing the ability to interact (both send and receive) with other I²C devices on the bus.

Devices on the I²C bus can be designated as either a master or a slave. Each Stellaris[®] I²C module supports both sending and receiving data as either a master or a slave, and also supports the simultaneous operation as both a master and a slave. There are a total of four I²C modes: Master Transmit, Master Receive, Slave Transmit, and Slave Receive. The Stellaris[®] I²C modules can operate at two speeds: Standard (100 Kbps) and Fast (400 Kbps).

Both the I²C master and slave can generate interrupts; the I²C master generates interrupts when a transmit or receive operation completes (or aborts due to an error) and the I²C slave generates interrupts when data has been sent or requested by a master.

15.1 Block Diagram

Figure 15-1. I²C Block Diagram

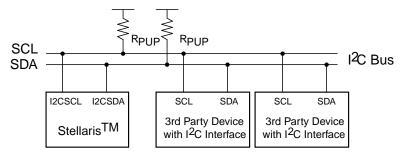


15.2 Functional Description

The Each I^2C module is comprised of both master and slave functions which are implemented as separate peripherals. For proper operation, the SDA and SCL pins must be connected to bi-directional open-drain pads. A typical I^2C bus configuration is shown in Figure 15-2 on page 354.

See "I²C" on page 407 for I²C timing diagrams.

Figure 15-2. I²C Bus Configuration



15.2.1 I²C Bus Functional Overview

The I²C bus uses only two signals: SDA and SCL, named I2CSDA and I2CSCL on Stellaris[®] microcontrollers. SDA is the bi-directional serial data line and SCL is the bi-directional serial clock line. The bus is considered idle when both lines are high.

Every transaction on the I²C bus is nine bits long, consisting of eight data bits and a single acknowledge bit. The number of bytes per transfer (defined as the time between a valid START and STOP condition, described in "START and STOP Conditions" on page 354) is unrestricted, but each byte has to be followed by an acknowledge bit, and data must be transferred MSB first. When a receiver cannot receive another complete byte, it can hold the clock line SCL Low and force the transmitter into a wait state. The data transfer continues when the receiver releases the clock SCL.

15.2.1.1 START and STOP Conditions

The protocol of the I²C bus defines two states to begin and end a transaction: START and STOP. A high-to-low transition on the SDA line while the SCL is high is defined as a START condition, and a low-to-high transition on the SDA line while SCL is high is defined as a STOP condition. The bus is considered busy after a START condition and free after a STOP condition. See Figure 15-3 on page 354.

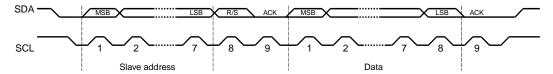
Figure 15-3. START and STOP Conditions



15.2.1.2 Data Format with 7-Bit Address

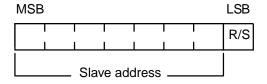
Data transfers follow the format shown in Figure 15-4 on page 355. After the START condition, a slave address is sent. This address is 7-bits long followed by an eighth bit, which is a data direction bit (\mathbb{R}/\mathbb{S} bit in the **I2CMSA** register). A zero indicates a transmit operation (send), and a one indicates a request for data (receive). A data transfer is always terminated by a STOP condition generated by the master, however, a master can initiate communications with another device on the bus by generating a repeated START condition and addressing another slave without first generating a STOP condition. Various combinations of receive/send formats are then possible within a single transfer.

Figure 15-4. Complete Data Transfer with a 7-Bit Address



The first seven bits of the first byte make up the slave address (see Figure 15-5 on page 355). The eighth bit determines the direction of the message. A zero in the R/S position of the first byte means that the master will write (send) data to the selected slave, and a one in this position means that the master will receive data from the slave.

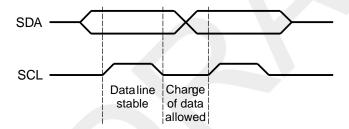
Figure 15-5. R/S Bit in First Byte



15.2.1.3 Data Validity

The data on the SDA line must be stable during the high period of the clock, and the data line can only change when SCL is low (see Figure 15-6 on page 355).

Figure 15-6. Data Validity During Bit Transfer on the I²C Bus



15.2.1.4 Acknowledge

All bus transactions have a required acknowledge clock cycle that is generated by the master. During the acknowledge cycle, the transmitter (which can be the master or slave) releases the SDA line. To acknowledge the transaction, the receiver must pull down SDA during the acknowledge clock cycle. The data sent out by the receiver during the acknowledge cycle must comply with the data validity requirements described in "Data Validity" on page 355.

When a slave receiver does not acknowledge the slave address, SDA must be left high by the slave so that the master can generate a STOP condition and abort the current transfer. If the master device is acting as a receiver during a transfer, it is responsible for acknowledging each transfer made by the slave. Since the master controls the number of bytes in the transfer, it signals the end of data to the slave transmitter by not generating an acknowledge on the last data byte. The slave transmitter must then release SDA to allow the master to generate the STOP or a repeated START condition.

15.2.1.5 Arbitration

A master may start a transfer only if the bus is idle. Its possible for two or more masters to generate a START condition within minimum hold time of the START condition. In these situations, an arbitration scheme takes place on the SDA line, while SCL is high. During arbitration, the first of the competing master devices to place a '1' (high) on SDA while another master transmits a '0' (low) will switch off its data output stage and retire until the bus is idle again.

Arbitration can take place over several bits. Its first stage is a comparison of address bits, and if both masters are trying to address the same device, arbitration continues on to the comparison of data bits.

15.2.2 Available Speed Modes

The I^2C clock rate is determined by the parameters: CLK_PRD , $TIMER_PRD$, SCL_LP , and SCL_HP .

where:

CLK_PRD is the system clock period

SCL_LP is the low phase of SCL (fixed at 6)

SCL_HP is the high phase of SCL (fixed at 4)

TIMER_PRD is the programmed value in the I²C Master Timer Period (I2CMTPR) register (see page 373).

The I²C clock period is calculated as follows:

```
SCL_PERIOD = 2*(1 + TIMER_PRD)*(SCL_LP + SCL_HP)*CLK_PRD
```

For example:

```
CLK_PRD = 50 ns
TIMER_PRD = 2
SCL_LP=6
SCL_HP=4
```

yields a SCL frequency of:

```
1/T = 333 \text{ Khz}
```

Table 15-1 on page 356 gives examples of Timer period, system clock, and speed mode (Standard or Fast).

Table 15-1. Examples of I²C Master Timer Period versus Speed Mode

System Clock	Timer Period	Standard Mode	Timer Period	Fast Mode
4 Mhz	0x01	100 Kbps	-	-
6 Mhz	0x02	100 Kbps	-	-
12.5 Mhz	0x06	89 Kbps	0x01	312 Kbps
16.7 Mhz	0x08	93 Kbps	0x02	278 Kbps
20 Mhz	0x09	100 Kbps	0x02	333 Kbps
25 Mhz	0x0C	96.2 Kbps	0x03	312 Kbps
33Mhz	0x10	97.1 Kbps	0x04	330 Kbps
40Mhz	0x13	100 Kbps	0x04	400 Kbps

System Clock	Timer Period	Standard Mode	Timer Period	Fast Mode
50Mhz	0x18	100 Kbps	0x06	357 Kbps

15.2.3 Interrupts

The I²C can generate interrupts when the following conditions are observed:

- Master transaction completed
- Master transaction error
- Slave transaction received
- Slave transaction requested

There is a separate interrupt signal for the I²C master and I²C modules. While both modules can generate interrupts for multiple conditions, only a single interrupt signal is sent to the interrupt controller.

15.2.3.1 I²C Master Interrupts

The I^2C master module generates an interrupt when a transaction completes (either transmit or receive), or when an error occurs during a transaction. To enable the I^2C master interrupt, software must write a '1' to the I^2C Master Interrupt Mask (I2CMIMR) register. When an interrupt condition is met, software must check the ERROR bit in the I^2C Master Control/Status (I2CMCS) register to verify that an error didn't occur during the last transaction. An error condition is asserted if the last transaction wasn't acknowledge by the slave or if the master was forced to give up ownership of the bus due to a lost arbitration round with another master. If an error is not detected, the application can proceed with the transfer. The interrupt is cleared by writing a '1' to the I^2C Master Interrupt Clear (I2CMICR) register.

If the application doesn't require the use of interrupts, the raw interrupt status is always visible via the I^2C Master Raw Interrupt Status (I2CMRIS) register.

15.2.3.2 I²C Slave Interrupts

The slave module generates interrupts as it receives requests from an I^2C master. To enable the I^2C slave interrupt, write a '1' to the I^2C Slave Interrupt Mask (I2CSIMR) register. Software determines whether the module should write (transmit) or read (receive) data from the I^2C Slave Data (I2CSDR) register, by checking the RREQ and TREQ bits of the I^2C Slave Control/Status (I2CSCSR) register. If the slave module is in receive mode and the first byte of a transfer is received, the FBR bit is set along with the RREQ bit. The interrupt is cleared by writing a '1' to the I^2C Slave Interrupt Clear (I2CSICR) register.

If the application doesn't require the use of interrupts, the raw interrupt status is always visible via the I²C Slave Raw Interrupt Status (I2CSRIS) register.

15.2.4 Loopback Operation

The I^2C modules can be placed into an internal loopback mode for diagnostic or debug work. This is accomplished by setting the LPBK bit in the I^2C Master Configuration (I2CMCR) register. In loopback mode, the SDA and SCL signals from the master and slave modules are tied together.

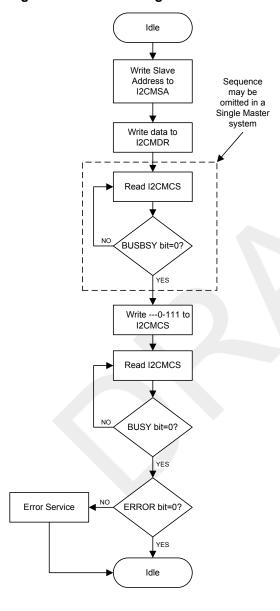
15.2.5 Command Sequence Flow Charts

This section details the steps required to perform the various I²C transfer types in both master and slave mode.

15.2.5.1 I²C Master Command Sequences

The figures that follow show the command sequences available for the I²C master.

Figure 15-7. Master Single SEND



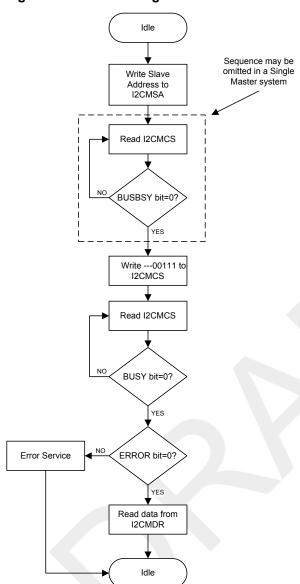


Figure 15-8. Master Single RECEIVE

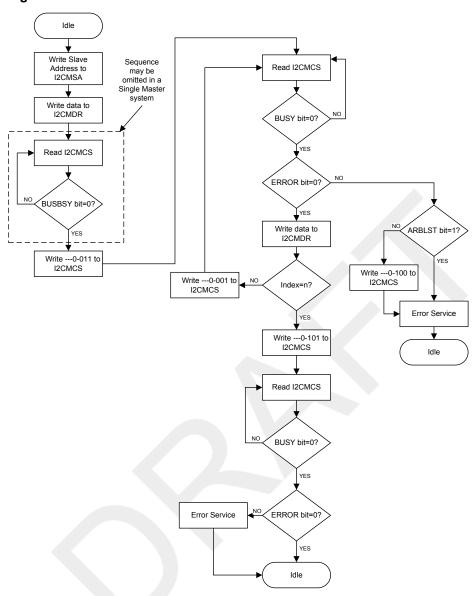


Figure 15-9. Master Burst SEND

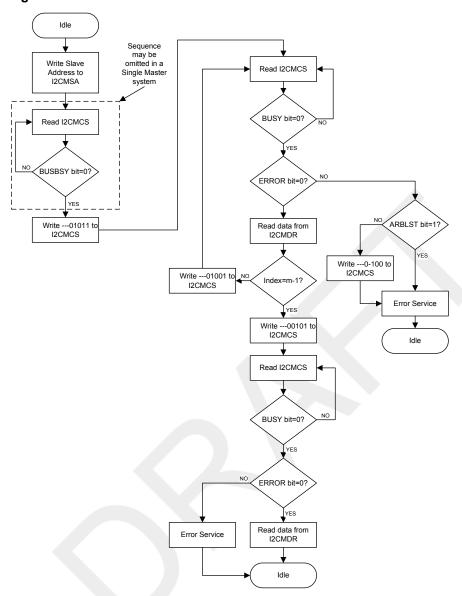


Figure 15-10. Master Burst RECEIVE

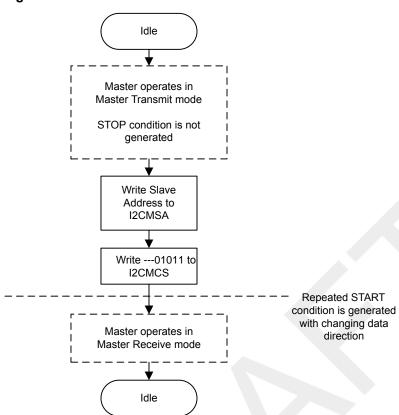


Figure 15-11. Master Burst RECEIVE after Burst SEND

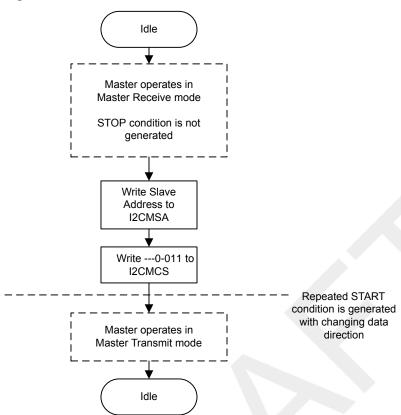


Figure 15-12. Master Burst SEND after Burst RECEIVE

15.2.5.2 I²C Slave Command Sequences

Figure 15-13 on page 364 presents the command sequence available for the I²C slave.

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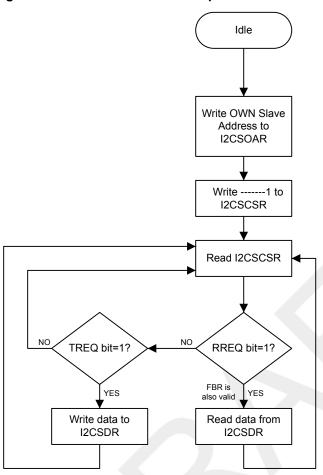


Figure 15-13. Slave Command Sequence

15.3 Initialization and Configuration

The following example shows how to configure the I²C module to send a single byte as a master. This assumes the system clock is 20 MHz.

- Enable the I²C clock by writing a value of 0x0000.1000 to the RCGC1 register in the System Control module.
- Enable the clock to the appropriate GPIO module via the RCGC2 register in the System Control module.
- 3. In the GPIO module, enable the appropriate pins for their alternate function using the **GPIOAFSEL** register. Also, be sure to enable the same pins for Open Drain operation.
- 4. Initialize the I²C Master by writing the **I2CMCR** register with a value of 0x0000.0020.
- 5. Set the desired SCL clock speed of 100 Kbps by writing the **I2CMTPR** register with the correct value. The value written to the **I2CMTPR** register represents the number of system clock periods in one SCL clock period. The TPR value is determined by the following equation:

```
TPR = (System Clock / (2 * (SCL_LP + SCL_HP) * SCL_CLK)) - 1;

TPR = (20MHz / (2 * (6 + 4) * 100000)) - 1;

TPR = 9
```

Write the **I2CMTPR** register with the value of 0x0000.0009.

- 6. Specify the slave address of the master and that the next operation will be a Send by writing the **I2CMSA** register with a value of 0x0000.0076. This sets the slave address to 0x3B.
- Place data (byte) to be sent in the data register by writing the I2CMDR register with the desired data.
- 8. Initiate a single byte send of the data from Master to Slave by writing the **I2CMCS** register with a value of 0x0000.0007 (STOP, START, RUN).
- 9. Wait until the transmission completes by polling the I2CMCS register's BUSBSY bit until it has been cleared.

15.4 I²C Register Map

Table 15-2 on page 365 lists the I²C registers. All addresses given are relative to the I²C base addresses for the master and slave:

I²C Master 0: 0x4002.0000

I²C Slave 0: 0x4002.0800

I²C Master 1: 0x4002.1000

I²C Slave 1: 0x4001.1800

Table 15-2. Inter-Integrated Circuit (I²C) Interface Register Map

Offset	Name	Туре	Reset	Description	See page
I ² C Maste	r				
0x000	I2CMSA	R/W	0x0000.0000	I2C Master Slave Address	367
0x004	I2CMCS	R/W	0x0000.0000	I2C Master Control/Status	368
800x0	I2CMDR	R/W	0x0000.0000	I2C Master Data	372
0x00C	I2CMTPR	R/W	0x0000.0001	I2C Master Timer Period	373
0x010	I2CMIMR	R/W	0x0000.0000	I2C Master Interrupt Mask	374
0x014	I2CMRIS	RO	0x0000.0000	I2C Master Raw Interrupt Status	375
0x018	I2CMMIS	RO	0x0000.0000	I2C Master Masked Interrupt Status	376
0x01C	I2CMICR	WO	0x0000.0000	I2C Master Interrupt Clear	377
0x020	I2CMCR	R/W	0x0000.0000	I2C Master Configuration	378
I ² C Slave					
0x000	I2CSOAR	R/W	0x0000.0000	I2C Slave Own Address	380

Offset	Name	Type	Reset	Description	See page
0x004	I2CSCSR	RO	0x0000.0000	I2C Slave Control/Status	381
0x008	I2CSDR	R/W	0x0000.0000	I2C Slave Data	383
0x00C	I2CSIMR	R/W	0x0000.0000	I2C Slave Interrupt Mask	384
0x010	I2CSRIS	RO	0x0000.0000	I2C Slave Raw Interrupt Status	385
0x014	I2CSMIS	RO	0x0000.0000	I2C Slave Masked Interrupt Status	386
0x018	I2CSICR	WO	0x0000.0000	I2C Slave Interrupt Clear	387

15.5 Register Descriptions (I²C Master)

The remainder of this section lists and describes the I²C master registers, in numerical order by address offset. See also "Register Descriptions (I2C Slave)" on page 379.

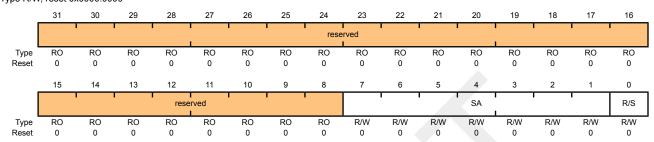
Register 1: I²C Master Slave Address (I2CMSA), offset 0x000

This register consists of eight bits: seven address bits (A6-A0), and a Receive/Send bit, which determines if the next operation is a Receive (High), or Send (Low).

I2C Master Slave Address (I2CMSA)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000 Offset 0x000

Type R/W, reset 0x0000.0000



Bit/Field	Name	Туре	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:1	SA	R/W	0	I ² C Slave Address
				This field specifies bits A6 through A0 of the slave address.
0	R/S	R/W	0	Receive/Send

The $\ensuremath{\mathbb{R}/S}$ bit specifies if the next operation is a Receive (High) or Send (Low).

0: Send

1: Receive

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Register 2: I²C Master Control/Status (I2CMCS), offset 0x004

This register accesses four control bits when written, and accesses seven status bits when read.

The status register consists of seven bits, which when read determine the state of the I²C bus controller.

The control register consists of four bits: the RUN, START, STOP, and ACK bits. The START bit causes the generation of the START, or REPEATED START condition.

The STOP bit determines if the cycle stops at the end of the data cycle, or continues on to a burst. To generate a single send cycle, the I^2C Master Slave Address (I2CMSA) register is written with the desired address, the R/S bit is set to 0, and the Control register is written with ACK=X (0 or 1), STOP=1, START=1, and RUN=1 to perform the operation and stop. When the operation is completed (or aborted due an error), the interrupt pin becomes active and the data may be read from the I2CMDR register. When the I^2C module operates in Master receiver mode, the ACK bit must be set normally to logic 1. This causes the I^2C bus controller to send an acknowledge automatically after each byte. This bit must be reset when the I^2C bus controller requires no further data to be sent from the slave transmitter.

Read-Only Status Register

I2C Master Control/Status (I2CMCS)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000 Offset 0x004 Type R/W, reset 0x0000.0000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		'	1	'			'	rese	rved	' '						
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		'	1	'	reserved		•	'	' !	BUSBSY	IDLE	ARBLST	DATACK	ADRACK	ERROR	BUSY
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6	BUSBSY	R	0	This bit specifies the state of the l^2C bus. If set, the bus is busy; otherwise, the bus is idle. The bit changes based on the START and STOP conditions.
5	IDLE	R	0	This bit specifies the I^2C controller state. If set, the controller is idle; otherwise the controller is not idle.
4	ARBLST	R	0	This bit specifies the result of bus arbitration. If set, the controller lost arbitration; otherwise, the controller won arbitration.
3	DATACK	R	0	This bit specifies the result of the last data operation. If set, the transmitted data was not acknowledged; otherwise, the data was acknowledged.

Bit/Field	Name	Type	Reset	Description
2	ADRACK	R	0	This bit specifies the result of the last address operation. If set, the transmitted address was not acknowledged; otherwise, the address was acknowledged.
1	ERROR	R	0	This bit specifies the result of the last bus operation. If set, an error occurred on the last operation; otherwise, no error was detected. The error can be from the slave address not being acknowledged, the transmit data not being acknowledged, or because the controller lost arbitration.
0	BUSY	R	0	This bit specifies the state of the controller. If set, the controller is busy; otherwise, the controller is idle. When the BUSY bit is set, the other status bits are not valid.

Write-Only Control Register

I2C Master Control/Status (I2CMCS)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000 Offset 0x004 Type R/W, reset 0x0000.0000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
				'				rese	rved		'					
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
						rese	rved	_	ı		'		ACK	STOP	START	RUN
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	W	W	W	W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Bit/Field	Name	Туре	Reset	Description
31:4	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
3	ACK	W	0	When set, causes received data byte to be acknowledged automatically by the master. See field decoding in Table 15-3 on page 370.
2	STOP	W	0	When set, causes the generation of the STOP condition. See field decoding in Table 15-3 on page 370.
1	START	W	0	When set, causes the generation of a START or repeated START condition. See field decoding in Table 15-3 on page 370.
0	RUN	W	0	When set, allows the master to send or receive data. See field decoding in Table 15-3 on page 370.

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Table 15-3. Write Field Decoding for I2CMCS[3:0] Field (Sheet 1 of 3)

	State		I2CMC	S[3:0]		Description
State	R/S	ACK	STOP	START	RUN	
Idle	0	X ^a	0	1	1	START condition followed by SEND (master goes to the Master Transmit state).
	0	Х	1	1	1	START condition followed by a SEND and STOP condition (master remains in Idle state).
	1	0	0	1	1	START condition followed by RECEIVE operation with negative ACK (master goes to the Master Receive state).
	1	0	1	1	1	START condition followed by RECEIVE and STOP condition (master remains in Idle state).
	1	1	0	1 1 START condition followed by I the Master Receive state).		START condition followed by RECEIVE (master goes to the Master Receive state).
	1	1	1	1	1	Illegal.
	All other co	mbinations	not listed	are non-or	perations.	NOP.
Master Transmit	Х	Х	0	0	1	SEND operation (master remains in Master Transmit state).
	Х	Х	1	0	0	STOP condition (master goes to Idle state).
	Х	Х	1	0	1	SEND followed by STOP condition (master goes to Idle state).
	0	Х	0	1	1	Repeated START condition followed by a SEND (master remains in Master Transmit state).
	0	Х	1	1	1	Repeated START condition followed by SEND and STOP condition (master goes to Idle state).
	1	0	0	1	1	Repeated START condition followed by a RECEIVE operation with a negative ACK (master goes to Master Receive state).
	1	1 0 1		1	1	Repeated START condition followed by a SEND and STOP condition (master goes to Idle state).
	1	1	0	1	1	Repeated START condition followed by RECEIVE (master goes to Master Receive state).
	1	1	1	1	1	Illegal.
	All other co	mbinations	s not listed	are non-or	perations.	NOP.

Current	I2CMSA[0]		I2CMC	S[3:0]	Description	
State	R/S	ACK	STOP	START	RUN	
Master Receive	Х	0	0	0	1	RECEIVE operation with negative ACK (master remains in Master Receive state).
	Х	Х	1	0	0	STOP condition (master goes to Idle state). ^b
	Х	0	1	0	1	RECEIVE followed by STOP condition (master goes to Idle state).
	Х	1	0	0	1	RECEIVE operation (master remains in Master Receive state).
	Х	1	1	0	1	Illegal.
	1	0	0	1	1	Repeated START condition followed by RECEIVE operation with a negative ACK (master remains in Master Receive state).
	1	0	1	1	1	Repeated START condition followed by RECEIVE and STOP condition (master goes to Idle state).
	1	1	0	1	1	Repeated START condition followed by RECEIVE (master remains in Master Receive state).
	0	Х	0	1	1	Repeated START condition followed by SEND (master goes to Master Transmit state).
	0	Х	1	1	1	Repeated START condition followed by SEND and STOP condition (master goes to Idle state).
	All other co	mbinations	s not listed	are non-op	erations.	NOP.

a. An X in a table cell indicates the bit can be 0 or 1.

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b. In Master Receive mode, a STOP condition should be generated only after a Data Negative Acknowledge executed by the master or an Address Negative Acknowledge executed by the slave.

Register 3: I²C Master Data (I2CMDR), offset 0x008

This register contains the data to be transmitted when in the Master Transmit state, and the data received when in the Master Receive state.

I2C Master Data (I2CMDR)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000

Offset 0x008

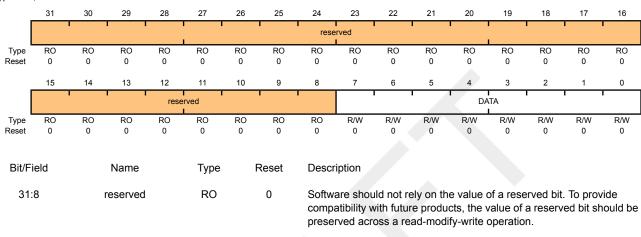
7:0

DATA

R/W

0x00

Type R/W, reset 0x0000.0000



Data transferred during transaction.

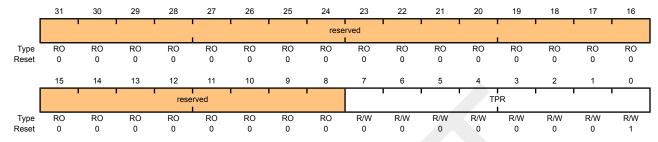
Register 4: I²C Master Timer Period (I2CMTPR), offset 0x00C

This register specifies the period of the SCL clock.

I2C Master Timer Period (I2CMTPR)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000 Offset 0x00C

Type R/W, reset 0x0000.0001



Bit/Field	Name	Type	Reset	Description
31:8	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
7:0	TPR	R/W	0x1	This field specifies the period of the SCL clock.

SCL_PRD = 2*(1 + TPR)*(SCL_LP + SCL_HP)*CLK_PRD

where:

SCL_PRD is the SCL line period (I²C clock).

 \mathtt{TPR} is the Timer Period register value (range of 1 to 255).

SCL_LP is the SCL Low period (fixed at 6).

SCL_HP is the SCL High period (fixed at 4).

Register 5: I²C Master Interrupt Mask (I2CMIMR), offset 0x010

This register controls whether a raw interrupt is promoted to a controller interrupt.

I2C Master Interrupt Mask (I2CMIMR)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000 Offset 0x010

Type R/W, reset 0x0000.0000

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
			•	'	' '		'	rese	erved					'		'
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0							
	15	14	13	12	11	10	9	. 8	7	6	5	4	3	2	1	0
			!	•			•	reserved								IM
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	R/W 0							
Bit/F	ield		Name		Type	F	Reset	Descr	ription							

2.00.0		.,,,,,		2000
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should preserved across a read-modify-write operation.
0	IM	R/W	0	This bit controls whether a raw interrupt is promoted to a controller

rupt is promoted to a controller interrupt. If set, the interrupt is not masked and the interrupt is promoted; otherwise, the interrupt is masked.

value of a reserved bit should be

Register 6: I²C Master Raw Interrupt Status (I2CMRIS), offset 0x014

This register specifies whether an interrupt is pending.

I2C Master Raw Interrupt Status (I2CMRIS)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000 Offset 0x014

Type RO	, reset 0x	(0000.000	00													
	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1	1		ı		1	rese	rved I							
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		1	•		, , , , , , , , , , , , , , , , , , ,		'	reserved	1		1					RIS
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
Bit/F	ield		Name		Туре	ı	Reset	Descr	iption							
31	:1		reserved		RO		0	compa	atibility v	ith futur/	e produ	cts, the v	of a rese alue of a operation	a reserv	•	
O	1		RIS		RO		0	maste	•			•	e (prior to ding; oth		٠,	

Register 7: I²C Master Masked Interrupt Status (I2CMMIS), offset 0x018

This register specifies whether an interrupt was signaled.

I2C Master Masked Interrupt Status (I2CMMIS)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000 Offset 0x018 Type RO, reset 0x0000.0000

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
			1	•				rese	rved							
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0							
,	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
			•					reserved		'					l	MIS
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0							

Bit/Field	Name	Туре	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	MIS	RO	0	This bit specifies the raw interrupt state (after masking) of the I ² C master block. If set, an interrupt was signaled; otherwise, an interrupt has not

been generated since the bit was last cleared.

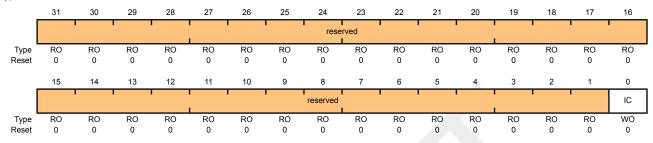
Register 8: I²C Master Interrupt Clear (I2CMICR), offset 0x01C

This register clears the raw interrupt.

I2C Master Interrupt Clear (I2CMICR)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000 Offset 0x01C

Type WO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	IC	WO	0	Interrupt Clear

This bit controls the clearing of the raw interrupt. A write of 1 clears the interrupt; otherwise, a write of 0 has no affect on the interrupt state. A read of this register returns no meaningful data.

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Register 9: I²C Master Configuration (I2CMCR), offset 0x020

This register configures the mode (Master or Slave) and sets the interface for test mode loopback.

I2C Master Configuration (I2CMCR)

I2C Master 0 base: 0x4002.0000 I2C Master 1 base: 0x4002.1000 Offset 0x020

Type R/W, reset 0x0000.0000

.,,,	,															
	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1	1	1	, , , , , , , , , , , , , , , , , , ,		1	rese	rved I		1	1	l	' '		1
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
_	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
					reser	ved					SFE	MFE		reserved		LPBK
Type	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	R/W	R/W	RO	RO	RO	R/W
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bit/F			Name		Туре		Reset	Descr								
31:	6		reserved	ł	RO		0							erved bit.		

				compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
5	SFE	R/W	0	I ² C Slave Function Enable

This bit specifies whether the interface may operate in Slave mode. If set, Slave mode is enabled; otherwise, Slave mode is disabled.

4 MFE R/W 0 I²C Master Function Enable

This bit specifies whether the interface may operate in Master mode. If set, Master mode is enabled; otherwise, Master mode is disabled and the interface clock is disabled.

3:1 reserved RO 0 Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

LPBK R/W 0 I²C Loopback

This bit specifies whether the interface is operating normally or in Loopback mode. If set, the device is put in a test mode loopback configuration; otherwise, the device operates normally.

0

15.6 Register Descriptions (I2C Slave)

The remainder of this section lists and describes the I^2C slave registers, in numerical order by address offset. See also "Register Descriptions (I^2C Master)" on page 366.

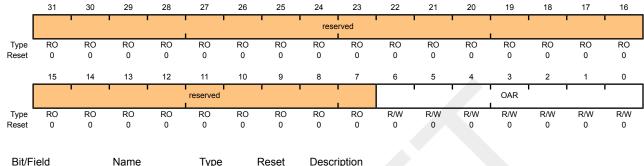


Register 10: I²C Slave Own Address (I2CSOAR), offset 0x000

This register consists of seven address bits that identify the Stellaris[®] I²C device on the I²C bus.

I2C Slave Own Address (I2CSOAR)

I2C Slave 0 base: 0x4002.0800 I2C Slave 1 base: 0x4001.1800 Offset 0x000 Type R/W, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:7	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
6:0	OAR	R/W	0	I ² C Slave Own Address

This field specifies bits A6 through A0 of the slave address.

Register 11: I²C Slave Control/Status (I2CSCSR), offset 0x004

This register accesses one control bit when written, and three status bits when read.

The read-only Status register consists of three bits: the FBR, RREQ, and TREQ bits. The First Byte Received (FBR) bit is set only after the Stellaris device detects its own slave address and receives the first data byte from the I^2C master. The Receive Request (RREQ) bit indicates that the Stellaris I^2C device has received a data byte from an I^2C master. Read one data byte from the I^2C Slave Data (I2CSDR) register to clear the RREQ bit. The Transmit Request (TREQ) bit indicates that the Stellaris I^2C device is addressed as a Slave Transmitter. Write one data byte into the I^2C Slave Data (I2CSDR) register to clear the TREQ bit.

The write-only Control register consists of one bit: the DA bit. The DA bit enables and disables the Stellaris $^{\$}$ I 2 C slave operation.

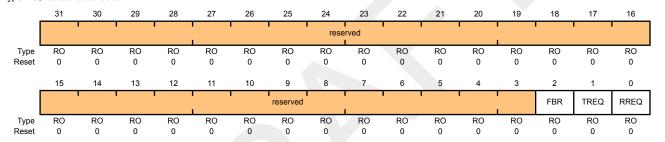
Read-Only Status Register

I2C Slave Control/Status (I2CSCSR)

Name

I2C Slave 0 base: 0x4002.0800 I2C Slave 1 base: 0x4001.1800 Offset 0x004 Type RO, reset 0x0000.0000

Bit/Field



Description

Reset

Type

31:3	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
2	FBR	RO	0	Indicates that the first byte following the slave's own address is received. This bit is only valid when the RREQ bit is set, and is automatically cleared when data has been read from the I2CSDR register.
				Note: This bit is not used for slave transmit operations.
1	TREQ	RO	0	This bit specifies the state of the I^2C slave with regards to outstanding transmit requests. If set, the I^2C unit has been addressed as a slave transmitter and uses clock stretching to delay the master until data has been written to the $I2CSDR$ register. Otherwise, there is no outstanding transmit request.
0	RREQ	RO	0	Receive Request

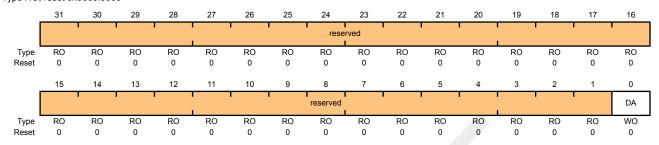
receive requests. If set, the I²C unit has outstanding receive data from the I²C master and uses clock stretching to delay the master until the data has been read from the **I2CSDR** register. Otherwise, no receive data is outstanding.

This bit specifies the status of the I²C slave with regards to outstanding

Write-Only Control Register

I2C Slave Control/Status (I2CSCSR)

I2C Slave 0 base: 0x4002.0800 I2C Slave 1 base: 0x4001.1800 Offset 0x004 Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	DA	WO	0	Device Active

1=Enables the I²C slave operation.

0=Disables the I²C slave operation.

Register 12: I²C Slave Data (I2CSDR), offset 0x008

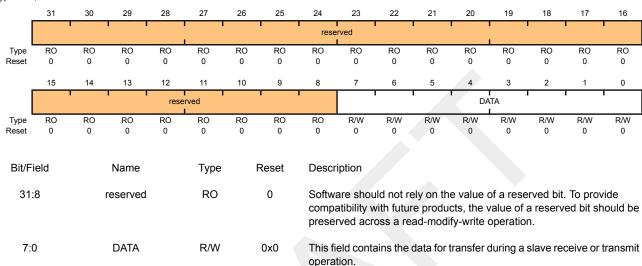
This register contains the data to be transmitted when in the Slave Transmit state, and the data received when in the Slave Receive state.

I2C Slave Data (I2CSDR)

I2C Slave 0 base: 0x4002.0800 I2C Slave 1 base: 0x4001.1800

Offset 0x008

Type R/W, reset 0x0000.0000



Register 13: I²C Slave Interrupt Mask (I2CSIMR), offset 0x00C

This register controls whether a raw interrupt is promoted to a controller interrupt.

I2C Slave Interrupt Mask (I2CSIMR)

I2C Slave 0 base: 0x4002.0800 I2C Slave 1 base: 0x4001.1800 Offset 0x00C Type R/W. reset 0x000

Offset 0x		x0000.00	00													
	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		1	1		1		1	rese	rved	•	1					
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
			•	,			'	reserved								IM
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	R/W 0
Bit/F	ield		Name		Туре	I	Reset	Descr	iption							
31	:1	I	reserved		RO		0	compa	are shou atibility w rved acro	ith futur	e produc	cts, the v	alue of	a reserv	•	
0)		IM		R/W		0		it contro				•			

otherwise, the interrupt is masked.

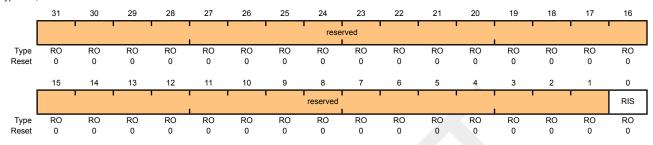
Register 14: I²C Slave Raw Interrupt Status (I2CSRIS), offset 0x010

This register specifies whether an interrupt is pending.

I2C Slave Raw Interrupt Status (I2CSRIS)

I2C Slave 0 base: 0x4002.0800 I2C Slave 1 base: 0x4001.1800 Offset 0x010

Type RO, reset 0x0000.0000



Bit/Field	Name	Type	Reset	Description
31:1	reserved	RO	0	Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.
0	RIS	RO	0	This bit specifies the raw interrupt state (prior to masking) of the I ² C

This bit specifies the raw interrupt state (prior to masking) of the I²C slave block. If set, an interrupt is pending; otherwise, an interrupt is not pending.

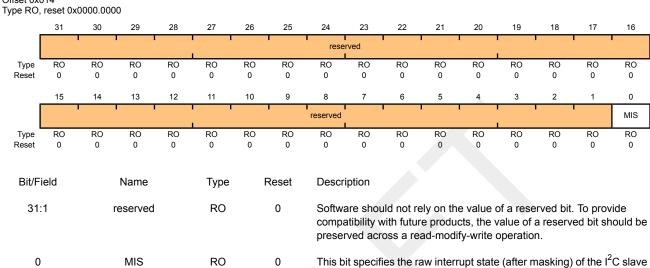
Register 15: I²C Slave Masked Interrupt Status (I2CSMIS), offset 0x014

This register specifies whether an interrupt was signaled.

I2C Slave Masked Interrupt Status (I2CSMIS)

I2C Slave 0 base: 0x4002.0800 I2C Slave 1 base: 0x4001.1800

Offset 0x014



block. If set, an interrupt was signaled; otherwise, an interrupt has not

been generated since the bit was last cleared.

Register 16: I²C Slave Interrupt Clear (I2CSICR), offset 0x018

This register clears the raw interrupt.

I2C Slave Interrupt Clear (I2CSICR)

I2C Slave 0 base: 0x4002.0800 I2C Slave 1 base: 0x4001.1800 Offset 0x018

Type WO, reset 0x0000.0000

.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	,		••													
	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	reserved								•							
Type Reset	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0	RO 0
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		I	! 	•	·		•	reserved	! !				! !	•		IC
Туре	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	RO	WO
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bit/F	ield		Name		Туре	F	Reset	Descr	ription							
0.4	4						^	0 "					,	1.1.9	_	

31:1 reserved RO 0 Software should not rely on the value of a reserved bit. To provide compatibility with future products, the value of a reserved bit should be preserved across a read-modify-write operation.

O IC WO 0 This bit controls the clearing of the raw interrupt. A write of 1 clears the

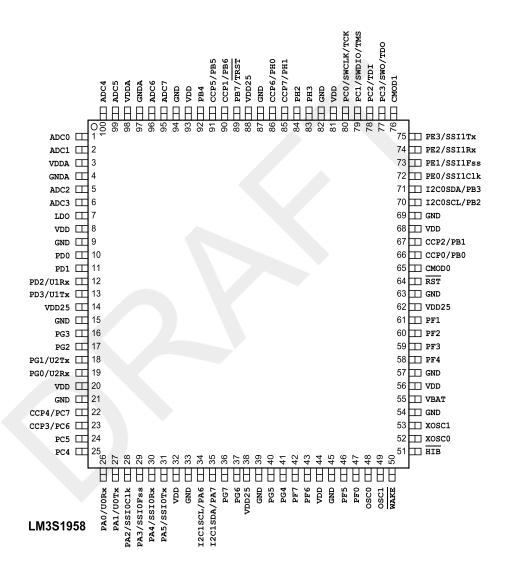
This bit controls the clearing of the raw interrupt. A write of 1 clears the interrupt; otherwise a write of 0 has no affect on the interrupt state. A read of this register returns no meaningful data.

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16 Pin Diagram

Figure 16-1 on page 388 shows the pin diagram and pin-to-signal-name mapping.

Figure 16-1. Pin Connection Diagram



17 Signal Tables

The following tables list the signals available for each pin. Functionality is enabled by software with the GPIOAFSEL register.

Important: All multiplexed pins are GPIOs by default, with the exception of the five JTAG pins (PB7 and PC[3:0]) which default to the JTAG functionality.

Table 17-1 on page 389 shows the pin-to-signal-name mapping, including functional characteristics of the signals. Table 17-2 on page 393 lists the signals in alphabetical order by signal name.

Table 17-3 on page 397 groups the signals by functionality, except for GPIOs. Table 17-4 on page 401 lists the GPIO pins and their alternate functionality.

Table 17-1. Signals by Pin Number

1 ADC0 I Analog Analog-to-digital converter input 0. 2 ADC1 I Analog Analog-to-digital converter input 1. 3 VDDA - Power The positive supply (3.3 V) for the analogic circuits (ADC, Analog Comparators, etc.) These are separated from VDD to minimate electrical noise contained on VDD faffecting the analog functions. 4 GNDA - Power The ground reference for the analogic (ADC, Analog Comparators, etc.). The separated from GND to minimize the elenoise contained on VDD from affecting analog functions. 5 ADC2 I Analog Analog-to-digital converter input 2. 6 ADC3 I Analog Analog-to-digital converter input 3. 7 LDO - Power Low drop-out regulator output voltage. pin requires an external capacitor between the pin and GND of 1 μF or greater. Who on-chip LDO is used to provide power logic, the LDO pin must also be connected.	
3 VDDA - Power The positive supply (3.3 V) for the analocircuits (ADC, Analog Comparators, etc. These are separated from VDD to minithe electrical noise contained on VDD faffecting the analog functions. 4 GNDA - Power The ground reference for the analog cin (ADC, Analog Comparators, etc.). These separated from GND to minimize the elenoise contained on VDD from affecting analog functions. 5 ADC2 I Analog Analog-to-digital converter input 2. 6 ADC3 I Analog Analog-to-digital converter input 3. 7 LDO - Power Low drop-out regulator output voltage. pin requires an external capacitor between the pin and GND of 1 μF or greater. Who on-chip LDO is used to provide power to the pin and GND of 1 μF or greater.	
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6 ADC3 I Analog Analog-to-digital converter input 3. 7 LDO - Power Low drop-out regulator output voltage. pin requires an external capacitor betw the pin and GND of 1 μF or greater. Who on-chip LDO is used to provide power to	se are ctrical
7 LDO - Power Low drop-out regulator output voltage. pin requires an external capacitor betw the pin and GND of 1 μF or greater. Who on-chip LDO is used to provide power to	
pin requires an external capacitor betw the pin and GND of 1 μF or greater. Who on-chip LDO is used to provide power to	
the VDD25 pins at the board level in act to the decoupling capacitor(s).	een en the o the ted to
8 VDD - Power Positive supply for I/O and some logic.	
9 GND - Power Ground reference for logic and I/O pins	-
10 PD0 I/O TTL GPIO port D bit 0	
11 PD1 I/O TTL GPIO port D bit 1	
12 PD2 I/O TTL GPIO port D bit 2	
U1Rx I TTL UART module 1 receive. When in IrDA this signal has IrDA modulation.	node,
13 PD3 I/O TTL GPIO port D bit 3	
U1Tx O TTL UART module 1 transmit. When in IrDA this signal has IrDA modulation.	node,
14 VDD25 - Power Positive supply for most of the logic fur including the processor core and most peripherals.	ction,
15 GND - Power Ground reference for logic and I/O pins	

Pin Number	Pin Name	Pin Type	Buffer Type	Description
16	PG3	I/O	TTL	GPIO port G bit 3
17	PG2	I/O	TTL	GPIO port G bit 2
18	PG1	I/O	TTL	GPIO port G bit 1
	U2Tx	0	TTL	UART 2 Transmit. When in IrDA mode, this signal has IrDA modulation.
19	PG0	I/O	TTL	GPIO port G bit 0
	U2Rx	I	TTL	UART 2 Receive. When in IrDA mode, this signal has IrDA modulation.
20	VDD	-	Power	Positive supply for I/O and some logic.
21	GND	-	Power	Ground reference for logic and I/O pins.
22	CCP4	I/O	TTL	Capture/Compare/PWM 4
	PC7	I/O	TTL	GPIO port C bit 7
23	CCP3	I/O	TTL	Capture/Compare/PWM 3
	PC6	I/O	TTL	GPIO port C bit 6
24	PC5	I/O	TTL	GPIO port C bit 5
25	PC4	I/O	TTL	GPIO port C bit 4
26	PA0	I/O	TTL	GPIO port A bit 0
	U0Rx	1	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
27	PA1	I/O	TTL	GPIO port A bit 1
	UOTx	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
28	PA2	I/O	TTL	GPIO port A bit 2
	SSIOClk	I/O	TTL	SSI module 0 clock
29	PA3	I/O	TTL	GPIO port A bit 3
	SSI0Fss	I/O	TTL	SSI module 0 frame
30	PA4	I/O	TTL	GPIO port A bit 4
	SSI0Rx	I	TTL	SSI module 0 receive
31	PA5	I/O	TTL	GPIO port A bit 5
	SSI0Tx	0	TTL	SSI module 0 transmit
32	VDD	-	Power	Positive supply for I/O and some logic.
33	GND	-	Power	Ground reference for logic and I/O pins.
34	I2C1SCL	I/O	OD	I2C module 1 clock
	PA6	I/O	TTL	GPIO port A bit 6
35	I2C1SDA	I/O	OD	I2C module 1 data
	PA7	I/O	TTL	GPIO port A bit 7
36	PG7	I/O	TTL	GPIO port G bit 7
37	PG6	I/O	TTL	GPIO port G bit 6
38	VDD25	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.
39	GND	-	Power	Ground reference for logic and I/O pins.
40	PG5	I/O	TTL	GPIO port G bit 5
41	PG4	I/O	TTL	GPIO port G bit 4
		1		· ·

Pin Number	Pin Name	Pin Type	Buffer Type	Description
42	PF7	I/O	TTL	GPIO port F bit 7
43	PF6	I/O	TTL	GPIO port F bit 6
44	VDD	-	Power	Positive supply for I/O and some logic.
45	GND	-	Power	Ground reference for logic and I/O pins.
46	PF5	I/O	TTL	GPIO port F bit 5
47	PF0	I/O	TTL	GPIO port F bit 0
48	osco	I	Analog	Main oscillator crystal input or an external clock reference input.
49	OSC1	0	Analog	Main oscillator crystal output.
50	WAKE	I	OD	An external input that brings the processor out of hibernate mode when asserted.
51	HIB	0	TTL	An output that indicates the processor is in hibernate mode.
52	XOSC0	-	Analog	Hibernation Module oscillator crystal input or an external clock reference input. Note that this is either a 4.19-MHz crystal or a 32.768-kHz oscillator for the Hibernation Module RTC. See the CLKSEL bit in the HIBCTL register.
53	XOSC1	0	Analog	Hibernation Module oscillator crystal output.
54	GND	-	Power	Ground reference for logic and I/O pins.
55	VBAT		Power	Power source for the Hibernation Module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation Module power-source supply.
56	VDD	-	Power	Positive supply for I/O and some logic.
57	GND	-	Power	Ground reference for logic and I/O pins.
58	PF4	I/O	TTL	GPIO port F bit 4
59	PF3	I/O	TTL	GPIO port F bit 3
60	PF2	I/O	TTL	GPIO port F bit 2
61	PF1	I/O	TTL	GPIO port F bit 1
62	VDD25	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.
63	GND	-	Power	Ground reference for logic and I/O pins.
64	RST	ı	TTL	System reset input.
65	CMOD0	I/O	TTL	CPU Mode bit 0. Input must be set to logic 0 (grounded); other encodings reserved.
66	CCP0	I/O	TTL	Capture/Compare/PWM 0
	PB0	I/O	TTL	GPIO port B bit 0
67	CCP2	I/O	TTL	Capture/Compare/PWM 2
	PB1	I/O	TTL	GPIO port B bit 1
68	VDD	-	Power	Positive supply for I/O and some logic.
69	GND	-	Power	Ground reference for logic and I/O pins.
70	I2C0SCL	I/O	OD	I2C module 0 clock
	PB2	I/O	TTL	GPIO port B bit 2

Pin Number	Pin Name	Pin Type	Buffer Type	Description
71	I2C0SDA	I/O	OD	I2C module 0 data
	PB3	I/O	TTL	GPIO port B bit 3
72	PE0	I/O	TTL	GPIO port E bit 0
	SSI1Clk	I/O	TTL	SSI module 1 clock
73	PE1	I/O	TTL	GPIO port E bit 1
	SSI1Fss	I/O	TTL	SSI module 1 frame
74	PE2	I/O	TTL	GPIO port E bit 2
	SSI1Rx	I	TTL	SSI module 1 receive
75	PE3	I/O	TTL	GPIO port E bit 3
	SSI1Tx	0	TTL	SSI module 1 transmit
76	CMOD1	I/O	TTL	CPU Mode bit 1. Input must be set to logic 0 (grounded); other encodings reserved.
77	PC3	I/O	TTL	GPIO port C bit 3
	SWO	0	TTL	JTAG TDO and SWO
	TDO	0	TTL	JTAG TDO and SWO
78	PC2	I/O	TTL	GPIO port C bit 2
	TDI	1	TTL	JTAG TDI
79	PC1	I/O	TTL	GPIO port C bit 1
	SWDIO	I/O	TTL	JTAG TMS and SWDIO
	TMS	I/O	TTL	JTAG TMS and SWDIO
80	PC0	I/O	TTL	GPIO port C bit 0
	SWCLK	I	TTL	JTAG/SWD CLK
	TCK	I	TTL	JTAG/SWD CLK
81	VDD	-	Power	Positive supply for I/O and some logic.
82	GND	-	Power	Ground reference for logic and I/O pins.
83	РН3	I/O	TTL	GPIO port H bit 3
84	PH2	I/O	TTL	GPIO port H bit 2
85	CCP7	I/O	TTL	Capture/Compare/PWM 7
	PH1	I/O	TTL	GPIO port H bit 1
86	CCP6	I/O	TTL	Capture/Compare/PWM 6
	PH0	I/O	TTL	GPIO port H bit 0
87	GND	-	Power	Ground reference for logic and I/O pins.
88	VDD25	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.
89	PB7	I/O	TTL	GPIO port B bit 7
	TRST	I	TTL	JTAG TRSTn
90	CCP1	I/O	TTL	Capture/Compare/PWM 1
	PB6	I/O	TTL	GPIO port B bit 6
91	CCP5	I/O	TTL	Capture/Compare/PWM 5
	PB5	I/O	TTL	GPIO port B bit 5
92	PB4	I/O	TTL	GPIO port B bit 4
93	VDD	-	Power	Positive supply for I/O and some logic.

Pin Number	Pin Name	Pin Type	Buffer Type	Description
94	GND	-	Power	Ground reference for logic and I/O pins.
95	ADC7	I	Analog	Analog-to-digital converter input 7.
96	ADC6	1	Analog	Analog-to-digital converter input 6.
97	GNDA	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.
98	VDDA	-	Power	The positive supply (3.3 V) for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions.
99	ADC5	I	Analog	Analog-to-digital converter input 5.
100	ADC4	I	Analog	Analog-to-digital converter input 4.

Table 17-2. Signals by Signal Name

Pin Name	Pin Number	Pin Type	Buffer Type	Description
ADC0	1	I (Analog	Analog-to-digital converter input 0.
ADC1	2	I	Analog	Analog-to-digital converter input 1.
ADC2	5		Analog	Analog-to-digital converter input 2.
ADC3	6		Analog	Analog-to-digital converter input 3.
ADC4	100		Analog	Analog-to-digital converter input 4.
ADC5	99	I	Analog	Analog-to-digital converter input 5.
ADC6	96	I I	Analog	Analog-to-digital converter input 6.
ADC7	95	I	Analog	Analog-to-digital converter input 7.
CCP0	66	I/O	TTL	Capture/Compare/PWM 0
CCP1	90	I/O	TTL	Capture/Compare/PWM 1
CCP2	67	I/O	TTL	Capture/Compare/PWM 2
CCP3	23	I/O	TTL	Capture/Compare/PWM 3
CCP4	22	I/O	TTL	Capture/Compare/PWM 4
CCP5	91	I/O	TTL	Capture/Compare/PWM 5
CCP6	86	I/O	TTL	Capture/Compare/PWM 6
CCP7	85	I/O	TTL	Capture/Compare/PWM 7
CMOD0	65	I/O	TTL	CPU Mode bit 0. Input must be set to logic 0 (grounded); other encodings reserved.
CMOD1	76	I/O	TTL	CPU Mode bit 1. Input must be set to logic 0 (grounded); other encodings reserved.
GND	9	-	Power	Ground reference for logic and I/O pins.
GND	15	-	Power	Ground reference for logic and I/O pins.
GND	21	-	Power	Ground reference for logic and I/O pins.
GND	33	-	Power	Ground reference for logic and I/O pins.
GND	39	-	Power	Ground reference for logic and I/O pins.
GND	45	-	Power	Ground reference for logic and I/O pins.
GND	54	-	Power	Ground reference for logic and I/O pins.

Pin Name	Pin Number	Pin Type	Buffer Type	Description
GND	57	-	Power	Ground reference for logic and I/O pins.
GND	63	-	Power	Ground reference for logic and I/O pins.
GND	69	-	Power	Ground reference for logic and I/O pins.
GND	82	-	Power	Ground reference for logic and I/O pins.
GND	87	-	Power	Ground reference for logic and I/O pins.
GND	94	-	Power	Ground reference for logic and I/O pins.
GNDA	4	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.
GNDA	97	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.
HIB	51	0	TTL	An output that indicates the processor is in hibernate mode.
I2C0SCL	70	I/O	OD	I2C module 0 clock
I2C0SDA	71	I/O	OD	I2C module 0 data
I2C1SCL	34	I/O	OD	I2C module 1 clock
I2C1SDA	35	I/O	OD	I2C module 1 data
LDO	7		Power	Low drop-out regulator output voltage. This pin requires an external capacitor between the pin and GND of 1 μ F or greater. When the on-chip LDO is used to provide power to the logic, the LDO pin must also be connected to the VDD25 pins at the board level in addition to the decoupling capacitor(s).
osc0	48		Analog	Main oscillator crystal input or an external clock reference input.
OSC1	49	0	Analog	Main oscillator crystal output.
PA0	26	I/O	TTL	GPIO port A bit 0
PA1	27	I/O	TTL	GPIO port A bit 1
PA2	28	I/O	TTL	GPIO port A bit 2
PA3	29	I/O	TTL	GPIO port A bit 3
PA4	30	I/O	TTL	GPIO port A bit 4
PA5	31	I/O	TTL	GPIO port A bit 5
PA6	34	I/O	TTL	GPIO port A bit 6
PA7	35	I/O	TTL	GPIO port A bit 7
PB0	66	I/O	TTL	GPIO port B bit 0
PB1	67	I/O	TTL	GPIO port B bit 1
PB2	70	I/O	TTL	GPIO port B bit 2
PB3	71	I/O	TTL	GPIO port B bit 3
PB4	92	I/O	TTL	GPIO port B bit 4
PB5	91	I/O	TTL	GPIO port B bit 5
PB6	90	I/O	TTL	GPIO port B bit 6

Pin Name	Pin Number	Pin Type	Buffer Type	Description
PB7	89	I/O	TTL	GPIO port B bit 7
PC0	80	I/O	TTL	GPIO port C bit 0
PC1	79	I/O	TTL	GPIO port C bit 1
PC2	78	I/O	TTL	GPIO port C bit 2
PC3	77	I/O	TTL	GPIO port C bit 3
PC4	25	I/O	TTL	GPIO port C bit 4
PC5	24	I/O	TTL	GPIO port C bit 5
PC6	23	I/O	TTL	GPIO port C bit 6
PC7	22	I/O	TTL	GPIO port C bit 7
PD0	10	I/O	TTL	GPIO port D bit 0
PD1	11	I/O	TTL	GPIO port D bit 1
PD2	12	I/O	TTL	GPIO port D bit 2
PD3	13	I/O	TTL	GPIO port D bit 3
PE0	72	I/O	TTL	GPIO port E bit 0
PE1	73	I/O	TTL	GPIO port E bit 1
PE2	74	I/O	TTL	GPIO port E bit 2
PE3	75	I/O	TTL	GPIO port E bit 3
PF0	47	I/O	TTL	GPIO port F bit 0
PF1	61	I/O	TTL	GPIO port F bit 1
PF2	60	I/O	TTL	GPIO port F bit 2
PF3	59	I/O	TTL	GPIO port F bit 3
PF4	58	I/O	TTL	GPIO port F bit 4
PF5	46	I/O	TTL	GPIO port F bit 5
PF6	43	I/O	TTL	GPIO port F bit 6
PF7	42	I/O	TTL	GPIO port F bit 7
PG0	19	I/O	TTL	GPIO port G bit 0
PG1	18	I/O	TTL	GPIO port G bit 1
PG2	17	I/O	TTL	GPIO port G bit 2
PG3	16	I/O	TTL	GPIO port G bit 3
PG4	41	I/O	TTL	GPIO port G bit 4
PG5	40	I/O	TTL	GPIO port G bit 5
PG6	37	I/O	TTL	GPIO port G bit 6
PG7	36	I/O	TTL	GPIO port G bit 7
PH0	86	I/O	TTL	GPIO port H bit 0
PH1	85	I/O	TTL	GPIO port H bit 1
PH2	84	I/O	TTL	GPIO port H bit 2
PH3	83	I/O	TTL	GPIO port H bit 3
RST	64	I	TTL	System reset input.
SSI0Clk	28	I/O	TTL	SSI module 0 clock
SSI0Fss	29	I/O	TTL	SSI module 0 frame
SSI0Rx	30	I	TTL	SSI module 0 receive
SSIOTx	31	0	TTL	SSI module 0 transmit

Pin Name	Pin Number	Pin Type	Buffer Type	Description
SSI1Clk	72	I/O	TTL	SSI module 1 clock
SSI1Fss	73	I/O	TTL	SSI module 1 frame
SSI1Rx	74	I	TTL	SSI module 1 receive
SSI1Tx	75	0	TTL	SSI module 1 transmit
SWCLK	80	I	TTL	JTAG/SWD CLK
SWDIO	79	I/O	TTL	JTAG TMS and SWDIO
SWO	77	0	TTL	JTAG TDO and SWO
TCK	80	I	TTL	JTAG/SWD CLK
TDI	78	I	TTL	JTAG TDI
TDO	77	0	TTL	JTAG TDO and SWO
TMS	79	I/O	TTL	JTAG TMS and SWDIO
TRST	89	I	TTL	JTAG TRSTn
U0Rx	26	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
UOTx	27	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
U1Rx	12	1	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
UlTx	13	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
U2Rx	19	7	TTL	UART 2 Receive. When in IrDA mode, this signal has IrDA modulation.
U2Tx	18	0	TTL	UART 2 Transmit. When in IrDA mode, this signal has IrDA modulation.
VBAT	55		Power	Power source for the Hibernation Module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation Module power-source supply.
VDD	8	-	Power	Positive supply for I/O and some logic.
VDD	20	-	Power	Positive supply for I/O and some logic.
VDD	32	-	Power	Positive supply for I/O and some logic.
VDD	44	-	Power	Positive supply for I/O and some logic.
VDD	56	-	Power	Positive supply for I/O and some logic.
VDD	68	-	Power	Positive supply for I/O and some logic.
VDD	81	-	Power	Positive supply for I/O and some logic.
VDD	93	-	Power	Positive supply for I/O and some logic.
VDD25	14	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.
VDD25	38	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.
VDD25	62	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.

Pin Name	Pin Number	Pin Type	Buffer Type	Description
VDD25	88	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.
VDDA	3	-	Power	The positive supply (3.3 V) for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions.
VDDA	98	-	Power	The positive supply (3.3 V) for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions.
WAKE	50	I	OD	An external input that brings the processor out of hibernate mode when asserted.
XOSC0	52	1	Analog	Hibernation Module oscillator crystal input or an external clock reference input. Note that this is either a 4.19-MHz crystal or a 32.768-kHz oscillator for the Hibernation Module RTC. See the CLKSEL bit in the HIBCTL register.
XOSC1	53	0	Analog	Hibernation Module oscillator crystal output.

Table 17-3. Signals by Function, Except for GPIO

Function	Pin Name	Pin Number	Pin Type	Buffer Type	Description
ADC	ADC0	1	1	Analog	Analog-to-digital converter input 0.
	ADC1	2	1	Analog	Analog-to-digital converter input 1.
	ADC2	5	1	Analog	Analog-to-digital converter input 2.
	ADC3	6		Analog	Analog-to-digital converter input 3.
	ADC4	100		Analog	Analog-to-digital converter input 4.
	ADC5	99	I	Analog	Analog-to-digital converter input 5.
	ADC6	96	I	Analog	Analog-to-digital converter input 6.
	ADC7	95	I	Analog	Analog-to-digital converter input 7.
General-Purpose	CCP0	66	I/O	TTL	Capture/Compare/PWM 0
Timers	CCP1	90	I/O	TTL	Capture/Compare/PWM 1
	CCP2	67	I/O	TTL	Capture/Compare/PWM 2
	CCP3	23	I/O	TTL	Capture/Compare/PWM 3
	CCP4	22	I/O	TTL	Capture/Compare/PWM 4
	CCP5	91	I/O	TTL	Capture/Compare/PWM 5
	CCP6	86	I/O	TTL	Capture/Compare/PWM 6
	CCP7	85	I/O	TTL	Capture/Compare/PWM 7
I2C	I2C0SCL	70	I/O	OD	I2C module 0 clock
	I2C0SDA	71	I/O	OD	I2C module 0 data
	I2C1SCL	34	I/O	OD	I2C module 1 clock
	I2C1SDA	35	I/O	OD	I2C module 1 data

Function	Pin Name	Pin Number	Pin Type	Buffer Type	Description
JTAG/SWD/SWO	SWCLK	80	I	TTL	JTAG/SWD CLK
	SWDIO	79	I/O	TTL	JTAG TMS and SWDIO
	SWO	77	0	TTL	JTAG TDO and SWO
	TCK	80	I	TTL	JTAG/SWD CLK
	TDI	78	I	TTL	JTAG TDI
	TDO	77	0	TTL	JTAG TDO and SWO
	TMS	79	I/O	TTL	JTAG TMS and SWDIO

Function	Pin Name	Pin Number	Pin Type	Buffer Type	Description		
Power	GND	9	-	Power	Ground reference for logic and I/O pins.		
	GND	15	-	Power	Ground reference for logic and I/O pins.		
	GND	21	-	Power	Ground reference for logic and I/O pins.		
	GND	33	-	Power	Ground reference for logic and I/O pins.		
	GND	39	-	Power	Ground reference for logic and I/O pins.		
	GND	45	-	Power	Ground reference for logic and I/O pins.		
	GND	54	-	Power	Ground reference for logic and I/O pins.		
	GND	57	-	Power	Ground reference for logic and I/O pins.		
	GND	63	-	Power	Ground reference for logic and I/O pins.		
	GND	69	-	Power	Ground reference for logic and I/O pins.		
	GND	82	-	Power	Ground reference for logic and I/O pins.		
	GND	87	-	Power	Ground reference for logic and I/O pins.		
	GND	94	-	Power	Ground reference for logic and I/O pins.		
	GNDA	4	-	Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.		
	GNDA	97		Power	The ground reference for the analog circuits (ADC, Analog Comparators, etc.). These are separated from GND to minimize the electrical noise contained on VDD from affecting the analog functions.		
	HIB	51	0	TTL	An output that indicates the processor is in hibernate mode.		
	LDO	7		Power	Low drop-out regulator output voltage. This pin requires an external capacitor between the pin and GND of 1 μ F or greater. When the on-chip LDO is used to provide power to the logic, the LDO pin must also be connected to the VDD25 pins at the board level in addition to the decoupling capacitor(s).		
	VBAT	55	-	Power	Power source for the Hibernation Module. It is normally connected to the positive terminal of a battery and serves as the battery backup/Hibernation Module power-source supply.		
	VDD	8	-	Power	Positive supply for I/O and some logic.		
	VDD	20	-	Power	Positive supply for I/O and some logic.		
	VDD	32	-	Power	Positive supply for I/O and some logic.		
	VDD	44	-	Power	Positive supply for I/O and some logic.		
	VDD	56	-	Power	Positive supply for I/O and some logic.		
	VDD	68	-	Power	Positive supply for I/O and some logic.		
	VDD	81	-	Power	Positive supply for I/O and some logic.		
	VDD	93	-	Power	Positive supply for I/O and some logic.		
	VDD25	14	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.		
	VDD25	38	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.		
	VDD25	62	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.		

Function	Pin Name	Pin Number	Pin Type	Buffer Type	Description
	VDD25	88	-	Power	Positive supply for most of the logic function, including the processor core and most peripherals.
	VDDA	3	-	Power	The positive supply (3.3 V) for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions.
	VDDA	98	-	Power	The positive supply (3.3 V) for the analog circuits (ADC, Analog Comparators, etc.). These are separated from VDD to minimize the electrical noise contained on VDD from affecting the analog functions.
	WAKE	50	I	OD	An external input that brings the processor out of hibernate mode when asserted.
SSI	SSI0Clk	28	I/O	TTL	SSI module 0 clock
	SSI0Fss	29	I/O	TTL	SSI module 0 frame
	SSIORx	30	I	TTL	SSI module 0 receive
	SSIOTx	31	0	TTL	SSI module 0 transmit
	SSI1Clk	72	I/O	TTL	SSI module 1 clock
	SSI1Fss	73	I/O	TTL	SSI module 1 frame
	SSI1Rx	74		TTL	SSI module 1 receive
	SSI1Tx	75	0	TTL	SSI module 1 transmit
System Control & Clocks	CMOD0	65	I/O	TTL	CPU Mode bit 0. Input must be set to logic 0 (grounded); other encodings reserved.
	CMOD1	76	I/O	TTL	CPU Mode bit 1. Input must be set to logic 0 (grounded); other encodings reserved.
	osc0	48	I	Analog	Main oscillator crystal input or an external clock reference input.
	OSC1	49	0	Analog	Main oscillator crystal output.
	RST	64	I	TTL	System reset input.
	TRST	89	I	TTL	JTAG TRSTn
	xosc0	52	I	Analog	Hibernation Module oscillator crystal input or an external clock reference input. Note that this is either a 4.19-MHz crystal or a 32.768-kHz oscillator for the Hibernation Module RTC. See the CLKSEL bit in the HIBCTL register.
	XOSC1	53	0	Analog	Hibernation Module oscillator crystal output.
UART	U0Rx	26	I	TTL	UART module 0 receive. When in IrDA mode, this signal has IrDA modulation.
	UOTx	27	0	TTL	UART module 0 transmit. When in IrDA mode, this signal has IrDA modulation.
	U1Rx	12	I	TTL	UART module 1 receive. When in IrDA mode, this signal has IrDA modulation.
	UlTx	13	0	TTL	UART module 1 transmit. When in IrDA mode, this signal has IrDA modulation.
	U2Rx	19	I	TTL	UART 2 Receive. When in IrDA mode, this signal has IrDA modulation.
	U2Tx	18	0	TTL	UART 2 Transmit. When in IrDA mode, this signal has IrDA modulation.

Table 17-4. GPIO Pins and Alternate Functions

GPIO Pin	Pin Number	Multiplexed Function	Multiplexed Function
PA0	26	UORx	
PA1	27	UOTx	
PA2	28	SSI0Clk	
PA3	29	SSI0Fss	
PA4	30	SSI0Rx	
PA5	31	SSIOTx	
PA6	34	I2C1SCL	
PA7	35	I2C1SDA	
PB0	66	CCP0	
PB1	67	CCP2	
PB2	70	I2C0SCL	
PB3	71	I2C0SDA	
PB4	92		
PB5	91	CCP5	
РВ6	90	CCP1	
PB7	89	TRST	
PC0	80	TCK	SWCLK
PC1	79	TMS	SWDIO
PC2	78	TDI	
PC3	77	TDO	SWO
PC4	25		
PC5	24	\	
PC6	23	CCP3	
PC7	22	CCP4	
PD0	10		
PD1	11		
PD2	12	U1Rx	
PD3	13	U1Tx	
PE0	72	SSI1Clk	
PE1	73	SSI1Fss	
PE2	74	SSI1Rx	
PE3	75	SSI1Tx	
PF0	47		
PF1	61		
PF2	60		
PF3	59		
PF4	58		
PF5	46		
PF6	43		
PF7	42		
PG0	19	U2Rx	

GPIO Pin	Pin Number	Multiplexed Function	Multiplexed Function
PG1	18	U2Tx	
PG2	17		
PG3	16		
PG4	41		
PG5	40		
PG6	37		
PG7	36		
PH0	86	CCP6	
PH1	85	CCP7	
PH2	84		
PH3	83		

18 Operating Characteristics

Table 18-1. Temperature Characteristics

Characteristic	Symbol	Value	Unit
Operating temperature range ^a	T _A	-40 to +85	°C

a. Maximum storage temperature is 150°C.

Table 18-2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal resistance (junction to ambient) ^a	Θ_{JA}	55.3	°C/W
Average junction temperature ^b	T _J	$T_A + (P_{AVG} \cdot \Theta_{JA})$	°C

- a. Junction to ambient thermal resistance $\boldsymbol{\theta}_{JA}$ numbers are determined by a package simulator.
- b. Power dissipation is a function of temperature.

19 Electrical Characteristics

19.1 DC Characteristics

19.1.1 Maximum Ratings

The maximum ratings are the limits to which the device can be subjected without permanently damaging the device.

Note: The device is not guaranteed to operate properly at the maximum ratings.

Table 19-1. Maximum Ratings

Characteristic	Symbol	Value		Unit
a .		Min	Max	
I/O supply voltage (V _{DD})	V _{DD}	0	4	٧
Core supply voltage (V _{DD25})	V _{DD25}	0	4	٧
Analog supply voltage (V _{DDA})	V_{DDA}	0	4	٧
Battery supply voltage (V _{BAT})	V_{BAT}	0	4	V
Input voltage	V _{IN}	-0.3	5.5	٧
Maximum current per output pins	I	-	25	mA

a. Voltages are measured with respect to GND.

Important: This device contains circuitry to protect the inputs against damage due to high-static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are connected to an appropriate logic voltage level (for example, either GND or VDD).

19.1.2 Recommended DC Operating Conditions

Table 19-2. Recommended DC Operating Conditions

Parameter	Parameter Name	Min	Nom	Max	Unit
V _{DD}	I/O supply voltage	3.0	3.3	3.6	V
V _{DD25}	Core supply voltage	2.25	2.5	2.75	V
V _{DDA}	Analog supply voltage	3.0	3.3	3.6	V
V _{BAT}	Battery supply voltage	2.3	3.0	3.6	V
V _{IH}	High-level input voltage	2.0	-	5.0	V
V _{IL}	Low-level input voltage	-0.3	-	1.3	V
V _{SIH}	High-level input voltage for Schmitt trigger inputs	0.8 * V _{DD}	-	V_{DD}	V
V _{SIL}	Low-level input voltage for Schmitt trigger inputs	0	-	0.2 * V _{DD}	V
V _{OH}	High-level output voltage	2.4	-	-	V
V _{OL}	Low-level output voltage	-	-	0.4	V
I _{OH}	High-level source current, V _{OH} =2.4 V				
	2-mA Drive	2.0	-	-	mA
	4-mA Drive	4.0	-	-	mA
	8-mA Drive	8.0	-	-	mA

Parameter	Parameter Name		Min	Nom	Max	Unit
I _{OL}	Low-level sink current, V _{OL} =0.4 V					
	2-mA	Orive	2.0	-	-	mA
	4-mA	Orive	4.0	-	-	mA
	8-mA	Orive	8.0	-	-	mA

19.1.3 On-Chip Low Drop-Out (LDO) Regulator Characteristics

Table 19-3. LDO Regulator Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
V _{LDOOUT}	Programmable internal (logic) power supply output value	2.25	2.5	2.75	V
	Output voltage accuracy	-	2%	-	%
t _{PON}	Power-on time	-	-	100	μs
t _{ON}	Time on	-		200	μs
t _{OFF}	Time off	Α-Υ	-	100	μs
V _{STEP}	Step programming incremental voltage	-	50	-	mV
C _{LDO}	External filter capacitor size for internal power supply	-	1	-	μF

19.1.4 Power Specifications

The power measurements specified in the tables that follow are run on the core processor using SRAM with the following specifications (except as noted):

- $V_{DD} = 3.3 \text{ V}$
- $V_{DD25} = 2.50 \text{ V}$
- V_{BAT} = 3.0 V
- V_{DDA} = 3.3 V
- Temperature = 25°C
- Clock Source (MOSC) =3.579545 MHz Crystal Oscillator
- Main oscillator (MOSC) = enabled
- Internal oscillator (IOSC) = disabled

19.1.5 Flash Memory Characteristics

Table 19-4. Flash Memory Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
PE _{CYC}	Number of guaranteed program/erase cycles before failure ^a	10,000	100,000	-	cycles
T _{RET}	Data retention at average operating temperature of 85°C	10	-	-	years
T _{PROG}	Word program time	20	-	-	μs
T _{ERASE}	Page erase time	20	-	-	ms
T _{ME}	Mass erase time	200	-	ı	ms

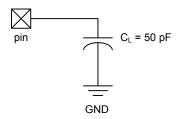
a. A program/erase cycle is defined as switching the bits from 1-> 0 -> 1.

19.2 AC Characteristics

19.2.1 Load Conditions

Unless otherwise specified, the following conditions are true for all timing measurements. Timing measurements are for 4-mA drive strength.

Figure 19-1. Load Conditions



19.2.2 Clocks

Table 19-5. Phase Locked Loop (PLL) Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
f _{ref_crystal}	Crystal reference ^a	3.579545	-	8.192	MHz
f _{ref_ext}	External clock reference ^a	3.579545	<u> </u>	8.192	MHz
f _{pll}	PLL frequency ^b	-	400	-	MHz
T _{READY}	PLL lock time	-	-	0.5	ms

a. The exact value is determined by the crystal value programmed into the XTAL field of the **Run-Mode Clock Configuration** (RCC) register.

Table 19-6. Clock Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
f _{IOSC}	Internal 12 MHz oscillator frequency	8.4	12	15.6	MHz
f _{IOSC30KHZ}	Internal 30 KHz oscillator frequency	21	30	39	KHz
f _{xosc}	Hibernation module oscillator frequency	-	4.194304	-	MHz
f _{XOSC_XTAL}	Crystal reference for hibernation oscillator	-	4.194304	-	MHz
f _{XOSC_EXT}	External clock reference for hibernation module	-	32.768	-	KHz
f _{MOSC}	Main oscillator frequency	1	-	8	MHz
t _{MOSC_per}	Main oscillator period	125	-	1000	ns
f _{ref_crystal_bypass}	Crystal reference using the main oscillator (PLL in BYPASS mode)	1	-	8	MHz
f _{ref_ext_bypass}	External clock reference (PLL in BYPASS mode) ^a	0	-	50	MHz
f _{system_clock}	System clock	0	-	50	MHz

a. The ADC must be clocked from the PLL or directly from a 14-MHz to 18-MHz clock source to operate properly.

Table 19-7. Crystal Characteristics

Parameter Name		Value				
Frequency	8	6	4	3.5	MHz	

b. PLL frequency is automatically calculated by the hardware based on the \mathtt{XTAL} field of the RCC register.

Parameter Name		Va	lue		Units
Frequency tolerance	±50	±50	±50	±50	ppm
Aging	±5	±5	±5	±5	ppm/yr
Oscillation mode	Parallel	Parallel	Parallel	Parallel	
Temperature stability (0 - 85 °C)	±25	±25	±25	±25	ppm
Motional capacitance (typ)	27.8	37.0	55.6	63.5	pF
Motional inductance (typ)	14.3	19.1	28.6	32.7	mH
Equivalent series resistance (max)	120	160	200	220	Ω
Shunt capacitance (max)	10	10	10	10	pF
Load capacitance (typ)	16	16	16	16	pF
Drive level (typ)	100	100	100	100	μW

19.2.3 Temperature Sensor

Table 19-8. Temperature Sensor Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
V _{TSO}	Output voltage	0.3	-	2.7	٧
t _{TSERR}	Output voltage temperature accuracy	-	-<	±3.5	°C
t _{TSNL}	Output temperature nonlinearity	-	-	±1	°C

19.2.4 Analog-to-Digital Converter

Table 19-9. ADC Characteristics

Parameter	Parameter Name	Min	Nom	Max	Unit
V _{ADCIN}	Maximum single-ended, full-scale analog input voltage	-	-	3.0	V
	Minimum single-ended, full-scale analog input voltage	-	-	0	V
	Maximum differential, full-scale analog input voltage	-	-	1.5	V
	Minimum differential, full-scale analog input voltage	-	-	-1.5	V
C _{ADCIN}	Equivalent input capacitance	-	1	-	pF
N	Resolution	-	10	-	bits
f _{ADC}	ADC internal clock frequency	14	16	18	MHz
t _{ADCCONV}	Conversion time	-	-	16	t _{ADC} cycles ^a
f _{ADCCONV}	Conversion rate	875	1000	1125	k samples/s
INL	Integral nonlinearity	-	-	±1	LSB
DNL	Differential nonlinearity	-	-	±1	LSB
OFF	Offset	-	-	±1	LSB
GAIN	Gain	-	-	±1	LSB

a. t_{ADC}= 1/f_{ADC clock}

19.2.5 I²C

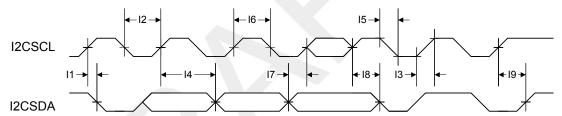
Table 19-10. I²C Characteristics

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
I1 ^a	t _{SCH}	Start condition hold time	36	1	1	system clocks

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
I2 ^a	t _{LP}	Clock Low period	36	-	-	system clocks
I3 _p	t _{SRT}	<code>I2CSCL/I2CSDA</code> rise time (V $_{\rm IL}$ =0.5 V to V $_{\rm IH}$ =2.4 V)	-	-	(see note b)	ns
I4 ^a	t _{DH}	Data hold time	2	-	-	system clocks
I5 ^c	t _{SFT}	<code>I2CSCL/I2CSDA</code> fall time (V $_{IH}$ =2.4 V to V $_{IL}$ =0.5 V)	-	9	10	ns
I6 ^a	t _{HT}	Clock High time	24	-	-	system clocks
I7 ^a	t _{DS}	Data setup time	18	-	-	system clocks
I8 ^a	t _{SCSR}	Start condition setup time (for repeated start condition only)	36	-	-	system clocks
l9 ^a	t _{SCS}	Stop condition setup time	24	-	-	system clocks

- a. Values depend on the value programmed into the TPR bit in the I²C Master Timer Period (I2CMTPR) register; a TPR programmed for the maximum I2CSCL frequency (TPR=0x2) results in a minimum output timing as shown in the table above. The I²C interface is designed to scale the actual data transition time to move it to the middle of the I2CSCL Low period. The actual position is affected by the value programmed into the TPR; however, the numbers given in the above values are minimum values.
- b. Because I2CSCL and I2CSDA are open-drain-type outputs, which the controller can only actively drive Low, the time I2CSCL or I2CSDA takes to reach a high level depends on external signal capacitance and pull-up resistor values.
- c. Specified at a nominal 50 pF load.

Figure 19-2. I²C Timing



19.2.6 Hibernation Module

The Hibernation Module requires special system implementation considerations since it is intended to power-down all other sections of its host device. The system power-supply distribution and interfaces of the system must be driven to 0 V_{DC} or powered down with the same regulator controlled by $\overline{\mathtt{HIB}}$.

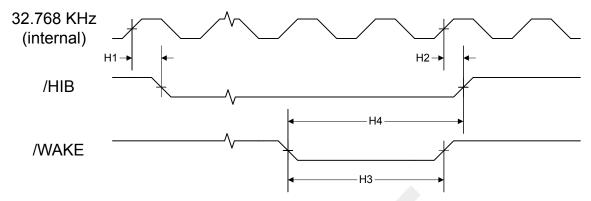
The regulators controlled by HIB are expected to have a settling time of 250 µs or less.

Table 19-11. Hibernation Module Characteristics

Parameter No	Parameter	Parameter Name	Min	Nom	Max	Unit
H1	t _{HIB_LOW}	Internal 32.768 KHz clock reference rising edge to /HIB asserted	-	200	-	μs
H2	t _{HIB_HIGH}	Internal 32.768 KHz clock reference rising edge to /HIB deasserted	-	30	-	μs
H3	t _{WAKE_ASSERT}	/WAKE assertion time	62	-	-	μs
H4	t _{WAKETOHIB}	/WAKE assert to /HIB desassert	62	-	124	μs
H5	t _{XOSC_SETTLE}	XOSC settling time ^a	20	-	-	ms
H6	t _{HIB_REG_WRITE}	Time for a write to non-volatile registers in HIB module to complete	92	-	-	μs

a. This parameter is highly sensitive to PCB layout and trace lengths, which may make this parameter time longer. Care must be taken in PCB design to minimize trace lengths and RLC (resistance, inductance, capacitance).

Figure 19-3. Hibernation Module Timing

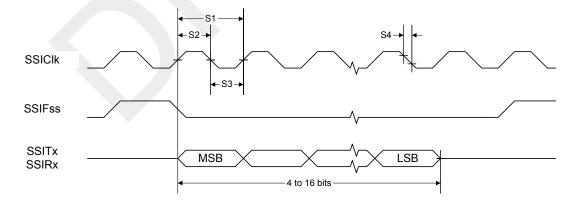


19.2.7 Synchronous Serial Interface (SSI)

Table 19-12. SSI Characteristics

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
S1	t _{clk_per}	SSIC1k cycle time	2	-	65024	system clocks
S2	t _{clk_high}	SSIC1k high time	-	1/2	-	t clk_per
S3	t _{clk_low}	SSIC1k low time	-	1/2	-	t clk_per
S4	t _{clkrf}	SSIC1k rise/fall time	-	7.4	26	ns
S5	t _{DMd}	Data from master valid delay time	0	-	20	ns
S6	t _{DMs}	Data from master setup time	20	•	-	ns
S7	t _{DMh}	Data from master hold time	40	-	-	ns
S8	t _{DSs}	Data from slave setup time	20	-	-	ns
S9	t _{DSh}	Data from slave hold time	40	-	-	ns

Figure 19-4. SSI Timing for TI Frame Format (FRF=01), Single Transfer Timing Measurement



SSIRx

SSICIK

SSIFss

SSIFss

SSITx

MSB

LSB

8-bit control

0

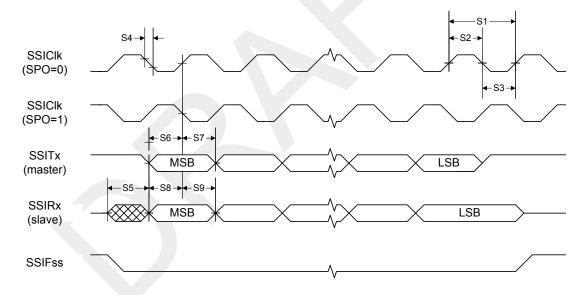
MSB

LSB

4 to 16 bits output data

Figure 19-5. SSI Timing for MICROWIRE Frame Format (FRF=10), Single Transfer





19.2.8 JTAG and Boundary Scan

Table 19-13. JTAG Characteristics

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
J1	f _{TCK}	TCK operational clock frequency	0	-	10	MHz
J2	t _{TCK}	TCK operational clock period	100	-	-	ns
J3	t _{TCK_LOW}	TCK clock Low time	-	t _{TCK}	-	ns

410

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
J4	t _{TCK_HIGH}	TCK clock High time	-	t _{TCK}	-	ns
J5	t _{TCK_R}	TCK rise time	0	-	10	ns
J6	t _{TCK_F}	тск fall time	0	-	10	ns
J7	t _{TMS_SU}	TMS setup time to TCK rise	20	-	-	ns
J8	t _{TMS_HLD}	TMS hold time from TCK rise	20	-	-	ns
J9	t _{TDI_} SU	TDI setup time to TCK rise	25	-	-	ns
J10	t _{TDI_HLD}	TDI hold time from TCK rise	25	-	-	ns
J11	TCK fall to Data Valid from High-Z	2-mA drive	-	23	35	ns
t _{TDO_ZDV}		4-mA drive		15	26	ns
_		8-mA drive		14	25	ns
		8-mA drive with slew rate control		18	29	ns
J12	TCK fall to Data Valid from Data Valid	2-mA drive	-	21	35	ns
t _{TDO_DV}		4-mA drive		14	25	ns
_		8-mA drive		13	24	ns
		8-mA drive with slew rate control		18	28	ns
J13	TCK fall to High-Z from Data Valid	2-mA drive	-	9	11	ns
t _{TDO_DVZ}		4-mA drive		7	9	ns
		8-mA drive		6	8	ns
		8-mA drive with slew rate control		7	9	ns
J14	t _{TRST}	TRST assertion time	100	-	-	ns
J15	t _{TRST_SU}	TRST setup time to TCK rise	10	-	-	ns

Figure 19-7. JTAG Test Clock Input Timing

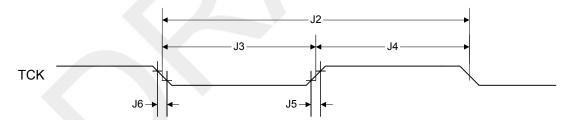


Figure 19-8. JTAG Test Access Port (TAP) Timing

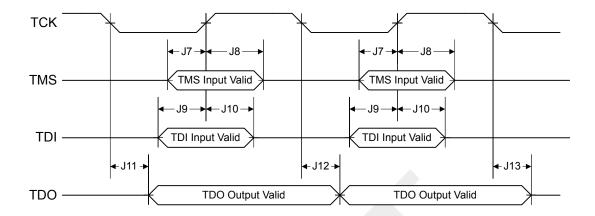
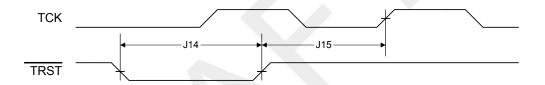


Figure 19-9. JTAG TRST Timing



19.2.9 General-Purpose I/O

Note: All GPIOs are 5 V-tolerant.

Table 19-14. GPIO Characteristics

Parameter	Parameter Name	Condition	Min	Nom	Max	Unit
t _{GPIOR}	GPIO Rise Time (from 20% to 80% of V _{DD})	2-mA drive	-	17	26	ns
		4-mA drive		9	13	ns
		8-mA drive		6	9	ns
		8-mA drive with slew rate control		10	12	ns
t _{GPIOF}	GPIO Fall Time (from 80% to 20% of V _{DD})	2-mA drive	-	17	25	ns
		4-mA drive		8	12	ns
		8-mA drive		6	10	ns
		8-mA drive with slew rate control		11	13	ns

19.2.10 Reset

Table 19-15. Reset Characteristics

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
R1	V_{TH}	Reset threshold	-	2.0	-	V

Parameter No.	Parameter	Parameter Name	Min	Nom	Max	Unit
R2	V _{BTH}	Brown-Out threshold	2.85	2.9	2.95	٧
R3	T _{POR}	Power-On Reset timeout	-	10	-	ms
R4	T _{BOR}	Brown-Out timeout	-	500	-	μs
R5	T _{IRPOR}	Internal reset timeout after POR	6	-	11	ms
R6	T _{IRBOR}	Internal reset timeout after BOR	0	-	1	μs
R7	T _{IRHWR}	Internal reset timeout after hardware reset (RST pin)	0	-	1	ms
R8	T _{IRSWR}	Internal reset timeout after software-initiated system reset a	2.5	-	20	μs
R9	T _{IRWDR}	Internal reset timeout after watchdog reset ^a	2.5	-	20	μs
R10	T _{VDDRISE}	Supply voltage (V _{DD}) rise time (0V-3.3V)	-	-	100	ms
R11	T _{MIN}	Minimum RST pulse width	2	-	ı	μs

a. 20 * t $_{MOSC_per}$

Figure 19-10. External Reset Timing (RST)

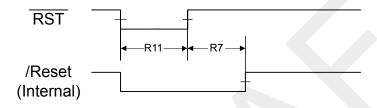


Figure 19-11. Power-On Reset Timing

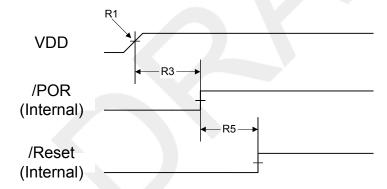


Figure 19-12. Brown-Out Reset Timing

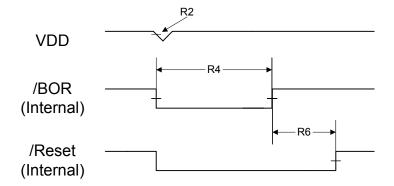


Figure 19-13. Software Reset Timing

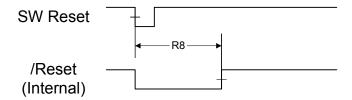
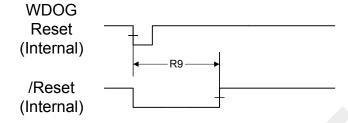
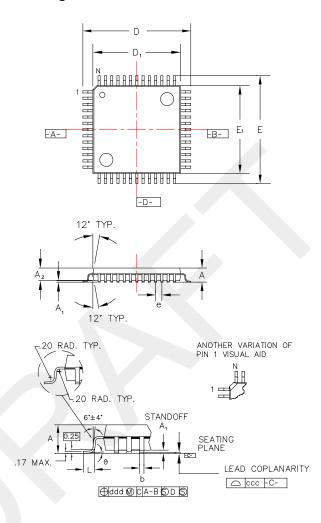


Figure 19-14. Watchdog Reset Timing



20 Package Information

Figure 20-1. 100-Pin LQFP Package



Notes

- 1. All dimensions shown in mm.
- 2. Dimensions shown are nominal with tolerances indicated.
- 3. Foot length 'L' is measured at gage plane 0.25 mm above seating plane.
- 4. L/F: Eftec 64T Cu or equivalent, 0.127 mm (0.005") or 0.152 mm (0.006") thick.
- Use variation BED for body dimensions.

Body +2.00 mm	Footprint, 1.4 mm	package thickness
Symbols	Leads	100L
Α	Max.	1.60
A ₁		0.05 Min./0.15 Max.

A ₂	±0.05	1.40						
D	±0.20	16.00						
D ₁	±0.05	14.00						
E	±0.20	16.00						
E ₁	±0.05	14.00						
L	±0.15/-0.10	0.60						
е	BASIC	0.50						
b	±0.05	0.22						
θ		0°~7°						
ddd	Max.	0.08						
ccc	Max.	0.08						
JEDEC Refer	ence Drawing	MS-026						
Variation [Variation Designator							

21 Ordering and Contact Information

21.1 Ordering Information

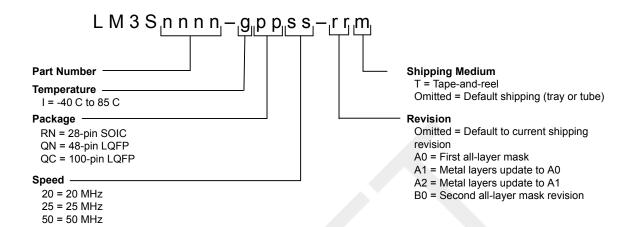


Table 21-1. Part Ordering Information

Orderable Part Number	
LM3S1958-IQC50	Stellaris® LM3S1958 Microcontroller

21.2 Company Information

Luminary Micro, Inc. designs, markets, and sells ARM Cortex-M3-based microcontrollers (MCUs). Austin, Texas-based Luminary Micro is the lead partner for the Cortex-M3 processor, delivering the world's first silicon implementation of the Cortex-M3 processor. Luminary Micro's introduction of the Stellaris® family of products provides 32-bit performance for the same price as current 8- and 16-bit microcontroller designs. With entry-level pricing at \$1.00 for an ARM technology-based MCU, Luminary Micro's Stellaris product line allows for standardization that eliminates future architectural upgrades or software tool changes.

Luminary Micro, Inc. 108 Wild Basin, Suite 350 Austin, TX 78746 Main: +1-512-279-8800 Fax: +1-512-279-8879

http://www.luminarymicro.com sales@luminarymicro.com

21.3 Support Information

For support on Luminary Micro products, contact: support@luminarymicro.com +1-512-279-8800, ext. 3

A Serial Flash Loader

A.1 Serial Flash Loader

The Stellaris[®] serial flash loader is a preprogrammed flash-resident utility used to download code to the flash memory of a device without the use of a debug interface. The serial flash loader uses a simple packet interface to provide synchronous communication with the device. The flash loader runs off the crystal and does not enable the PLL, so its speed is determined by the crystal used. The two serial interfaces that can be used are the UARTO and SSI interfaces. For simplicity, both the data format and communication protocol are identical for both serial interfaces.

A.2 Interfaces

Once communication with the flash loader is established via one of the serial interfaces, that interface is used until the flash loader is reset or new code takes over. For example, once you start communicating using the SSI port, communications with the flash loader via the UART are disabled until the device is reset.

A.2.1 UART

The Universal Asynchronous Receivers/Transmitters (UART) communication uses a fixed serial format of 8 bits of data, no parity, and 1 stop bit. The baud rate used for communication is automatically detected by the flash loader and can be any valid baud rate supported by the host and the device. The auto detection sequence requires that the baud rate should be no more than 1/32 the crystal frequency of the board that is running the serial flash loader. This is actually the same as the hardware limitation for the maximum baud rate for any UART on a Stellaris[®] device.

In order to determine the baud rate, the serial flash loader needs to determine the relationship between its own crystal frequency and the baud rate. This is enough information for the flash loader to configure its UART to the same baud rate as the host. This automatic baud-rate detection allows the host to use any valid baud rate that it wants to communicate with the device.

The method used to perform this automatic synchronization relies on the host sending the flash loader two bytes that are both 0x55. This generates a series of pulses to the flash loader that it can use to calculate the ratios needed to program the UART to match the host's baud rate. After the host sends the pattern, it attempts to read back one byte of data from the UART. The flash loader returns the value of 0xCC to indicate successful detection of the baud rate. If this byte is not received after at least twice the time required to transfer the two bytes, the host can resend another pattern of 0x55, 0x55, and wait for the 0xCC byte again until the flash loader acknowledges that it has received a synchronization pattern correctly. For example, the time to wait for data back from the flash loader should be calculated as at least 2*(20(bits/sync)/baud rate (bits/sec)). For a baud rate of 115200, this time is 2*(20/115200) or 0.35 ms.

A.2.2 SSI

The Synchronous Serial Interface (SSI) port also uses a fixed serial format for communications, with the framing defined as Motorola format with SPH set to 1 and SPO set to 1. See the section on SSI formats for more details on this transfer protocol. Like the UART, this interface has hardware requirements that limit the maximum speed that the SSI clock can run. This allows the SSI clock to be at most 1/12 the crystal frequency of the board running the flash loader. Since the host device is the master, the SSI on the flash loader device does not need to determine the clock as it is provided directly by the host.

A.3 Packet Handling

All communications, with the exception of the UART auto-baud, are done via defined packets that are acknowledged (ACK) or not acknowledged (NAK) by the devices. The packets use the same format for receiving and sending packets, including the method used to acknowledge successful or unsuccessful reception of a packet.

A.3.1 Packet Format

All packets sent and received from the device use the following byte-packed format.

```
struct
{
  unsigned char ucSize;
  unsigned char ucCheckSum;
  unsigned char Data[];
};
```

ucSize The first byte received holds the total size of the transfer including

the size and checksum bytes.

ucChecksum

This holds a simple checksum of the bytes in the data buffer only.

The algorithm is Data[0]+Data[1]+...+ Data[ucSize-3].

Data This is the raw data intended for the device, which is formatted in

some form of command interface. There should be ucSize-2 bytes of data provided in this buffer to or from the device.

A.3.2 Sending Packets

The actual bytes of the packet can be sent individually or all at once; the only limitation is that commands that cause flash memory access should limit the download sizes to prevent losing bytes during flash programming. This limitation is discussed further in the commands that interact with the flash.

Once the packet has been formatted correctly by the host, it should be sent out over the UART or SSI interface. Then the host should poll the UART or SSI interface for the first non-zero data returned from the device. The first non-zero byte will either be an ACK (0xCC) or a NAK (0x33) byte from the device indicating the packet was received successfully (ACK) or unsuccessfully (NAK). This does not indicate that the actual contents of the command issued in the data portion of the packet were valid, just that the packet was received correctly.

A.3.3 Receiving Packets

The flash loader sends a packet of data in the same format that it receives a packet. The flash loader may transfer leading zero data before the first actual byte of data is sent out. The first non-zero byte is the size of the packet followed by a checksum byte, and finally followed by the data itself. There is no break in the data after the first non-zero byte is sent from the flash loader. Once the device communicating with the flash loader receives all the bytes, it must either ACK or NAK the packet to indicate that the transmission was successful. The appropriate response after sending a NAK to the flash loader is to resend the command that failed and request the data again. If needed, the host may send leading zeros before sending down the ACK/NAK signal to the flash loader, as the flash loader only accepts the first non-zero data as a valid response. This zero padding is needed by the SSI interface in order to receive data to or from the flash loader.

A.4 Commands

The next section defines the list of commands that can be sent to the flash loader. The first byte of the data should always be one of the defined commands, followed by data or parameters as determined by the command that is sent.

A.4.1 COMMAND_PING (0X20)

This command simply accepts the command and sets the global status to success. The format of the packet is as follows:

```
Byte[0] = 0x03;
Byte[1] = checksum(Byte[2]);
Byte[2] = COMMAND PING;
```

The ping command has 3 bytes and the value for COMMAND_PING is 0x20 and the checksum of one byte is that same byte, making Byte[1] also 0x20. Since the ping command has no real return status, the receipt of an ACK can be interpreted as a successful ping to the flash loader.

A.4.2 COMMAND GET STATUS (0x23)

This command returns the status of the last command that was issued. Typically, this command should be sent after every command to ensure that the previous command was successful or to properly respond to a failure. The command requires one byte in the data of the packet and should be followed by reading a packet with one byte of data that contains a status code. The last step is to ACK or NAK the received data so the flash loader knows that the data has been read.

```
Byte[0] = 0x03
Byte[1] = checksum(Byte[2])
Byte[2] = COMMAND GET STATUS
```

A.4.3 COMMAND_DOWNLOAD (0x21)

This command is sent to the flash loader to indicate where to store data and how many bytes will be sent by the COMMAND_SEND_DATA commands that follow. The command consists of two 32-bit values that are both transferred MSB first. The first 32-bit value is the address to start programming data into, while the second is the 32-bit size of the data that will be sent. This command also triggers an erase of the full area to be programmed so this command takes longer than other commands. This results in a longer time to receive the ACK/NAK back from the board. This command should be followed by a COMMAND_GET_STATUS to ensure that the Program Address and Program size are valid for the device running the flash loader.

The format of the packet to send this command is a follows:

```
Byte[0] = 11
Byte[1] = checksum(Bytes[2:10])
Byte[2] = COMMAND_DOWNLOAD
Byte[3] = Program Address [31:24]
Byte[4] = Program Address [23:16]
Byte[5] = Program Address [7:0]
Byte[6] = Program Address [7:0]
Byte[7] = Program Size [31:24]
Byte[8] = Program Size [23:16]
Byte[9] = Program Size [15:8]
Byte[10] = Program Size [7:0]
```

A.4.4 COMMAND_SEND_DATA (0x24)

This command should only follow a COMMAND_DOWNLOAD command or another COMMAND_SEND_DATA command if more data is needed. Consecutive send data commands automatically increment address and continue programming from the previous location. The caller should limit transfers of data to a maximum 8 bytes of packet data to allow the flash to program successfully and not overflow input buffers of the serial interfaces. The command terminates programming once the number of bytes indicated by the COMMAND_DOWNLOAD command has been received. Each time this function is called it should be followed by a COMMAND_GET_STATUS to ensure that the data was successfully programmed into the flash. If the flash loader sends a NAK to this command, the flash loader does not increment the current address to allow retransmission of the previous data.

```
Byte[0] = 11
Byte[1] = checksum(Bytes[2:10])
Byte[2] = COMMAND_SEND_DATA
Byte[3] = Data[0]
Byte[4] = Data[1]
Byte[5] = Data[2]
Byte[6] = Data[3]
Byte[7] = Data[4]
Byte[8] = Data[5]
Byte[9] = Data[6]
Byte[10] = Data[7]
```

A.4.5 COMMAND_RUN (0x22)

This command is used to tell the flash loader to execute from the address passed as the parameter in this command. This command consists of a single 32-bit value that is interpreted as the address to execute. The 32-bit value is transmitted MSB first and the flash loader responds with an ACK signal back to the host device before actually executing the code at the given address. This allows the host to know that the command was received successfully and the code is now running.

```
Byte[0] = 7
Byte[1] = checksum(Bytes[2:6])
Byte[2] = COMMAND_RUN
Byte[3] = Execute Address[31:24]
Byte[4] = Execute Address[23:16]
Byte[5] = Execute Address[15:8]
Byte[6] = Execute Address[7:0]
```

A.4.6 COMMAND RESET (0x25)

This command is used to tell the flash loader device to reset. This is useful when downloading a new image that overwrote the flash loader and wants to start from a full reset. Unlike the COMMAND_RUN command, this allows the initial stack pointer to be read by the hardware and set up for the new code. It can also be used to reset the flash loader if a critical error occurs and the host device wants to restart communication with the flash loader.

```
Byte[0] = 3
Byte[1] = checksum(Byte[2])
Byte[2] = COMMAND_RESET
```

The flash loader responds with an ACK signal back to the host device before actually executing the software reset to the device running the flash loader. This allows the host to know that the command was received successfully and the part will be reset.

B Register Quick Reference

Name	Offset	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
System Co Base: 0x40																	
DID0				VER									CL	ASS			
RO	0x000				MA	JOR											
PBORCTL R/W	0x030															BORIOR	
LDOPCTL																BONION	
R/W	0x034													VA	\DJ		
RIS	0x050																
RO											PLLLRIS					BORRIS	
IMC R/W	0x054										PLLLIM					BORIM	
MISC R/W1C	0x058										PLLLMIS					BORMIS	
RESC R/W	0x05C											LDO	SW	WDT	BOR	POR	EXT
RCC						ACG		SYS	SDIV		VERKEEU	LDO		***	BOIL	TOIL	EXI
R/W	0x060			PWRDN		BYPASS			X	ĀL		osc	OSCSRC			IOSCDIS	MOSCDIS
PLLCFG	0x064						/7										
RO		0	D					F							R	1	
RCC2	0x070	USERCC2					SYS	DIV2		I							
R/W				PWRDN2		BYPASS2	DODU	(00)05				OSCSRC2	2				
dslpolkofg R/W	0x144						DSDIV	ORIDE			Г	SOSCSR	C				
DID1			V	ER.			F/	AM						RTNO			
RO	0x004	F	PINCOUN	IT							TEMP		Р	KG	ROHS	QL	JAL
DC0	0x008								SRA	MSZ							
RO									FLAS	SHSZ					I	I	
DC1 RO	0x010		SY	SDIV			MAXA	DCSPD		MPU	HIB	TEMPSNS	PLL	WDT	SWO	SWD	SARADO0 JTAG
DC2							5 5 1			•				TIMER3			
RO	0x014		I2C1		I2C0							SSI1	SSI0		UART2	UART1	UART0
DC3	0x018			CCP5	CCP4	CCP3	CCP2	CCP1	CCP0	ADC7	ADC6	ADC5	ADC4	ADC3	ADC2	ADC1	ADC0
RO																	

		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name	Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RO		CCP7	CCP6							GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
RCGC0	0x100																SARADO0
R/W	0.2.100						MAXA	DCSPD			HIB			WDT			
SCGC0	0x110																SARADCO
R/W							MAXA	DCSPD	I		HIB			WDT			
DCGC0 R/W	0x120																SARADCO
							MAXA	DCSPD			HIB			WDT	TIME DO	TIMED 4	TIMEDO
RCGC1 R/W	0x104		I2C1		I2C0							SSI1	SSI0	TIMER3	TIMER2 UART2	TIMER1	TIMER0
			1201		1200							3311	3310	TIMER3		TIMER1	TIMER0
SCGC1 R/W	0x114		I2C1		I2C0							SSI1	SSI0	TIVILITO	UART2	UART1	UART0
DCGC1														TIMER3	TIMER2	TIMER1	TIMER0
R/W	0x124		I2C1		I2C0							SSI1	SSI0		UART2	UART1	UART0
RCGC2																	
R/W	0x108									GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
SCGC2	0x118																
R/W	UXTIO									GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
DCGC2	0x128																
R/W										GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
SRCR0	0x040																SARADO0
R/W											HIB			WDT			
SRCR1 R/W	0x044		I2C1		12C0							0014	6610	TIMER3			TIMER0
			1201		1200							SSI1	SSI0		UART2	UART1	UART0
SRCR2 R/W	0x048									GPIOH	GPIOG	GPIOF	GPIOE	GPIOD	GPIOC	GPIOB	GPIOA
Hibernatio	n Module																
HIBRTCC									R	гсс							
RO	0x000								R	гсс							
HIBRTCM0	0004								RT	СМ0							
R/W	0x004								RT	СМ0							
HIBRTCM1	0x008								RT	CM1							
R/W									RT	CM1							
HIBRTCLD	0x00C		RTCLD														
R/W									RT	CLD							
HIBCTL	0x010																
R/W										VABORT	CLK32EN	LONBATEN	PINWEN	RTCWEN	CLKSEL	HIBREQ	RTCEN
HIBIM	0x014																

		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name	Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R/W														EXTW	LOWBAT	RTCALT1	RTCALT0
HIBRIS RO	0x018													EXTW	LOWBAT	RTCALT1	RTCALT0
HIBMIS RO	0x01C													EXTW	LOWBAT	RTCALT1	RTCALT0
HIBIC W1C	0x020													EXTW	LOWBAT	RTCALT1	RTCALT0
HIBRTCT R/W	0x024								TF	RIM							
HIBDATA R/W	0x030- 0x12C									TD							
Internal Me Base: 0x40 Base: 0x40	00F.D000																
FMA R/W	0x000		OFFSET OFFSET														
FMD R/W	0x004	OFFSET DATA DATA															
FMC								\rightarrow	-	KEY							
R/W	800x0													COMT	MERASE	ERASE	WRITE
FCRIS RO	0x00C															PRIS	ARIS
FCIM R/W	0x010															PMASK	AMASK
FCMISC R/W1C	0x014															PMISC	AMISC
USECRL R/W	0x140												US	SEC			
FMPRE0	0x130								READ_I	ENABLE							
R/W	and 0x200								READ_I	ENABLE							
FMPPE0 R/W	0x134 and 0x400									ENABLE							
USER DBG	0x1D0	NOWATEN								DATA							
R/W	VX 100							DATA							INIT1	DBG1	DBG0
USER_REGO	0x1E0	NOTWALLEN	NOTATIEN DATA														
R/W									DA	TΑ							

		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name	Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
USER_REG1	0x1E4	NOWALEN								DATA							
R/W	UX IE4								DA	TΑ							
FMPRE1	0x204								READ_E	ENABLE							
R/W									READ_E	ENABLE							
FMPRE2	0x208								READ_E								
K/W									READ_E								
FMPRE3 R/W	0x20C								READ_E								
													_				
FMPPE1 R/W	0x404								PROG_I			4					
FMDDEO									PROG_I								
FMPPE2 R/W	0x408								PROG_I		~ ~						
FMPPE3									PROG_I	_							
R/W	0x40C								PROG_I								
Conorol D	urnaaa In	nut/Outnu	to (CRIO	٠,					11100_1	LIV (DEE							
General-P Base: 0x4		put/Outpu	is (GPIO	5)													
Base: 0x4																	
Base: 0x4																	
Base: 0x4																	
Base: 0x4	002.4000																
Base: 0x4	002.5000																
Base: 0x4	002.6000																
Base: 0x4	002.7000																
GPIODATA																	
R/W	0x000												DA	ιΤΑ			
GPIODIR																	
R/W	0x400		$ \leftarrow $										D	IR			
GPIOIS																	
R/W	0x404												l:	S			
GPIOIBE R/W	0x408													_			
R/VV													IE	BE			
GPIOIEV R/W	0x40C																
													IE	:V			
GPIOIM R/W	0x410																
													IM	ic			
GPIORIS RO	0x414												R	IS			
GPIOMIS RO	0x418												М	IS			

		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name	Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GPIOICR																	
W1C	0x41C												ļ.	С			
GPIOAFSEL																	
R/W	0x420												AF	SEL			
GPIODR2R																	
R/W	0x500												DF	RV2			
GPIODR4R	0x504																
R/W	UX5U4												DF	RV4			
GPIODR8R	0x508																
R/W	UXUUU												DF	8V8			
GPIOODR	0x50C																
R/W													OI	DE			
GPIOPUR	0x510																
R/W													Pl	JE			
GPIOPDR	0x514																
R/W													PI	DE			
GPIOSLR	0x518																
R/W													SI	RL			
GPIODEN	0x51C																
R/W													DI	ΞN			
GPIOLOCK	0x520				4					CK							
R/W									LC	CK							
GPIOCR	0x524																
													C	R			
GPIOPaiphD4 RO	0xFD0													.			
													PI	D4			
CPOPaiphD5 RO	0xFD4												DI	D.F.			
													PI	D5			
GPIOPeiphD6 RO	0xFD8												DI	D6			
														D0			
CPIOPeipHD7 RO	0xFDC												PI	D7			
CPOPaiphD0 RO	0xFE0												PI	D0			
														-			
GPIOPaiphD1 RO	0xFE4												PI	D1			
GPIOPeiphID2	0xFE8																
upi E.E.																	

		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name	Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RO													PI	D2			
GPIOP uiph D3																	
RO	0xFEC											I	PI	D3	I		1
GPIOPCeIID0	0xFF0																
RO													CI	D0			
GPIOPCeIID1	0xFF4																
													CI	D1			
GPIOPCeIID2 RO	0xFF8												CI	D2			
GPIOPCeIID3																	
RO	0xFFC												CI	D3			
General-Pu Base: 0x40 Base: 0x40 Base: 0x40	003.0000 003.1000 003.2000																
GPTMCFG	0x000																
R/W	UXUUU														(GPTMCFO	3
GPTIVITAMIR	0x004																
R/W														TAAMS	TACMR	TA	MR
GPTMTBMR R/W	0x008													TRAMS	TBCMR	TR	MR
GPTMCTL																	
R/W	0x00C		TBPWML	TBOTE		TBE	/ENT	TBSTALL	TBEN		TAPWML	TAOTE	RTCEN	TAE	/ENT	TASTALL	TAEN
GPTMIMR	0x018																
R/W	02010						CBEIM	СВМІМ	твтоім					RTCIM	CAEIM	CAMIM	TATOIM
GPTMRIS RO	0x01C						CBERIS	CBMRIS	TBTORIS					RTCRIS	CAERIS	CAMRIS	TATORIS
GPTMMIS RO	0x020						CBEMIS	CBMMIS	TBTOMIS					RTCMIS	CAEMIS	CAMMIS	TATOMIS
GPTMICR							CBECINT	CBMCINT	TBICONT					RTCCINT	CAECINT	CAMCINT	TATOONT
W1C	0x024									DU							
									TAII	-1717							
W1C GPTMTAILR R/W	0x024 0x028								TAII								
GPTIMTAILR										LRL							

Name	Offset	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GPIMBMAICHR R/W	0x034								TBN	//RL							
GPTMTAPR										··· ·							
R/W	0x038												TAF	PSR			
GPTMTBPR																	
R/W	0x03C											1	TBF	PSR	1		
GPTIMTAPIVIR	0x040																
R/W													TAP	SMR			
GPIMIBPWR	0x044																
R/W													TBP	SMR			
GPTMTAR RO	0x048								TA								
									TA	RL							
GPTMTBR RO	0x04C								TD	DI							
Watchdog	Timer		TBRL														
Base: 0x40			WDTLoad														
WDTLOAD	0x000		WDTLoad														
R/W	0,000		WDTLoad WDTLoad														
WDTVALUE	0x004								WDT	Value							
RO									WDT	Value							
WDTCTL	0x008																
R/W																RESEN	INTEN
WDTICR WO	0x00C								WDT								
									WDT	IntClr							
WDTRIS RO	0x010																WDTRIS
WDTMIS																	פואוטייי
RO	0x014																WDTMIS
WDTTEST																	
R/W	0x418								STALL								
WDTLOCK									WDT	Lock							
R/W	0xC00								WDT	Lock							
WDTP aip hD4	0500																
RO	0xFD0										1		PI	D4		1	
WDTP aiph D5	0xFD4																
RO	VAI 154												PI	D5			
WDTPeriphD6	0xFD8																

		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name (Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ю													PI	D6			
NDTPeiphD7	0xFDC																
80	UXFDC												PI	D7			
NDTPeiphD0	0xFE0																
RO													PI	D0			
NDTP aiph ID1 RO	0xFE4												D.	D4			
													PI	D1			
NDTPeiphD2 RO	0xFE8												PI	D2			
NDTPeiphD3																	
80	0xFEC												PI	D3			
NDTPCelID0	0xFF0																
ю '	UXFFU												CI	D0			
NDTPCellD1	0xFF4																
RO													CI	D1			
NDTPCeIID2 RO	0xFF8												01	D0			
													CI	D2			
NDTPCeIID3 RO	0xFFC												CI	D3			
Analog-to-D	Digital Co	nverter (ADC)														
3ase: 0x400	03.8000										ı					ı	
ADCACTSS R/W	0x000					¥								ASEN3	ASEN2	ASEN1	ASEN0
ADCRIS																	
ю	0x004													INR3	INR2	INR1	INR0
ADCIM	0x008																
R/W														MASK3	MASK2	MASK1	MASK0
ADCISC R/W1C	0x00C																
														IN3	IN2	IN1	IN0
ADCOSTAT R/W1C	0x010													OV3	OV2	OV1	OV0
ADCEMUX																	
R/W	0x014		El	M3	I .		E	M2			E	M1			EI	М0	1
ADCUSTAT R/W1C	0x018													111/2	111/2	11/4	111/0
														0/3	UV2	UV1	UV0
ADCSSPRI R/W	0x020			S	S3			SS	S2			SS	S1			s	S0
R/W1C				S	S3			S	S2			SS	S1	UV3	UV2	UV	

		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name	Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ADCPSSI		10		10	'-		10			•			•		_	'	
WO	0x028													SS3	SS2	SS1	SS0
ADCSAC																	
R/W	0x030															AVG	
ADCSSMUX0	0x040			MUX7				MUX6				MUX5				MUX4	
R/W	02040			MUX3				MUX2				MUX1				MUX0	
ADCSSCTL0	0x044	TS7	IE7	END7	D7	TS6	IE6	END6	D6	TS5	IE5	END5	D5	TS4	IE4	END4	D4
R/W		TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0
ADCSSFF00 RO	0x048																
												DA	TA .				
ADCSSFF01 RO	0x068											D4	ATA .				
ADCSSFF02 RO	0x088											DA	TA.				
ADCSSF51/ATO																	
RO	0x04C				FULL				EMPTY		HF	PTR			TF	PTR	
ADCSSFSTAT1																	
RO	0x06C				FULL				EMPTY		HF	PTR			TF	PTR	
ADCSSFSTAT2	0x08C																
RO					FULL				EMPTY		HF	PTR			TF	PTR	
ADCSSMUX1	0x060																
R/W				MUX3				MUX2				MUX1				MUX0	
ADCSSCTL1 R/W	0x064		150	ENDO	200	T 00	150	FNDO			154	END4	5.4	T00	150	ENDO	
		TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0
ADCSSMUX2 R/W	0x080			MUX3				MUX2				MUX1				MUX0	
ADCSSCTL2																	
R/W	0x084	TS3	IE3	END3	D3	TS2	IE2	END2	D2	TS1	IE1	END1	D1	TS0	IE0	END0	D0
ADCSSMUX3																	
R/W	0x0A0															MUX0	
ADCSSCTL3	0x0A4																
R/W	UXUA4													TS0	IE0	END0	D0
ADCSSFF03 RO	0x0A8																
ADCSSFSIAI3	0x0AC																
ADCTMLB	0×100																
ADO I IVILD	UA 100																

		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name	Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R/W									C	NT		CONT	DIFF	TS		MUX	
ADCTMLB R/W	0x100																LB
Universal A Base: 0x40 Base: 0x40 Base: 0x40	000.C000 000.D000	nous Rec	eivers/Tra	ansmitter	s (UARTs))											
UARTDR RO	0x000					OE	BE	PE	FE				DA	ATA			
UARTRSR/																	
UARTECR R/W	0x004													OE	BE	PE	FE
UARTRSR/ UARTECR R/W	0x004												DA	ATA			
UARTFR RO	0x018									TXFE	RXFF	TXFF	RXFE	BUSY			
UARTILPR R/W	0x020												II PC	OVSR			
UARTIBRD													12.12	, voit			
R/W	0x024								DIV	/INT							
uartfbrd R/W	0x028													DIVE	RAC		
UARTLCRH R/W	0x02C									SPS	\\/I	.EN	FEN	STP2	EPS	PEN	BRK
UARTCTL R/W	0x030							RXE	TXE	LBE				02	SIRLP	SIREN	UARTEN
UARTIFLS R/W	0x034												RXIFLSEL			TXIFLSEI	
UARTIM R/W	0x038						OEIM	BEIM	PEIM	FEIM	RTIM	TXIM	RXIM				
UARTRIS	0x03C						JEIWI	SERVI		. LIW		· ZXIIVI					
RO UARTMIS							OERIS	BERIS	PERIS	FERIS	RTRIS	TXRIS	RXRIS				
RO	0x040						OEMIS	BEMIS	PEMIS	FEMIS	RTMIS	TXMIS	RXMIS				
UARTICR W1C	0x044						OEIC	BEIC	PEIC	FEIC	RTIC	TXIC	RXIC				
uarip _{aja} hd4 Ro	0xFD0																

Name	Offset	31 15	30 14	29 13	28 12	27 11	26 10	25 9	24 8	23 7	22 6	21 5	20	19	18	17	16
			14	13	12	- "	10	9	0	,	0	5		D4	2	'	U
uaripeiphos Ro	0xFD4												PI	D5			
UARTPeiphD6																	
RO	0xFD8												PI	D6			
JARTPeiphD7																	
RO	0xFDC												PI	D7			
UARTRejphD0	0																
RO	0xFE0												PI	D0			
UARTR ajul D1																	
RO	0xFE4												PI	D1			
UARTReiphD2																	
RO	0xFE8												PI	D2		1	
UARTPeiphD3																	
RO	0xFEC												PI	D3			
UARTPCaIDO																	
RO	0xFF0												CI	D0			
UARTIPCe II D1																	
RO RO	0xFF4												CI	D1			
													0.				
uartipoald2 Ro	0xFF8												CI	D2			
													CI	D2			
uartipoald3 Ro	0xFFC																
													CI	D3			
Synchrono Base: 0x40		Interface	(SSI)														
Base: 0x40 Base: 0x40																	
SSICR0	0x000																
R/W	UXUUU				S	CR	·			SPH	SPO	FF	RF		D	SS	
SSICR1	0064																
R/W	0x004													SOD	MS	SSE	LBM
SSIDR																	
R/W	0x008								DA	ATA							
SSISR																	
RO	0x00C												BSY	RFF	RNE	TNF	TFE
SSICPSR																	
R/W	0x010												CPSI	DVSR			
														- •			
SSIIM																	

		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name	Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
														TXIM	RXIM	RTIM	RORIM
SSIRIS																	
RO	0x018													TXRIS	RXRIS	RTRIS	RORRIS
SSIMIS																	
RO	0x01C													TXMIS	RXMIS	RTMIS	RORMIS
SSIICR																	
W1C	0x020															RTIC	RORIC
SSIPeriphID4	0																
RO	0xFD0												PI	D4			
SSIPeriphID5	0FD4											$ \wedge $					
RO	0xFD4												PI	D5			
SSIPeriphID6	0xFD8																
RO	UXFDO												PI	D6			
SSIPeriphID7	0xFDC																
RO	OXI DC												PI	D7			
SSIPeriphID0	0xFE0																
RO	OXI EU												PI	D0			
SSIPeriphID1	0xFE4																
RO	UXI L-I												PI	D1			
SSIPeriphID2	0xFE8																
RO	J. 20						1						PI	D2			
SSIPeriphID3	0xFEC																
RO													PI	D3			
SSIPCellID0	0xFF0																
RO													CI	D0		1	
SSIPCellID1	0xFF4																
RO													CI	D1	ı		
SSIPCellID2	0xFF8																
RO													CI	D2			
SSIPCelIID3	0xFFC																
RO													CI	D3			
Inter-Integ		uit (I ² C) I	nterface														
Base: 0x40 Base: 0x40																	
Base: 0x40																	
Base: 0x40	001.1800														I		
I2CMSA	0x000																
R/W													SA				R/S

Nama	Offset	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
Name	Offset	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
I2CMCS R/W	0x004										BUSBSY	IDLE	ARBI ST	DATACK	ADRACK	FRROR	BUSY
12CMCS	0x004										БООВОТ	IDLL	AINDLOT	BAIAOR	ADIVIOR	LITTOR	5001
R/W														ACK	STOP	START	RUN
I2CMDR R/W	0x008												DA	ATA			
I2CMTPR	0x00C																
R/W													TF	PR			
R/W	0x010											$ \wedge $					IM
I2CMRIS RO	0x014																RIS
I2CMMIS	0x018																Nio
RO	UXUIO																MIS
I2CMICR WO	0x01C																IC
I2CMCR	0x020																
R/W												SFE	MFE				LPBK
I2CSOAR R/W	0x000													OAR			
I2CSCSR RO	0x004														FBR	TREQ	RREQ
I2CSCSR	0x004														FBK	IREQ	KKEQ
RO	0,004																DA
I2CSDR R/W	0x008												DA	ATA			
I2CSIMR	0x00C																
R/W																	IM
I2CSRIS RO	0x010																RIS
I2CSMIS RO	0x014																MIC
I2CSICR																	MIS
WO	0x018																IC